A/D Flash MCU with LCD Driver & High Accuracy HIRC

HT67F2452

Revision: V1.11   Date: February 25, 2025

Features

CPU Features

- Operating voltage
  - f_{SYS}=4MHz: 1.8V~5.5V
- Up to 1μs instruction cycle with 4MHz system clock at V_{DD}=5V
- Power down and wake-up functions to reduce power consumption
- Oscillators
  - External High Speed Crystal – HXT
  - External Low Speed 32.768kHz Crystal – LXT
  - Internal High Speed 4MHz RC – HIRC
  - Internal 32.768kHz RC – LIRC
- Fully integrated internal oscillators require no external components
- Multi-mode operation: FAST, SLOW, IDLE and SLEEP
- All instructions executed in 1~3 instruction cycles
- Table read instructions
- 115 powerful instructions
- 8-level subroutine nesting
- Bit manipulation instruction

Peripheral Features

- Flash Program Memory: 8K×16
- RAM Data Memory: 512×8
- True EEPROM Memory: 128×8
- In Application Programming – IAP
- Watchdog Timer function
- Up to 44 bidirectional I/O lines
- High driver current output pin for IR LED applications
- LCD Driver function
  - SEGs×COMs: 30×4, 29×5 or 28×6
  - Duty type: 1/4 duty, 1/5 duty or 1/6 duty
  - Bias level: 1/3 bias
  - Bias type: R type or C type
  - Waveform type: type A or type B
- Programmable I/O source current for LED applications
- Four external interrupt lines shared with I/O pins
- Multiple Timer Modules for time measurement, input capture, compare match output, PWM output function or single pulse output function
- Single fully-duplex Universal Asynchronous Receiver and Transmitter Interface – UART
- Dual Time Base functions for generation of fixed time interrupt signals
- 8 external channel 12-bit resolution A/D converter with Internal Reference Voltage V_R
- Low Voltage Reset function – LVR
- Low Voltage Detect function – LVD
- Package types: 32/44/48-pin LQFP

Development Tools

For rapid product development and to simplify device parameter setting, Holtek has provided relevant development tools which users can download from the following link:

https://www.holtek.com/page/tool-detail/dev_plat/ha/IR_Remote_Controller_Workshop

https://www.holtek.com/page/tool-detail/dev_plat/ha/air_conditioner_workshop

General Description

The HT67F2452 is a Flash Memory A/D 8-bit high performance RISC architecture microcontroller with LCD driver designed for a wide range of applications that interface directly to analog signals and require a LCD display.
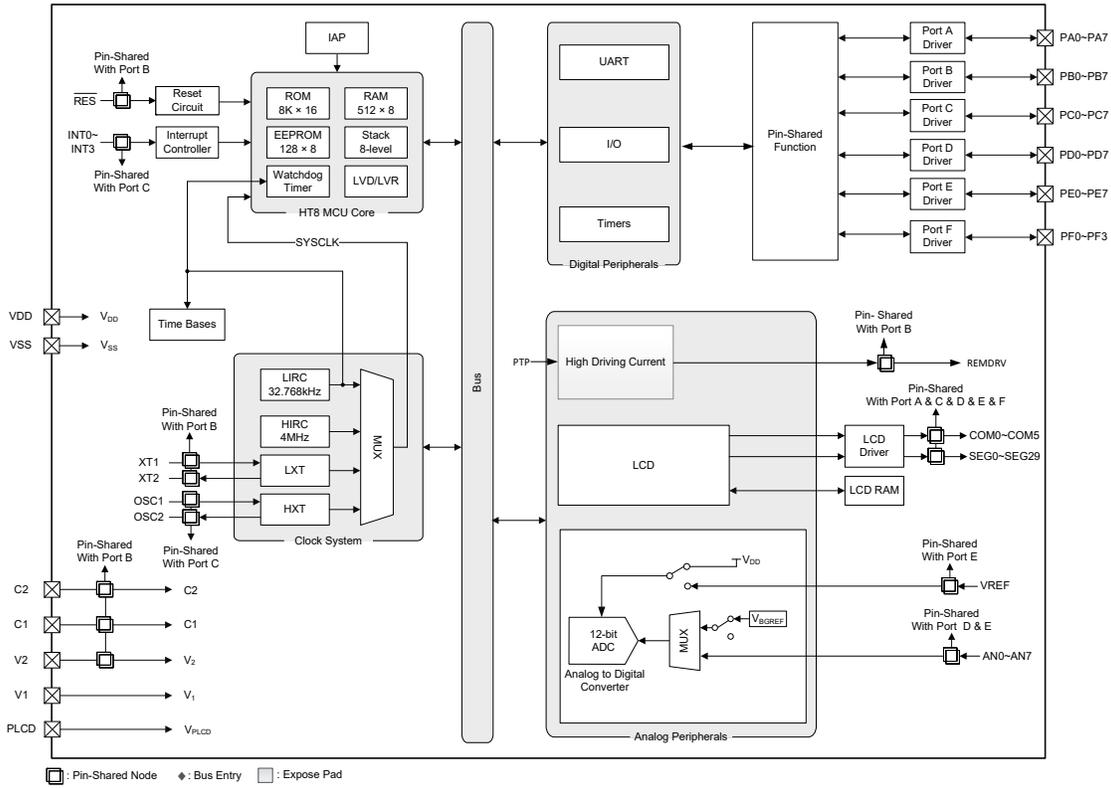
For memory features, the Flash Memory offers users the convenience of multi-programming features. Other memory includes an area of RAM Data Memory as well as an area of true EEPROM memory for storage of non-volatile data such as serial numbers, calibration data etc. By using the In Application Programming technology, users have a convenient means to directly store their measured data in the Flash Program Memory as well as having the ability to easily update their application programs.

Analog features include a multi-channel 12-bit A/D converter function. Multiple and extremely flexible Timer Modules provide timing, pulse generation and PWM generation functions. Communication with the outside world is catered for by including fully integrated UART interface function, this popular interface which provides designers with a means of easy communication with external peripheral hardware. Protective features such as an internal Watchdog Timer, Low Voltage Reset and Low Voltage Detector coupled with excellent noise immunity and ESD protection ensure that reliable operation is maintained in hostile electrical environments.
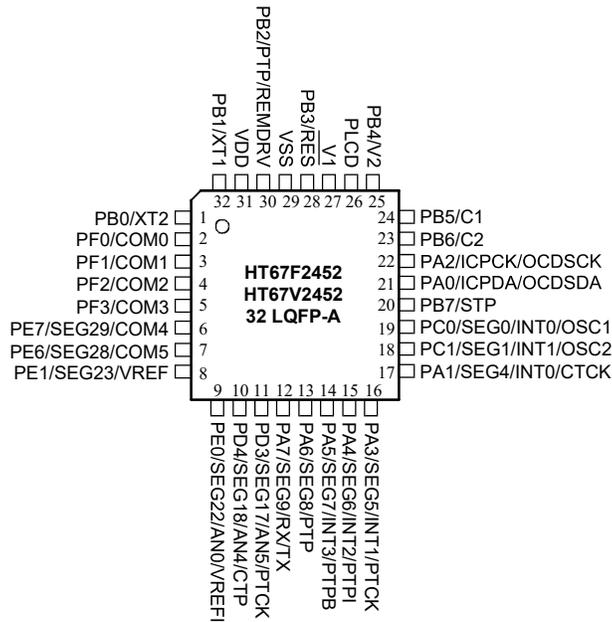
A full choice of external, internal, high and low oscillator is provided including two fully integrated system oscillators which require no external components for its implementation. The ability to operate and switch dynamically between a range of operating modes using different clock sources gives users the ability to optimise microcontroller operation and minimise power consumption. The inclusion of both LCD and LED driver functions allows for easy and cost effective solutions in applications that require interface to these display types.
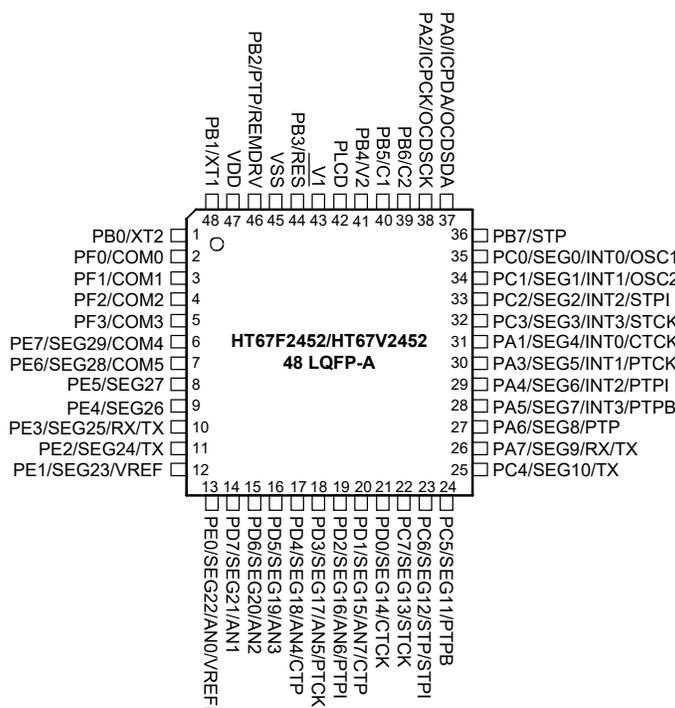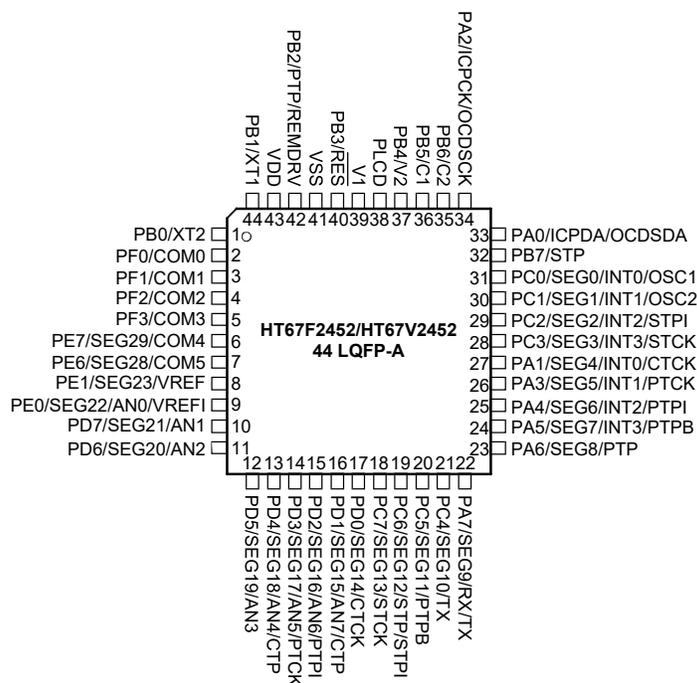
The inclusion of flexible I/O programming features, Time-Base functions along with many other features ensure that the device will find excellent use in applications such as LCD remote controller, electronic metering, environmental monitoring, handheld instruments, household appliances, electronically controlled tools, motor driving in addition to many others.

Block Diagram

Pin Assignment

**HT67F2452/HT67V2452
44 LQFP-A**

Left side pins:
- PB0/XT2 — 1
- PF0/COM0 — 2
- PF1/COM1 — 3
- PF2/COM2 — 4
- PF3/COM3 — 5
- PE7/SEG29/COM4 — 6
- PE6/SEG28/COM5 — 7
- PE1/SEG23/VREF — 8
- PE0/SEG22/AN0/VREFI — 9
- PD7/SEG21/AN1 — 10
- PD6/SEG20/AN2 — 11

Top side pins (44–34):
- PB1/XT1
- VDD
- PB2/PTP/REMDRV
- VSS
- PB3/RES
- V1
- PLCD
- PB4/V2
- PB5/C1
- PB6/C2
- PA2/ICPCK/OCDSCK

Right side pins:
- 33 — PA0/ICPDA/OCDSDA
- 32 — PB7/STP
- 31 — PC0/SEG0/INT0/OSC1
- 30 — PC1/SEG1/INT1/OSC2
- 29 — PC2/SEG2/INT2/STPI
- 28 — PC3/SEG3/INT3/STCK
- 27 — PA1/SEG4/INT0/CTCK
- 26 — PA3/SEG5/INT1/PTCK
- 25 — PA4/SEG6/INT2/PTPI
- 24 — PA5/SEG7/INT3/PTPB
- 23 — PA6/SEG8/PTP

Bottom side pins (12–22):
- PD5/SEG19/AN3
- PD4/SEG18/AN4/CTP
- PD3/SEG17/AN5/PTCK
- PD2/SEG16/AN6/PTPI
- PD1/SEG15/AN7/CTCK
- PD0/SEG14/CTCK
- PC7/SEG13/STCK
- PC6/SEG12/STP/STPI
- PC5/SEG11/PTPB
- PC4/SEG10/TX
- PA7/SEG9/RX/TX

**HT67F2452/HT67V2452
48 LQFP-A**

Left side pins:
- PB0/XT2 — 1
- PF0/COM0 — 2
- PF1/COM1 — 3
- PF2/COM2 — 4
- PF3/COM3 — 5
- PE7/SEG29/COM4 — 6
- PE6/SEG28/COM5 — 7
- PE5/SEG27 — 8
- PE4/SEG26 — 9
- PE3/SEG25/RX/TX — 10
- PE2/SEG24/TX — 11
- PE1/SEG23/VREF — 12

Top side pins (48–37):
- PB1/XT1
- VDD
- PB2/PTP/REMDRV
- VSS
- PB3/RES
- V1
- PLCD
- PB4/V2
- PB5/C1
- PB6/C2
- PA2/ICPCK/OCDSCK
- PA0/ICPDA/OCDSDA

Right side pins:
- 36 — PB7/STP
- 35 — PC0/SEG0/INT0/OSC1
- 34 — PC1/SEG1/INT1/OSC2
- 33 — PC2/SEG2/INT2/STPI
- 32 — PC3/SEG3/INT3/STCK
- 31 — PA1/SEG4/INT0/CTCK
- 30 — PA3/SEG5/INT1/PTCK
- 29 — PA4/SEG6/INT2/PTPI
- 28 — PA5/SEG7/INT3/PTPB
- 27 — PA6/SEG8/PTP
- 26 — PA7/SEG9/RX/TX
- 25 — PC4/SEG10/TX

Bottom side pins (13–24):
- PE0/SEG22/AN0/VREFI
- PD7/SEG21/AN1
- PD6/SEG20/AN2
- PD5/SEG19/AN3
- PD4/SEG18/AN4/CTP
- PD3/SEG17/AN5/PTCK
- PD2/SEG16/AN6/PTPI
- PD1/SEG15/AN7/CTCK
- PD0/SEG14/CTCK
- PC7/SEG13/STCK
- PC6/SEG12/STP/STPI
- PC5/SEG11/PTPB

Note: 1. If the pin-shared pin functions have multiple outputs, the desired pin-shared function is determined by the corresponding software control bits.

2. The OCDSDA and OCDSCK pins are supplied as OCDS dedicated pins and as such only available for the HT67V2452 device which is the OCDS EV chip for the HT67F2452 device.

3. For less pin-count package types there will be unbonded pins which should be properly configured to avoid unwanted current consumption resulting from floating input condition. Refer to the "Standby Current Considerations" and "Input/Output Ports" sections.

Pin Description

The function of each pin is listed in the following table, however the details behind how each pin is configured is contained in other sections of the datasheet. Note that where more than one package type exists the table will reflect the situation for the larger package type.

Pin Name	Function	OPT	I/T	O/T	Description
PA0/OCDSDA/ ICPDA	PA0	PAWU PAPU	ST	CMOS	General purpose I/O. Register enabled pull-up and wake-up
	OCDSDA	—	ST	CMOS	OCDS data/address pin, for EV chip only
	ICPDA	—	ST	CMOS	ICP data/address pin
PA1/SEG4/INT0/ CTCK	PA1	PAWU PAPU PAS0	ST	CMOS	General purpose I/O. Register enabled pull-up and wake-up
	SEG4	PAS0	—	LCD	LCD segment output
	INT0	INTEG INTC0 PAS0 IFS0	ST	—	External Interrupt input 0
	CTCK	PAS0 IFS0	ST	—	CTM clock input
PA2/OCDSCK/ ICPCK	PA2	PAWU PAPU	ST	CMOS	General purpose I/O. Register enabled pull-up and wake-up
	OCDSCK	—	ST	—	OCDS clock input, for EV chip only
	ICPCK	—	ST	CMOS	ICP clock pin
PA3/SEG5/INT1/ PTCK	PA3	PAWU PAPU PAS0	ST	CMOS	General purpose I/O. Register enabled pull-up and wake-up
	SEG5	PAS0	—	LCD	LCD segment output
	INT1	PAS0 INTEG INTC0 IFS0	ST	—	External Interrupt input 1
	PTCK	PAS0 IFS0	ST	—	PTM clock input
PA4/SEG6/INT2/ PTPI	PA4	PAWU PAPU PAS1	ST	CMOS	General purpose I/O. Register enabled pull-up and wake-up
	SEG6	PAS1	—	LCD	LCD segment output
	INT2	PAS1 INTEG INTC3 IFS0	ST	—	External Interrupt input 2
	PTPI	PAS1 IFS1	ST	—	PTM capture input
PA5/SEG7/INT3/ PTPB	PA5	PAWU PAPU PAS1	ST	CMOS	General purpose I/O. Register enabled pull-up and wake-up
	SEG7	PAS1	—	LCD	LCD segment output
	INT3	PAS1 INTEG INTC3 IFS0	ST	—	External Interrupt input 3
	PTPB	PAS1	—	CMOS	PTM inverting output

Pin Name	Function	OPT	I/T	O/T	Description
PA6/SEG8/PTP	PA6	PAWU PAPU PAS1	ST	CMOS	General purpose I/O. Register enabled pull-up and wake-up
	SEG8	PAS1	—	LCD	LCD segment output
	PTP	PAS1	—	CMOS	PTM output
PA7/SEG9/RX/TX	PA7	PAWU PAPU PAS1	ST	CMOS	General purpose I/O. Register enabled pull-up and wake-up
	SEG9	PAS1	—	LCD	LCD segment output
	RX/TX	PAS1 IFS0	ST	CMOS	UART serial data input in full-duplex communication or UART serial data input/output in Single Wire Mode communication
PB0/XT2	PB0	PBPU PBS0	ST	CMOS	General purpose I/O. Register enabled pull-up
	XT2	PBS0	—	LXT	LXT oscillator pin
PB1/XT1	PB1	PBPU PBS0	ST	CMOS	General purpose I/O. Register enabled pull-up
	XT1	PBS0	LXT	—	LXT oscillator pin
PB2/PTP/ REMDRV	PB2	PBPU PBS0	ST	CMOS	General purpose I/O with high current driver output. Register enabled pull-up
	PTP	PBS0	—	CMOS	PTM output
	REMDRV	PBS0	—	CMOS NMOS	IR LED driver (high driving current)
PB3/$\overline{\text{RES}}$	PB3	PBPU RSTC	ST	CMOS	General purpose I/O. Register enabled pull-up
	$\overline{\text{RES}}$	RSTC	ST	—	External reset input
PB4/V2	PB4	PBPU PBS1	ST	CMOS	General purpose I/O. Register enabled pull-up
	V2	PBS1	PWR	AN	LCD voltage pump
PB5/C1	PB5	PBPU PBS1	ST	CMOS	General purpose I/O. Register enabled pull-up
	C1	PBS1	AN	AN	LCD voltage pump
PB6/C2	PB6	PBPU PBS1	ST	CMOS	General purpose I/O. Register enabled pull-up
	C2	PBS1	AN	AN	LCD voltage pump
PB7/STP	PB7	PBPU PBS1	ST	CMOS	General purpose I/O. Register enabled pull-up
	STP	PBS1	—	CMOS	STM output
PC0/SEG0/INT0/ OSC1	PC0	PCPU PCS0	ST	CMOS	General purpose I/O. Register enabled pull-up
	SEG0	PCS0	—	LCD	LCD segment output
	INT0	PCS0 INTEG INTC0 IFS0	ST	—	External Interrupt 0
	OSC1	PCS0	HXT	—	HXT oscillator pin

Pin Name	Function	OPT	I/T	O/T	Description
PC1/SEG1/INT1/ OSC2	PC1	PCPU PCS0	ST	CMOS	General purpose I/O. Register enabled pull-up
	SEG1	PCS0	—	LCD	LCD segment output
	INT1	PCS0 INTEG INTC0 IFS0	ST	—	External Interrupt 1
	OSC2	PCS0	—	HXT	HXT oscillator pin
PC2/SEG2/INT2/ STPI	PC2	PCPU PCS0	ST	CMOS	General purpose I/O. Register enabled pull-up
	SEG2	PCS0	—	LCD	LCD segment output
	INT2	PCS0 INTEG INTC3 IFS0	ST	—	External Interrupt 2
	STPI	PCS0 IFS1	ST	—	STM capture input
PC3/SEG3/INT3/ STCK	PC3	PCPU PCS0	ST	CMOS	General purpose I/O. Register enabled pull-up
	SEG3	PCS0	—	LCD	LCD segment output
	INT3	PCS0 INTEG INTC3 IFS0	ST	—	External Interrupt 3
	STCK	PCS0 IFS0	ST	—	STM clock input
PC4/SEG10/TX	PC4	PCPU PCS1	ST	CMOS	General purpose I/O. Register enabled pull-up
	SEG10	PCS1	—	LCD	LCD segment output
	TX	PCS1	—	CMOS	UART serial data output
PC5/SEG11/ PTPB	PC5	PCPU PCS1	ST	CMOS	General purpose I/O. Register enabled pull-up
	SEG11	PCS1	—	LCD	LCD segment output
	PTPB	PCS1	—	CMOS	PTM inverting output
PC6/SEG12/STP/ STPI	PC6	PCPU PCS1	ST	CMOS	General purpose I/O. Register enabled pull-up
	SEG12	PCS1	—	LCD	LCD segment output
	STP	PCS1	—	CMOS	STM output
	STPI	PCS1 IFS1	ST	—	STM capture input
PC7/SEG13/ STCK	PC7	PCPU PCS1	ST	CMOS	General purpose I/O. Register enabled pull-up
	SEG13	PCS1	—	LCD	LCD segment output
	STCK	PCS1 IFS0	ST	—	STM clock input
PD0/SEG14/ CTCK	PD0	PDPU PDS0	ST	CMOS	General purpose I/O. Register enabled pull-up
	SEG14	PDS0	—	LCD	LCD segment output
	CTCK	PDS0 IFS0	ST	—	CTM clock input

Pin Name	Function	OPT	I/T	O/T	Description
PD1/SEG15/AN7/ CTP	PD1	PDPU PDS0	ST	CMOS	General purpose I/O. Register enabled pull-up
	SEG15	PDS0	—	LCD	LCD segment output
	AN7	PDS0	AN	—	A/D Converter external input channel
	CTP	PDS0	—	CMOS	CTM clock input
PD2/SEG16/AN6/ PTPI	PD2	PDPU PDS0	ST	CMOS	General purpose I/O. Register enabled pull-up
	SEG16	PDS0	—	LCD	LCD segment output
	AN6	PDS0	AN	—	A/D Converter external input channel
	PTPI	PDS0 IFS1	ST	—	PTM capture input
PD3/SEG17/AN5/ PTCK	PD3	PDPU PDS0	ST	CMOS	General purpose I/O. Register enabled pull-up
	SEG17	PDS0	—	LCD	LCD segment output
	AN5	PDS0	AN	—	A/D Converter external analog input
	PTCK	PDS0 IFS0	ST	—	PTM clock input
PD4/SEG18/AN4/ CTP	PD4	PDPU PDS1	ST	CMOS	General purpose I/O. Register enabled pull-up
	SEG18	PDS1	—	LCD	LCD segment output
	AN4	PDS1	AN	—	A/D Converter external input channel
	CTP	PDS1	—	CMOS	CTM clock input
PD5/SEG19/AN3	PD5	PDPU PDS1	ST	CMOS	General purpose I/O. Register enabled pull-up
	SEG19	PDS1	—	LCD	LCD segment output
	AN3	PDS1	AN	—	A/D Converter external input channel
PD6/SEG20/AN2	PD6	PDPU PDS1	ST	CMOS	General purpose I/O. Register enabled pull-up
	SEG20	PDS1	—	LCD	LCD segment output
	AN2	PDS1	AN	—	A/D Converter external input channel
PD7/SEG21/AN1	PD7	PDPU PDS1	ST	CMOS	General purpose I/O. Register enabled pull-up
	SEG21	PDS1	—	LCD	LCD segment output
	AN1	PDS1	AN	—	A/D Converter external input channel
PE0/SEG22/AN0/ VREFI	PE0	PEPU PES0	ST	CMOS	General purpose I/O. Register enabled pull-up
	SEG22	PES0	—	LCD	LCD segment output
	AN0	PES0	AN	—	A/D Converter external input channel
	VREFI	PES0	AN	—	A/D Converter PGA input
PE1/SEG23/ VREF	PE1	PEPU PES0	ST	CMOS	General purpose I/O. Register enabled pull-up
	SEG23	PES0	—	LCD	LCD segment output
	VREF	PES0	AN	—	A/D Converter external reference voltage input
PE2/SEG24/TX	PE2	PEPU PES0	ST	CMOS	General purpose I/O. Register enabled pull-up
	SEG24	PES0	—	LCD	LCD segment output
	TX	PES0	—	CMOS	UART serial data output

Pin Name	Function	OPT	I/T	O/T	Description
PE3/SEG25/RX/TX	PE3	PEPU PES0	ST	CMOS	General purpose I/O. Register enabled pull-up
	SEG25	PES0	—	LCD	LCD segment output
	RX/TX	PES0 IFS0	ST	CMOS	UART serial data input in full-duplex communication or UART serial data input / output in Single Wire Mode communication
PE4/SEG26	PE4	PEPU PES1	ST	CMOS	General purpose I/O. Register enabled pull-up
	SEG26	PES1	—	LCD	LCD segment output
PE5/SEG27	PE5	PEPU PES1	ST	CMOS	General purpose I/O. Register enabled pull-up
	SEG27	PES1	—	LCD	LCD segment output
PE6/SEG28/COM5	PE6	PEPU PES1	ST	CMOS	General purpose I/O. Register enabled pull-up
	SEG28	PES1	—	LCD	LCD segment output
	COM5	PES1	—	LCD	LCD common output
PE7/SEG29/COM4	PE7	PEPU PES1	ST	CMOS	General purpose I/O. Register enabled pull-up
	SEG29	PES1	—	LCD	LCD segment output
	COM4	PES1	—	LCD	LCD common output
PF0/COM0	PF0	PFPU PFS0	ST	CMOS	General purpose I/O. Register enabled pull-up
	COM0	PFS0	—	LCD	LCD common output
PF1/COM1	PF1	PFPU PFS0	ST	CMOS	General purpose I/O. Register enabled pull-up
	COM1	PFS0	—	LCD	LCD common output
PF2/COM2	PF2	PFPU PFS0	ST	CMOS	General purpose I/O. Register enabled pull-up
	COM2	PFS0	—	LCD	LCD common output
PF3/COM3	PF3	PFPU PFS0	ST	CMOS	General purpose I/O. Register enabled pull-up
	COM3	PFS0	—	LCD	LCD common output
PLCD	PLCD	—	PWR	AN	LCD power supply
V1	V1	—	PWR	AN	LCD voltage pump
VDD	VDD	—	PWR	—	Positive power supply
VSS	VSS	—	PWR	—	Negative power supply

Legend: I/T: Input type;   O/T: Output type;

OPT: Optional by register option;   ST: Schmitt Trigger input;

CMOS: CMOS output;   NMOS: NMOS output;

AN: Analog signal;   PWR: Power;

LXT: Low frequency crystal oscillator;   HXT: High frequency crystal oscillator;

LCD: LCD SEG/COM output.

Absolute Maximum Ratings

Supply Voltage ....V_{SS}-0.3V to 6.0V

Input Voltage .... V_{SS}-0.3V to V_{DD}+0.3V

Storage Temperature.. -60°C to 150°C

Operating Temperature.. -40°C to 85°C

I_{OL} Total 750mA

I_{OH} Total .... -80mA

Total Power Dissipation 1200mW

Note: These are stress ratings only. Stresses exceeding the range specified under "Absolute Maximum Ratings" may cause substantial damage to the device. Functional operation of this device at other conditions beyond those listed in the specification is not implied and prolonged exposure to extreme conditions may affect device reliability.

D.C. Characteristics

For data in the following tables, note that factors such as oscillator type, operating voltage, operating frequency, pin load conditions, temperature and program instruction type, etc., can all exert an influence on the measured values.

Operating Voltage Characteristics

Ta=25°C

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V_{DD}	Operating Voltage – HXT	f_{SYS}=4MHz	1.8	—	5.5	V
	Operating Voltage – HIRC	f_{SYS}=4MHz	1.8	—	5.5	
	Operating Voltage – LXT	f_{SYS}=32768Hz	1.8	—	5.5	
	Operating Voltage – LIRC	f_{SYS}=32768Hz	1.8	—	5.5	

Operating Current Characteristics

Ta=25°C

Symbol	Operating Mode	Test Conditions		Min.	Typ.	Max.	Unit
		V_{DD}	Conditions				
I_{DD}	SLOW Mode – LIRC	1.8V	f_{SYS}=32768Hz	—	12	24	µA
		3V		—	15	30	
		5V		—	30	50	
	SLOW Mode – LXT	1.8V	f_{SYS}=32768Hz	—	12	24	µA
		3V		—	15	30	
		5V		—	30	50	
	FAST Mode – HIRC	1.8V	f_{SYS}=4MHz	—	0.8	1.2	mA
		3V		—	1.0	1.5	
		5V		—	2	3	
	FAST Mode – HXT	1.8V	f_{SYS}=4MHz	—	0.8	1.2	
		3V		—	1.0	1.5	
		5V		—	2	3	

Note: When using the characteristic table data, the following notes should be taken into consideration:
1. Any digital inputs are setup in a non-floating condition.
2. All measurements are taken under conditions of no load and with all peripherals in an off state.
3. There are no DC current paths.
4. All Operating Current values are measured using a continuous NOP instruction program loop.

Standby Current Characteristics

Ta=25°C, unless otherwise specified

Symbol	Standby Mode	Test Conditions		Min.	Typ.	Max.	Max. @85°C	Unit
		V_{DD}	Conditions					
I_{STB}	SLEEP Mode	1.8V	WDT off	—	0.5	0.8	7.0	μA
		3V		—	0.6	0.9	8.0	
		5V		—	0.7	2.0	11.0	
		1.8V	WDT on	—	1.5	3.0	8.0	
		3V		—	1.8	3.6	9.0	
		5V		—	3	5	12	
	IDLE0 Mode – LIRC	1.8V	f_{SUB} on	—	2.4	4.0	8.0	μA
		3V		—	3	5	9.0	
		5V		—	5	10	12	
	IDLE0 Mode – LXT	1.8V	f_{SUB} on	—	2.4	4.0	8.0	μA
		3V		—	3	5	9	
		5V		—	5	10	12	
	IDLE1 Mode – HIRC	1.8V	f_{SUB} on, f_{SYS}=4MHz	—	450	650	760	μA
		3V		—	480	700	860	
		5V		—	600	800	960	
	IDLE1 Mode – HXT	1.8V	f_{SUB} on, f_{SYS}=4MHz	—	288	400	480	μA
		3V		—	360	500	600	
		5V		—	850	1000	1200	

Note: When using the characteristic table data, the following notes should be taken into consideration:
1. Any digital inputs are setup in a non-floating condition.
2. All measurements are taken under conditions of no load and with all peripherals in an off state.
3. There are no DC current paths.
4. All Standby Current values are taken after a HALT instruction execution thus stopping all instruction execution.

A.C. Characteristics

For data in the following tables, note that factors such as oscillator type, operating voltage, operating frequency and temperature etc., can all exert an influence on the measured values.

High Speed Internal Oscillator – HIRC – Frequency Accuracy

During the program writing operation the writer will trim the HIRC oscillator with ±0.03% accuracy at a user selected HIRC frequency and user selected voltage of 3V.

Symbol	Parameter	Test Conditions		Min	Typ	Max	Unit
		V_{DD}	Temp.				
f_{HIRC}	4MHz Writer Trimmed HIRC Frequency	2.2V~3.6V	-10°C~50°C	-0.8%	4	+0.8%	MHz
			-40°C~85°C	-2.0%	4	+2.0%	
		1.8V~3.6V	-10°C~50°C	-0.8%	4	+0.8%	
			-40°C~85°C	-2.0%	4	+2.0%	
		2.2V~5.5V	-10°C~50°C	-0.8%	4	+0.8%	
			-40°C~85°C	-2.0%	4	+2.0%	
		1.8V~5.5V	-40°C~85°C	-2.0%	4	+2.0%	

Low Speed Internal Oscillator Characteristics – LIRC

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Unit
		V_{DD}	Temp.				
f_{LIRC}	LIRC Frequency	1.8V~3.6V (trim @ 3V)	-10°C~50°C	-2.0%	32.768	+2.0%	kHz
			-40°C~85°C	-5.5%	32.768	+5.5%	
		3.3V~5.5V (trim @ 5V)	-10°C~50°C	-3.0%	32.768	+3.0%	
			-40°C~85°C	-6.0%	32.768	+6.0%	
		1.8V~5.5V (trim @ 3V)	-40°C~85°C	-6.0%	32.768	+6.0%	
		1.8V~5.5V (trim @ 3V)	25°C	-3.0%	32.768	+3.0%	
t_{START}	LIRC Start Up Time	—	—	—	—	100	µs

Low Speed Crystal Oscillator Characteristics – LXT

Ta=25°C

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Unit
		V_{DD}	Conditions				
f_{LXT}	LXT Frequency	1.8V~5.5V	—	—	32768	—	Hz
t_{START}	LXT Start Up Time	3V	—	—	—	1000	ms
		5V	—	—	—	1000	
Duty Cycle	Duty Cycle	—	—	40	—	60	%
R_{NEG}	Negative Resistance	1.8V	—	3×ESR	—	—	Ω

Note: C1 and C2 are external components, C1=C2=10pF, C_L=7pF, ESR=30kΩ.

Operating Frequency Characteristic Curves

System Start Up Time Characteristics

Ta=-40°C~85°C

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Unit
		V_{DD}	Conditions				
t_{SST}	System Start-up Time Wake-up from condition where f_{SYS} is off	—	$f_{SYS}=f_H\sim f_H/64$, $f_H=f_{HXT}$	—	128	—	t_{HXT}
		—	$f_{SYS}=f_H\sim f_H/64$, $f_H=f_{HIRC}$	—	16	—	t_{HIRC}
		—	$f_{SYS}=f_{SUB}=f_{LXT}$	—	1024	—	t_{LXT}
		—	$f_{SYS}=f_{SUB}=f_{LIRC}$	—	2	—	t_{LIRC}
	System Start-up Time Wake-up from condition where f_{SYS} is on	—	$f_{SYS}=f_H\sim f_H/64$, $f_H=f_{HXT}$ or f_{HIRC}	—	2	—	t_H
		—	$f_{SYS}=f_{SUB}=f_{LXT}$ or f_{LIRC}	—	2	—	t_{SUB}

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Unit
		V_{DD}	Conditions				
t_{SST}	System Speed Switch Time FAST to SLOW Mode or SLOW to FAST Mode	—	f_{HXT} switches from off → on	—	1024	—	t_{HXT}
		—	f_{HIRC} switches from off → on	—	16	—	t_{HIRC}
		—	f_{LXT} switches from off → on	—	1024	—	t_{LXT}
t_{RSTD}	System Reset Delay Time Reset Source from Power-on Reset or LVR Hardware Reset	—	RR_{POR}=5V/ms	10	16	22	ms
	System Reset Delay Time LVRC/WDTC/RSTC Software Reset	—	—				
	System Reset Delay Time (Reset Source from WDT Overflow or $\overline{RES}$ pin reset)	—	—	10	16	22	ms

Note: 1. For the System Start-up time values, whether f_{SYS} is on or off depends upon the mode type and the chosen f_{SYS} system oscillator. Details are provided in the System Operating Modes section.

2. The time units, shown by the symbols t_{HXT}, t_{HIRC} etc., are the inverse of the corresponding frequency values as provided in the frequency tables. For example, t_{HIRC}=1/f_{HIRC}, t_{SYS}=1/f_{SYS} etc.

3. If the LIRC is used as the system clock and if it is off when in the SLEEP Mode, then an additional LIRC start up time, t_{START}, as provided in the LIRC frequency table, must be added to the t_{SST} time in the table above.

4. The System Speed Switch Time is effectively the time taken for the newly activated oscillator to start up.

Input/Output Characteristics

Ta=25°C

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Unit
		V_{DD}	Conditions				
V_{IL}	Input Low Voltage for I/O Ports except PB2 and $\overline{RES}$ Pins	5V	—	0	—	1.5	V
		—	—	0	—	$0.2V_{DD}$	
	Input Low Voltage for $\overline{RES}$ pin	—	V_{DD}≥ 2.7	0	—	$0.4V_{DD}$	
		—	1.8≤V_{DD}< 2.7	0	—	$0.3V_{DD}$	
V_{IH}	Input High Voltage for I/O Ports except PB2 and $\overline{RES}$ Pins	5V	—	3.5	—	5.0	V
		—	—	$0.8V_{DD}$	—	V_{DD}	
	Input High Voltage for $\overline{RES}$ pin	—	—	$0.9V_{DD}$	—	V_{DD}	V
I_{OL}	Sink Current for I/O Ports except PB2 Pins	3V	V_{OL}=0.1V_{DD}	16	32	—	mA
		5V		32	65	—	
I_{OH}	Source Current for I/O Ports except PB2 Pins	3V	V_{OH}=0.9V_{DD}, SLEDCn[m+1:m]=00, (n=0~1; m=0, 2, 4, 6)	-0.7	-1.5	—	mA
		5V		-1.5	-2.9	—	
		3V	V_{OH}=0.9V_{DD}, SLEDCn[m+1:m]=01, (n=0~1; m=0, 2, 4, 6)	-1.3	-2.5	—	
		5V		-2.5	-5.1	—	
		3V	V_{OH}=0.9V_{DD}, SLEDCn[m+1:m]=10, (n=0~1; m=0, 2, 4, 6)	-1.8	-3.6	—	
		5V		-3.6	-7.3	—	
		3V	V_{OH}=0.9V_{DD}, SLEDCn[m+1:m]=11, (n=0~1; m=0, 2, 4, 6)	-4	-8	—	
		5V		-8	-16	—	
R_{PH}	Pull-high Resistance for I/O Ports except PB2 Pins [Note]	3V	LVPU=0 PxPU=FFH (Px: PA~PF)	20	60	100	kΩ
		5V		10	30	50	
		3V	LVPU=1 PxPU=FFH (Px: PA~PF)	6.67	15.00	23.00	
		5V		3.5	7.5	12.0	

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Unit
		V_{DD}	Conditions				
I_{LEAK}	Input Leakage Current for I/O Ports except PB2 Pins	3V	$V_{IN}=V_{DD}$ or $V_{IN}=V_{SS}$	—	—	±1	µA
		5V					
t_{TCK}	TM Clock Input Pin Minimum Pulse Width	—	—	0.3	—	—	µs
t_{TPI}	TM Capture Input Pin Minimum Pulse Width	—	—	0.3	—	—	µs
t_{INT}	External Interrupt Minimum Pulse Width	—	—	10	—	—	µs
t_{RES}	External Reset Minimum Low Pulse Width	—	—	10	—	—	µs
t_{SRESET}	Minimum Software Reset Width to Reset	—	—	45	90	120	µs

Note: The R_{PH} internal pull high resistance value is calculated by connecting to ground and enabling the input pin with a pull-up resistor and then measuring the pin current at the specified supply voltage level. Dividing the voltage by this measured current provides the R_{PH} value.

REMDRV Characteristics

Ta=25°C

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Unit
		V_{DD}	Conditions				
V_{IL}	Input Low Voltage for PB2 Pin	5V	—	0	—	1.5	V
		—		0	—	$0.2V_{DD}$	
V_{IH}	Input High Voltage for PB2 Pin	5V	—	3.5	—	5.0	V
		—		$0.8V_{DD}$	—	V_{DD}	
I_{OL}	Sink Current for REM Device Output [1]	3V	$V_{OL}=0.5V$, REMEN bit=1 (REMS[1:0]=00)	75	125	—	mA
		3V	$V_{OL}=0.5V$, REMEN bit=1 (REMS[1:0]=01)	125	250	—	
		3V	$V_{OL}=0.5V$, REMEN bit=1 (REMS[1:0]=10)	185	375	—	
		3V	$V_{OL}=0.5V$, REMEN bit=1 (REMS[1:0]=11)	250	500	—	
	Source Current for PB2 Pin	3V	$V_{OL}=0.1V_{DD}$	16	32	—	mA
		5V		32	65	—	
I_{OH}	Source Current for PB2 Pin	3V	$V_{OH}=0.9V_{DD}$, SLEDC0[5:4]=00	-0.7	-1.5	—	mA
		5V		-1.5	-2.9	—	
		3V	$V_{OH}=0.9V_{DD}$, SLEDC0[5:4]=01	-1.3	-2.5	—	
		5V		-2.5	-5.1	—	
		3V	$V_{OH}=0.9V_{DD}$, SLEDC0[5:4]=10	-1.8	-3.6	—	
		5V		-3.6	-7.3	—	
		3V	$V_{OH}=0.9V_{DD}$, SLEDC0[5:4]=11	-4	-8	—	
		5V		-8	-16	—	
R_{PH}	Pull-high Resistance for PB2 Pin [2]	3V	LVPU=0, PBPU2=1	20	60	100	kΩ
		5V		10	30	50	
		3V	LVPU=1, PBPU2=1	6.67	15.00	23.00	
		5V		3.5	7.5	12.0	
I_{LEAK}	Input Leakage Current for PB2 Pin	3V	$V_{IN}=V_{DD}$ or $V_{IN}=V_{SS}$	—	—	±1	µA
		5V					
t_{READYB}	High Current Output Function Stable Time for PB2 Pin	—	READYB state changed from 0 to 1 and then to 0 again	300	—	—	µs

Note: 1. The REMDRV output is controlled by PTM in the PWM mode which can be used to generate the IR carrier signal. It's strongly recommended that the PWM frequency is under 56kHz to generate a proper REMDRV sink current.

2. The R_{PH} internal pull high resistance value is calculated by connecting to ground and enabling the input pin with a pull-up resistor and then measuring the pin current at the specified supply voltage level. Dividing the voltage by this measured current provides the R_{PH} value.

A/D Converter Electrical Characteristics

Ta=25°C, unless otherwise specified

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Unit
		V_DD	Conditions				
V_ADI	Input Voltage	—	—	0	—	V_REF	V
V_REF	Reference Voltage	—	—	1.8	—	V_DD	V
N_R	Resolution	—	—	—	—	12	Bit
DNL	Differential Non-linearity	1.8V	SAINS[3:0]=0000B, SAVRS[1:0]=01B, V_REF=V_DD, t_ADCK=2.0µs	-3	—	3	LSB
		2V	SAINS[3:0]=0000B, SAVRS[1:0]=01B, V_REF=V_DD, t_ADCK=0.5µs				
		3V					
		5V					
		1.8V	SAINS[3:0]=0000B, SAVRS[1:0]=01B, V_REF=V_DD, t_ADCK=10µs				
		3V					
		5V					
INL	Integral Non-linearity	1.8V	SAINS[3:0]=0000B, SAVRS[1:0]=01B, V_REF=V_DD, t_ADCK=2.0µs Ta=-40°C~85°C	-4	—	4	LSB
		2V	SAINS[3:0]=0000B, SAVRS[1:0]=01B, V_REF=V_DD, t_ADCK=0.5µs Ta=-40°C~85°C				
		3V					
		5V					
		1.8V	SAINS[3:0]=0000B, SAVRS[1:0]=01B, V_REF=V_DD, t_ADCK=10µs Ta=-40°C~85°C				
		3V					
		5V					
I_ADC	Additional Current Consumption for A/D Converter Enable	1.8V	No load, t_ADCK=2.0µs	—	280	400	µA
		3V	No load, t_ADCK=0.5µs	—	450	600	µA
		5V	No load, t_ADCK=0.5µs	—	850	1000	µA
t_ADCK	Clock Period	—	1.8V≤V_DD<2.0V	2.0	—	10.0	µs
			2.0V≤V_DD≤5.5V	0.5	—	10.0	µs
t_ON2ST	A/D Converter On-to-Start Time	—	—	4	—	—	µs
t_ADC	Conversion Time (Including A/D Converter Sample and Hold Time)	—	—	—	16	—	t_ADCK
I_PGA	Additional Current for PGA Enable	2.2V	No load, PGAIS=1, PGAGS[1:0]=01	—	250	500	µA
		3V		—	300	600	
		5V		—	400	700	
V_OR	PGA Maximum Output Voltage Range	2.2V	—	V_SS+0.1	—	V_DD-0.1	V
		3V					
		5V					
V_VR	Fix Voltage Output of PGA	2.2V~5.5V	Ta=-40°C~85°C, V_RI=V_BGREF (PGAIS=1)	-1%	2	+1%	V
		3.2V~5.5V		-1%	3	+1%	
		4.2V~5.5V		-1%	4	+1%	
V_IR	PGA Input Voltage Range	3V	Gain=1, PGAIS=0 Relative gain Gain error <±5%	V_SS+0.1	—	V_DD-1.4	V
		5V		V_SS+0.1	—	V_DD-1.4	V

Memory Electrical Characteristics

Ta=-40°C~85°C, unless otherwise specified

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Unit
		V_{DD}	Conditions				
V_{RW}	V_{DD} for Read/Write	—	—	V_{DDmin}	—	V_{DDmax}	V
Flash Program Memory							
t_{FWR}	Write Time	—	FWERTS bit=0	—	2.2	2.7	ms
		—	FWERTS bit=1	—	3.0	3.6	ms
t_{FER}	Erase Time	—	FWERTS bit=0	—	3.2	3.9	ms
		—	FWERTS bit=1	—	3.7	4.5	ms
E_P	Cell Endurance	—	—	10K	—	—	E/W
t_{RETD}	ROM Data Retention Time	—	Ta=25°C	—	40	—	Year
t_{ACTV}	ROM Activation Time – Wake-up from Power Down Mode [(Note)]	—	—	32	—	64	µs
Data EEPROM Memory							
t_{EEWR}	Write Time (Byte Mode)	—	EWERTS bit=0	—	5.4	6.6	ms
		—	EWERTS bit=1	—	6.7	8.1	ms
	Write Time (Page Mode)	—	EWERTS bit=0	—	2.2	2.7	ms
		—	EWERTS bit=1	—	3.0	3.6	ms
t_{EEER}	Erase Time	—	EWERTS bit=0	—	3.2	3.9	ms
		—	EWERTS bit=1	—	3.7	4.5	ms
E_P	Cell Endurance	—	—	100K	—	—	E/W
t_{RETD}	ROM Data Retention Time	—	Ta=25°C	—	40	—	Year
RAM Data Memory							
V_{DR}	RAM Data Retention Voltage	—	Device in SLEEP Mode	1	—	—	V

Note: 1. The ROM activation time t_{ACTV} should be added when calculating the total system start-up time of a wake-up from the power down mode.

2. "E/W" means Erase/Write times.

Internal Reference Voltage Characteristics

Ta=-40°C~85°C, unless otherwise specified

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Unit
		V_{DD}	Conditions				
V_{BGREF}	Bandgap Reference Voltage	1.8V~2.2V	—	-10%	1.2	+10%	V
		2.2V~5.5V	—	-1%	1.2	+1%	
I_{BGREF}	Operating Current	5.5V	—	—	25	40	µA
PSRR	Power Supply Rejection Ratio	—	Ta=25°C, V_{RIPPLE}=1V_{P-P}, f_{RIPPLE}=100Hz	75	—	—	dB
En	Output Noise	—	Ta=25°C, no load current, f=0.1Hz~10Hz	—	300	—	µV_{RMS}
I_{SD}	Shutdown Current	—	VBGREN=0	—	—	0.1	µA
t_{START}	Start Up Time	1.8V~5.5V	Ta=25°C	—	—	400	µs

Note: 1. All the above parameters are measured under conditions of no load condition unless otherwise described.

2. A 0.1µF ceramic capacitor should be connected between VDD and GND.

3. The V_{BGREF} voltage is used as the A/D converter PGA input signal.

LVD/LVR Electrical Characteristics

Ta=25°C, unless otherwise specified

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Unit
		V_{DD}	Conditions				
V_{LVR}	Low Voltage Reset Voltage	—	LVR enable, voltage select 1.7V	-5%	1.7	+5%	V
			LVR enable, voltage select 1.9V		1.9		
			LVR enable, voltage select 2.55V	-3%	2.55	+3%	
			LVR enable, voltage select 3.15V		3.15		
			LVR enable, voltage select 3.8V		3.8		
V_{LVD}	Low Voltage Detection Voltage	—	LVD enable, voltage select 1.8V	-5%	1.8	+5%	V
			LVD enable, voltage select 2.0V		2.0		
			LVD enable, voltage select 2.4V		2.4		
			LVD enable, voltage select 2.7V		2.7		
			LVD enable, voltage select 3.0V		3.0		
			LVD enable, voltage select 3.3V		3.3		
			LVD enable, voltage select 3.6V		3.6		
			LVD enable, voltage select 4.0V		4.0		
I_{LVRLVD}	Operating Current	3V	LVD enable, LVR enable, V_{LVR}=1.9V, V_{LVD}=2V	—	—	10	μA
		5V		—	10	15	
t_{LVDS}	LVDO Stable Time	—	For LVR enable, LVD off → on Ta=-40°C ~85°C	—	—	18	μs
		—	For LVR disable, LVD off → on Ta=-40°C ~85°C	—	—	150	μs
t_{LVR}	Minimum Low Voltage Width to Reset	—	TLVR[1:0]=00B	120	240	480	μs
			TLVR[1:0]=01B	0.5	1.0	2.0	ms
			TLVR[1:0]=10B	1	2	4	
			TLVR[1:0]=11B	2	4	8	
t_{LVD}	Minimum Low Voltage Width to Interrupt	—	—	40	120	900	μs
I_{LVR}	Additional Current for LVR Enable	5V	LVD disable	—	—	14	μA
I_{LVD}	Additional Current for LVD Enable	5V	LVR disable	—	—	14	μA

LCD Electrical Characteristics

Ta=25°C

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Unit
		V_{DD}	Conditions				
V_{IN}	LCD Operating Voltage	—	Power supply from V_{DD} (for R type)	3.0	—	5.5	V
		—	Power supply from PLCD pin (for C type)	2.0	—	3.7	
		—	Power supply from V1 pin (for C type)	3.0	—	5.5	
		—	Power supply from V2 pin (for C type)	1.0	—	1.8	
		—	Power supply from V_A (for C type)	3.0	—	5.5	
		—	Power supply from V_B (for C type)	2.0	—	3.7	
		1.8V~ 3.3V	Power supply from V_C (for C type)	-10%	1.0	+10%	

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Unit
		V_{DD}	Conditions				
I_{LCD}	Additional Current for LCD Enable – R type	3V	No load, R_T=1170kΩ,V_A=V_{DD}, 1/3 bias	—	3	6	μA
		5V		—	5	10	
		3V	No load, R_T=225kΩ,V_A=V_{DD}, 1/3 bias	—	16	28	
		5V		—	21	40	
		3V	No load, R_T=45kΩ,V_A=V_{DD}, 1/3 bias	—	65	95	
		5V		—	110	160	
	Additional Current for LCD Enabled – C type	3V	No load, V_A=V_1=V_{DD}, 1/3 bias	—	0.6	1.2	
		5V		—	1	2	
I_{LCDOL}	LCD Common and Segment Sink Current	3V	V_{OL}=0.1V_{DD}	210	420	—	μA
		5V		350	700	—	
I_{LCDOH}	LCD Common and Segment Source Current	3V	V_{OH}=0.9V_{DD}	-80	-160	—	μA
		5V		-180	-360	—	

Power-on Reset Characteristics

Ta=-40°C~85°C

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Unit
		V_{DD}	Conditions				
V_{POR}	V_{DD} Start Voltage to Ensure Power-on Reset	—	—	—	—	100	mV
RR_{POR}	V_{DD} Rising Rate to Ensure Power-on Reset	—	—	0.035	—	—	V/ms
t_{POR}	Minimum Time for V_{DD} Stays at V_{POR} to Ensure Power-on Reset	—	—	1	—	—	ms
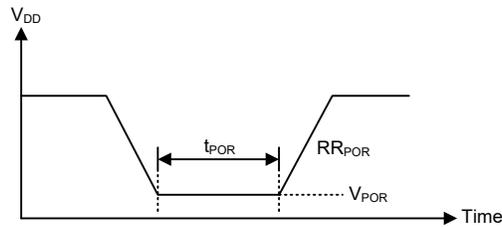
System Architecture

A key factor in the high-performance features of the Holtek range of microcontrollers is attributed to their internal system architecture. The device takes advantage of the usual features found within RISC microcontrollers providing increased speed of operation and enhanced performance. The pipelining scheme is implemented in such a way that instruction fetching and instruction execution are overlapped, hence instructions are effectively executed in one or two cycles for most of the standard or extended instructions respectively. The exceptions to this are branch or call instructions which need one more cycle. An 8-bit wide ALU is used in practically all instruction set operations, which carries out arithmetic operations, logic operations, rotation, increment, decrement, branch decisions, etc. The internal data path is simplified by moving data through the Accumulator and the ALU. Certain internal registers are implemented in the Data Memory and can be directly or indirectly addressed. The simple addressing methods of these registers along with additional architectural features ensure that a minimum of external components is required to provide a functional I/O and A/D control system with maximum reliability and flexibility. This makes the device suitable for low-cost, high-volume production for controller applications.

Clocking and Pipelining

The main system clock, derived from either an HIRC, LIRC, HXT or LXT oscillator is subdivided into four internally generated non-overlapping clocks, T1~T4. The Program Counter is incremented at the beginning of the T1 clock during which time a new instruction is fetched. The remaining T2~T4 clocks carry out the decoding and execution functions. In this way, one T1~T4 clock cycle forms one instruction cycle. Although the fetching and execution of instructions takes place in consecutive instruction cycles, the pipelining structure of the microcontroller ensures that instructions are effectively executed in one instruction cycle. The exception to this are instructions where the contents of the Program Counter are changed, such as subroutine calls or jumps, in which case the instruction will take one more instruction cycle to execute.

For instructions involving branches, such as jump or call instructions, two machine cycles are required to complete instruction execution. An extra cycle is required as the program takes one cycle to first obtain the actual jump or call address and then another cycle to actually execute the branch. The requirement for this extra cycle should be taken into account by programmers in timing sensitive applications.
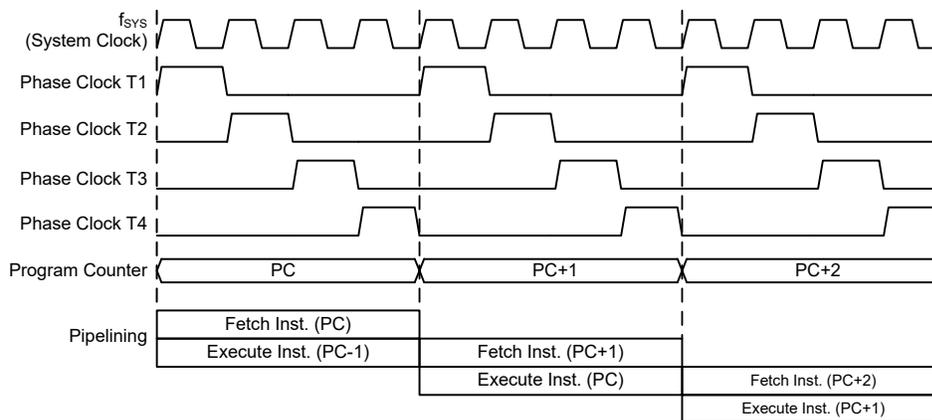
System Clocking and Pipelining
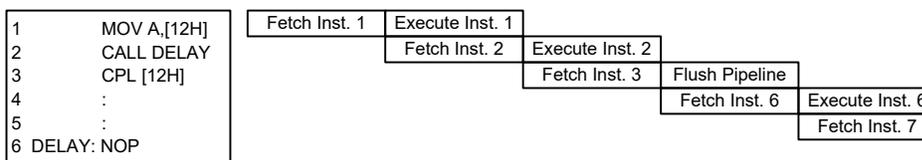
Instruction Fetching

Program Counter

During program execution, the Program Counter is used to keep track of the address of the next instruction to be executed. It is automatically incremented by one each time an instruction is executed except for instructions, such as "JMP" or "CALL" that demands a jump to a non-consecutive Program Memory address. Only the lower 8 bits, known as the Program Counter Low Register, are directly addressable by the application program.

When executing instructions requiring jumps to non-consecutive addresses such as a jump instruction, a subroutine call, interrupt or reset, etc., the microcontroller manages program control by loading the required address into the Program Counter. For conditional skip instructions, once the condition has been met, the next instruction, which has already been fetched during the present instruction execution, is discarded and a dummy cycle takes its place while the correct instruction is obtained.

Program Counter	
High Byte	**PCL Register**
PC12~PC8	PCL7~PCL0

Program Counter

The lower byte of the Program Counter, known as the Program Counter Low register or PCL, is available for program control and is a readable and writeable register. By transferring data directly into this register, a short program jump can be executed directly. However, as only this low byte is available for manipulation, the jumps are limited to the present page of memory that is 256 locations. When such program jumps are executed it should also be noted that a dummy cycle will be inserted. Manipulating the PCL register may cause program branching, so an extra cycle is needed to pre-fetch.

Stack

This is a special part of the memory which is used to save the contents of the Program Counter only. The stack is organized into 8 levels and is neither part of the data nor part of the program space, and is neither readable nor writeable. The activated level is indexed by the Stack Pointer, and is neither readable nor writeable. At a subroutine call or interrupt acknowledge signal, the contents of the Program Counter are pushed onto the stack. At the end of a subroutine or an interrupt routine, signaled by a return instruction, RET or RETI, the Program Counter is restored to its previous value from the stack. After a device reset, the Stack Pointer will point to the top of the stack.
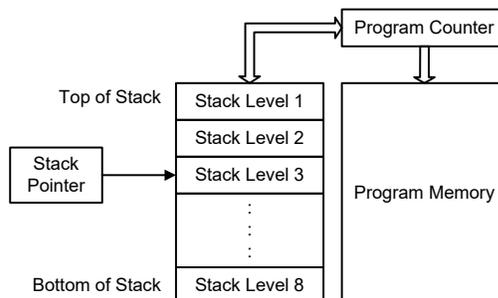
If the stack is full and an enabled interrupt takes place, the interrupt request flag will be recorded but the acknowledge signal will be inhibited. When the Stack Pointer is decremented, by RET or RETI, the interrupt will be serviced. This feature prevents stack overflow allowing the programmer to use the structure more easily. However, when the stack is full, a CALL subroutine instruction can still be executed which will result in a stack overflow. Precautions should be taken to avoid such cases which might cause unpredictable program branching. If the stack is overflow, the first Program Counter save in the stack will be lost.

Arithmetic and Logic Unit – ALU

The arithmetic-logic unit or ALU is a critical area of the microcontroller that carries out arithmetic and logic operations of the instruction set. Connected to the main microcontroller data bus, the ALU receives related instruction codes and performs the required arithmetic or logical operations after which the result will be placed in the specified register. As these ALU calculation or operations may result in carry, borrow or other status changes, the status register will be correspondingly updated to reflect these changes. The ALU supports the following functions:

- Arithmetic operations:
  ADD, ADDM, ADC, ADCM, SUB, SUBM, SBC, SBCM, DAA,
  LADD, LADDM, LADC, LADCM, LSUB, LSUBM, LSBC, LSBCM, LDAA

- Logic operations:

  AND, OR, XOR, ANDM, ORM, XORM, CPL, CPLA,

  LAND, LANDM, LOR, LORM, LXOR, LXORM, LCPL, LCPLA

- Rotation:

  RRA, RR, RRCA, RRC, RLA, RL, RLCA, RLC,

  LRR, LRRA, LRRCA, LRRC, LRLA, LRL, LRLCA, LRLC

- Increment and Decrement:

  INCA, INC, DECA, DEC, LINCA, LINC, LDECA, LDEC

- Branch decision:

  JMP, SZ, SZA, SNZ, SIZ, SDZ, SIZA, SDZA, CALL, RET, RETI,

  LSNZ, LSZ, LSZA, LSIZ, LSIZA, LSDZ, LSDZA

Flash Program Memory

The Program Memory is the location where the user code or program is stored. For this device the Program Memory is Flash type, which means it can be programmed and re-programmed a large number of times, allowing the user the convenience of code modification on the same device. By using the appropriate programming tools, the Flash device offer users the flexibility to conveniently debug and develop their applications while also offering a means of field programming and updating.

Structure

The Program Memory has a capacity of 8K×16 bits. The Program Memory is addressed by the Program Counter and also contains data, table information and interrupts entries. Table data, which can be setup in any location within the Program Memory, is addressed by a separate table pointer register.

000H	Initialisation Vector
004H	
	Interrupt Vectors
034H	
n00H	
	Look-up Table
nFFH	
1FFFH	16 bits
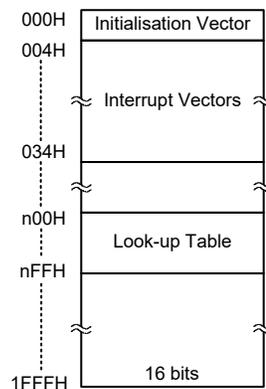
Program Memory Structure

Special Vectors

Within the Program Memory, certain locations are reserved for the reset and interrupts. The location 0000H is reserved for use by the device reset for program initialisation. After a device reset is initiated, the program will jump to this location and begin execution.

Look-up Table

Any location within the Program Memory can be defined as a look-up table where programmers can store fixed data. To use the look-up table, the table pointer must first be setup by placing the address of the look up data to be retrieved in the table pointer register, TBLP and TBHP. These registers define the total address of the look-up table.

After setting up the table pointer, the table data can be retrieved from the Program Memory using the corresponding table read instruction such as "TABRD [m]" or "TABRDL [m]" respectively when the memory [m] is located in Sector 0. If the memory [m] is located in other sectors, the data can be retrieved from the program memory using the corresponding extended table read instruction such as "LTABRD [m]" or "LTABRDL [m]" respectively. When the instruction is executed, the lower order table byte from the Program Memory will be transferred to the user defined Data Memory register [m] as specified in the instruction. The higher order table data byte from the Program Memory will be transferred to the TBLH special register.

The accompanying diagram illustrates the addressing data flow of the look-up table.
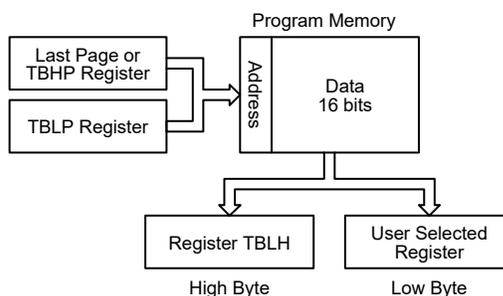
Table Program Example

The following example shows how the table pointer and table data is defined and retrieved from the microcontroller. This example uses raw table data located in the Program Memory which is stored there using the ORG statement. The value at this ORG statement is "1F00H" which refers to the start address of the last page within the 8K Program Memory of the microcontroller. The table pointer low byte register is setup here to have an initial value of "06H". This will ensure that the first data read from the data table will be at the Program Memory address "1F06H" or 6 locations after the start of the last page. Note that the value for the table pointer is referenced to the address specified by TBLP and TBHP if the "TABRD [m]" or "LTABRD [m]" instruction is being used. The high byte of the table data which in this case is equal to zero will be transferred to the TBLH register automatically when the "TABRD [m]" or "LTABRD [m]" instruction is executed.

Because the TBLH register is a read/write register and can be restored, care should be taken to ensure its protection if both the main routine and Interrupt Service Routine use table read instructions. If using the table read instructions, the Interrupt Service Routines may change the value of the TBLH and subsequently cause errors if used again by the main routine. As a rule it is recommended that simultaneous use of the table read instructions should be avoided. However, in situations where simultaneous use cannot be avoided, the interrupts should be disabled prior to the execution of any main routine table-read instructions. Note that all table related instructions require two instruction cycles to complete their operation.

Table Read Program Example

```
tempreg1 db ?        ; temporary register #1
tempreg2 db ?        ; temporary register #2
:
:
mov a,06h            ; initialise low table pointer - note that this address is referenced
mov tblp,a           ; to the last page or the page that tbhp pointed
mov a,1Fh            ; initialise high table pointer
mov tbhp,a
:
:
tabrd tempreg1       ; transfers value in table referenced by table pointer data at program
                     ; memory address "1F06H" transferred to tempreg1 and TBLH
dec tblp             ; reduce value of table pointer by one
tabrd tempreg2       ; transfers value in table referenced by table pointer
                     ; data at program memory address "1F05H" transferred to
                     ; tempreg2 and TBLH in this example the data "1AH" is
                     ; transferred to tempreg1 and data "0FH" to register tempreg2
:
org 1F00h            ; sets initial address of program memory
dc 00Ah, 00Bh, 00Ch, 00Dh, 00Eh, 00Fh, 01Ah, 01Bh
:
```

In Circuit Programming – ICP

The provision of Flash type Program Memory provides the user with a means of convenient and easy upgrades and modifications to their programs on the same device. As an additional convenience, Holtek has provided a means of programming the microcontroller in-circuit using a 4-pin interface. This provides manufacturers with the possibility of manufacturing their circuit boards complete with a programmed or un-programmed microcontroller, and then programming or upgrading the program at a later stage. This enables product manufacturers to easily keep their manufactured products supplied with the latest program releases without removal and re-insertion of the device.

The Flash MCU to Writer programming pins correspondence table is as follows:

Holtek Writer Pins	MCU Programming Pins	Pin Description
ICPDA	PA0	Programming serial data/address
ICPCK	PA2	Programming clock
VDD	VDD	Power supply
VSS	VSS	Ground

The Program Memory can be programmed serially in-circuit using this 4-wire interface. Data is downloaded and uploaded serially on a single pin with an additional line for the clock. Two additional lines are required for the power supply. The technical details regarding the in-circuit programming of the device are beyond the scope of this document and will be supplied in supplementary literature.

During the programming process, the user must take care of the ICPDA and ICPCK pins for data and clock programming purposes to ensure that no other outputs are connected to these two pins.
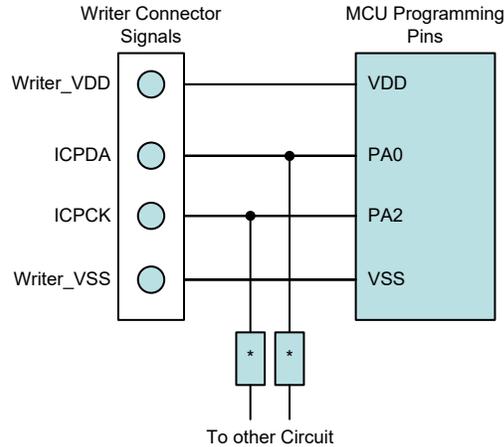
Note: * may be resistor or capacitor. The resistance of * must be greater than 1kΩ or the capacitance of * must be less than 1nF.

On-Chip Debug Support — OCDS

There is an EV chip named HT67V2452 which is used to emulate the real MCU device named HT67F2452. The EV chip device also provides an "On-Chip Debug" function to debug the real MCU device during the development process. The EV chip and the real MCU device are almost functionally compatible except for "On-Chip Debug" function. Users can use the EV chip device to emulate the real chip device behavior by connecting the OCDSDA and OCDSCK pins to the Holtek HT-IDE development tools. The OCDSDA pin is the OCDS Data/Address input/output pin while the OCDSCK pin is the OCDS clock input pin. When users use the EV chip for debugging, other functions which are shared with the OCDSDA and OCDSCK pins in the device will have no effect in the EV chip. For more detailed OCDS information, refer to the corresponding document named "Holtek e-Link for 8-bit MCU OCDS User's Guide".

Holtek e-Link Pins	EV Chip Pins	Pin Description
OCDSDA	OCDSDA	On-chip debug support data/address input/output
OCDSCK	OCDSCK	On-chip debug support clock input
VDD	VDD	Power supply
VSS	VSS	Ground

In Application Programming – IAP

Flash type Program Memory provides the user with a means of convenient and easy upgrades and modifications to their programs on the same device. The provision of IAP function offers users the convenience of Flash Memory multi-programming features. The convenience of the IAP function is that it can execute the updated program procedure using its internal firmware, without requiring an external Program Writer or PC. In addition, the IAP interface can also be any type of communication protocol, such as UART, using I/O pins. Regarding the internal firmware, the user can select versions provided by Holtek or create their own. The following section illustrates the procedures regarding how to implement the IAP firmware.

Flash Memory Read/Write Size

The Flash memory Erase and Write operations are carried out in a page format while the Read operation is carried out in a word format. The page size and write buffer size are both assigned with a capacity of 32 words. Note that the Erase operation should be executed before the Write operation is executed.

When the Flash Memory Erase/Write Function is successfully enabled, the CFWEN bit will be set high. When the CFWEN bit is set high, the data can be written into the write buffer. The FWT bit is used to initiate the write process and then indicate the write operation status. This bit is set high by application programs to initiate a write process and will be cleared by hardware if the write process is finished.

The Read operation can be carried out by executing a specific read procedure. The FRDEN bit is used to enable the read function and the FRD bit is used to initiate the read process by application programs and then indicate the read operation status. When the read process is finished, this bit will be cleared by hardware.

Operations	Format
Erase	32 words/page
Write	32 words/time
Read	1 word/time
Note: Page size = Write buffer size = 32 words.	

IAP Read/Erase/Write Format

Page	FARH	FARL [7:5]	FARL [4:0]
0	0000 0000	000	
1	0000 0000	001	
2	0000 0000	010	
3	0000 0000	011	
4	0000 0000	100	
5	0000 0000	101	
6	0000 0000	110	
7	0000 0000	111	Tag Address
8	0000 0001	000	
9	0000 0001	001	
⋮	⋮	⋮	
⋮	⋮	⋮	
254	0001 1111	110	
255	0001 1111	111	

Page Number and Address Selection

Read Data Word to FD0H/FD0L

Flash Memory

FARH/FARL =FA12~FA0 → Word m

FD0H | FD0L

Note: "m" is specified by FA12~FA0

Write Page Data to FD0L/FD0H (32 words/page)

Flash Memory

FARH/FARL =FA12~FA0 → Page addr. =FA12~FA5 → Page n

Write buffer addr. =FA4~FA0 →

CLWB → Write Buffer   00000b ⋮ 11111b

FD0H | FD0L

Note: "n" is specified by FA12~FA5
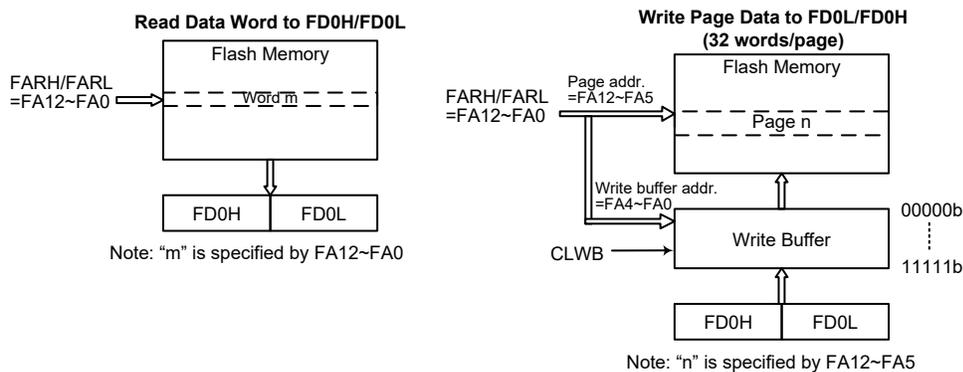
Flash Memory IAP Read/Write Structure

Write Buffer

The write buffer is used to store the written data temporarily when executing the write operation. The Write Buffer can be filled with written data after the Flash Memory Erase/Write Function has been successfully enabled by executing the Flash Memory Erase/Write Function Enable procedure. The write buffer can be cleared by configuring the CLWB bit in the FC2 register. The CLWB bit can be set high to enable the Clear Write Buffer procedure. When the procedure is finished this bit will be cleared to low by the hardware. It is recommended that the write buffer should be cleared by setting the CLWB bit high before the write buffer is used for the first time or when the data in the write buffer is updated.

The write buffer size is 32 words corresponding to a page. The write buffer address is mapped to a specific Flash memory page specified by the memory address bits, FA12~FA5. The data written into the FD0L and FD0H registers will be loaded into the write buffer. When data is written into the high byte data register, FD0H, it will result in the data stored in the high and low byte data registers both being written into the write buffer. It will also cause the flash memory address to be incremented by one, after which the new address will be loaded into the FARH and FARL address registers. When the flash memory address reaches the page boundary, 11111b of a page with 32 words, the address will now not be incremented but will stop at the last address of the page. At this point a new page address should be specified for any other erase/write operations.

After a write process is finished, the write buffer will automatically be cleared by the hardware. Note that the write buffer should be cleared manually by the application program when the data written into the flash memory is incorrect in the data verification step. The data should again be written into the write buffer after the write buffer has been cleared when the data is found to be incorrect during the data verification step.

IAP Flash Program Memory Registers

There are two address registers, four 16-bit data registers and three control registers, located in Sector 1. Read and Write operations to the Flash memory are carried out using 16-bit data operations using the address and data registers and the control register. Several registers control the overall operation of the internal Flash Program Memory.

Register Name	Bit							
	7	6	5	4	3	2	1	0
FC0	CFWEN	FMOD2	FMOD1	FMOD0	FWPEN	FWT	FRDEN	FRD
FC1	D7	D6	D5	D4	D3	D2	D1	D0
FC2	—	—	—	—	—	—	FWERTS	CLWB
FARL	FA7	FA6	FA5	FA4	FA3	FA2	FA1	FA0
FARH	—	—	—	FA12	FA11	FA10	FA9	FA8
FD0L	D7	D6	D5	D4	D3	D2	D1	D0
FD0H	D15	D14	D13	D12	D11	D10	D9	D8
FD1L	D7	D6	D5	D4	D3	D2	D1	D0
FD1H	D15	D14	D13	D12	D11	D10	D9	D8
FD2L	D7	D6	D5	D4	D3	D2	D1	D0
FD2H	D15	D14	D13	D12	D11	D10	D9	D8
FD3L	D7	D6	D5	D4	D3	D2	D1	D0
FD3H	D15	D14	D13	D12	D11	D10	D9	D8

IAP Register List

• **FC0 Register**

Bit	7	6	5	4	3	2	1	0
Name	CFWEN	FMOD2	FMOD1	FMOD0	FWPEN	FWT	FRDEN	FRD
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7   **CFWEN**: Flash Memory Erase/Write enable control
             0: Flash memory erase/write function is disabled
             1: Flash memory erase/write function has been successfully enabled
             When this bit is cleared to 0 by application program, the Flash memory erase/write function is disabled. Note that writing a "1" into this bit results in no action. This bit is used to indicate the Flash memory erase/write function status. When this bit is set to 1 by the hardware, it means that the Flash memory erase/write function is enabled successfully. Otherwise, the Flash memory erase/write function is disabled if the bit is zero.

Bit 6~4   **FMOD2~FMOD0**: Flash memory mode selection
             000: Write Mode
             001: Page Erase Mode
             010: Reserved
             011: Read Mode
             100: Reserved
             101: Reserved
             110: Flash memory Erase/Write function Enable Mode
             111: Reserved
             These bits are used to select the Flash Memory operation modes. Note that the "Flash memory Erase/Write function Enable Mode" should first be successfully enabled before the Erase or Write Flash memory operation is executed.

Bit 3   **FWPEN**: Flash memory Erase/Write function enable procedure trigger
             0: Erase/Write function enable procedure is not triggered or procedure timer times out
             1: Erase/Write function enable procedure is triggered and procedure timer starts to count
             This bit is used to activate the Flash memory Erase/Write function enable procedure and an internal timer. It is set by the application programs and then cleared by hardware when the internal timer times out. The correct patterns must be written into the FD1L/FD1H, FD2L/FD2H and FD3L/FD3H register pairs respec-tively as soon as possible after the FWPEN bit is set high.

Bit 2   **FWT**: Flash memory write initiate control
             0: Do not initiate Flash memory write or indicating that a Flash memory write
                process has completed
             1: Initiate Flash memory write process
             This bit is set by software and cleared to 0 by the hardware when the Flash memory write process has completed.

Bit 1   **FRDEN**: Flash memory read enable control
             0: Flash memory read disable
             1: Flash memory read enable
             This is the Flash memory Read Enable Bit which must be set high before any Flash memory read operations are carried out. Clearing this bit to zero will inhibit Flash memory read operations.

Bit 0   **FRD**: Flash memory read initiate control
             0: Do not initiate Flash memory read or indicating that a Flash memory read process has
                completed
             1: Initiate Flash memory read process
             This bit is set by software and cleared to 0 by the hardware when the Flash memory read process has completed.

Note: 1. The FWT, FRDEN and FRD bits cannot be set to "1" at the same time with a single instruction.
      2. Ensure that the f_{SUB} clock is stable before executing the erase/write operation.

3. Note that the CPU will be stopped when a read, write or erase operation is successfully activated.

4. Ensure that the read/erase/write operation is totally complete before executing other operations.

• **FC1 Register**

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	D5	D4	D3	D2	D1	D0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~0   **D7~D0**: Chip reset pattern

When a specific value of "55H" is written into this register, a reset signal will be generated to reset the whole chip.

• **FC2 Register**

Bit	7	6	5	4	3	2	1	0
Name	—	—	—	—	—	—	FWERTS	CLWB
R/W	—	—	—	—	—	—	R/W	R/W
POR	—	—	—	—	—	—	0	0

Bit 7~2   Unimplemented, read as "0"

Bit 1   **FWERTS**: Erase time and Write time select

0: Erase time is 3.2ms (t_{FER}) / Write time is 2.2ms (t_{FWR})
1: Erase time is 3.7ms (t_{FER}) / Write time is 3.0ms (t_{FWR})

Bit 0   **CLWB**: Flash memory write buffer clear control

0: Do not initiate a Write Buffer Clear process or indicating that a Write Buffer Clear process has completed
1: Initiate Write Buffer Clear process

This bit is set by software and cleared to 0 by hardware when the Write Buffer Clear process has completed.

• **FARL Register**

Bit	7	6	5	4	3	2	1	0
Name	FA7	FA6	FA5	FA4	FA3	FA2	FA1	FA0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~0   **FA7~FA0**: Flash memory address bit 7 ~ bit 0

• **FARH Register**

Bit	7	6	5	4	3	2	1	0
Name	—	—	—	FA12	FA11	FA10	FA9	FA8
R/W	—	—	—	R/W	R/W	R/W	R/W	R/W
POR	—	—	—	0	0	0	0	0

Bit 7~5   Unimplemented, read as "0"

Bit 4~0   **FA12~FA8**: Flash memory address bit 12 ~ bit 8

• **FD0L Register**

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	D5	D4	D3	D2	D1	D0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~0   **D7~D0**: The first Flash memory data word bit 7 ~ bit 0

Note that data written into the low byte data register FD0L will only be stored in the FD0L register and not loaded into the lower 8-bit write buffer.

• **FD0H Register**

Bit	7	6	5	4	3	2	1	0
Name	D15	D14	D13	D12	D11	D10	D9	D8
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~0   **D15~D8**: The first Flash memory data word bit 15 ~ bit 8

Note that when 8-bit data is written into the high byte data register FD0H, the whole 16 bits of data stored in the FD0H and FD0L registers will simultaneously be loaded into the 16-bit write buffer after which the contents of the Flash memory address register pair, FARH and FARL, will be incremented by one.

• **FD1L Register**

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	D5	D4	D3	D2	D1	D0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~0   **D7~D0**: The second Flash memory data word bit 7 ~ bit 0

• **FD1H Register**

Bit	7	6	5	4	3	2	1	0
Name	D15	D14	D13	D12	D11	D10	D9	D8
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~0   **D15~D8**: The second Flash memory data word bit 15 ~ bit 8

• **FD2L Register**

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	D5	D4	D3	D2	D1	D0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~0   **D7~D0**: The third Flash memory data word bit 7 ~ bit 0

• **FD2H Register**

Bit	7	6	5	4	3	2	1	0
Name	D15	D14	D13	D12	D11	D10	D9	D8
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~0   **D15~D8**: The third Flash memory data word bit 15 ~ bit 8

• **FD3L Register**

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	D5	D4	D3	D2	D1	D0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~0   **D7~D0**: The fourth Flash memory data word bit 7 ~ bit 0

• **FD3H Register**

Bit	7	6	5	4	3	2	1	0
Name	D15	D14	D13	D12	D11	D10	D9	D8
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~0   **D15~D8**: The fourth Flash memory data word bit 15 ~ bit 8

Flash Memory Erase/Write Flow

It is important to understand the Flash memory Erase/Write flow before the Flash memory contents are updated. Users can refer to the corresponding operation procedures when developing their IAP program to ensure that the flash memory contents are correctly updated.

Flash Memory Erase/Write Flow Descriptions

1. Activate the "Flash Memory Erase/Write function enable procedure" first. When the Flash Memory Erase/Write function is successfully enabled, the CFWEN bit in the FC0 register will automatically be set high by hardware. After this, Erase or Write operations can be executed on the Flash memory. Refer to the "Flash Memory Erase/Write Function Enable Procedure" for details.

2. Configure the flash memory address to select the desired erase page, tag address and then erase this page. For a page erase operation, set the FARL and FARH registers to specify the start address of the erase page, then write dummy data into the FD0H register to tag address. The current address will be internally incremented by one after each dummy data is written into the FD0H register. When the address reaches the page boundary, 11111b, the address will not be further incremented but stop at the last address of the page. Note that the write operation to the FD0H register is used to tag address, it must be implemented to determine which addresses to be erased.

3. Execute a Blank Check operation to ensure whether the page erase operation is successful or not. The "TABRD" instruction should be executed to read the flash memory contents and to check if the contents is 0000h or not. If the flash memory page erase operation fails, users should go back to Step 2 and execute the page erase operation again.

4. Write data into the specific page. Refer to the "Flash Memory Write Procedure" for details.

5. Execute the "TABRD" instruction to read the flash memory contents and check if the written data is correct or not. If the data read from the flash memory is different from the written data, it means that the page write operation has failed. The CLWB bit should be set high to clear the write buffer and then write the data into the specific page again if the write operation has failed.

6. Clear the CFWEN bit to disable the Flash Memory Erase/Write function enable mode if the current page Erase and Write operations are complete if no more pages need to be erased or written.
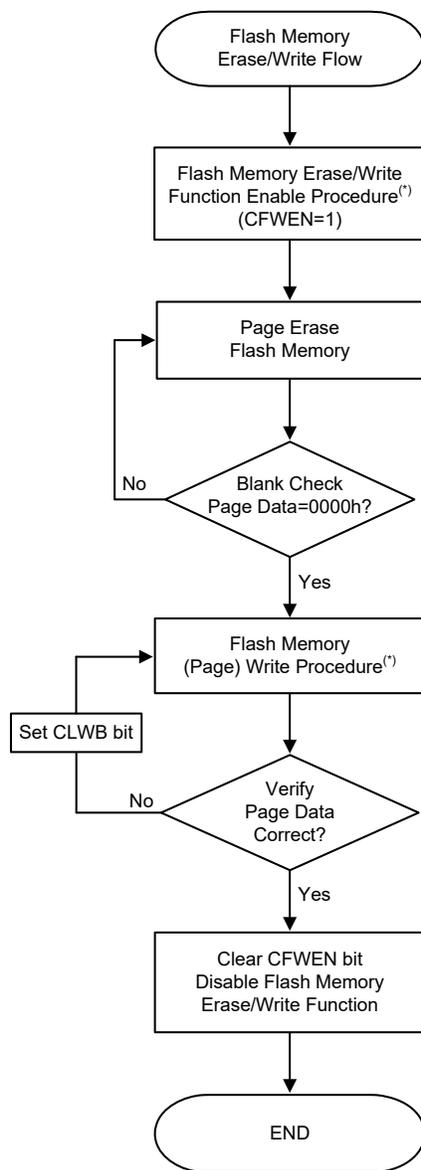
Flash Memory Erase/Write Flow

Note: The Flash Memory Erase/Write Function Enable procedure and Flash Memory Write procedure will be described in the following sections.

Flash Memory Erase/Write Function Enable Procedure

The Flash Memory Erase/Write Function Enable Mode is specially designed to prevent the flash memory contents from being wrongly modified. In order to allow users to change the Flash memory data using the IAP control registers, users must first enable the Flash Memory Erase/Write function.

Flash Memory Erase/Write Function Enable Procedure Description

1. Write data "110" to the FMOD [2:0] bits in the FC0 register to select the Flash Memory Erase/Write Function Enable Mode.

2. Set the FWPEN bit in the FC0 register to "1" to activate the Flash Memory Erase/Write Function. This will also activate an internal timer.

3. Write the correct data pattern into the Flash data registers, FD1L~FD3L and FD1H~FD3H, as soon as possible after the FWPEN bit is set high. The enable Flash memory erase/write function data pattern is 00H, 0DH, C3H, 04H, 09H and 40H corresponding to the FD1L~FD3L and FD1H~FD3H registers respectively.

4. Once the timer has timed out, the FWPEN bit will automatically be cleared to 0 by hardware regardless of the input data pattern.

5. If the written data pattern is incorrect, the Flash memory erase/write function will not be enabled successfully and the above steps should be repeated. If the written data pattern is correct, the Flash memory erase/write function will be enabled successfully.

6. Once the Flash memory write function is enabled, the Flash memory contents can be updated by executing the page erase and write operations using the IAP control registers.

To disable the Flash memory write function, the CFWEN bit in the FC0 register can be cleared. There is no need to execute the above procedure.

Flash Memory
Erase/Write Function
Enable Procedure

↓

FMOD[2:0]=110

↓

Set FWPEN=1
Hardware start a timer

↓

Write the following pattern to Flash Data register
FD1L=00h, FD1H=04h
FD2L=0Dh, FD2H=09h
FD3L=C3h, FD3H=40h

↓

No ← Is timer
Time-out
FWPEN=0?

↓ Yes

Is pattern
correct ? → No

↓ Yes

CFWEN=1
Flash Memory Erase/Write
Function Enabled

CFWEN=0
Flash Memory Erase/Write
Function Disabled

↓

END
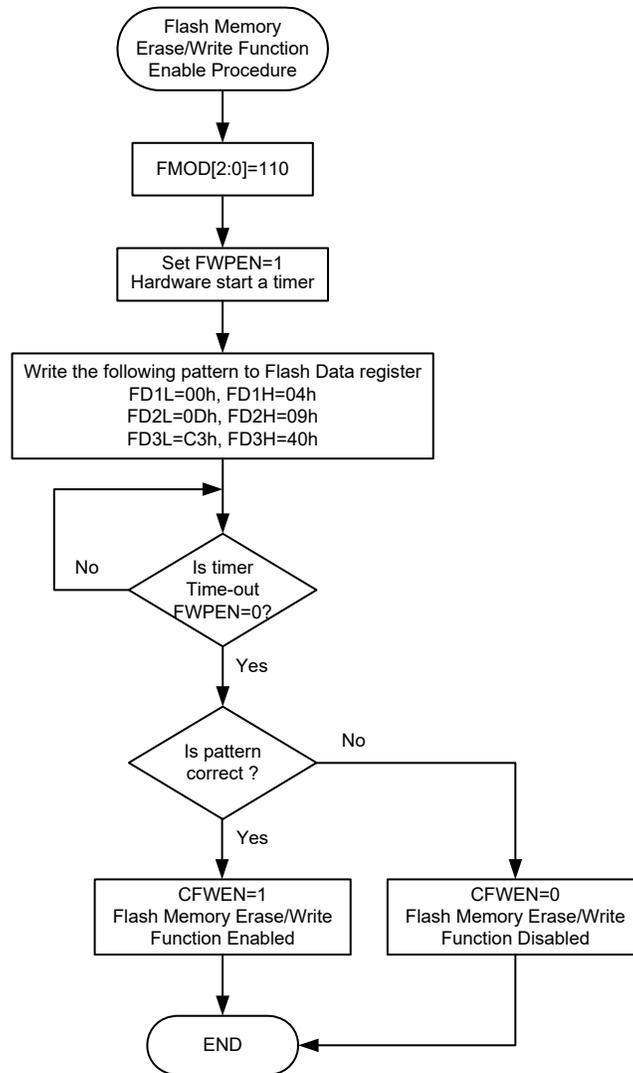
Flash Memory Erase/Write Function Enable Procedure

Flash Memory Write Procedure

After the Flash memory erase/write function has been successfully enabled as the CFWEN bit is set high, the data to be written into the flash memory can be loaded into the write buffer. The selected flash memory page data should be erased by properly configuring the IAP control registers before the data write procedure is executed.

The write buffer size is 32 words, known as a page, whose address is mapped to a specific flash memory page specified by the memory address bits, FA12~FA5. It is important to ensure that the page where the write buffer data is located is the same one which the memory address bits, FA12~FA5, specify.

Flash Memory Consecutive Write Description

The maximum amount of write data is 32 words for each write operation. The write buffer address will be automatically incremented by one when consecutive write operations are executed. The start address of a specific page should first be written into the FARL and FARH registers. Then the data word should first be written into the FD0L register and then the FD0H register. At the same time the write buffer address will be incremented by one and then the next data word can be written into the FD0L and FD0H registers for the next address without modifying the address register pair, FARH and FARL. When the write buffer address reaches the page boundary the address will not be further incremented but will stop at the last address of the page.

1. Activate the "Flash Memory Erase/Write function enable procedure". Check the CFWEN bit value and then execute the erase/write operations if the CFWEN bit is set high. Refer to the "Flash Memory Erase/Write function enable procedure" for more details.

2. Set the FMOD field to "001" to select the erase operation and set the CLWB bit high to clear the write buffer. Set the FWT bit high to erase the desired page which is specified by the FARH and FARL registers and has been tagged address. Wait until the FWT bit goes low.

3. Execute a Blank Check operation using the table read instruction to ensure that the erase operation has successfully completed.

   Go to step 2 if the erase operation is not successful.

   Go to step 4 if the erase operation is successful.

4. Set the FMOD field to "000" to select the write operation.

5. Setup the desired start address in the FARH and FARL registers. Write the desired data words consecutively into the FD0L and FD0H registers within a page as specified by their consecutive addresses. The maximum written data number is 32 words.

6. Set the FWT bit high to write the data words from the write buffer to the flash memory. Wait until the FWT bit goes low.

7. Verify the data using the table read instruction to ensure that the write operation has successfully completed.

   If the write operation has not successfully completed, set the CLWB bit high to clear the write buffer and then go to step 5.

   Go to step 8 if the write operation is successful.

8. Clear the CFWEN bit low to disable the Flash memory erase/write function.
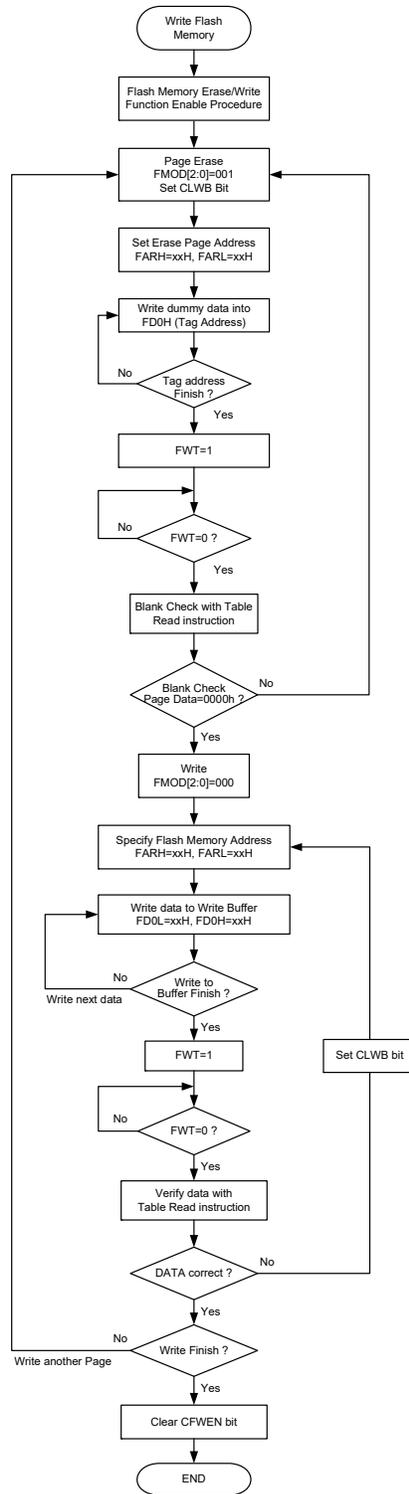
```
                      ┌──────────────────┐
                      │   Write Flash    │
                      │     Memory       │
                      └──────────────────┘
                               │
              ┌────────────────────────────────┐
              │ Flash Memory Erase/Write        │
              │ Function Enable Procedure       │
              └────────────────────────────────┘
                               │
              ┌────────────────────────────────┐
              │        Page Erase               │
              │      FMOD[2:0]=001              │
              │       Set CLWB Bit              │
              └────────────────────────────────┘
                               │
              ┌────────────────────────────────┐
              │  Set Erase Page Address         │
              │  FARH=xxH, FARL=xxH            │
              └────────────────────────────────┘
                               │
              ┌────────────────────────────────┐
              │  Write dummy data into          │
              │  FD0H (Tag Address)            │
              └────────────────────────────────┘
                               │
                    < Tag address Finish ? >  No
                               │ Yes
              ┌────────────────────────────────┐
              │           FWT=1                 │
              └────────────────────────────────┘
                               │
                        < FWT=0 ? >  No
                               │ Yes
              ┌────────────────────────────────┐
              │  Blank Check with Table         │
              │  Read instruction               │
              └────────────────────────────────┘
                               │
              < Blank Check Page Data=0000h ? >  No
                               │ Yes
              ┌────────────────────────────────┐
              │     Write FMOD[2:0]=000        │
              └────────────────────────────────┘
                               │
              ┌────────────────────────────────┐
              │  Specify Flash Memory Address   │
              │  FARH=xxH, FARL=xxH            │
              └────────────────────────────────┘
                               │
              ┌────────────────────────────────┐
              │  Write data to Write Buffer     │
              │  FD0L=xxH, FD0H=xxH            │
              └────────────────────────────────┘
                               │
                 < Write to Buffer Finish ? >  No (Write next data)
                               │ Yes
              ┌────────────────────────────────┐
              │           FWT=1                 │       ┌──────────────┐
              └────────────────────────────────┘       │ Set CLWB bit │
                               │                        └──────────────┘
                        < FWT=0 ? >  No
                               │ Yes
              ┌────────────────────────────────┐
              │  Verify data with               │
              │  Table Read instruction         │
              └────────────────────────────────┘
                               │
                       < DATA correct ? >  No
                               │ Yes
                       < Write Finish ? >  No (Write another Page)
                               │ Yes
              ┌────────────────────────────────┐
              │       Clear CFWEN bit           │
              └────────────────────────────────┘
                               │
                      ┌──────────────────┐
                      │       END        │
                      └──────────────────┘
```

Flash Memory Consecutive Write Procedure

Note: 1. When the erase or write operation is successfully activated, all CPU operations will temporarily cease.

2. It will take certain time for the FWT bit state changing from high to low in the erase or write operation, which can be selected by the FWERTS bit in the FC2 register.

Flash Memory Non-Consecutive Write Description

The main difference between Flash Memory Consecutive and Non-Consecutive Write operations is whether the data words to be written are located in consecutive addresses or not. If the data to be written is not located in consecutive addresses the desired address should be re-assigned after a data word is successfully written into the Flash Memory.

A two data word non-consecutive write operation is taken as an example here and described as follows:

1. Activate the "Flash Memory Erase/Write function enable procedure". Check the CFWEN bit value and then execute the erase/write operation if the CFWEN bit is set high. Refer to the "Flash Memory Erase/Write function enable procedure" for more details.

2. Set the FMOD field to "001" to select the erase operation and set the CLWB bit high to clear the write buffer. Set the FWT bit high to erase the desired page which is specified by the FARH and FARL registers and has been tagged address. Wait until the FWT bit goes low.

3. Execute a Blank Check operation using the table read instruction to ensure that the erase operation has successfully completed.

   Go to step 2 if the erase operation is not successful.

   Go to step 4 if the erase operation is successful.

4. Set the FMOD field to "000" to select the write operation.

5. Setup the desired address ADDR1 in the FARH and FRARL registers. Write the desired data word DATA1 first into the FD0L register and then into the FD0H register.

6. Set the FWT bit high to transfer the data word from the write buffer to the flash memory. Wait until the FWT bit goes low.

7. Verify the data using the table read instruction to ensure that the write operation has successfully completed.

   If the write operation has not successfully completed, set the CLWB bit high to clear the write buffer and then go to step 5.

   Go to step 8 if the write operation is successful.

8. Setup the desired address ADDR2 in the FARH and FRARL registers. Write the desired data word DATA2 first into the FD0L register and then into the FD0H register.

9. Set the FWT bit high to transfer the data word from the write buffer to the flash memory. Wait until the FWT bit goes low.

10. Verify the data using the table read instruction to ensure that the write operation has successfully completed.

11. If the write operation has not successfully completed, set the CLWB bit high to clear the write buffer and then go to step 8.

12. Go to step 11 if the write operation is successful.

13. Clear the CFWEN bit low to disable the Flash memory erase/write function.
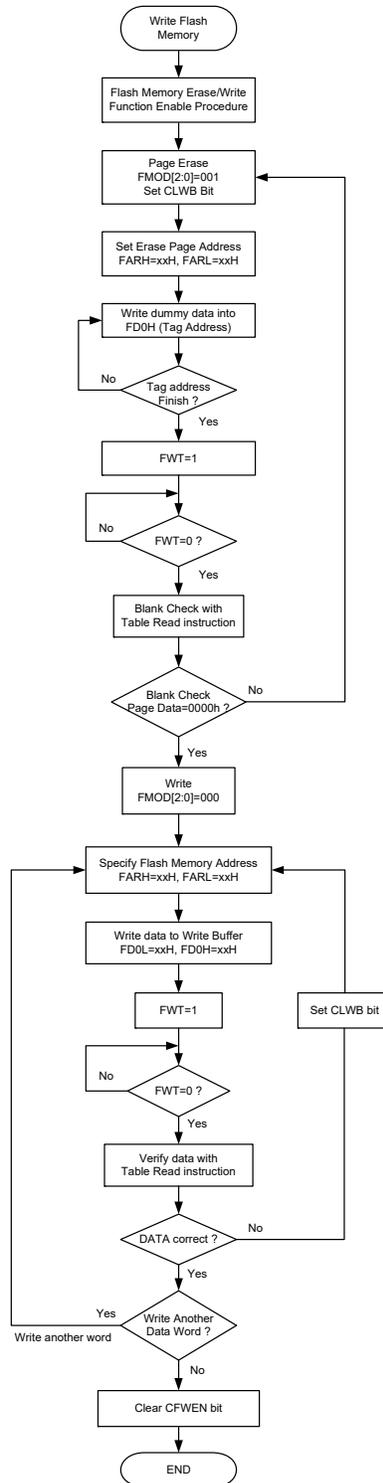
Flash Memory Non-Consecutive Write Procedure

Note: 1. When the erase or write operation is successfully activated, all CPU operations will temporarily cease.

2. It will take certain time for the FWT bit state changing from high to low in the erase or write operation, which can be selected by the FWERTS bit in the FC2 register.

Important Points to Note for Flash Memory Write Operations

1. The "Flash Memory Erase/Write Function Enable Procedure" must be successfully activated before the Flash Memory erase/write operation is executed.

2. The Flash Memory erase operation is executed to erase a whole page.

3. The whole write buffer data will be written into the flash memory in a page format. The corresponding address cannot exceed the page boundary.

4. After the data is written into the flash memory the flash memory contents must be read out using the table read instruction, TABRD, and checked if it is correct or not. If the data written into the flash memory is incorrect, the write buffer should be cleared by setting the CLWB bit high and then writing the data again into the write buffer. Then activate a write operation on the same flash memory page without erasing it. The data check, buffer clear and data re-write steps should be repeatedly executed until the data written into the flash memory is correct.

5. The system frequency should be setup to the maximum application frequency when data write and data check operations are executed using the IAP function.

Flash Memory Read Procedure

To activate the Flash Memory Read procedure, the FMOD field should be set to "011" to select the flash memory read mode and the FRDEN bit should be set high to enable the read function. The desired flash memory address should be written into the FARH and FARL registers and then the FRD bit should be set high. After this the flash memory read operation will be activated. The data stored in the specified address can be read from the data registers, FD0H and FD0L, when the FRD bit goes low. There is no need to first activate the Flash Memory Erase/Write Function Enable Procedure before the flash memory read operation is executed.
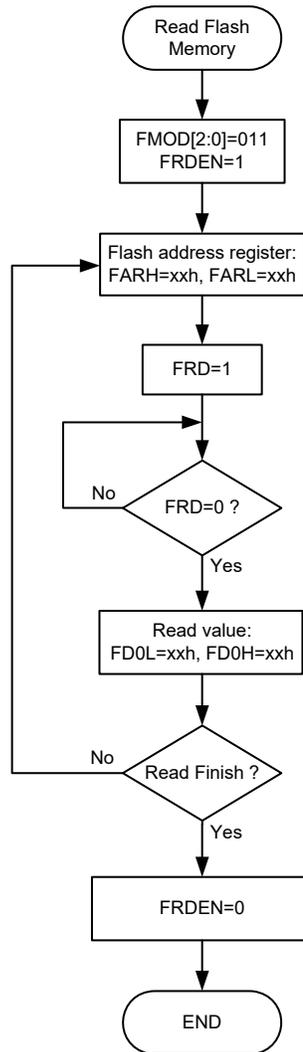
Flash Memory Read Procedure

Note: 1. When the read operation is successfully activated, all CPU operations will temporarily cease.
2. It will take a typical time of three instruction cycles for the FRD bit state changing from high to low.

Data Memory

The Data Memory is a volatile area of 8-bit wide RAM internal memory and is the location where temporary information is stored.

Categorized into three types, the first of these is an area of RAM where special function registers are located. These registers have fixed locations and are necessary for correct operation of the device. Many of these registers can be read from and written to directly under program control, however, some remain protected from user manipulation. The second area of Data Memory is reserved for general purpose use. All locations within this area are read and write accessible under program control. The third area is reserved for the LCD Data Memory. This special area of Data Memory is mapped directly to the LCD display so data written into this memory area will directly affect the displayed data.

Structure

The Data Memory is subdivided into several sectors, all of which are implemented in 8-bit wide Memory.

Each of the Data Memory sectors is categorized into two types, the Special Purpose Data Memory and the General Purpose Data Memory. However, the Data Memory Sector 4 is reserved for the LCD display data.

The address range of the Special Purpose Data Memory for the device is from 00H to 7FH while the General Purpose Data Memory address range is from 80H to FFH.

Switching between the different Data Memory sectors is achieved by setting the Memory Pointers to the correct value if using the indirect addressing method. The start address of the Data Memory for the device is the address 00H.

Special Purpose Data Memory	General Purpose Data Memory		LCD Data Memory	
Located Sectors	**Capacity**	**Sector: Address**	**Capacity**	**Sector: Address**
0, 1	512×8	0: 80H~FFH 1: 80H~FFH ⋮ 3: 80H~FFH	32×8	4: 00H~1FH

Data Memory Summary

Data Memory Structure
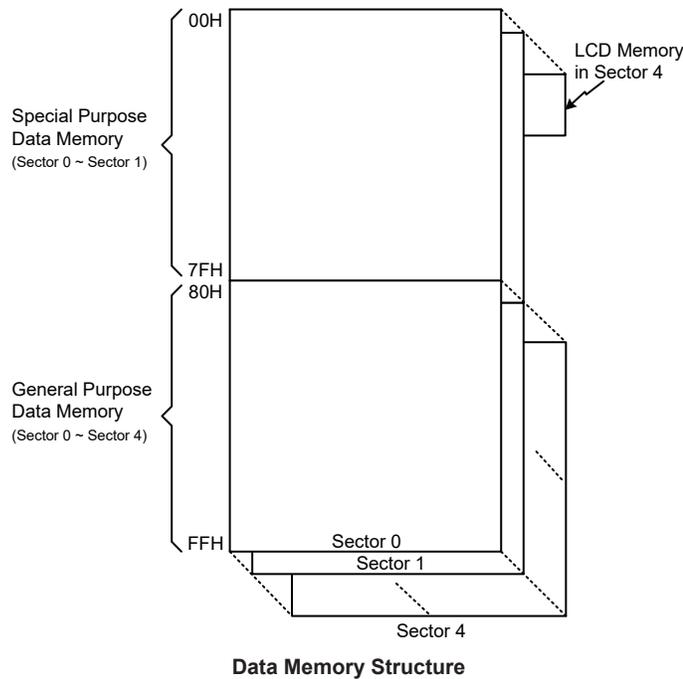
Data Memory Addressing

For the device that supports the extended instructions, there is no Bank Pointer for Data Memory. For Data Memory the desired Sector is pointed by the MP1H or MP2H register and the certain Data Memory address in the selected sector is specified by the MP1L or MP2L register when using indirect addressing access.

Direct Addressing can be used in all sectors using the extended instructions which can address all available data memory space. For the accessed data memory which is located in any data memory sectors except Sector 0, the extended instructions can be used to access the data memory instead of using the indirect addressing access. The main difference between standard instructions and extended instructions is that the data memory address "m" in the extended instructions has 11 valid bits for this device, the high byte indicates a sector and the low byte indicates a specific address.

General Purpose Data Memory

All microcontroller programs require an area of read/write memory where temporary data can be stored and retrieved for use later. It is this area of RAM memory that is known as General Purpose Data Memory. This area of Data Memory is fully accessible by the user programing for both reading and writing operations. By using the bit operation instructions individual bits can be set or reset under program control giving the user a large range of flexibility for bit manipulation in the Data Memory.

Special Purpose Data Memory

This area of Data Memory is where registers, necessary for the correct operation of the microcontroller, are stored. Most of the registers are both readable and writeable but some are protected and are readable only, the details of which are located under the relevant Special Function Register section. Note that for locations that are unused, any read instruction to these addresses will return the value "00H".

Address	Sector 0	Sector 1		Address	Sector 0	Sector 1
00H	IAR0	FC0		40H		EEC
01H	MP0	FC1		41H	EEA	
02H	IAR1	FC2		42H	EED	
03H	MP1L	FARL		43H	LVPUC	
04H	MP1H	FARH		44H	LCDC0	
05H	ACC	FD0L		45H	LCDC1	
06H	PCL	FD0H		46H	SLEDC0	
07H	TBLP	FD1L		47H	SLEDC1	
08H	TBLH	FD1H		48H	SLEDC2	
09H	TBHP	FD2L		49H		
0AH	STATUS	FD2H		4AH		
0BH		FD3L		4BH	STMC0	
0CH	IAR2	FD3H		4CH	STMC1	
0DH	MP2L			4DH	STMDL	
0EH	MP2H	ORMC		4EH	STMDH	
0FH	RSTFC	TLVRC		4FH	STMAL	
10H	INTC0			50H	STMAH	
11H	INTC1			51H	STMRP	
12H	INTC2			52H	PSC0R	
13H	INTC3			53H	TB0C	
14H	PA			54H	PSC1R	
15H	PAC			55H	TB1C	
16H	PAPU			56H	SADOL	
17H	PAWU			57H	SADOH	
18H	PB			58H	SADC0	
19H	PBC			59H	SADC1	
1AH	PBPU			5AH	SADC2	
1BH				5BH	IFS0	
1CH	NMSR			5CH	IFS1	
1DH	PC			5DH		
1EH	PCC			5EH		
1FH	PCPU			5FH	PAS0	
20H	PD			60H	PAS1	
21H	PDC			61H	PBS0	
22H	PDPU			62H	PBS1	
23H	PE			63H	PCS0	
24H	PEC			64H	PCS1	
25H	PEPU			65H	PDS0	
26H	PF			66H	PDS1	
27H	PFC			67H	PES0	
28H	PFPU			68H	PES1	
29H				69H	PFS0	
2AH				6AH		
2BH				6BH	PTMC0	
2CH				6CH	PTMC1	
2DH				6DH	PTMDL	
2EH				6EH	PTMDH	
2FH				6FH	PTMAL	
30H	SCC			70H	PTMAH	
31H	HIRCC			71H	PTMRPL	
32H	HXTC			72H	PTMRPH	
33H	LXTC			73H	CTMC0	
34H				74H	CTMC1	
35H				75H	CTMDL	
36H	RSTC			76H	CTMDH	
37H	VBGRC			77H	CTMAL	
38H				78H	CTMAH	
39H	INTEG			79H		
3AH	WDTC			7AH	UCR3	
3BH	LVRC			7BH	USR	
3CH	LVDC			7CH	UCR1	
3DH	MFI0			7DH	UCR2	
3EH	MFI1			7EH	TXR_RXR	
3FH	MFI2			7FH	BRG	

☐ : Unused, read as 00H

Special Purpose Data Memory

Special Function Register Description

Most of the Special Function Register details will be described in the relevant functional sections, however several registers require a separate description in this section.

Indirect Addressing Registers – IAR0, IAR1, IAR2

The Indirect Addressing Registers, IAR0, IAR1 and IAR2, although having their locations in normal RAM register space, do not actually physically exist as normal registers. The method of indirect addressing for RAM data manipulation uses these Indirect Addressing Registers and Memory Pointers, in contrast to direct memory addressing, where the actual memory address is specified. Actions on the IAR0, IAR1 and IAR2 registers will result in no actual read or write operation to these registers but rather to the memory location specified by their corresponding Memory Pointers, MP0, MP1L/MP1H or MP2L/MP2H. Acting as a pair, IAR0 and MP0 can together access data only from Sector 0 while the IAR1 register together with the MP1L/MP1H register pair and IAR2 register together with the MP2L/MP2H register pair can access data from any Data Memory Sector. As the Indirect Addressing Registers are not physically implemented, reading the Indirect Addressing Registers will return a result of "00H" and writing to the registers will result in no operation.

Memory Pointers – MP0, MP1L/MP1H, MP2L/MP2H

Five Memory Pointers, known as MP0, MP1L/MP1H, MP2L/MP2H, are provided. These Memory Pointers are physically implemented in the Data Memory and can be manipulated in the same way as normal registers providing a convenient way with which to address and track data. When any operation to the relevant Indirect Addressing Registers is carried out, the actual address that the microcontroller is directed to is the address specified by the related Memory Pointer. MP0, together with Indirect Addressing Register, IAR0, are used to access data from Sector 0, while MP1L/MP1H together with IAR1 and MP2L/MP2H together with IAR2 are used to access data from all sectors according to the corresponding MP1H or MP2H register. Direct Addressing can be used in all sectors using the corresponding instruction which can address all available data memory space.

The following example shows how to clear a section of four Data Memory locations already defined as locations adres1 to adres4.

Indirect Addressing Program Example 1

```
data .section ´data´
adres1  db ?
adres2  db ?
adres3  db ?
adres4  db ?
block   db ?
code .section at 0 ´code´
org 00h
start:
    mov a, 04h              ; setup size of block
    mov block, a
    mov a, offset adres1    ; Accumulator loaded with first RAM address
    mov mp0, a              ; setup memory pointer with first RAM address
loop:
    clr IAR0               ; clear the data at address defined by MP0
    inc mp0                ; increment memory pointer
    sdz block              ; check if last memory location has been cleared
    jmp loop
continue:
```

Indirect Addressing Program Example 2

```
data .section ´data´
adres1  db ?
adres2  db ?
adres3  db ?
adres4  db ?
block   db ?
code .section at 0 ´code´
org 00h
start:
    mov a, 04h              ; setup size of block
    mov block, a
    mov a, 01h              ; setup the memory sector
    mov mp1h, a
    mov a, offset adres1    ; Accumulator loaded with first RAM address
    mov mp1l, a             ; setup memory pointer with first RAM address
loop:
    clr IAR1               ; clear the data at address defined by MP1L
    inc mp1l              ; increment memory pointer MP1L
    sdz block             ; check if last memory location has been cleared
    jmp loop
continue:
```

The important point to note here is that in the example shown above, no reference is made to specific Data Memory addresses.

Direct Addressing Program Example using Extended Instructions

```
data .section ´data´
temp    db ?
code .section at 0 ´code´
org 00h
start:
    lmov a, [m]           ; move [m] data to acc
    lsub a, [m+1]         ; compare [m] and [m+1] data
    snz  c               ; [m]>[m+1]?
    jmp  continue        ; no
    lmov a, [m]           ; yes, exchange [m] and [m+1] data
    mov  temp, a
    lmov a, [m+1]
    lmov [m], a
    mov  a, temp
    lmov [m+1], a
continue:
```

Note: Here "m" is a data memory address located in any data memory sectors. For example, m=1F0H, it indicates address 0F0H in Sector 1.

Accumulator – ACC

The Accumulator is central to the operation of any microcontroller and is closely related with operations carried out by the ALU. The Accumulator is the place where all intermediate results from the ALU are stored. Without the Accumulator it would be necessary to write the result of each calculation or logical operation such as addition, subtraction, shift, etc., to the Data Memory resulting in higher programming and timing overheads. Data transfer operations usually involve the temporary storage function of the Accumulator; for example, when transferring data between one user-defined register and another, it is necessary to do this by passing the data through the Accumulator as no direct transfer between two registers is permitted.

Program Counter Low Register – PCL

To provide additional program control functions, the low byte of the Program Counter is made accessible to programmers by locating it within the Special Purpose area of the Data Memory. By manipulating this register, direct jumps to other program locations are easily implemented. Loading a value directly into this PCL register will cause a jump to the specified Program Memory location. However, as the register is only 8-bit wide, only jumps within the current Program Memory page are permitted. When such operations are used, note that a dummy cycle will be inserted.

Look-up Table Registers – TBLP, TBHP, TBLH

These three special function registers are used to control operation of the look-up table which is stored in the Program Memory. TBLP and TBHP are the table pointers and indicate the location where the table data is located. Their value must be setup before any table read commands are executed. Their value can be changed, for example using the "INC" or "DEC" instructions, allowing for easy table data pointing and reading. TBLH is the location where the high order byte of the table data is stored after a table read data instruction has been executed. Note that the lower order table data byte is transferred to a user defined location.

Option Memory Mapping Register – ORMC

The ORMC register is used to enable Option Memory Mapping function. The Option Memory capacity is 64 words. When a specific pattern of 55H and AAH is consecutively written into this register, the Option Memory Mapping function will be enabled and then the Option Memory code can be read by using the table read instruction. The Option Memory addresses 00H~3FH will be mapped to Program Memory last page addresses C0H~FFH.

To successfully enable the Option Memory Mapping function, the specific pattern of 55H and AAH must be written into the ORMC register in two consecutive instruction cycles. It is therefore recommended that the global interrupt bit EMI should first be cleared before writing the specific pattern, and then set high again at a proper time according to users' requirements after the pattern is successfully written. An internal timer will be activated when the pattern is successfully written. The mapping operation will be automatically finished after a period of $4 \times t_{LIRC}$. Therefore, users should read the data in time, otherwise the Option Memory Mapping function needs to be restarted. After the completion of each consecutive write operation to the ORMC register, the timer will recount.

When the table read instructions are used to read the Option Memory code, both "TABRD [m]" and "TABRDL [m]" instructions can be used. However, care must be taken if the "TABRD [m]" instruction is used, the table pointer defined by the TBHP register must be referenced to the last page. Refer to corresponding sections about the table read instruction for more details.

• ORMC Register

Bit	7	6	5	4	3	2	1	0
Name	ORMC7	ORMC6	ORMC5	ORMC4	ORMC3	ORMC2	ORMC1	ORMC0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~0 **ORMC7~ORMC0**: Option Memory Mapping specific pattern
When a specific pattern of 55H and AAH is written into this register, the Option Memory Mapping function will be enabled. Note that the register content will be cleared after the MCU is woken up from the IDLE/SLEEP mode.

Status Register – STATUS

This 8-bit register contains the SC flag, CZ flag, zero flag (Z), carry flag (C), auxiliary carry flag (AC), overflow flag (OV), power down flag (PDF), and watchdog time-out flag (TO). These arithmetic/logical operation and system management flags are used to record the status and operation of the microcontroller.

With the exception of the TO and PDF flags, bits in the status register can be altered by instructions like most other registers. Any data written into the status register will not change the TO or PDF flag. In addition, operations related to the status register may give different results due to the different instruction operations. The TO flag can be affected only by a system power-up, a WDT time-out or by executing the "CLR WDT" or "HALT" instruction. The PDF flag is affected only by executing the "HALT" or "CLR WDT" instruction or during a system power-up.

The Z, OV, AC, C, SC and CZ flags generally reflect the status of the latest operations.

- C is set if an operation results in a carry during an addition operation or if a borrow does not take place during a subtraction operation; otherwise C is cleared. C is also affected by a rotate through carry instruction.

- AC is set if an operation results in a carry out of the low nibbles in addition, or no borrow from the high nibble into the low nibble in subtraction; otherwise AC is cleared.

- Z is set if the result of an arithmetic or logical operation is zero; otherwise Z is cleared.

- OV is set if an operation results in a carry into the highest-order bit but not a carry out of the highest-order bit, or vice versa; otherwise OV is cleared.

- PDF is cleared by a system power-up or executing the "CLR WDT" instruction. PDF is set by executing the "HALT" instruction.

- TO is cleared by a system power-up or executing the "CLR WDT" or "HALT" instruction. TO is set by a WDT time-out.

- CZ is the operational result of different flags for different instructions. Refer to register definitions for more details.

- SC is the result of the "XOR" operation which is performed by the OV flag and the MSB of the current instruction operation result.

In addition, on entering an interrupt sequence or executing a subroutine call, the status register will not be pushed onto the stack automatically. If the contents of the status registers are important and if the subroutine can corrupt the status register, precautions must be taken to correctly save it.

• **STATUS Register**

Bit	7	6	5	4	3	2	1	0
Name	SC	CZ	TO	PDF	OV	Z	AC	C
R/W	R/W	R/W	R	R	R/W	R/W	R/W	R/W
POR	x	x	0	0	x	x	x	x

"x": Unknown

Bit 7　　　**SC**: The result of the "XOR" operation which is performed by the OV flag and the MSB of the instruction operation result.

Bit 6　　　**CZ**: The operational result of different flags for different instructions.
For SUB/SUBM/LSUB/LSUBM instructions, the CZ flag is equal to the Z flag.
For SBC/SBCM/LSBC/LSBCM instructions, the CZ flag is the "AND" operation result which is performed by the previous operation CZ flag and current operation zero flag.
For other instructions, the CZ flag will not be affected.

Bit 5　　　**TO**: Watchdog time-out flag
　　　0: After power up or executing the "CLR WDT" or "HALT" instruction
　　　1: A watchdog time-out occurred.

Bit 4　　　**PDF**: Power down flag
　　　0: After power up or executing the «CLR WDT" instruction
　　　1: By executing the "HALT" instruction

Bit 3　　　**OV**: Overflow flag
　　　0: No overflow
　　　1: An operation results in a carry into the highest-order bit but not a carry out of the highest-order bit or vice versa.

Bit 2　　　**Z**: Zero flag
　　　0: The result of an arithmetic or logical operation is not zero
　　　1: The result of an arithmetic or logical operation is zero

Bit 1　　　**AC**: Auxiliary flag
　　　0: No auxiliary carry
　　　1: An operation results in a carry out of the low nibbles in addition, or no borrow from the high nibble into the low nibble in subtraction

Bit 0　　　**C**: Carry flag
　　　0: No carry-out
　　　1: An operation results in a carry during an addition operation or if a borrow does not take place during a subtraction operation
The "C" flag is also affected by a rotate through carry instruction.

EEPROM Data Memory

This device contains an area of internal EEPROM Data Memory. EEPROM is by its nature a non-volatile form of re-programmable memory, with data retention even when its power supply is removed. By incorporating this kind of data memory, a whole new host of application possibilities are made available to the designer. The availability of EEPROM storage allows information such as product identification numbers, calibration values, specific user data, system setup data or other product information to be stored directly within the product microcontroller. The process of reading and writing data to the EEPROM memory has been reduced to a very trivial affair.

EEPROM Data Memory Structure

The EEPROM Data Memory capacity is 128×8 bits for the device. Unlike the Program Memory and RAM Data Memory, the EEPROM Data Memory is not directly mapped into memory space and is therefore not directly addressable in the same way as the other types of memory. Read and Write operations to the EEPROM are carried out in single byte operations using an address register and a data register in Sector 0 and a single control register in Sector 1.

EEPROM Registers

Three registers control the overall operation of the internal EEPROM Data Memory. These are the address registers, EEA, the data register, EED and a single control register, EEC. As both the EEA and EED registers are located in Sector 0, they can be directly accessed in the same way as any other Special Function Register. The EEC register however, being located in Sector 1, can only be read from or written to indirectly using the MP1L/MP1H or MP2L/MP2H Memory Pointer and Indirect Addressing Register, IAR1/IAR2. Because the EEC control register is located at address 40H in Sector 1, the MP1L or MP2L Memory Pointer must first be set to the value 40H and the MP1H or MP2H Memory Pointer high byte set to the value, 01H, before any operations on the EEC register are executed.

Register Name	Bit							
	7	6	5	4	3	2	1	0
EEA	—	EEA6	EEA5	EEA4	EEA3	EEA2	EEA1	EEA0
EED	D7	D6	D5	D4	D3	D2	D1	D0
EEC	EWERTS	EREN	ER	MODE	WREN	WR	RDEN	RD

EEPROM Register List

• **EEA Register**

Bit	7	6	5	4	3	2	1	0
Name	—	EEA6	EEA5	EEA4	EEA3	EEA2	EEA1	EEA0
R/W	—	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	—	0	0	0	0	0	0	0

Bit 7   Unimplemented, read as "0"

Bit 6~0   **EEA6~EEA0**: Data EEPROM address bit 6 ~ bit 0

• **EED Register**

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	D5	D4	D3	D2	D1	D0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~0   **D7~D0**: Data EEPROM data bit 7 ~ bit 0

• **EEC Register**

Bit	7	6	5	4	3	2	1	0
Name	EWERTS	EREN	ER	MODE	WREN	WR	RDEN	RD
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7   **EWERTS**: EEPROM Erase time and Write time select
0: Erase time is 3.2ms (t_{EEER}) / Write time is 2.2ms (t_{EEWR})
1: Erase time is 3.7ms (t_{EEER}) / Write time is 3.0ms (t_{EEWR})

Bit 6   **EREN**: Data EEPROM erase enable
0: Disable
1: Enable
This bit is used to enable data EEPROM erase function and must be set high before erase operations are carried out. This bit will be automatically reset to zero by the hardware after the erase cycle has finished. Clearing this bit to zero will inhibit data EEPROM erase operations.

Bit 5   **ER**: EEPROM erase control
0: Erase cycle has finished
1: Activate an erase cycle
When this bit is set high by the application program, an erase cycle will be activated. This bit will be automatically reset to zero by the hardware after the erase cycle has finished. Setting this bit high will have no effect if the EREN has not first been set high.

Bit 4   **MODE**: EEPROM Operation mode select
0: Byte operation mode
1: Page operation mode
This is the EEPROM Page operation mode select bit and when set high by the application program will select the Page write or erase or read function. Otherwise, the EEPROM is the byte write or read function. The EEPROM page buffer size is 16-byte.

Bit 3   **WREN**: Data EEPROM write enable
0: Disable
1: Enable
This is the Data EEPROM Write Enable Bit which must be set high before Data EEPROM write operations are carried out. Clearing this bit to zero will inhibit Data EEPROM write operations. Note that this bit will automatically be reset to zero by hardware after the write cycle has finished.

Bit 2   **WR**: EEPROM write control
0: Write cycle has finished
1: Activate a write cycle
This is the Data EEPROM Write Control Bit and when set high by the application program will activate a write cycle. This bit will be automatically reset to zero by the hardware after the write cycle has finished. Setting this bit high will have no effect if the WREN has not first been set high.

Bit 1   **RDEN**: Data EEPROM read enable
0: Disable
1: Enable
This is the Data EEPROM Read Enable Bit which must be set high before Data EEPROM read operations are carried out. Clearing this bit to zero will inhibit Data EEPROM read operations.

Bit 0   **RD**: EEPROM read control
0: Read cycle has finished
1: Activate a read cycle
This is the Data EEPROM Read Control Bit and when set high by the application program will activate a read cycle. This bit will be automatically reset to zero by the hardware after the read cycle has finished. Setting this bit high will have no effect if the RDEN bit has not first been set high.

Note: 1. The EREN, ER, WREN, WR, RDEN and RD cannot be set high at the same time in one instruction.

    2. Ensure that the f_{SUB} clock is stable before executing the erase/write operation.

    3. Ensure that the erase or write operation is totally complete before changing the contents of the EEPROM related registers or activating the IAP function.

Reading Operation from the EEPROM

Reading data from the EEPROM can be implemented by two modes for this device, byte read mode or page read mode, which is controlled by the EEPROM operation mode selection bit, MODE, in the EEC register.

Byte Read Mode

The EEPROM byte read operation can be executed when the mode selection bit, MODE, is cleared to zero. For a byte read operation the desired EEPROM address should first be placed in the EEA register, as well as the read enable bit, RDEN, in the EEC register should be set high to enable the read function. Then setting the RD bit high will initiate the EEPROM byte read operation. Note that setting the RD bit high only will not initiate a read operation if the RDEN bit is not set high. When the read cycle terminates, the EEPROM data can be read from the EED register and the RD bit will automatically be cleared to zero. The data will remain in the EED register until another read or write operation is executed. The application program can poll the RD bit to determine when the data is valid for reading.

Page Read Mode

The EEPROM page read operation can be executed when the mode selection bit, MODE, is set high. The page size can be up to 16 bytes for the page read operation. For a page read operation the start address of the desired EEPROM page should first be placed in the EEA register, as well as the read enable bit, RDEN, in the EEC register should be set high to enable the read function. Then setting the RD bit high will initiate the EEPROM page read operation. Note that setting the RD bit high only will not initiate a read operation if the RDEN bit is not set high. When the current byte read cycle terminates, the EEPROM data can be read from the EED register and then the current address will be incremented by one by hardware. After this the RD bit will automatically be cleared to zero. The data which is stored in the next EEPROM address can continuously be read when the RD bit is again set high without reconfiguring the EEPROM address and RDEN control bit. The application program can poll the RD bit to determine when the data is valid for reading.

The EEPROM address higher 3 bits are used to specify the desired page location while the lower 4 bits are used to point to the actual address. In the page read operation mode the lower 4-bit address value will automatically be incremented by one. However, the higher 3-bit address value will not be incremented by hardware. When the EEPROM address lower 4-bit value which is internally incremented by one in the page mode reaches the page boundary, known as 0FH, the EEPROM address lower 4-bit value will stop at 0FH. The EEPROM address will not "roll over".

Page Erase Operation to the EEPROM

The EEPROM page erase operation can be executed when the mode selection bit, MODE, is set high. The EEPROM is capable of a 16-byte page erase. The internal page buffer will be cleared by hardware after power on reset. When the EEPROM erase enable control bit, namely EREN, is changed from "1" to "0", the internal page buffer will also be cleared. Note that when the EREN bit is changed from "0" to "1", the internal page buffer will not be cleared. The EEPROM address higher 3 bits are used to specify the desired page location while the lower 4 bits are used to point to the actual address. In the page erase operation mode, the lower 4-bit address value will automatically

be incremented by one after each dummy data byte is written into the EED register. However, the higher 3-bit address value will not be incremented by hardware. When the EEPROM address lower 4-bit value which is internally incremented by one in the page mode reaches the page boundary, known as 0FH, the EEPROM address lower 4-bit value will stop at 0FH. The EEPROM address will not "roll over".

For page erase operations the start address of the desired EEPROM page should first be placed in the EEA register, then the dummy data to be written should be placed in the EED register. The maximum data length for a page is 16 bytes. Note that the write operation to the EED register is used to tag address, it must be implemented to determine which addresses to be erased. When the page dummy data is completely written, then the EREN bit in the EEC register should be set high to enable erase operations and the ER bit must be immediately set high to initiate the EEPROM erase process. These two instructions must be executed in two consecutive instruction cycles to activate an erase operation successfully. The global interrupt enable bit EMI should also first be cleared before implementing an erase operation and then set again after a valid erase activation procedure has completed.

Note: The above steps must be executed sequentially to successfully complete the page erase operation, refer to the corresponding programming example.

As the EEPROM erase cycle is controlled using an internal timer whose operation is asynchronous to microcontroller system clock, a certain time will elapse before the data will have been erased from the EEPROM. Detecting when the erase cycle has finished can be implemented either by polling the ER bit in the EEC register or by using the EEPROM interrupt. When the erase cycle terminates, the ER bit will be automatically cleared to zero by the microcontroller, informing the user that the page data has been erased. The application program can therefore poll the ER bit to determine when the erase cycle has ended. After the erase operation is finished, the EREN bit will be set low by hardware. The Data EEPROM erased page content will all be zero after a page erase operation.

Write Operation to the EEPROM

Writing data to the EEPROM can be implemented by two modes for this device, byte write mode or page write mode, which is controlled by the EEPROM operation mode selection bit, MODE, in the EEC register.

Byte Write Mode

The EEPROM byte write operation can be executed when the mode selection bit, MODE, is cleared to zero. For byte write operations the desired EEPROM address should first be placed in the EEA register, then the data to be written should be placed in the EED register. To write data to the EEPROM, the write enable bit, WREN, in the EEC register must first be set high to enable the write function. After this, the WR bit in the EEC register must be immediately set high to initiate a write cycle. These two instructions must be executed in two consecutive instruction cycles to activate a write operation successfully. The global interrupt bit EMI should also first be cleared before implementing any write operations, and then set high again after a valid write activation procedure has completed. Note that setting the WR bit high only will not initiate a write cycle if the WREN bit is not set.

Note: The above steps must be executed sequentially to successfully complete the byte write operation, refer to the corresponding programming example.

As the EEPROM write cycle is controlled using an internal timer whose operation is asynchronous to microcontroller system clock, a certain time will elapse before the data will have been written into the EEPROM. Detecting when the write cycle has finished can be implemented either by polling the WR bit in the EEC register or by using the EEPROM interrupt. When the write cycle terminates, the WR bit will be automatically cleared to zero by the microcontroller, informing the user that the data has been written to the EEPROM. The application program can therefore poll the WR bit to

determine when the write cycle has ended. After the write operation is finished, the WREN bit will be set low by hardware. Note that a byte erase operation will automatically be executed before a byte write operation is successfully activated.

Page Write Mode

Before a page write operation is executed, it is important to ensure that a relevant page erase operation has been successfully executed. The EEPROM page write operation can be executed when the mode selection bit, MODE, is set high. The EEPROM is capable of a 16-byte page write. The internal page buffer will be cleared by hardware after power on reset. When the EEPROM write enable control bit, namely WREN, is changed from "1" to "0", the internal page buffer will also be cleared. Note that when the WREN bit is changed from "0" to "1", the internal page buffer will not be cleared. A page write is initiated in the same way as a byte write initiation except that the EEPROM data can be written up to 16 bytes. The EEPROM address higher 3 bits are used to specify the desired page location while the lower 4 bits are used to point to the actual address. In the page write operation mode the lower 4-bit address value will automatically be incremented by one after each data byte is written into the EED register. However, the higher 3-bit address value will not be incremented by hardware. When the EEPROM address lower 4-bit value which is internally incremented by one in the page mode reaches the page boundary, known as 0FH, the EEPROM address lower 4-bit value will stop at 0FH. The EEPROM address will not "roll over". At this point any data write operations to the EED register will be invalid.

For page write operations the start address of the desired EEPROM page should first be placed in the EEA register, then the data to be written should be placed in the EED register. The maximum data length for a page is 16 bytes. Note that when a data byte is written into the EED register, then the data in the EED register will be loaded into the internal page buffer and the current address value will automatically be incremented by one. When the page data is completely written into the page buffer, then the WREN bit in the EEC register should be set high to enable write operations and the WR bit must be immediately set high to initiate the EEPROM write process. These two instructions must be executed in two consecutive instruction cycles to activate a write operation successfully. The global interrupt enable bit EMI should also first be cleared before implementing any write operations, and then set high again after a valid write activation procedure has completed. Note that setting the WR bit high only will not initiate a write cycle if the WREN bit is not set.

Note: The above steps must be executed sequentially to successfully complete the page write operation, refer to the corresponding programming example.

As the EEPROM write cycle is controlled using an internal timer whose operation is asynchronous to microcontroller system clock, a certain time will elapse before the data will have been written into the EEPROM. Detecting when the write cycle has finished can be implemented either by polling the WR bit in the EEC register or by using the EEPROM interrupt. When the write cycle terminates, the WR bit will be automatically cleared to zero by the microcontroller, informing the user that the data has been written to the EEPROM. The application program can therefore poll the WR bit to determine when the write cycle has ended. After the write operation is finished, the WREN bit will be set low by hardware.

Write Protection

Protection against inadvertent write operation is provided in several ways. After the device is powered-on the Write Enable bit in the control register will be cleared preventing any write operations. Also at power-on the Memory Pointer high byte register, MP1H or MP2H, will be reset to zero, which means that Data Memory Sector 0 will be selected. As the EEPROM control register is located in Sector 1, this adds a further measure of protection against spurious write operations.

During normal program operation, ensuring that the Write Enable bit in the control register is cleared will safeguard against incorrect write operations.

EEPROM Interrupt

The EEPROM interrupt is generated when an EEPROM erase or write cycle has ended. The EEPROM interrupt must first be enabled by setting the DEE bit in the relevant interrupt register. When an EEPROM erase or write cycle ends, the DEF request flag will be set. If the global and EEPROM interrupts are enabled and the stack is not full, a jump to the associated EEPROM interrupt vector will take place. When the interrupt is serviced, the EEPROM interrupt flag will be automatically reset. More details can be obtained in the Interrupt section.

Programming Considerations

Care must be taken that data is not inadvertently written to the EEPROM. Protection can be enhanced by ensuring that the Write Enable bit is normally cleared to zero when not writing. Also the Memory Pointer high byte register, MP1H or MP2H, could be normally cleared to zero as this would inhibit access to Sector 1 where the EEPROM control register exists. Although certainly not necessary, consideration might be given in the application program to the checking of the validity of new write data by a simple read back process.

When writing data the WR bit must be set high immediately after the WREN bit has been set high, to ensure the write cycle executes correctly. The global interrupt bit EMI should also be cleared before a write or erase cycle is executed and then set again after a valid write or erase activation procedure has completed. Note that the device should not enter the IDLE or SLEEP mode until the EEPROM read or write operation is totally complete. Otherwise, the EEPROM read or write operation will fail.

Programming Examples

Reading a Data Byte from the EEPROM – polling method

```
MOV A, EEPROM_ADRES      ; user defined address
MOV EEA, A
MOV A, 040H              ; setup memory pointer low byte MP1L
MOV MP1L, A              ; MP1 points to EEC register
MOV A, 01H               ; setup memory pointer high byte MP1H
MOV MP1H, A
CLR IAR1.4               ; clear MODE bit, select byte operation mode
SET IAR1.1               ; set RDEN bit, enable read operations
SET IAR1.0               ; start Read Cycle - set RD bit
BACK:
SZ IAR1.0                ; check for read cycle end
JMP BACK
CLR IAR1                 ; disable EEPROM read function
CLR MP1H
MOV A, EED               ; move read data to register
MOV READ_DATA, A
```

Reading a Data Page from the EEPROM – polling method

```
MOV A, EEPROM_ADRES      ; user defined address
MOV EEA, A
MOV A, 040H              ; setup memory pointer low byte MP1L
MOV MP1L, A              ; MP1 points to EEC register
MOV A, 01H               ; setup memory pointer high byte MP1H
MOV MP1H, A
SET IAR1.4               ; set MODE bit, select page operation mode
```

```
SET IAR1.1                  ; set RDEN bit, enable read operations
; ~~~~ The data length can be up to 16 bytes (Start) ~~~~
CALL READ
CALL READ
:
:
JMP PAGE_READ_FINISH
; ~~~~ The data length can be up to 16 bytes (End) ~~~~
READ:
SET IAR1.0                  ; start Read Cycle - set RD bit
BACK:
SZ  IAR1.0                  ; check for read cycle end
JMP BACK
MOV A, EED                  ; move read data to register
MOV READ_DATA, A
RET
:
PAGE_READ_FINISH:
CLR IAR1                    ; disable EEPROM read function
CLR MP1H
```

Erasing a Data Page to the EEPROM − Polling Method

```
MOV A, EEPROM_ADRES        ; user defined address
MOV EEA, A
; ~~~~ The data length can be up to 16 bytes (Start) ~~~~
CALL WRITE_BUF
CALL WRITE_BUF
:
:
JMP Erase_START
; ~~~~ The data length can be up to 16 bytes (End) ~~~~
WRITE_BUF:
MOV A, EEPROM_DATA         ; user defined data, erase mode don't care data value
MOV EED, A
RET
:
Erase_START:
MOV A, 040H                ; setup memory pointer low byte MP1L
MOV MP1L, A                ; MP1 points to EEC register
MOV A, 01H                 ; setup memory pointer high byte MP1H
MOV MP1H, A
SET IAR1.4                 ; set MODE bit, select page operation mode
CLR EMI
SET IAR1.6                 ; set EREN bit, enable erase operations
SET IAR1.5                 ; start Erase Cycle - set ER bit – executed immediately
                           ; after setting EREN bit
SET EMI
BACK:
SZ  IAR1.5                 ; check for erase cycle end
JMP BACK
CLR MP1H
```

Writing a Data Byte to the EEPROM – Polling Method

```
MOV A, EEPROM_ADRES      ; user defined address
MOV EEA, A
MOV A, EEPROM_DATA       ; user defined data
MOV EED, A
MOV A, 040H              ; setup memory pointer low byte MP1L
MOV MP1L, A              ; MP1 points to EEC register
MOV A, 01H               ; setup memory pointer high byte MP1H
MOV MP1H, A
CLR IAR1.4               ; clear MODE bit, select byte operation mode
CLR EMI
SET IAR1.3               ; set WREN bit, enable write operations
SET IAR1.2               ; start Write Cycle - set WR bit – executed immediately
                         ; after setting WREN bit
SET EMI
BACK:
SZ  IAR1.2               ; check for write cycle end
JMP BACK
CLR MP1H
```

Writing a Data Page to the EEPROM – polling method

```
MOV A, EEPROM_ADRES      ; user defined address
MOV EEA, A
; ~~~~ The data length can be up to 16 bytes (Start) ~~~~
CALL WRITE_BUF
CALL WRITE_BUF
:
:
JMP WRITE_START
; ~~~~ The data length can be up to 16 bytes (End) ~~~~
WRITE_BUF:
MOV A, EEPROM_DATA       ; user defined data
MOV EED, A
RET
:
WRITE_START:
MOV A, 040H              ; setup memory pointer low byte MP1L
MOV MP1L, A              ; MP1 points to EEC register
MOV A, 01H               ; setup memory pointer high byte MP1H
MOV MP1H, A
SET IAR1.4               ; set MODE bit, select page operation mode
CLR EMI
SET IAR1.3               ; set WREN bit, enable write operations
SET IAR1.2               ; start Write Cycle - set WR bit – executed immediately
                         ; after setting WREN bit
SET EMI
BACK:
SZ  IAR1.2               ; check for write cycle end
JMP BACK
CLR MP1H
```

Oscillators

Various oscillator options offer the user a wide range of functions according to their various application requirements. The flexible features of the oscillator functions ensure that the best optimization can be achieved in terms of speed and power saving. Oscillator operation is selected through relevant control registers.

Oscillator Overview

In addition to being the source of the main system clock the oscillators also provide clock sources for the Watchdog Timer and Time Base Interrupts. External oscillators requiring some external components as well as fully integrated internal oscillators requiring no external components are provided to form a wide range of both fast and slow system oscillators. The higher frequency oscillators provide higher performance but carry with it the disadvantage of higher power requirements, while the opposite is of course true for the lower frequency oscillators. With the capability of dynamically switching between fast and slow system clock, the device have the flexibility to optimize the performance/power ratio, a feature especially important in power sensitive portable applications.

Type	Name	Frequency	Pins
External High Speed Crystal	HXT	400kHz~4MHz	OSC1/OSC2
Internal High Speed RC	HIRC	4MHz	—
External Low Speed Crystal	LXT	32.768kHz	XT1/XT2
Internal Low Speed RC	LIRC	32.768kHz	—

Oscillator Types

System Clock Configurations

There are four methods of generating the system clock, two high speed oscillators and two low speed oscillators. The high speed oscillator is the external crystal/ceramic oscillator, HXT, and the internal 4MHz RC oscillator, HIRC. The low speed oscillators are the internal 32.768kHz RC oscillator, LIRC, and the external 32.768kHz crystal oscillator, LXT. Selecting whether the low or high speed oscillator is used as the system oscillator is implemented using the CKS2~CKS0 bits in the SCC register and as the system clock can be dynamically selected.

The actual source clock used for the low speed oscillator is chosen via the FSS bit in the SCC register. The frequency of the slow speed or high speed system clock is determined using the CKS2~CKS0 bits in the SCC register. Note that two oscillator selections must be made namely one high speed and one low speed system oscillators.
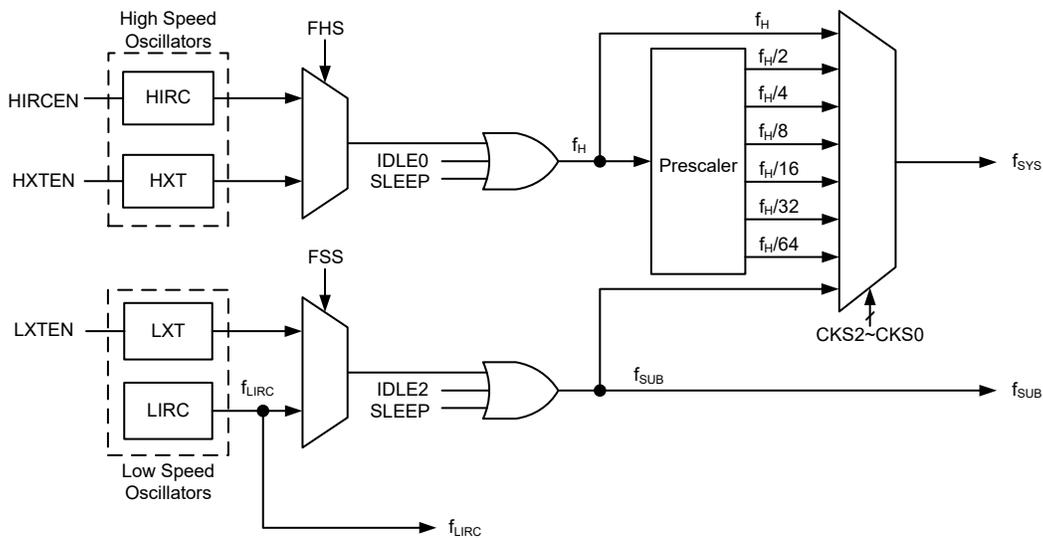
System Clock Configurations

External Crystal/Ceramic Oscillator – HXT

The External Crystal/Ceramic System Oscillator is one of the high frequency oscillator choices, which is selected via a software control bit, FHS. For most crystal oscillator configurations, the simple connection of a crystal across OSC1 and OSC2 will create the necessary phase shift and feedback for oscillation, without requiring external capacitors. However, for some crystal types and frequencies, to ensure oscillation, it may be necessary to add two small value capacitors, C1 and C2. Using a ceramic resonator will usually require two small value capacitors, C1 and C2, to be connected as shown for oscillation to occur. The values of C1 and C2 should be selected in consultation with the crystal or resonator manufacturer's specification.

For oscillator stability and to minimise the effects of noise and crosstalk, it is important to ensure that the crystal and any associated resistors and capacitors along with interconnecting lines are all located as close to the MCU as possible.
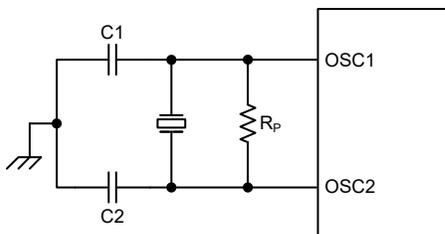
Note: 1. R_P is normally not required. C1 and C2 are required.
2. Although not shown OSC1/OSC2 pins have a parasitic capacitance of around 7pF.

Crystal/Resonator Oscillator – HXT

HXT Oscillator C1 and C2 Values		
Crystal Frequency	C1	C2
4MHz	0 pF	0 pF
1MHz	100 pF	100 pF
Note: C1 and C2 values are for guidance only.		

Crystal Recommended Capacitor Values

Internal High Speed RC Oscillator – HIRC

The internal RC oscillator is a fully integrated system oscillator requiring no external components. The internal RC oscillator has a fixed frequency of 4MHz. Device trimming during the manufacturing process and the inclusion of internal frequency compensation circuits are used to ensure that the influence of the power supply voltage, temperature and process variations on the oscillation frequency are minimised.

External 32.768kHz Crystal Oscillator – LXT

The external 32.768kHz crystal system oscillator is one of the low frequency oscillator choices, which is selected via a software control bit, FSS. This clock source has a fixed frequency of 32.768kHz and requires a 32.768kHz crystal to be connected between pins XT1 and XT2. The external resistor and capacitor components connected to the 32.768kHz crystal are necessary to provide oscillation. For applications where precise frequencies are essential, these components may be required to provide frequency compensation due to different crystal manufacturing tolerances. After the LXT oscillator is enabled by setting the LXTEN bit to 1, there is a time delay associated with the LXT oscillator waiting for it to start-up.

When the microcontroller enters the SLEEP or IDLE Mode, the system clock is switched off to stop microcontroller activity and to conserve power. However, in many microcontroller applications it may be necessary to keep the internal timers operational even when the microcontroller is in the SLEEP or IDLE Mode. To do this, another clock, independent of the system clock, must be provided.

However, for some crystals, to ensure oscillation and accurate frequency generation, it is necessary to add two small value external capacitors, C1 and C2. The exact values of C1 and C2 should be selected in consultation with the crystal or resonator manufacturer's specification.

The pin-shared software control bits determine if the XT1/XT2 pins are used for the LXT oscillator or as I/O or other pin-shared functional pins.

- If the LXT oscillator is not used for any clock source, the XT1/XT2 pins can be used as normal I/O or other pin-shared functional pins.

- If the LXT oscillator is used for any clock source, the 32.768kHz crystal should be connected to the XT1/XT2 pins.

For oscillator stability and to minimise the effects of noise and crosstalk, it is important to ensure that the crystal and any associated resistors and capacitors along with interconnecting lines are all located as close to the MCU as possible.
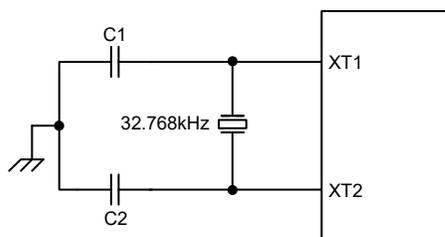
Note: 1. C1 and C2 are required.
2. Although not shown XT1/XT2 pins have a parasitic capacitance of around 7pF.

External LXT Oscillator

LXT Oscillator C1 and C2 Values		
Crystal Frequency	C1	C2
32.768kHz	10pF	10pF
Note: C1 and C2 values are for guidance only.		

32.768kHz Crystal Recommended Capacitor Values

LXT Oscillator Low Power Function

The LXT oscillator can function in one of two modes, the Speed-Up Mode and the Low Power Mode. The mode selection is executed using the LXTSP bit in the register.

LXTSP	LXT Mode
0	Low Power
1	Speed Up

When the LXTSP bit is set to high, the LXT Speed-Up Mode will be enabled. In the Speed-Up Mode the LXT oscillator will power up and stabilise quickly. However, after the LXT oscillator has fully powered up, it can be placed into the Low-Power Mode by clearing the LXTSP bit to zero and the oscillator will continue to run but with reduced current consumption. It is important to note that the LXT operating mode switching must be properly controlled before the LXT oscillator clock is selected as the system clock source. Once the LXT oscil-lator clock is selected as the system clock source using the CKS bit field and FSS bit in the SCC register, the LXT oscillator operating mode can not be changed.

It should be noted that, no matter what condition the LXTSP bit is set to, the LXT oscillator will be always function normally, the only difference is that it will take more time to start up if it is in the Low-power mode.

Internal 32.768kHz Oscillator – LIRC

The Internal 32.768kHz System Oscillator is a fully integrated RC oscillator with a typical frequency of 32.768kHz, requiring no external components for its implementation. Device trimming during the manufacturing process and the inclusion of internal frequency compensation circuits are used to ensure that the influence of the power supply voltage, temperature and process variations on the oscillation frequency are minimised.

Operating Modes and System Clocks

Present day applications require that their microcontrollers have high performance but often still demand that they consume as little power as possible, conflicting requirements that are especially true in battery powered portable applications. The fast clocks required for high performance will by their nature increase current consumption and of course vice versa, lower speed clocks reduce current consumption. As both high and low speed clock sources are provided the means to switch between them dynamically, the user can optimise the operation of their microcontroller to achieve the best performance/power ratio.

System Clocks

The device has different clock sources for both the CPU and peripheral function operation. By providing the user with a wide range of clock selections using register programming, a clock system can be configured to obtain maximum application performance.

The main system clock, can come from either a high frequency, f_H, or low frequency, f_{SUB}, source, and is selected using the CKS2~CKS0 bits in the SCC register. The high speed system clock is sourced from an HXT or HIRC oscillator, selected via configuring the FHS bit in the SCC register. The low speed system clock source can be sourced from the internal clock f_{SUB}. If f_{SUB} is selected then it can be sourced from the LXT or LIRC oscillator, selected via configuring the FSS bit in the SCC register. The other choice, which is a divided version of the high speed system oscillator has a range of $f_H/2 \sim f_H/64$.
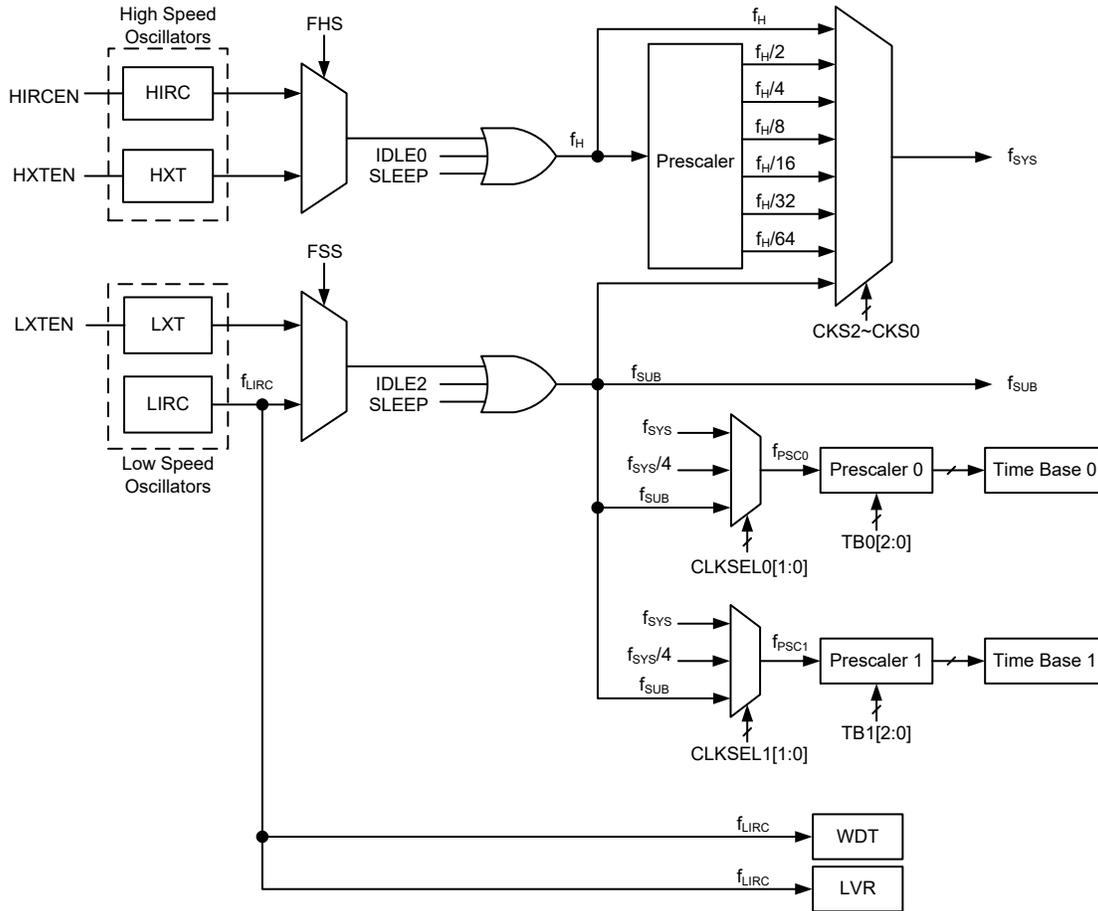
Device Clock Configurations

Note: When the system clock source f_{SYS} is switched to f_{SUB} from f_H, the high speed oscillator can be stopped to conserve the power or continue to oscillate to provide the clock source, $f_H \sim f_H/64$, for peripheral circuit to use, which is determined by configuring the corresponding high speed oscillator enable control bit.

System Operation Modes

There are six different modes of operation for the microcontroller, each one with its own special characteristics and which can be chosen according to the specific performance and power requirements of the application. There are two modes allowing normal operation of the microcontroller, the FAST Mode and SLOW Mode. The remaining four modes, the SLEEP, IDLE0, IDLE1 and IDLE2 Mode are used when the microcontroller CPU is switched off to conserve power.

| Operation Mode | CPU | Register Setting | | | f_{SYS} | f_H | f_{SUB} | f_{LIRC} |
		FHIDEN	FSIDEN	CKS2~CKS0				
FAST	On	x	x	000~110	f_H~f_H/64	On	On	On
SLOW	On	x	x	111	f_{SUB}	On/Off [(1)]	On	On
IDLE0	Off	0	1	000~110	Off	Off	On	On
				111	On			
IDLE1	Off	1	1	xxx	On	On	On	On
IDLE2	Off	1	0	000~110	On	On	Off	On
				111	Off			
SLEEP	Off	0	0	xxx	Off	Off	Off	On/Off [(2)]

"x": Don't care

Note: 1. The f_H clock will be switched on or off by configuring the corresponding oscillator enable bit in the SLOW mode.

2. The f_{LIRC} clock can be switched on or off which is controlled by the WDT function being enabled or disabled in the SLEEP mode.

FAST Mode

This is one of the main operating modes where the microcontroller has all of its functions operational and where the system clock is provided by one of the high speed oscillators. This mode operates allowing the microcontroller to operate normally with a clock source will come from one of the high speed oscillators, either the HXT or HIRC oscillator. The high speed oscillator will however first be divided by a ratio ranging from 1 to 64, the actual ratio being selected by the CKS2~CKS0 bits in the SCC register. Although a high speed oscillator is used, running the microcontroller at a divided clock ratio reduces the operating current.

SLOW Mode

This is also a mode where the microcontroller operates normally although now with a slower speed clock source. The clock source used will be from f_{SUB}. The f_{SUB} clock is derived from the LXT or LIRC oscillator determined by the FSS bit in the SCC register.

SLEEP Mode

The SLEEP Mode is entered when a HALT instruction is executed and when the FHIDEN and FSIDEN bit are low. In the SLEEP mode the CPU will be stopped and both the high and low speed oscillators will be switched off. However the f_{LIRC} clock can still continue to operate if the WDT function is enabled by the WDTC register.

IDLE0 Mode

The IDLE0 Mode is entered when a HALT instruction is executed and when the FHIDEN bit in the SCC register is low and the FSIDEN bit in the SCC register is high. In the IDLE0 Mode the CPU will be switched off but the low speed oscillator will be turned on to drive some peripheral functions.

IDLE1 Mode

The IDLE1 Mode is entered when a HALT instruction is executed and when the FHIDEN bit in the SCC register is high and the FSIDEN bit in the SCC register is high. In the IDLE1 Mode the CPU will be switched off but both the high and low speed oscillators will be turned on to provide a clock source to keep some peripheral functions operational.

IDLE2 Mode

The IDLE2 Mode is entered when a HALT instruction is executed and when the FHIDEN bit in the SCC register is high and the FSIDEN bit in the SCC register is low. In the IDLE2 Mode the CPU will be switched off but the high speed oscillator will be turned on to provide a clock source to keep some peripheral functions operational.

Control Registers

The registers, SCC, HIRCC, HXTC and LXTC, are used to control the system clock and the corresponding oscillator configurations.

Register Name	Bit							
	7	6	5	4	3	2	1	0
SCC	CKS2	CKS1	CKS0	—	FHS	FSS	FHIDEN	FSIDEN
HIRCC	—	—	—	—	—	—	HIRCF	HIRCEN
HXTC	—	—	—	—	—	HXTM	HXTF	HXTEN
LXTC	—	—	—	—	—	LXTSP	LXTF	LXTEN

System Operating Mode Control Register List

• **SCC Register**

Bit	7	6	5	4	3	2	1	0
Name	CKS2	CKS1	CKS0	—	FHS	FSS	FHIDEN	FSIDEN
R/W	R/W	R/W	R/W	—	R/W	R/W	R/W	R/W
POR	0	0	0	—	0	0	0	0

Bit 7~5   **CKS2~CKS0**: System clock selection
      000: f_H
      001: $f_H/2$
      010: $f_H/4$
      011: $f_H/8$
      100: $f_H/16$
      101: $f_H/32$
      110: $f_H/64$
      111: f_{SUB}

      These three bits are used to select which clock is used as the system clock source. In addition to the system clock source directly derived from f_H or f_{SUB}, a divided version of the high speed system oscillator can also be chosen as the system clock source.

Bit 4   Unimplemented, read as "0"

Bit 3   **FHS**: High frequency clock selection
      0: HIRC
      1: HXT

Bit 2   **FSS**: Low frequency clock selection
      0: LIRC
      1: LXT

Bit 1   **FHIDEN**: High frequency oscillator control when CPU is switched off
      0: Disable
      1: Enable

      This bit is used to control whether the high speed oscillator is activated or stopped when the CPU is switched off by executing a "HALT" instruction.

Bit 0   **FSIDEN**: Low frequency oscillator control when CPU is switched off
      0: Disable
      1: Enable

      This bit is used to control whether the low speed oscillator is activated or stopped when the CPU is switched off by executing a "HALT" instruction.

Note: A certain delay is required before the relevant clock is successfully switched to the target clock source after any clock switching setup using the CKS2~CKS0 bits, FHS bit or FSS bit. A proper delay time must be arranged before executing the following operations which require immediate reaction with the target clock source.

Clock switching delay time = $4×t_{SYS}+[0~(1.5×t_{Curr.}+0.5×t_{Tar.})]$, where $t_{Curr.}$ indicates the current clock period, $t_{Tar.}$ Indicates the target clock period and t_{SYS} indicates the current sytem clock period.

• **HIRCC Register**

Bit	7	6	5	4	3	2	1	0
Name	—	—	—	—	—	—	HIRCF	HIRCEN
R/W	—	—	—	—	—	—	R	R/W
POR	—	—	—	—	—	—	0	1

Bit 7~2   Unimplemented, read as "0"

Bit 1   **HIRCF**: HIRC oscillator stable flag
              0: HIRC unstable
              1: HIRC stable

              This bit is used to indicate whether the HIRC oscillator is stable or not. When the HIRCEN bit is set to 1 to enable the HIRC oscillator, the HIRCF bit will first be cleared to 0 and then set to 1 after the HIRC oscillator is stable.

Bit 0   **HIRCEN**: HIRC oscillator enable control
              0: Disable
              1: Enable

• **HXTC Register**

Bit	7	6	5	4	3	2	1	0
Name	—	—	—	—	—	HXTM	HXTF	HXTEN
R/W	—	—	—	—	—	R/W	R	R/W
POR	—	—	—	—	—	0	0	0

Bit 7~3   Unimplemented, read as "0"

Bit 2   **HXTM**: HXT mode selection
              0: HXT frequency ≤ 10MHz (sink/source current is smaller)
              1: HXT frequency > 10MHz (sink/source current is larger)

              Note that this bit should be configured correctly according to the used HXT frequency. If HXTM=0 while the HXT frequency is larger than 10MHz, the oscillation performance at a low voltage condition may be not well. If HXTM=1 while the HXT frequency is less than 10MHz, the oscillator frequency and the current may be abnormal.

              This bit must be properly configured before the HXT is enabled. When the OSC1 and OSC2 pin functions have been enabled using relevant pin-shared control bits and the HXTEN bit has been set to 1 to enable the HXT oscillator, it is invalid to change the value of the HXTM bit. When the OSC1 or OSC2 pin function is disabled, then the HXTM bit can be changed by software, regardless of the HXTEN bit value.

Bit 1   **HXTF**: HXT oscillator stable flag
              0: HXT unstable
              1: HXT stable

              This bit is used to indicate whether the HXT oscillator is stable or not. When the HXTEN bit is set to 1 to enable the HXT oscillator, the HXTF bit will first be cleared to 0 and then set to 1 after the HXT oscillator is stable.

Bit 0   **HXTEN**: HXT oscillator enable control
              0: Disable
              1: Enable

• **LXTC Register**

Bit	7	6	5	4	3	2	1	0
Name	—	—	—	—	—	LXTSP	LXTF	LXTEN
R/W	—	—	—	—	—	R/W	R	R/W
POR	—	—	—	—	—	0	0	0

Bit 7~3   Unimplemented, read as "0"

Bit 2   **LXTSP**: LXT speed-up control
    0: Disable
    1: Enable

This bit is used to control whether the LXT oscillator is operating in the low power or Speed-Up mode. When the LXTSP bit is set high, the LXT oscillator will oscillate quickly but consume more power. If the LXTSP bit is cleared to zero, the LXT oscillator will consume less power but take longer time to stablise. It is important to note that this bit cannot be changed after the LXT oscillator is selected as the system clock source using the CKS2~CKS0 and FSS bits in the SCC register

Bit 1   **LXTF**: LXT oscillator stable flag
    0: LXT unstable
    1: LXT stable

This bit is used to indicate whether the LXT oscillator is stable or not. When the LXTEN bit is set to 1 to enable the LXT oscillator, the LXTF bit will first be cleared to 0 and then set to 1 after the LXT oscillator is stable.

Bit 0   **LXTEN**: LXT oscillator enable control
    0: Disable
    1: Enable

Operating Mode Switching

The device can switch between operating modes dynamically allowing the user to select the best performance/power ratio for the present task in hand. In this way microcontroller operations that do not require high performance can be executed using slower clocks thus requiring less operating current and prolonging battery life in portable applications.

In simple terms, Mode Switching between the FAST Mode and SLOW Mode is executed using the CKS2~CKS0 bits in the SCC register while Mode Switching from the FAST/SLOW Modes to the SLEEP/IDLE Modes is executed via the HALT instruction. When a HALT instruction is executed, whether the device enters the IDLE Mode or the SLEEP Mode is determined by the condition of the FHIDEN and FSIDEN bits in the SCC register.
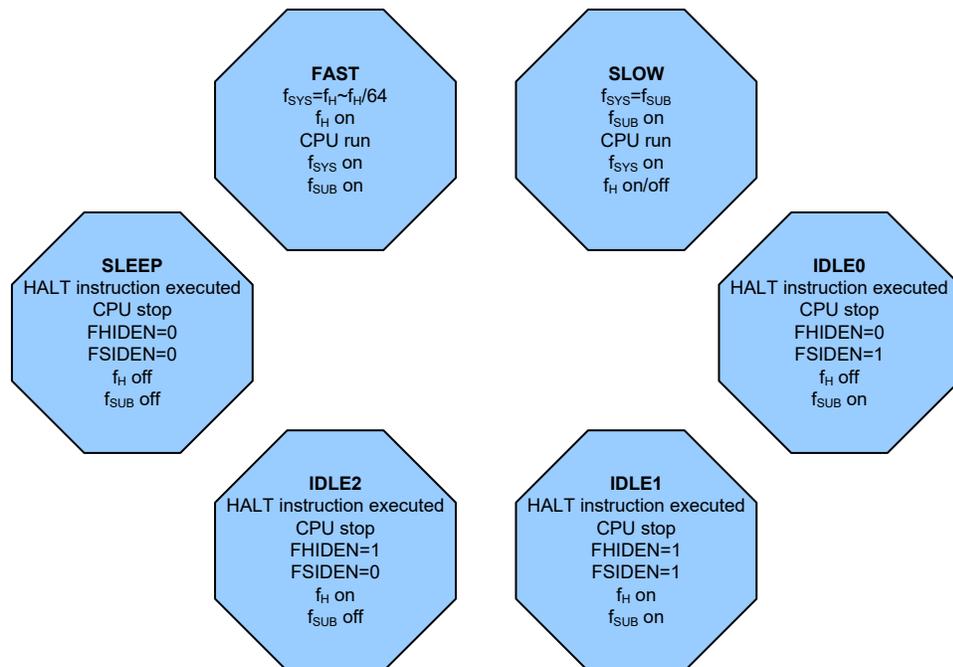
FAST Mode to SLOW Mode Switching

When running in the FAST Mode, which uses the high speed system oscillator, and therefore consumes more power, the system clock can switch to run in the SLOW Mode by setting the CKS2~CKS0 bits to "111" in the SCC register. This will then use the low speed system oscillator which will consume less power. Users may decide to do this for certain operations which do not require high performance and can subsequently reduce power consumption.

The SLOW Mode is sourced from the LXT or LIRC oscillator determined by the FSS bit in the SCC register and therefore requires these oscillators to be stable before full mode switching occurs.

```
┌──────────────────────────────────────────── FAST Mode

                                  CKS2~CKS0 = 111
                        └──────────────────────── SLOW Mode

                  FHIDEN=0, FSIDEN=0
                  HALT instruction is executed
                  └──────────────────────────── SLEEP Mode

            FHIDEN=0, FSIDEN=1
            HALT instruction is executed
            └──────────────────────────────── IDLE0 Mode

      FHIDEN=1, FSIDEN=1
      HALT instruction is executed
      └──────────────────────────────────── IDLE1 Mode

FHIDEN=1, FSIDEN=0
HALT instruction is executed
└──────────────────────────────────────── IDLE2 Mode
```
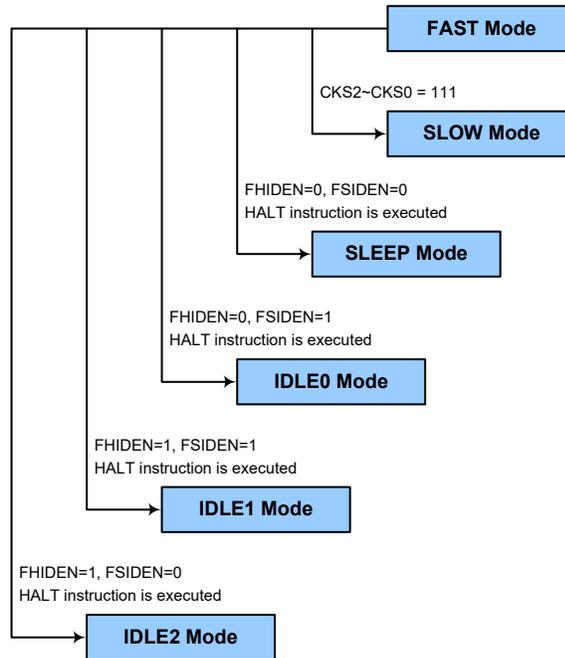
SLOW Mode to FAST Mode Switching

In SLOW mode the system clock is derived from f_{SUB}. When system clock is switched back to the FAST mode from f_{SUB}, the CKS2~CKS0 bits should be set to "000"~"110" and then the system clock will respectively be switched to f_H~$f_H/64$.

However, if f_H is not used in SLOW mode and thus switched off, it will take some time to re-oscillate and stabilise when switching to the FAST mode from the SLOW Mode. This is monitored using the HXTF bit in the HXTC register or the HIRCF bit in the HIRCC register. The time duration required for the high speed system oscillator stabilization is specified in the System Start Up Time Characteristics.
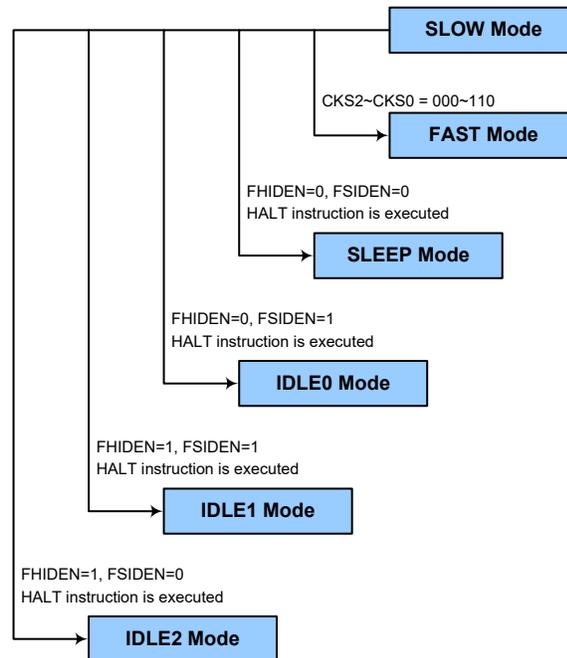
Entering the SLEEP Mode

There is only one way for the device to enter the SLEEP Mode and that is to execute the "HALT" instruction in the application program with both the FHIDEN and FSIDEN bits in the SCC register equal to "0". In this mode all the clocks and functions will be switched off except the WDT function. When this instruction is executed under the conditions described above, the following will occur:

- The system clock will be stopped and the application program will stop at the "HALT" instruction.
- The Data Memory contents and registers will maintain their present condition.
- The I/O ports will maintain their present conditions.
- In the status register, the Power Down flag PDF will be set, and WDT timeout flag TO will be cleared.
- The WDT will be cleared and resume counting if the WDT function is enabled. If the WDT function is disabled, the WDT will be cleared and then stopped.

Entering the IDLE0 Mode

There is only one way for the device to enter the IDLE0 Mode and that is to execute the "HALT" instruction in the application program with the FHIDEN bit in the SCC register equal to "0" and the FSIDEN bit in the SCC register equal to "1". When this instruction is executed under the conditions described above, the following will occur:

- The f_H clock will be stopped and the application program will stop at the "HALT" instruction, but the f_{SUB} clock will be on.
- The Data Memory contents and registers will maintain their present condition.
- The I/O ports will maintain their present conditions.
- In the status register, the Power Down flag PDF will be set, and WDT timeout flag TO will be cleared.
- The WDT will be cleared and resume counting if the WDT function is enabled. If the WDT function is disabled, the WDT will be cleared and then stopped.

Entering the IDLE1 Mode

There is only one way for the device to enter the IDLE1 Mode and that is to execute the "HALT" instruction in the application program with both the FHIDEN and FSIDEN bits in the SCC register equal to "1". When this instruction is executed under the conditions described above, the following will occur:

- The f_H and f_{SUB} clocks will be on but the application program will stop at the "HALT" instruction.
- The Data Memory contents and registers will maintain their present condition.
- The I/O ports will maintain their present conditions.
- In the status register, the Power Down flag PDF will be set, and WDT timeout flag TO will be cleared.
- The WDT will be cleared and resume counting if the WDT function is enabled. If the WDT function is disabled, the WDT will be cleared and then stopped.

Entering the IDLE2 Mode

There is only one way for the device to enter the IDLE2 Mode and that is to execute the "HALT" instruction in the application program with the FHIDEN bit in the SCC register equal to "1" and the FSIDEN bit in the SCC register equal to "0". When this instruction is executed under the conditions described above, the following will occur:

- The f_H clock will be on but the f_{SUB} clock will be off and the application program will stop at the "HALT" instruction.
- The Data Memory contents and registers will maintain their present condition.
- The I/O ports will maintain their present conditions.
- In the status register, the Power Down flag PDF will be set, and WDT timeout flag TO will be cleared.
- The WDT will be cleared and resume counting if the WDT function is enabled. If the WDT function is disabled, the WDT will be cleared and then stopped.

Standby Current Considerations

As the main reason for entering the SLEEP or IDLE Mode is to keep the current consumption of the device to as low a value as possible, perhaps only in the order of several micro-amps except in the IDLE1 and IDLE2 Mode, there are other considerations which must also be taken into account by the circuit designer if the power consumption is to be minimised. Special attention must be made to the I/O pins on the device. All high-impedance input pins must be connected to either a fixed high or low level as any floating input pins could create internal oscillations and result in increased current consumption. This also applies to device which has different package types, as there may be unbonded pins. These must either be setup as outputs or if setup as inputs must have pull-high resistors connected.

Care must also be taken with the loads, which are connected to I/O pins, which are setup as outputs. These should be placed in a condition in which minimum current is drawn or connected only to external circuits that do not draw current, such as other CMOS inputs. Also note that additional standby current will also be required if the LIRC or LXT oscillator has enabled.

In the IDLE1 and IDLE2 Mode the high speed oscillator is on, if the peripheral function clock source is derived from the high speed oscillator, the additional standby current will also be perhaps in the order of several hundred micro-amps.

Wake-up

To minimise power consumption the device can enter the SLEEP or any IDLE Mode, where the CPU will be switched off. However, when the device is woken up again, it will take a considerable time for the original system oscillator to restart, stablise and allow normal operation to resume.

After the system enters the SLEEP or IDLE Mode, it can be woken up from one of various sources listed as follows:

- An external pin reset
- An external falling edge on Port A
- A system interrupt
- A WDT overflow

If the system is woken up by an external $\overline{\text{RES}}$ pin reset, the device will experience a full system reset, however, if the device is woken up by a WDT overflow, a Watchdog Timer reset will be initiated. Although both of these wake-up methods will initiate a reset operation, the actual source of the wake-up can be determined by examin-ing the TO and PDF flags. The PDF flag is cleared by a system power-up or executing the clear Watchdog Timer instructions and is set when executing the "HALT" instruction. The TO flag is set if a WDT time-out occurs, and causes a wake-up that only resets the Program Counter and Stack Pointer, the other flags remain in their original status.

Each pin on Port A can be setup using the PAWU register to permit a negative transition on the pin to wake up the system. When a Port A pin wake-up occurs, the program will resume execution at the instruction following the "HALT" instruction. If the system is woken up by an interrupt, then two possible situations may occur. The first is where the related interrupt is disabled or the interrupt is enabled but the stack is full, in which case the program will resume execution at the instruction following the "HALT" instruction. In this situation, the interrupt which woke up the device will not be immediately serviced, but will rather be serviced later when the related interrupt is finally enabled or when a stack level becomes free. The other situation is where the related interrupt is enabled and the stack is not full, in which case the regular interrupt response takes place. If an interrupt request flag is set high before entering the SLEEP or IDLE Mode, the wake-up function of the related interrupt will be disabled.

Watchdog Timer

The Watchdog Timer is provided to prevent program malfunctions or sequences from jumping to unknown locations, due to certain uncontrollable external events such as electrical noise.

Watchdog Timer Clock Source

The Watchdog Timer clock source is provided by the internal clock, f_{LIRC}. The LIRC internal oscillator has an approximate frequency of 32.768kHz and this specified internal clock period can vary with V_{DD}, temperature and process variations. The Watchdog Timer source clock is then subdivided by a ratio of 2^8 to 2^{18} to give longer timeouts, the actual value being chosen using the WS2~WS0 bits in the WDTC register.

Watchdog Timer Control Register

A single register, WDTC, controls the required timeout period as well as the enable/disable and reset MCU operation.

• **WDTC Register**

Bit	7	6	5	4	3	2	1	0
Name	WE4	WE3	WE2	WE1	WE0	WS2	WS1	WS0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	1	0	1	0	0	1	1

Bit 7~3   **WE4~WE0**: WDT function software control
         10101: Disable
         01010: Enable
         Others: Reset MCU

         When these bits are changed by the environmental noise or software setting to reset the microcontroller, the reset operation will be activated after a delay time, t_{SRESET}, and the WRF bit in the RSTFC register will be set high.

Bit 2~0   **WS2~WS0**: WDT time-out period selection
         000: $2^8/f_{LIRC}$
         001: $2^{10}/f_{LIRC}$
         010: $2^{12}/f_{LIRC}$
         011: $2^{14}/f_{LIRC}$
         100: $2^{15}/f_{LIRC}$
         101: $2^{16}/f_{LIRC}$
         110: $2^{17}/f_{LIRC}$
         111: $2^{18}/f_{LIRC}$

         These three bits determine the division ratio of the watchdog timer source clock, which in turn determines the time-out period.

• **RSTFC Register**

Bit	7	6	5	4	3	2	1	0
Name	—	—	—	—	RSTF	LVRF	LRF	WRF
R/W	—	—	—	—	R/W	R/W	R/W	R/W
POR	—	—	—	—	0	x	0	0

"x": Unknown

Bit 7~4   Unimplemented, read as "0"
Bit 3   **RSTF**: Reset control register software reset flag
         Refer to the "Internal Reset Control" section
Bit 2   **LVRF**: LVR function reset flag
         Refer to the "Low Voltage Reset" section

Bit 1   **LRF**: LVR control register software reset flag

Refer to the "Low Voltage Reset" section

Bit 0   **WRF**: WDT control register software reset flag

0: Not occur
1: Occurred

This bit is set high by the WDT control register software reset and cleared by the application program. Note that this bit can only be cleared to zero by the application program.

Watchdog Timer Operation

The Watchdog Timer operates by providing a device reset when its timer overflows. This means that in the application program and during normal operation the user has to strategically clear the Watchdog Timer before it overflows to prevent the Watchdog Timer from executing a reset. This is done using the clear watchdog instruction. If the program malfunctions for whatever reason, jumps to an unknown location, or enters an endless loop, this clear instruction will not be executed in the correct manner, in which case the Watchdog Timer will overflow and reset the device. There are five bits, WE4~WE0, in the WDTC register to offer the enable/disable control and reset control of the Watchdog Timer. The WDT function will be disabled when the WE4~WE0 bits are set to a value of 10101B while the WDT function will be enabled if the WE4~WE0 bits are equal to 01010B. If the WE4~WE0 bits are set to any other values, other than 01010B and 10101B, it will reset the device after a delay time, t_{SRESET}. After power on these bits will have a value of 01010B.

WE4~WE0 Bits	WDT Function
10101B	Disable
01010B	Enable
Any other values	Reset MCU

Watchdog Timer Function Control

Under normal program operation, a Watchdog Timer time-out will initialise a device reset and set the status bit TO. However, if the system is in the SLEEP or IDLE Mode, when a Watchdog Timer time-out occurs, the TO bit in the status register will be set and only the Program Counter and Stack Pointer will be reset. Four methods can be adopted to clear the contents of the Watchdog Timer. The first is a WDT software reset, which means a certain value except 01010B and 10101B written into the WE4~WE0 bit filed, the second is using the Watchdog Timer software clear instruction and the third is via a HALT instruction. The last is an external hardware reset, which means a low level on the external reset pin if the external reset pin is selected by the RSTC register.

There is only one method of using software instruction to clear the Watchdog Timer. That is to use the single "CLR WDT" instruction to clear the WDT.

The maximum time out period is when the 2^{18} division ratio is selected. As an example, with a 32.768kHz LIRC oscillator as its source clock, this will give a maximum watchdog period of around 8 seconds for the 2^{18} division ratio, and a minimum timeout of 8ms for the 2^8 division ration.
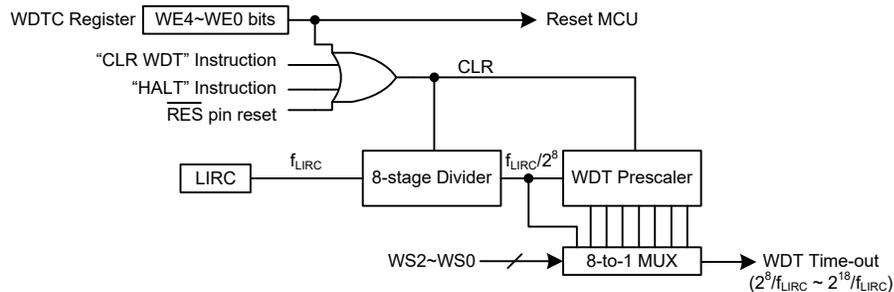
Watchdog Timer

Reset and Initialisation

A reset function is a fundamental part of any microcontroller ensuring that the device can be set to some predetermined condition irrespective of outside parameters. The most important reset condition is after power is first applied to the microcontroller. In this case, internal circuitry will ensure that the microcontroller, after a short delay, will be in a well-defined state and ready to execute the first program instruction. After this power-on reset, certain important internal registers will be set to defined states before the program commences. One of these registers is the Program Counter, which will be reset to zero forcing the microcontroller to begin program execution from the lowest Program Memory address.

In addition to the power-on reset, situations may arise where it is necessary to forcefully apply a reset condition when the device is running. One example of this is where after power has been applied and the device is already running, the $\overline{\text{RES}}$ line is forcefully pulled low. In such a case, known as a normal operation reset, some of the registers remain unchanged allowing the device to proceed with normal operation after the reset line is allowed to return high.

Another type of reset is when the Watchdog Timer overflows and resets. All types of reset operations result in different register conditions being setup. Another reset exists in the form of a Low Voltage Reset, LVR, where a full reset, is implemented in situations where the power supply voltage falls below a certain threshold.

Reset Functions

There are several ways in which a microcontroller reset can occur, through events occurring both internally and externally.

Power-on Reset

The most fundamental and unavoidable reset is the one that occurs after power is first applied to the microcontroller. As well as ensuring that the Program Memory begins execution from the first memory address, a power-on reset also ensures that certain other registers are preset to known conditions. All the I/O port and port control registers will power up in a high condition ensuring that all I/O ports will be first set to inputs.
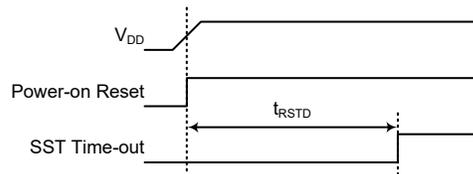
Note: t_{RSTD} is power-on delay specified in System Start Up Time Characteristics.
Power-On Reset Timing Chart

$\overline{\text{RES}}$ Pin Reset

As the reset pin is shared with I/O pins, the reset function must be selected using a control register, RSTC. Although the microcontroller has an internal RC reset function, if the V_{DD} power supply rise time is not fast enough or does not stabilise quickly at power-on, the internal reset function may be incapable of providing proper reset operation. For this reson it is recommended that an external RC network is connected to the $\overline{\text{RES}}$ pin, whose additional time delay will ensure that the $\overline{\text{RES}}$ pin remains low for an extended period to allow the power supply to stabilise. During this time delay, normal operation of the microcontroller will be inhibited. After the $\overline{\text{RES}}$ line reaches a certain voltage value, the reset delay time, t_{RSTD}, is invoked to provide an extea delay time after which the microcontroller will begin normal operation. The abbreviation SST in the figures stands for System Start-up Time. For most applications a resistor connected between VDD and the $\overline{\text{RES}}$ line and a capacitor connected betweeb VSS and the $\overline{\text{RES}}$ pin will provide a suitable external reset circuit. Any

wiring connected to the $\overline{\text{RES}}$ pin should be kept as short as possible to minimise any stray noise interference. For applications that operate within an environment where more noise is present the Enhanced Reset Circuit shown is recommended.
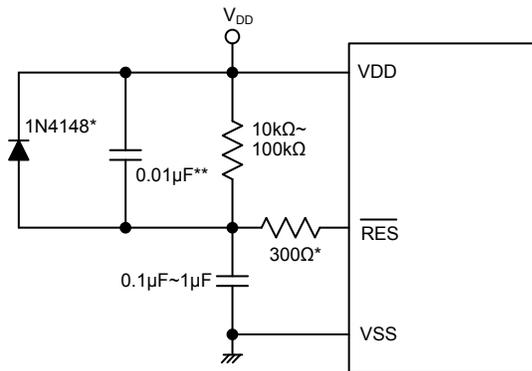
External $\overline{\text{RES}}$ Circuit

Note: * It is recommended that this component is added for added ESD protection.

  ** It is recommended that this component is added in environments where power line noise is significant.

Pulling the $\overline{\text{RES}}$ pin low using external hardware will also execute a device reset. In this case, as in the case of other resets, the Progran Counter will reset to zero and program execution initiated from this point.
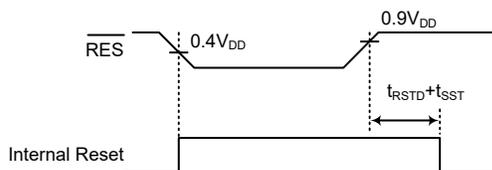
$\overline{\text{RES}}$ Reset Timing Chart

There is an internal reset control register, RSTC, which is used to provide a reset when the device operates abnormally due to the environmental noise interference. If the content of the RSTC register is set to any value other than 01010101B or 10101010B, it will reset the device after a delay time, t_{SRESET}. After power on the register will have a value of 01010101B.

RSTC7~RSTC0 Bits	Reset Function
01010101B	I/O
10101010B	$\overline{\text{RES}}$
Any other value	Reset MCU

Internal Reset Function Control

- **RSTC Register**

Bit	7	6	5	4	3	2	1	0
Name	RSTC7	RSTC6	RSTC5	RSTC4	RSTC3	RSTC2	RSTC1	RSTC0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	1	0	1	0	1	0	1

Bit 7~0   **RSTC7~RSTC0**: Reset function control
  01010101: I/O pin
  10101010: $\overline{\text{RES}}$ pin
  Other values: Reset MCU

If these bits are changed due to adverse environmental conditions, the microcontroller will be reset. The reset operation will be activated after a delay time, t_{SRESET}, and the RSTF bit in the RSTFC register will be set to 1. All resets will reset this register to POR value except the WDT time out hardware warm reset. Note that if the register is set to 10101010 to select the $\overline{RES}$ pin, this configuration has higher priority than other related pin-shared controls.

• **RSTFC Register**

Bit	7	6	5	4	3	2	1	0
Name	—	—	—	—	RSTF	LVRF	LRF	WRF
R/W	—	—	—	—	R/W	R/W	R/W	R/W
POR	—	—	—	—	0	x	0	0

"x": Unknown

Bit 7~4 Unimplemented, read as "0"

Bit 3 **RSTF**: Reset control register software reset flag
  0: Not occurred
  1: Occurred
  This bit is set to 1 by the RSTC control register software reset and cleared by the application program. Note that this bit can only be cleared to 0 by the application program.

Bit 2 **LVRF**: LVR function reset flag
  Refer to the "Low Voltage Reset" section

Bit 1 **LRF**: LVR control register software reset flag
  Refer to the "Low Voltage Reset" section

Bit 0 **WRF**: WDT control register software reset flag
  Refer to the "Watchdog Timer Control Register" section

Low Voltage Reset – LVR

The microcontroller contains a low voltage reset circuit in order to monitor the supply voltage of the device and provides an MCU reset should the value fall below a certain predefined level. The LVR function can be enabled or disabled by the LVRC control register. If the LVRC control register is configured to enable the LVR function, the LVR function will be always enabled except in the SLEEP or IDLE mode. If the supply voltage of the device drops to within a range of $0.9V{\sim}V_{LVR}$ such as might occur when changing the battery, the LVR will automatically reset the device internally and the LVRF bit in the RSTFC register will also be set high. For a valid LVR signal, a low supply voltage, i.e., a voltage in the range between $0.9V{\sim}V_{LVR}$ must exist for a time greater than that specified by t_{LVR} in the LVD/LVR Electrical Characteristics. If the low supply voltage state does not exceed this value, the LVR will ignore the low supply voltage and will not perform a reset function. The actual t_{LVR} value can be selected by the TLVR1~TLVR0 bits in the TLVRC register.

The actual V_{LVR} value can be selected by the LVS7~LVS0 bits in the LVRC register. If the LVS7~LVS0 bits are changed to some certain values by the environmental noise or software setting, the LVR will reset the device after a delay time, t_{SRESET}. When this happens, the LRF bit in the RSTFC register will be set high. After power on the register will have the value of 01100110B. Note that the LVR function will be automatically disabled when the device enters the IDLE/SLEEP mode.
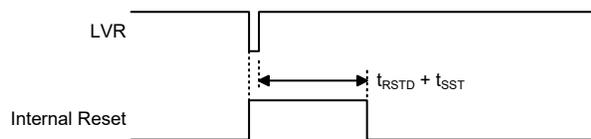
Low Voltage Reset Timing Chart

Low Voltage Reset Registers

The LVRC and TLVRC registers are used to control the Low Voltage Reset function.

Register Name	Bit							
	7	6	5	4	3	2	1	0
LVRC	LVS7	LVS6	LVS5	LVS4	LVS3	LVS2	LVS1	LVS0
TLVRC	—	—	—	—	—	—	TLVR1	TLVR0

Low Voltage Reset Register List

• **LVRC Register**

Bit	7	6	5	4	3	2	1	0
Name	LVS7	LVS6	LVS5	LVS4	LVS3	LVS2	LVS1	LVS0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	1	1	0	0	1	1	0

Bit 7~0   **LVS7~LVS0**: LVR voltage select
       01100110: 1.7V
       01010101: 1.9V
       00110011: 2.55V
       10011001: 3.15V
       10101010: 3.8V
       11110000: LVR disable
       Other values: MCU reset (register is reset to POR value)

When an actual low voltage condition occurs, as specified by one of the five defined LVR voltage values above, an MCU reset will be generated. The reset operation will be activated after the low voltage condition keeps more than a t_{LVR} time. The actual tLVR value can be selected by the TLVR1~TLVR0 bits in the TLVRC register. In this situation the register contents will remain the same after such a reset occurs.

Any register value, other than 11110000B and the five defined LVR values above, will also result in the generation of an MCU reset. The reset operation will be activated after a delay time, t_{SRESET}. However in this situation the register contents will be reset to the POR value.

• **TLVRC Register**

Bit	7	6	5	4	3	2	1	0
Name	—	—	—	—	—	—	TLVR1	TLVR0
R/W	—	—	—	—	—	—	R/W	R/W
POR	—	—	—	—	—	—	0	1

Bit 7~2   Unimplemented, read as "0"

Bit 1~0   **TLVR1~TLVR0**: Minimum low voltage width to reset time, t_{LVR}, selection
       00: (7~8)×t_{LIRC}
       01: (31~32)×t_{LIRC}
       10: (63~64)×t_{LIRC}
       11: (127~128)×t_{LIRC}

• **RSTFC Register**

Bit	7	6	5	4	3	2	1	0
Name	—	—	—	—	RSTF	LVRF	LRF	WRF
R/W	—	—	—	—	R/W	R/W	R/W	R/W
POR	—	—	—	—	0	x	0	0

"x": Unknown

Bit 7~4　　Unimplemented, read as "0"

Bit 3　　**RSTF**: Reset control register software reset flag

　　　　Refer to the "Internal Reset Control" section

Bit 2　　**LVRF**: LVR function reset flag

　　　　0: Not occur
　　　　1: Occurred

　　　　This bit is set high when a specific Low Voltage Reset situation occurs. This bit can only be cleared to zero by the application program.

Bit 1　　**LRF**: LVR control register software reset flag

　　　　0: Not occur
　　　　1: Occurred

　　　　This bit is set high if the LVRC register contains any non-defined LVR voltage register values. This in effect acts like a software-reset function. This bit can only be cleared to zero by the application program.

Bit 0　　**WRF**: WDT control register software reset flag

　　　　Refer to the "Watchdog Timer Control Register" section

In Application Programming Reset

When a specific value of "55H" is written into the FC1 register, a reset signal will be generated to reset the whole device. Refer to the IAP section for more associated details.

Watchdog Time-out Reset during Normal Operation

When a Watchdog time-out Reset occurs during normal operation, the Watchdog time-out flag TO will be set to "1".
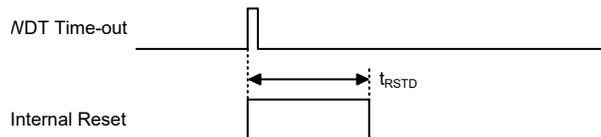
WDT Time-out Reset during Normal Operation Timing Chart

Watchdog Time-out Reset during SLEEP or IDLE Mode

The Watchdog time-out Reset during SLEEP or IDLE Mode is a little different from other kinds of reset. Most of the conditions remain unchanged except that the Program Counter and the Stack Pointer will be cleared to zero and the TO and PDF flags will be set high. Refer to the System Start Up Time Characteristics for t_{SST} details.
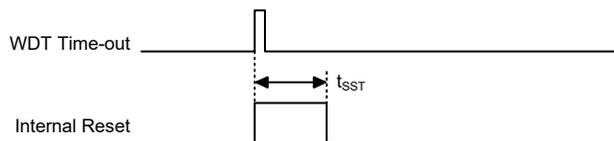
WDT Time-out Reset during SLEEP or IDLE Mode Timing Chart

Reset Initial Conditions

The different types of reset described affect the reset flags in different ways. These flags, known as PDF and TO are located in the status register and are controlled by various microcontroller operations, such as the SLEEP or IDLE Mode function or Watchdog Timer. The reset flags are shown in the table:

TO	PDF	Reset Conditions
0	0	Power-on reset
u	u	$\overline{RES}$ or LVR reset during FAST or SLOW Mode operation
1	u	WDT time-out reset during FAST or SLOW Mode operation
1	1	WDT time-out reset during IDLE or SLEEP Mode operation

"u": Unchanged

The following table indicates the way in which the various components of the microcontroller are affected after a power-on reset occurs.

Item	Condition after Reset
Program Counter	Reset to zero
Interrupts	All interrupts will be disabled
WDT, Time Bases	Clear after reset, WDT begins counting
Timer Modules	All Timer Modules will be turned off
Input/Output Ports	I/O ports will be setup as inputs
Stack Pointer	Stack Pointer will point to the top of the stack

The different kinds of resets all affect the internal registers of the microcontroller in different ways. To ensure reliable continuation of normal program execution after a reset occurs, it is important to know what condition the microcontroller is in after a particular reset occurs. The following table describes how each type of reset affects each of the microcontroller internal registers.

Register	Reset (Power On)	WDT Time-out (Normal Operation)	$\overline{RES}$ Reset (Normal Operation)	$\overline{RES}$ Reset (IDLE/SLEEP)	WDT Time-out (IDLE/SLEEP)
IAR0	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
MP0	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
IAR1	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
MP1L	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
MP1H	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
ACC	xxxx xxxx	uuuu uuuu	uuuu uuuu	uuuu uuuu	uuuu uuuu
PCL	0000 0000	0000 0000	0000 0000	0000 0000	0000 0000
TBLP	xxxx xxxx	uuuu uuuu	uuuu uuuu	uuuu uuuu	uuuu uuuu
TBLH	xxxx xxxx	uuuu uuuu	uuuu uuuu	uuuu uuuu	uuuu uuuu
TBHP	---x xxxx	---u uuuu	---u uuuu	---u uuuu	---u uuuu
STATUS	xx00 xxxx	uu1u uuuu	uuuu uuuu	uu01 uuuu	uu11 uuuu
IAR2	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
MP2L	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
MP2H	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
RSTFC	---- 0x00	---- uuuu	---- uuuu	---- uuuu	---- uuuu
INTC0	-000 0000	-000 0000	-000 0000	-000 0000	-uuu uuuu
INTC1	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
INTC2	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
INTC3	--00 --00	--00 --00	--00 --00	--00 --00	--uu --uu
PA	1111 1111	1111 1111	1111 1111	1111 1111	uuuu uuuu
PAC	1111 1111	1111 1111	1111 1111	1111 1111	uuuu uuuu
PAPU	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu

Register	Reset (Power On)	WDT Time-out (Normal Operation)	$\overline{RES}$ Reset (Normal Operation)	$\overline{RES}$ Reset (IDLE/SLEEP)	WDT Time-out (IDLE/SLEEP)
PAWU	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
PB	1111 1111	1111 1111	1111 1111	1111 1111	uuuu uuuu
PBC	1111 1111	1111 1111	1111 1111	1111 1111	uuuu uuuu
PBPU	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
NMSR	---- 0000	---- 0000	---- 0000	---- 0000	---- uuuu
PC	1111 1111	1111 1111	1111 1111	1111 1111	uuuu uuuu
PCC	1111 1111	1111 1111	1111 1111	1111 1111	uuuu uuuu
PCPU	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
PD	1111 1111	1111 1111	1111 1111	1111 1111	uuuu uuuu
PDC	1111 1111	1111 1111	1111 1111	1111 1111	uuuu uuuu
PDPU	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
PE	1111 1111	1111 1111	1111 1111	1111 1111	uuuu uuuu
PEC	1111 1111	1111 1111	1111 1111	1111 1111	uuuu uuuu
PEPU	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
PF	---- 1111	---- 1111	---- 1111	---- 1111	---- uuuu
PFC	---- 1111	---- 1111	---- 1111	---- 1111	---- uuuu
PFPU	---- 0000	---- 0000	---- 0000	---- 0000	---- uuuu
SCC	000- 0000	000- 0000	000- 0000	000- 0000	uuu- uuuu
HIRCC	---- --01	---- --01	---- --01	---- --01	---- --uu
HXTC	---- -000	---- -000	---- -000	---- -000	---- -uuu
LXTC	---- -000	---- -000	---- -000	---- -000	---- -uuu
RSTC	0101 0101	0101 0101	0101 0101	0101 0101	uuuu uuuu
VBGRC	---- ---0	---- ---0	---- ---0	---- ---0	---- ---u
INTEG	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
WDTC	0101 0011	0101 0011	0101 0011	0101 0011	uuuu uuuu
LVRC	0110 0110	0110 0110	0110 0110	0110 0110	uuuu uuuu
LVDC	--00 -000	--00 -000	--00 -000	--00 -000	--uu -uuu
MFI0	--00 --00	--00 --00	--00 --00	--00 --00	--uu --uu
MFI1	--00 --00	--00 --00	--00 --00	--00 --00	--uu --uu
MFI2	--00 --00	--00 --00	--00 --00	--00 --00	--uu --uu
EEA	-000 0000	-000 0000	-000 0000	-000 0000	-uuu uuuu
EED	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
LVPUC	---- ---0	---- ---0	---- ---0	---- ---0	---- ---u
LCDC0	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
LCDC1	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
SLEDC0	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
SLEDC1	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
SLEDC2	--00 0000	--00 0000	--00 0000	--00 0000	--uu uuuu
STMC0	0000 0---	0000 0---	0000 0---	0000 0---	uuuu u---
STMC1	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
STMDL	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
STMDH	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
STMAL	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
STMAH	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
STMRP	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
PSC0R	---- --00	---- --00	---- --00	---- --00	---- --uu
TB0C	0--- -000	0--- -000	0--- -000	0--- -000	u--- -uuu

Register	Reset (Power On)	WDT Time-out (Normal Operation)	$\overline{RES}$ Reset (Normal Operation)	$\overline{RES}$ Reset (IDLE/SLEEP)	WDT Time-out (IDLE/SLEEP)
PSC1R	- - - - - - 0 0	- - - - - - 0 0	- - - - - - 0 0	- - - - - - 0 0	- - - - - - u u
TB1C	0 - - - - 0 0 0	0 - - - - 0 0 0	0 - - - - 0 0 0	0 - - - - 0 0 0	u - - - - u u u
SADOL (ADRFS=0)	x x x x - - - -	x x x x - - - -	x x x x - - - -	x x x x - - - -	u u u u - - - -
SADOL (ADRFS=1)	x x x x x x x x	x x x x x x x x	x x x x x x x x	x x x x x x x x	u u u u u u u u
SADOH (ADRFS=0)	x x x x x x x x	x x x x x x x x	x x x x x x x x	x x x x x x x x	u u u u u u u u
SADOH (ADRFS=1)	- - - - x x x x	- - - - x x x x	- - - - x x x x	- - - - x x x x	- - - - u u u u
SADC0	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
SADC1	0000 -000	0000 -000	0000 -000	0000 -000	uuuu -uuu
SADC2	0--0 0000	0--0 0000	0--0 0000	0--0 0000	u--u uuuu
IFS0	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
IFS1	- - - - - - 0 0	- - - - - - 0 0	- - - - - - 0 0	- - - - - - 0 0	- - - - - - u u
PAS0	0 0 - - 0 0 - -	0 0 - - 0 0 - -	0 0 - - 0 0 - -	0 0 - - 0 0 - -	u u — u u - -
PAS1	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
PBS0	- - 0 0 0000	- - 0 0 0000	- - 0 0 0000	- - 0 0 0000	- - u u uuuu
PBS1	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
PCS0	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
PCS1	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
PDS0	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
PDS1	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
PES0	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
PES1	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
PFS0	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
PTMC0	0000 0 - - -	0000 0 - - -	0000 0 - - -	0000 0 - - -	uuuu u - - -
PTMC1	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
PTMDL	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
PTMDH	- - - - - - 0 0	- - - - - - 0 0	- - - - - - 0 0	- - - - - - 0 0	- - - - - - u u
PTMAL	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
PTMAH	- - - - - - 0 0	- - - - - - 0 0	- - - - - - 0 0	- - - - - - 0 0	- - - - - - u u
PTMRPL	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
PTMRPH	- - - - - - 0 0	- - - - - - 0 0	- - - - - - 0 0	- - - - - - 0 0	- - - - - - u u
CTMC0	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
CTMC1	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
CTMDL	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
CTMDH	- - - - - - 0 0	- - - - - - 0 0	- - - - - - 0 0	- - - - - - 0 0	- - - - - - u u
CTMAL	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
CTMAH	- - - - - - 0 0	- - - - - - 0 0	- - - - - - 0 0	- - - - - - 0 0	- - - - - - u u
UCR3	- - - - - - - 0	- - - - - - - 0	- - - - - - - 0	- - - - - - - 0	- - - - - - - u
USR	0000 1011	0000 1011	0000 1011	0000 1011	uuuu uuuu
UCR1	0000 00x0	0000 00x0	0000 00x0	0000 00x0	uuuu uuuu
UCR2	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
TXR_RXR	x x x x x x x x	x x x x x x x x	x x x x x x x x	x x x x x x x x	uuuu uuuu
BRG	x x x x x x x x	x x x x x x x x	x x x x x x x x	x x x x x x x x	uuuu uuuu
FC0	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
FC1	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu

Register	Reset (Power On)	WDT Time-out (Normal Operation)	$\overline{RES}$ Reset (Normal Operation)	$\overline{RES}$ Reset (IDLE/SLEEP)	WDT Time-out (IDLE/SLEEP)
FC2	- - - - - - 0 0	- - - - - - 0 0	- - - - - - 0 0	- - - - - - 0 0	- - - - - - u u
FARL	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
FARH	- - - 0 0000	- - - 0 0000	- - - 0 0000	- - - 0 0000	- - - u uuuu
FD0L	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
FD0H	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
FD1L	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
FD1H	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
FD2L	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
FD2H	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
FD3L	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
FD3H	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
EEC	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
ORMC	0000 0000	0000 0000	0000 0000	0000 0000	uuuu uuuu
TLVRC	- - - - - - 0 1	- - - - - - 0 1	- - - - - - 0 1	- - - - - - 0 1	- - - - - - u u

Note: "u" stands for unchanged

"x" stands for unknown

"-" stands for unimplemented

Input/Output Ports

Holtek microcontrollers offer considerable flexibility on their I/O ports. With the input or output designation of every pin fully under user program control, pull-high selections for all ports and wake-up selections on certain pins, the user is provided with an I/O structure to meet the needs of a wide range of application possibilities.

The device provides bidirectional input/output lines labeled with port names PA~PF. These I/O ports are mapped to the RAM Data Memory with specific addresses as shown in the Special Purpose Data Memory table. All of these I/O ports can be used for input and output operations. For input operation, these ports are non-latching, which means the inputs must be ready at the T2 rising edge of instruction "MOV A, [m]", where m denotes the port address. For output operation, all the data is latched and remains unchanged until the output latch is rewritten.

Register Name	Bit							
	7	6	5	4	3	2	1	0
PA	PA7	PA6	PA5	PA4	PA3	PA2	PA1	PA0
PAC	PAC7	PAC6	PAC5	PAC4	PAC3	PAC2	PAC1	PAC0
PAPU	PAPU7	PAPU6	PAPU5	PAPU4	PAPU3	PAPU2	PAPU1	PAPU0
PAWU	PAWU7	PAWU6	PAWU5	PAWU4	PAWU3	PAWU2	PAWU1	PAWU0
PB	PB7	PB6	PB5	PB4	PB3	PB2	PB1	PB0
PBC	PBC7	PBC6	PBC5	PBC4	PBC3	PBC2	PBC1	PBC0
PBPU	PBPU7	PBPU6	PBPU5	PBPU4	PBPU3	PBPU2	PBPU1	PBPU0
NMSR	—	—	—	—	REMS1	REMS0	REMEN	READYB
PC	PC7	PC6	PC5	PC4	PC3	PC2	PC1	PC0
PCC	PCC7	PCC6	PCC5	PCC4	PCC3	PCC2	PCC1	PCC0
PCPU	PCPU7	PCPU6	PCPU5	PCPU4	PCPU3	PCPU2	PCPU1	PCPU0
PD	PD7	PD6	PD5	PD4	PD3	PD2	PD1	PD0
PDC	PDC7	PDC6	PDC5	PDC4	PDC3	PDC2	PDC1	PDC0
PDPU	PDPU7	PDPU6	PDPU5	PDPU4	PDPU3	PDPU2	PDPU1	PDPU0
PE	PE7	PE6	PE5	PE4	PE3	PE2	PE1	PE0
PEC	PEC7	PEC6	PEC5	PEC4	PEC3	PEC2	PEC1	PEC0
PEPU	PEPU7	PEPU6	PEPU5	PEPU4	PEPU3	PEPU2	PEPU1	PEPU0
PF	—	—	—	—	PF3	PF2	PF1	PF0
PFC	—	—	—	—	PFC3	PFC2	PFC1	PFC0
PFPU	—	—	—	—	PFPU3	PFPU2	PFPU1	PFPU0
LVPUC	—	—	—	—	—	—	—	LVPU

"—": Unimplemented

Input/Output Logic Function Register List

Pull-high Resistors

Many product applications require pull-high resistors for their switch inputs usually requiring the use of an external resistor. To eliminate the need for these external resistors, all I/O pins, when configured as a digital input have the capability of being connected to an internal pull-high resistor. These pull-high resistors are selected using the LVPUC and PxPU registers, and are implemented using weak PMOS transistors. The PxPU register is used to determine whether the pull-high function is enabled or not while the LVPUC register is used to select the pull-high resistors value for low voltage power supply applications.

Note that the pull-high resistor can be controlled by the relevant pull-high control register only when the pin-shared functional pin is selected as an digital input or NMOS output. Otherwise, the pull-high resistors cannot be enabled.

• **PxPU Register**

Bit	7	6	5	4	3	2	1	0
Name	PxPU7	PxPU6	PxPU5	PxPU4	PxPU3	PxPU2	PxPU1	PxPU0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

PxPUn: I/O port x pin pull-high function control
　　　　0: Disable
　　　　1: Enable

The PxPUn bit is used to control the pin pull-high function. Here the "x" can be A, B, C, D, E or F. However, the actual available bits for each I/O port may be different.

• **LVPUC Register**

Bit	7	6	5	4	3	2	1	0
Name	—	—	—	—	—	—	—	LVPU
R/W	—	—	—	—	—	—	—	R/W
POR	—	—	—	—	—	—	—	0

Bit 7~1　　Unimplemented, read as "0"

Bit 0　　**LVPU**: Pull-high resistor selectionfor low voltage power supply
　　　　0: All pin pull-high resistors are 60kΩ @ 3V
　　　　1: All pin pull-high resistors are 15kΩ @ 3V

This bit is used to select the pull-high resistor value for low voltage power supply applications. The LVPU bit is only available when the corresponding pin pull-high function is enabled by setting the relevant pull-high control bit high. This bit will have no effect when the pull-high function is disabled.

Port A Wake-up

The HALT instruction forces the microcontroller into the SLEEP or IDLE Mode which preserves power, a feature that is important for battery and other low-power applications. Various methods exist to wake-up the microcontroller, one of which is to change the logic condition on one of the Port A pins from high to low. This function is especially suitable for applications that can be woken up via external switches. Each pin on Port A can be selected individually to have this wake-up feature using the PAWU register.

Note that the wake-up function can be controlled by the wake-up control registers only when the pin-shared functional pin is selected as general purpose input and the MCU enters the IDLE/SLEEP mode.

• **PAWU Register**

Bit	7	6	5	4	3	2	1	0
Name	PAWU7	PAWU6	PAWU5	PAWU4	PAWU3	PAWU2	PAWU1	PAWU0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~0　　**PAWU7~PAWU0**: I/O port A pin wake-up control
　　　　0: Disable
　　　　1: Enable

I/O Port Control Registers

Each I/O port has its own control register known as PAC~PFC, to control the input/output configuration. With this control register, each CMOS output, NMOS output or input with or without pull-high resistor structures can be reconfigured dynamically under software control. Each pin of the I/O ports is directly mapped to a bit in its associated port control register. For the I/O pin to function as an input, the corresponding bit of the control register must be written as a "1". This will then allow the logic state of the input pin to be directly read by instructions. When the corresponding bit of the control register is written as a "0", the I/O pin will be setup as a CMOS output or NMOS output. Note that the NMOS output function, which is only available for the REMDRV port. If the pin is currently setup as an output, instructions can still be used to read the output register. However, it should be noted that the program will in fact only read the status of the output data latch and not the actual logic status of the output pin.

• PxC Register

Bit	7	6	5	4	3	2	1	0
Name	PxC7	PxC6	PxC5	PxC4	PxC3	PxC2	PxC1	PxC0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	1	1	1	1	1	1	1	1

PxCn: I/O port x pin type selection
    0: Output
    1: Input

The PxCn bit is used to control the pin type selection. Here the "x" can be A, B, C, D, E or F. However, the actual available bits for each I/O port may be different.

PB2 High Current Output Function Control

After the PB2 pin has been set as an NMOS output (REMDRV) by properly setting the related pin-shared control bits and the REMEN bit in the NMSR register, the PB2 internal charge pump circuit can be switched on. The READYB bit in the same register can be used to check whether the NMOS output driver is ready to function.

• NMSR Register

Bit	7	6	5	4	3	2	1	0
Name	—	—	—	—	REMS1	REMS0	REMEN	READYB
R/W	—	—	—	—	R/W	R/W	R/W	R
POR	—	—	—	—	0	0	0	0

Bit 7~4   Unimplemented, read as "0"

Bit 3~2   **REMS1~REMS0**: REM current select bits
        00: 125mA
        01: 250mA
        10: 375mA
        11: 500mA

Bit 1   **REMEN**: Internal charge pumps switch on/off control
        0: Disable
        1: Enable

        This bit is used to enable the internal charge pump circuit and is only available when the PB2 pin is configured as an NMOS type output function (REMDRV) by properly setting the related pin-shared control bits. When a HALT instruction is executed, the charge pump circuit will be turned off automatically until the MCU is woken up.

Bit 0   **READYB**: PB2 pin high current output function ready flag
        0: Ready
        1: Not ready

This bit is used to indicate that whether the NMOS output driver is ready to deliver the data signal or not. This bit is only available when the REMEN bit has been set high. When the high current output function is enabled, including a wake-up from the IDLE/SLEEP mode with the REMEN bit being set high, a certain period delay is necessary for the NMOS output driver to become stable before the data signal is sent to the PB output pins. Ensure that the NMOS output driver is ready by polling the READYB bit before delivering the data signal.

When the REMEN bit changes from "0" to "1", the READYB bit will first be set to "1", after a certain period delay, known as t_{READYB}, it will be cleared to "0" indiating that the high current output function is ready to deliver data signals. More details regarding the relationship between the relevant register settings and the internal charge pump control will be described in the I/O Pin Structure section.
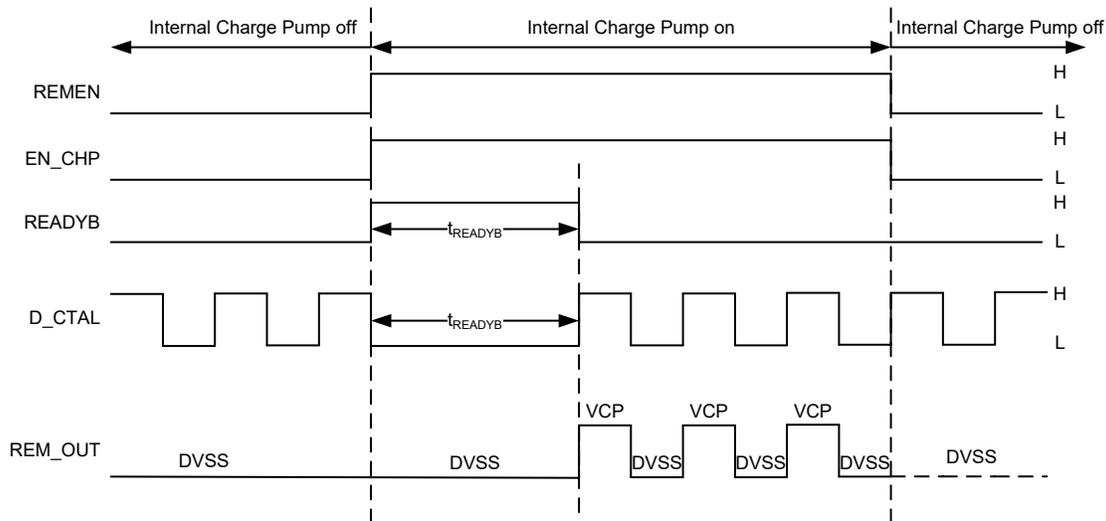
When in the NMOS output mode and the charge pump has been activated, if a HALT instruction is executed, the charge pump circuit will be turned off automatically with the REMEN bit remaining high. After the MCU is woken up, the charge pump will be re-enabled automatically without requiring REMEN bit re-configuration. However, a period delay t_{READYB} is still required before the NMOS output driver returns stable.
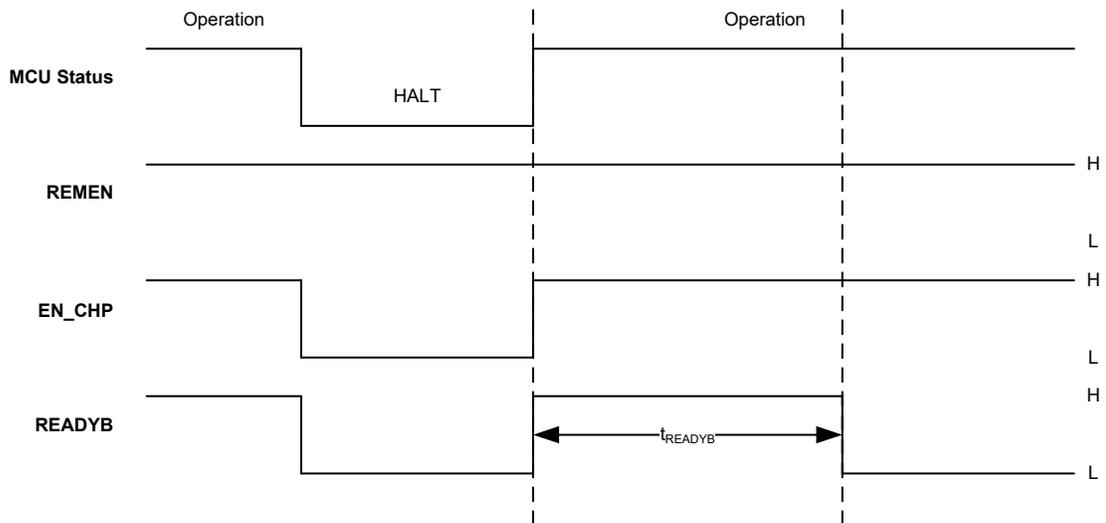
I/O Port Source Current Control

The device supports different source current driving capability for each I/O port. With the corresponding selection registers, SLEDC0, SLEDC1 and SLEDC2, each I/O port can support four levels of the source current driving capability. Users should refer to the Input/Output Characteristics section to select the desired source current for different applications.

Register Name	Bit							
	7	6	5	4	3	2	1	0
SLEDC0	SLEDC07	SLEDC06	SLEDC05	SLEDC04	SLEDC03	SLEDC02	SLEDC01	SLEDC00
SLEDC1	SLEDC17	SLEDC16	SLEDC15	SLEDC14	SLEDC13	SLEDC12	SLEDC11	SLEDC10
SLEDC2	—	—	SLEDC25	SLEDC24	SLEDC23	SLEDC22	SLEDC21	SLEDC20

I/O Port Source Current Control Register List

• SLEDC0 Register

Bit	7	6	5	4	3	2	1	0
Name	SLEDC07	SLEDC06	SLEDC05	SLEDC04	SLEDC03	SLEDC02	SLEDC01	SLEDC00
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~6   **SLEDC07~SLEDC06**: PB7~PB4 source current selection
        00: Source current = Level 0 (min.)
        01: Source current = Level 1
        10: Source current = Level 2
        11: Source current = Level 3 (max.)

Bit 5~4   **SLEDC05~SLEDC04**: PB3~PB0 source current selection
        00: Source current = Level 0 (min.)
        01: Source current = Level 1
        10: Source current = Level 2
        11: Source current = Level 3 (max.)

Bit 3~2   **SLEDC03~SLEDC02**: PA7~PA4 source current selection
        00: Source current = Level 0 (min.)
        01: Source current = Level 1
        10: Source current = Level 2
        11: Source current = Level 3 (max.)

Bit 1~0   **SLEDC01~SLEDC00**: PA3~PA0 source current selection
        00: Source current = Level 0 (min.)
        01: Source current = Level 1
        10: Source current = Level 2
        11: Source current = Level 3 (max.)

• SLEDC1 Register

Bit	7	6	5	4	3	2	1	0
Name	SLEDC17	SLEDC16	SLEDC15	SLEDC14	SLEDC13	SLEDC12	SLEDC11	SLEDC10
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~6   **SLEDC17~SLEDC16**: PD7~PD4 source current selection
        00: Source current = Level 0 (min.)
        01: Source current = Level 1
        10: Source current = Level 2
        11: Source current = Level 3 (max.)

Bit 5~4   **SLEDC15~SLEDC14**: PD3~PD0 source current selection
                00: Source current = Level 0 (min.)
                01: Source current = Level 1
                10: Source current = Level 2
                11: Source current = Level 3 (max.)

Bit 3~2   **SLEDC13~SLEDC12**: PC7~PC4 source current selection
                00: Source current = Level 0 (min.)
                01: Source current = Level 1
                10: Source current = Level 2
                11: Source current = Level 3 (max.)

Bit 1~0   **SLEDC11~SLEDC10**: PC3~PC0 source current selection
                00: Source current = Level 0 (min.)
                01: Source current = Level 1
                10: Source current = Level 2
                11: Source current = Level 3 (max.)

• **SLEDC2 Register**

Bit	7	6	5	4	3	2	1	0
Name	—	—	SLEDC25	SLEDC24	SLEDC23	SLEDC22	SLEDC21	SLEDC20
R/W	—	—	R/W	R/W	R/W	R/W	R/W	R/W
POR	—	—	0	0	0	0	0	0

Bit 7~6   Unimplemented, read as "0"

Bit 5~4   **SLEDC25~SLEDC24**: PF3~PF0 source current selection
                00: Source current = Level 0 (min.)
                01: Source current = Level 1
                10: Source current = Level 2
                11: Source current = Level 3 (max.)

Bit 3~2   **SLEDC23~SLEDC22**: PE7~PE4 source current selection
                00: Source current = Level 0 (min.)
                01: Source current = Level 1
                10: Source current = Level 2
                11: Source current = Level 3 (max.)

Bit 1~0   **SLEDC21~SLEDC20**: PE3~PE0 source current selection
                00: Source current = Level 0 (min.)
                01: Source current = Level 1
                10: Source current = Level 2
                11: Source current = Level 3 (max.)

Pin-shared Functions

The flexibility of the microcontroller range is greatly enhanced by the use of pins that have more than one function. Limited numbers of pins can force serious design constraints on designers but by supplying pins with multi-functions, many of these difficulties can be overcome. For these pins, the desired function of the multi-function I/O pins is selected by a series of registers via the application program control.

Pin-shared Function Selection Registers

The limited number of supplied pins in a package can impose restrictions on the amount of functions a certain device can contain. However by allowing the same pins to share several different functions and providing a means of function selection, a wide range of different functions can be incorporated into even relatively small package sizes. The device includes Port "x" output function Selection register "n", labeled as PxSn and Input Function Selection register, labeled as IFSi, which can select the desired functions of the multi-function pin-shared pins.

The most important point to note is to make sure that the desired pin-shared function is properly selected and also deselected. For most pin-shared functions, to select the desired pin-shared function, the pin-shared function should first be correctly selected using the corresponding pin-shared control register. After that the corresponding peripheral functional setting should be configured and then the peripheral function can be enabled. However, special point must be noted for some digital input pins, such as INTn, xTCK, xTPI etc, which share the same pin-shared control configuration with their corresponding general purpose I/O functions when setting the relevant functions, in addition to the necessary pin-shared control and peripheral functional setup aforementioned, they must also be setup as input by setting the corresponding bit in the I/O port control register. To correctly deselect the pin-shared function, the peripheral function should first be disabled and then the corresponding pin-shared function control register can be modified to select other pin-shared functions.

Register Name	Bit							
	7	6	5	4	3	2	1	0
PAS0	PAS07	PAS06	—	—	PAS03	PAS02	—	—
PAS1	PAS17	PAS16	PAS15	PAS14	PAS13	PAS12	PAS11	PAS10
PBS0	PBS07	PBS06	PBS05	PBS04	PBS03	PBS02	PBS01	PBS00
PBS1	PBS17	PBS16	PBS15	PBS14	PBS13	PBS12	PBS11	PBS10
PCS0	PCS07	PCS06	PCS05	PCS04	PCS03	PCS02	PCS01	PCS00
PCS1	PCS17	PCS16	PCS15	PCS14	PCS13	PCS12	PCS11	PCS10
PDS0	PDS07	PDS06	PDS05	PDS04	PDS03	PDS02	PDS01	PDS00
PDS1	PDS17	PDS16	PDS15	PDS14	PDS13	PDS12	PDS11	PDS10
PES0	PES07	PES06	PES05	PES04	PES03	PES02	PES01	PES00
PES1	PES17	PES16	PES15	PES14	PES13	PES12	PES11	PES10
PFS0	PFS07	PFS06	PFS05	PFS04	PFS03	PFS02	PFS01	PFS00
IFS0	RXPS	INT3PS	INT2PS	INT1PS	INT0PS	CTCKPS	PTCKPS	STCKPS
IFS1	—	—	—	—	—	—	PTPIPS	STPIPS

Pin-shared Function Selection Register List

• **PAS0 Register**

Bit	7	6	5	4	3	2	1	0
Name	PAS07	PAS06	—	—	PAS03	PAS02	—	—
R/W	R/W	R/W	—	—	R/W	R/W	—	—
POR	0	0	—	—	0	0	—	—

Bit 7~6 **PAS07~PAS06**: PA3 pin-shared function selection
   00: PA3/INT1/PTCK
   01: PA3/INT1/PTCK
   10: PA3/INT1/PTCK
   11: SEG5

Bit 5~4 Unimplemented, read as "0"

Bit 3~2 **PAS03~PAS02**: PA1 pin-shared function selection
   00: PA1/INT0/CTCK
   01: PA1/INT0/CTCK
   10: PA1/INT0/CTCK
   11: SEG4

Bit 1~0 Unimplemented, read as "0"

• **PAS1 Register**

Bit	7	6	5	4	3	2	1	0
Name	PAS17	PAS16	PAS15	PAS14	PAS13	PAS12	PAS11	PAS10
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~6 **PAS17~PAS16**: PA7 pin-shared function selection
00: PA7
01: PA7
10: RX/TX
11: SEG9

Bit 5~4 **PAS15~PAS14**: PA6 pin-shared function selection
00: PA6
01: PA6
10: PTP
11: SEG8

Bit 3~2 **PAS13~PAS12**: PA5 pin-shared function selection
00: PA5/INT3
01: PA5/INT3
10: PTPB
11: SEG7

Bit 1~0 **PAS11~PAS10**: PA4 pin-shared function selection
00: PA4/INT2/PTPI
01: PA4/INT2/PTPI
10: PA4/INT2/PTPI
11: SEG6

• **PBS0 Register**

Bit	7	6	5	4	3	2	1	0
Name	—	—	PBS05	PBS04	PBS03	PBS02	PBS01	PBS00
R/W	—	—	R/W	R/W	R/W	R/W	R/W	R/W
POR	—	—	0	0	0	0	0	0

Bit 7~6 Unimplemented, read as "0"

Bit 5~4 **PBS05~PBS04**: PB2 pin-shared function selection
00: PB2
01: PB2
10: PTP
11: REMDRV

Bit 3~2 **PBS03~PBS02**: PB1 pin-shared function selection
00: PB1
01: PB1
10: PB1
11: XT1

Bit 1~0 **PBS01~PBS00**: PB0 pin-shared function selection
00: PB0
01: PB0
10: PB0
11: XT2

• **PBS1 Register**

Bit	7	6	5	4	3	2	1	0
Name	PBS17	PBS16	PBS15	PBS14	PBS13	PBS12	PBS11	PBS10
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~6   **PBS17~PBS16**: PB7 pin-shared function selection
       00: PB7
       01: PB7
       10: PB7
       11: STP

Bit 5~4   **PBS15~PBS14**: PB6 pin-shared function selection
       00: PB6
       01: PB6
       10: PB6
       11: C2

Bit 3~2   **PBS13~PBS12**: PB5 pin-shared function selection
       00: PB5
       01: PB5
       10: PB5
       11: C1

Bit 1~0   **PBS11~PBS10**: PB4 pin-shared function selection
       00: PB4
       01: PB4
       10: PB4
       11: V2

• **PCS0 Register**

Bit	7	6	5	4	3	2	1	0
Name	PCS07	PCS06	PCS05	PCS04	PCS03	PCS02	PCS01	PCS00
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~6   **PCS07~PCS06**: PC3 pin-shared function selection
       00: PC3/INT3/STCK
       01: PC3/INT3/STCK
       10: PC3/INT3/STCK
       11: SEG3

Bit 5~4   **PCS05~PCS04**: PC2 pin-shared function selection
       00: PC2/INT2/STPI
       01: PC2/INT2/STPI
       10: PC2/INT2/STPI
       11: SEG2

Bit 3~2   **PCS03~PCS02**: PC1 pin-shared function selection
       00: PC1/INT1
       01: PC1/INT1
       10: OSC2
       11: SEG1

Bit 1~0   **PCS01~PCS00**: PC0 pin-shared function selection
       00: PC0/INT0
       01: PC0/INT0
       10: OSC1
       11: SEG0

• **PCS1 Register**

Bit	7	6	5	4	3	2	1	0
Name	PCS17	PCS16	PCS15	PCS14	PCS13	PCS12	PCS11	PCS10
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~6   **PCS17~PCS16**: PC7 pin-shared function selection
         00: PC7/STCK
         01: PC7/STCK
         10: PC7/STCK
         11: SEG13

Bit 5~4   **PCS15~PCS14**: PC6 pin-shared function selection
         00: PC6/STPI
         01: PC6/STPI
         10: STP
         11: SEG12

Bit 3~2   **PCS13~PCS12**: PC5 pin-shared function selection
         00: PC5
         01: PC5
         10: PTPB
         11: SEG11

Bit 1~0   **PCS11~PCS10**: PC4 pin-shared function selection
         00: PC4
         01: PC4
         10: TX
         11: SEG10

• **PDS0 Register**

Bit	7	6	5	4	3	2	1	0
Name	PDS07	PDS06	PDS05	PDS04	PDS03	PDS02	PDS01	PDS00
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~6   **PDS07~PDS06**: PD3 pin-shared function selection
         00: PD3/PTCK
         01: PD3/PTCK
         10: AN5
         11: SEG17

Bit 5~4   **PDS05~PDS04**: PD2 pin-shared function selection
         00: PD2/PTPI
         01: PD2/PTPI
         10: AN6
         11: SEG16

Bit 3~2   **PDS03~PDS02**: PD1 pin-shared function selection
         00: PD1
         01: CTP
         10: AN7
         11: SEG15

Bit 1~0   **PDS01~PDS00**: PD0 pin-shared function selection
         00: PD0/CTCK
         01: PD0/CTCK
         10: PD0/CTCK
         11: SEG14

• **PDS1 Register**

Bit	7	6	5	4	3	2	1	0
Name	PDS17	PDS16	PDS15	PDS14	PDS13	PDS12	PDS11	PDS10
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~6   **PDS17~PDS16**: PD7 pin-shared function selection
         00: PD7
         01: PD7
         10: AN1
         11: SEG21

Bit 5~4   **PDS15~PDS14**: PD6 pin-shared function selection
         00: PD6
         01: PD6
         10: AN2
         11: SEG20

Bit 3~2   **PDS13~PDS12**: PD5 pin-shared function selection
         00: PD5
         01: PD5
         10: AN3
         11: SEG19

Bit 1~0   **PDS11~PDS10**: PD4 pin-shared function selection
         00: PD4
         01: CTP
         10: AN4
         11: SEG18

• **PES0 Register**

Bit	7	6	5	4	3	2	1	0
Name	PES07	PES06	PES05	PES04	PES03	PES02	PES01	PES00
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~6   **PES07~PES06**: PE3 pin-shared function selection
         00: PE3
         01: PE3
         10: RX/TX
         11: SEG25

Bit 5~4   **PES05~PES04**: PE2 pin-shared function selection
         00: PE2
         01: PE2
         10: TX
         11: SEG24

Bit 3~2   **PES03~PES02**: PE1 pin-shared function selection
         00: PE1
         01: PE1
         10: VREF
         11: SEG23

Bit 1~0   **PES01~PES00**: PE0 pin-shared function selection
         00: PE0
         01: VREFI
         10: AN0
         11: SEG22

• **PES1 Register**

Bit	7	6	5	4	3	2	1	0
Name	PES17	PES16	PES15	PES14	PES13	PES12	PES11	PES10
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~6   **PES17~PES16**: PE7 pin-shared function selection
    00: PE7
    01: PE7
    10: COM4
    11: SEG29

Bit 5~4   **PES15~PES14**: PE6 pin-shared function selection
    00: PE6
    01: PE6
    10: COM5
    11: SEG28

Bit 3~2   **PES13~PES12**: PE5 pin-shared function selection
    00: PE5
    01: PE5
    10: PE5
    11: SEG27

Bit 1~0   **PES11~PES10**: PE4 pin-shared function selection
    00: PE4
    01: PE4
    10: PE4
    11: SEG26

• **PFS0 Register**

Bit	7	6	5	4	3	2	1	0
Name	PFS07	PFS06	PFS05	PFS04	PFS03	PFS02	PFS01	PFS00
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~6   **PFS07~PFS06**: PF3 pin-shared function selection
    00: PF3
    01: PF3
    10: PF3
    11: COM3

Bit 5~4   **PFS05~PFS04**: PF2 pin-shared function selection
    00: PF2
    01: PF2
    10: PF2
    11: COM2

Bit 3~2   **PFS03~PFS02**: PF1 pin-shared function selection
    00: PF1
    01: PF1
    10: PF1
    11: COM1

Bit 1~0   **PFS01~PFS00**: PF0 pin-shared function selection
    00: PF0
    01: PF0
    10: PF0
    11: COM0

• **IFS0 Register**

Bit	7	6	5	4	3	2	1	0
Name	RXPS	INT3PS	INT2PS	INT1PS	INT0PS	CTCKPS	PTCKPS	STCKPS
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7   **RXPS**: RX/TX input source pin selection
                0: PA7
                1: PE3

Bit 6   **INT3PS**: INT3 input source pin selection
                0: PA5
                1: PC3

Bit 5   **INT2PS**: INT2 input source pin selection
                0: PA4
                1: PC2

Bit 4   **INT1PS**: INT1 input source pin selection
                0: PA3
                1: PC1

Bit 3   **INT0PS**: INT0 input source pin selection
                0: PA1
                1: PC0

Bit 2   **CTCKPS**: CTCK input source pin selection
                0: PD0
                1: PA1

Bit 1   **PTCKPS**: PTCK input source pin selection
                0: PD3
                1: PA3

Bit 0   **STCKPS**: STCK input source pin selection
                0: PC7
                1: PC3

• **IFS1 Register**

Bit	7	6	5	4	3	2	1	0
Name	—	—	—	—	—	—	PTPIPS	STPIPS
R/W	—	—	—	—	—	—	R/W	R/W
POR	—	—	—	—	—	—	0	0

Bit 7~2   Unimplemented, read as "0"

Bit 1   **PTPIPS**: PTPI input source pin selection
                0: PD2
                1: PA4

Bit 0   **STPIPS**: STPI input source pin selection
                0: PC6
                1: PC2

I/O Pin Structures

The accompanying diagram illustrates the internal structures of the I/O logic function. As the exact logical construction of the I/O pin will differ from this diagram, it is supplied as a guide only to assist with the functional understanding of the logic function I/O pins. The wide range of pin-shared structures does not permit all types to be shown.
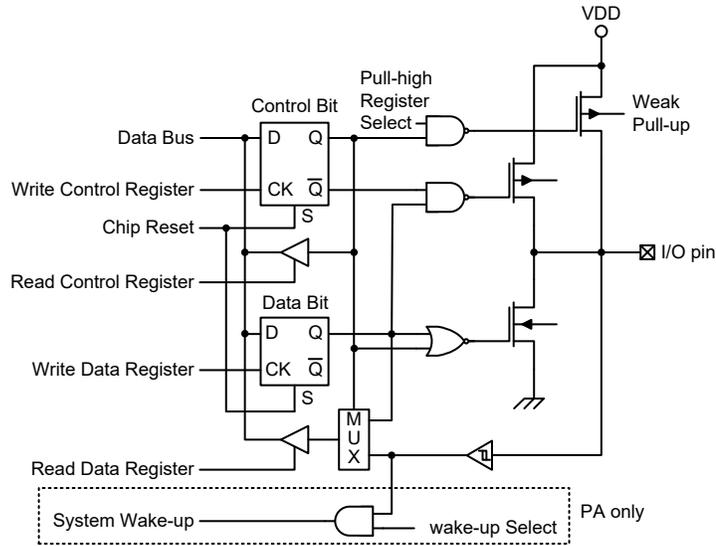
Logic Function Input/Output Structure – expect PB2 Port
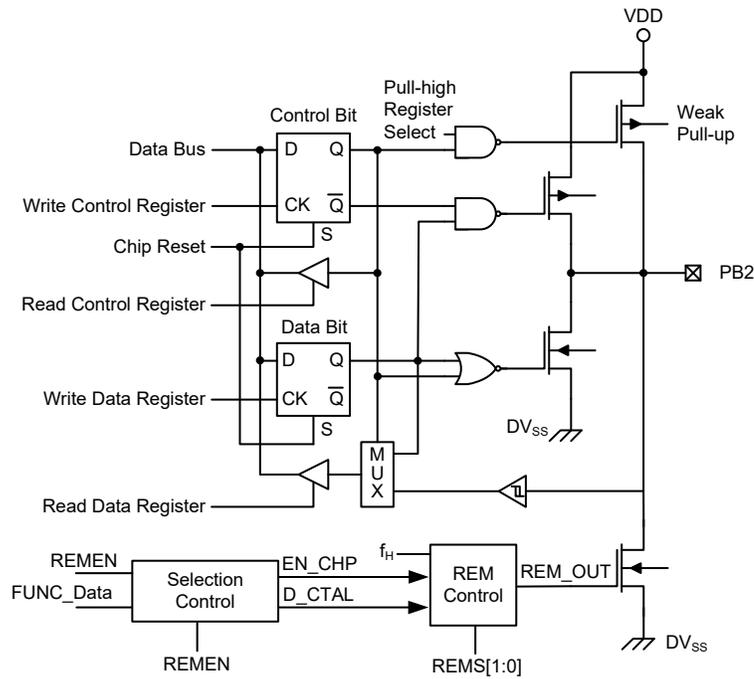
Logic Function Input/Output Structure – PB2 Port

Mode	Register Setting	Selection Control Ouptut		REM Control		
PBS0[5:4]	REMEN	D_CTAL	EN_CHP	Charge Pump	REM_OUT	REM_OUT Voltage Level
PB2	x	0	0	Off	0	DV$_{SS}$
REMDRV	0	FUNC_Data	0	Off	0	DV$_{SS}$
	1	FUNC_Data	1	On	FUNC_Data	V$_{CP}$/DV$_{SS}$
PTP	x	0	0	Off	0	DV$_{SS}$

"x": Don't care

Note: 1. V$_{CP}$ is the charge pump voltage.

2. FUNC_Data, which is the source of control signal D_CTAL, comes from PTP.

3. DV$_{SS}$ is not bounded to the external package but internally connected to V$_{SS}$.

Programming Considerations

Within the user program, one of the things first to consider is port initialisation. After a reset, all of the I/O data and port control registers will be set to high. This means that all I/O pins will be defaulted to an input state, the level of which depends on the other connected circuitry and whether pull-high selections have been chosen. If the port control registers are then programmed to setup some pins as outputs, these output pins will have an initial high output value unless the associated port data registers are first programmed. Selecting which pins are inputs and which are outputs can be achieved byte-wide by loading the correct values into the appropriate port control register or by programming individual bits in the port control register using the "SET [m].i" and "CLR [m].i" instructions. Note that when using these bit control instructions, a read-modify-write operation takes place. The microcontroller must first read in the data on the entire port, modify it to the required new bit values and then rewrite this data back to the output ports.

Port A has the additional capability of providing wake-up functions. When the device is in the SLEEP or IDLE Mode, various methods are available to wake the device up. One of these is a high to low transition of any of the Port A pins. Single or multiple pins on Port A can be setup to have this function.

Timer Modules – TM

One of the most fundamental functions in any microcontroller devices is the ability to control and measure time. To implement time related functions the device includes several Timer Modules, generally abbreviated to the name TM. The TMs are multi-purpose timing units and serve to provide operations such as Timer/Counter, Input Capture, Compare Match Output and Single Pulse Output as well as being the functional unit for the generation of PWM signals. Each of the TMs has two interrupts. The addition of input and output pins for TM ensures that users are provided with timing units with a wide and flexible range of features.

The common features of the different TM types are described here with more detailed information provided in the individual Compact, Standard and Periodic TM sections.

Introduction

The device contains several TM units and each individual TM can be categorised as a certain type, namely Compact Type TM, Standard Type TM or Periodic Type TM. Although similar in nature, the different TM types vary in their feature complexity. The common features to all of the Standard and Periodic Type TMs will be described in this section and the detailed operation regarding each of the TM types will be described in separate sections. The main features and differences between the three types of TMs are summarised in the accompanying table.

TM Function	CTM	STM	PTM
Timer/Counter	√	√	√
Input Capture	—	√	√
Compare Match Output	√	√	√
PWM Output	1	√	√
Single Pulse Output	—	√	√
PWM Alignment	Edge	Edge	Edge
PWM Adjustment Period & Duty	Duty or Period	Duty or Period	Duty or Period

TM Function Summary

TM Operation

The TMs offer a diverse range of functions, from simple timing operations to PWM signal generation. The key to understanding how the TM operates is to see it in terms of a free running counter whose value is then compared with the value of pre-programmed internal comparator. When the free running counter has the same value as the pre-programmed comparator, known as a compare match situation, a TM interrupt signal will be generated which can clear the counter and perhaps also change the condition of the TM output pin. The internal TM counter is driven by a user selectable clock source, which can be an internal clock or an external pin.

TM Clock Source

The clock source which drives the main counter in the each TM can originate from various sources. The selection of the required clock source is implemented using the xTCK2~xTCK0 bits in the xTM control registers, where "x" stands for C, S or P type TM and "n" stands for the specific TM serial number. The clock source can be a ratio of the system clock f_{SYS} or the internal high clock f_H, the f_{SUB} clock source or the external xTCK pin. The xTCK pin clock source is used to allow an external signal to drive the TM as an external clock source or for event counting.

TM Interrupts

The Compact, Standard or Periodic type TM has two internal interrupts, the internal comparator A or comparator P, which generate a TM interrupt when a compare match condition occurs. When a TM interrupt is generated, it can be used to clear the counter and also to change the state of the TM output pin.

TM External Pins

Each of the TMs, irrespective of what type, has one or two TM input pins, with the label xTCK and xTPI respectively. The xTM input pin, xTCK, is essentially a clock source for the xTM and is selected using the xTCK2~xTCK0 bits in the xTMC0 register. This external TM input pin allows an external clock source to drive the internal TM. The xTCK input pin can be chosen to have either a rising or falling active edge. The STCK and PTCK pins are also used as the external trigger input pin in single pulse output mode for the STM and PTM respectively.

For STM and PTM, another input pin, STPI or PTPI, is the capture input whose active edge can be a rising edge, a falling edge or both rising and falling edges and the active edge transition type is selected using the STIO1~STIO0 or PTIO1~PTIO0 bits in the STMC1 or PTMC1 register respectively. There is another capture input, PTCK, for PTM capture input mode, which can be used as the external trigger input source except the PTPI pin.

The TMs each have one or two output pins, xTP and xTPB. The PTPB is the inverted signal of the PTP output. When the TM is in the Compare Match Output Mode, these pins can be controlled by the TM to switch to a high or low level or to toggle when a compare match situation occurs. The output pins are also the pins where the TM generates the PWM output waveform.

As the TM input/output pins are pin-shared with other functions, the TM input/output function must first be setup using relevant pin-shared function selection registers. The details of the pin-shared function selection are described in the pin-shared function section.

CTM		STM		PTM	
Input	**Output**	**Input**	**Output**	**Input**	**Output**
CTCK	CTP	STCK, STPI	STP	PTCK, PTPI	PTP, PTPB

TM External Pins
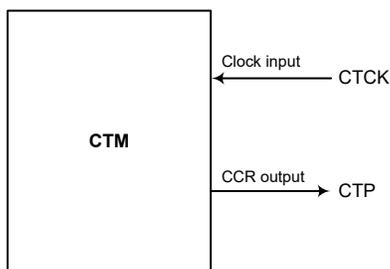
CTM Function Pin Block Diagram
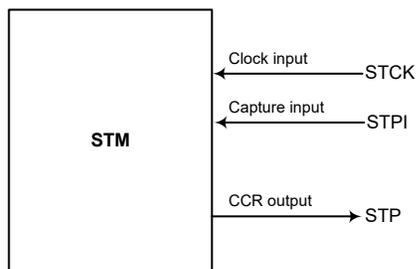
STM Function Pin Block Diagram
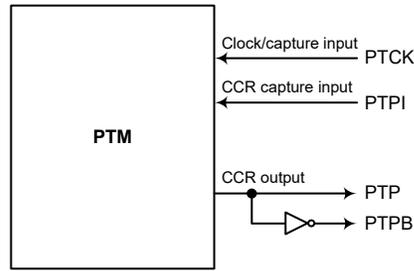
PTM Function Pin Block Diagram

Programming Considerations

The TM Counter Registers and the Capture/Compare CCRA and CCRP register, all have a low and high byte structure. The high bytes can be directly accessed, but as the low bytes can only be accessed via an internal 8-bit buffer, reading or writing to these register pairs must be carried out in a specific way. The important point to note is that data transfer to and from the 8-bit buffer and its related low byte only takes place when a write or read operation to its corresponding high byte is executed.

As the CCRA and CCRP registers are implemented in the way shown in the following diagram and accessing these register pairs is carried out in a specific way as described above, it is recommended to use the "MOV" instruction to access the CCRA and CCRP low byte registers, named xTMAL and PTMRPL, using the following access procedures. Accessing the CCRA or CCRP low byte registers without following these access procedures will result in unpredictable values.
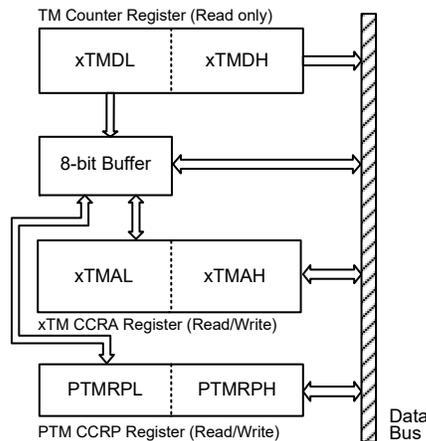
The following steps show the read and write procedures:

- Writing Data to CCRA or CCRP
  - Step 1. Write data to low byte xTMAL or PTMRPL
    - Note that here data is only written to the 8-bit buffer.
  - Step 2. Write data to high byte xTMAH or PTMRPH
    - Here data is written directly to the high byte registers and simultaneously data is latched from the 8-bit buffer to the low byte registers.
- Reading Data from the Counter Registers and CCRA or CCRP
  - Step 1. Read data from the high byte xTMDH, xTMAH or PTMRPH
    - Here data is read directly from the high byte registers and simultaneously data is latched from the Low Byte register into the 8-bit buffer.
  - Step 2. Read data from the low byte xTMDL, xTMAL or PTMRPL
    - This step reads data from the 8-bit buffer.

Compact Type TM – CTM

Although the simplest form of the three TM types, the Compact type TM still contains three operating modes, which are Compare Match Output, Timer/Event Counter and PWM Output modes. The Compact type TM can also be controlled with an external input pin and can drive one external output pins.
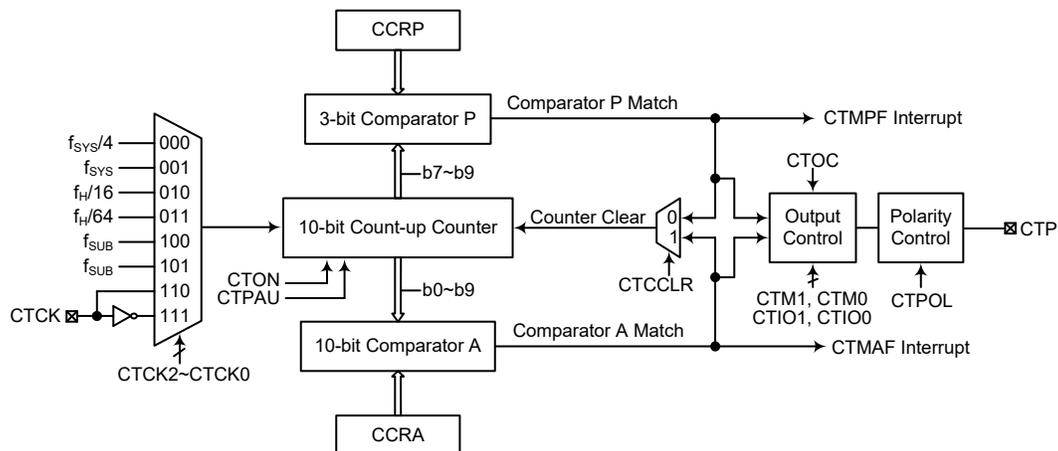
Note: The CTM external pins are pin-shared with other functions, so before using the CTM function, ensure that the pin-shared function registers have been set properly to enable the CTM pin function.

10-bit Compact Type TM Block Diagram

Compact Type TM Operation

Its core is a 10-bit count-up counter which is driven by a user selectable internal or external clock source. There are also two internal comparators with the names, Comparator A and Comparator P. These comparators will compare the value in the counter with CCRP and CCRA registers. The CCRP is three bits wide whose value is compared with the highest three bits in the counter while the CCRA is the ten bits and therefore compares with all counter bits.

The only way of changing the value of the 10-bit counter using the application program, is to clear the counter by changing the CTON bit from low to high. The counter will also be cleared automatically by a counter overflow or a compare match with one of its associated comparators. When these conditions occur, a CTM interrupt signal will also usually be generated. The Compact Type TM can operate in a number of different operational modes, can be driven by different clock sources including an input pin. All operating setup conditions are selected using relevant internal registers.

Compact Type TM Register Description

Overall operation of the Compact type TM is controlled using several registers. A read only register pair exists to store the internal counter 10-bit value, while a read/write register pair exists to store the internal 10-bit CCRA value. The remaining two registers are control registers which setup the different operating and control modes as well as the three CCRP bits.

Register Name	Bit							
	7	6	5	4	3	2	1	0
CTMC0	CTPAU	CTCK2	CTCK1	CTCK0	CTON	CTRP2	CTRP1	CTRP0
CTMC1	CTM1	CTM0	CTIO1	CTIO0	CTOC	CTPOL	CTDPX	CTCCLR
CTMDL	D7	D6	D5	D4	D3	D2	D1	D0
CTMDH	—	—	—	—	—	—	D9	D8
CTMAL	D7	D6	D5	D4	D3	D2	D1	D0
CTMAH	—	—	—	—	—	—	D9	D8

10-bit Compact Type TM Register List

• **CTMC0 Register**

Bit	7	6	5	4	3	2	1	0
Name	CTPAU	CTCK2	CTCK1	CTCK0	CTON	CTRP2	CTRP1	CTRP0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7 **CTPAU**: CTM Counter Pause Control

0: Run
1: Pause

The counter can be paused by setting this bit high. Clearing the bit to zero restores normal counter operation. When in a Pause condition the CTM will remain powered up and continue to consume power. The counter will retain its residual value when this bit changes from low to high and resume counting from this value when the bit changes to a low value again.

Bit 6~4 **CTCK2~CTCK0**: Select CTM Counter clock

000: $f_{SYS}/4$
001: f_{SYS}
010: $f_H/16$
011: $f_H/64$
100: f_{SUB}
101: f_{SUB}
110: CTCK rising edge clock
111: CTCK falling edge clock

These three bits are used to select the clock source for the CTM. The external pin clock source can be chosen to be active on the rising or falling edge. The clock source f_{SYS} is the system clock, while f_H and f_{SUB} are other internal clocks, the details of which can be found in the "Operating Modes and System Clocks" section.

Bit 3 **CTON**: CTM Counter On/Off Control

0: Off
1: On

This bit controls the overall on/off function of the CTM. Setting the bit high enables the counter to run, clearing the bit to 0 disables the CTM. Clearing this bit to zero will stop the counter from counting and turn off the CTM which will reduce its power consumption. When the bit changes state from low to high the internal counter value will be reset to zero, however when the bit changes from high to low, the internal counter will retain its residual value until the bit returns high again.

If the CTM is in the Compare Match Output Mode or the PWM Output Mode then the CTM output pin will be reset to its initial condition, as specified by the CTOC bit, when the CTON bit changes from low to high.

Bit 2~0   **CTRP2~CTRP0**: CTM CCRP 3-bit register, compared with the CTM Counter bit 9 ~ bit 7

Comparator P Match Period
  000: 1024 CTM clocks
  001: 128 CTM clocks
  010: 256 CTM clocks
  011: 384 CTM clocks
  100: 512 CTM clocks
  101: 640 CTM clocks
  110: 768 CTM clocks
  111: 896 CTM clocks

These three bits are used to setup the value on the internal CCRP 3-bit register, which are then compared with the internal counter's highest three bits. The result of this comparison can be selected to clear the internal counter if the CTCCLR bit is set to zero. Setting the CTCCLR bit to zero ensures that a compare match with the CCRP values will reset the internal counter. As the CCRP bits are only compared with the highest three counter bits, the compare values exist in 128 clock cycle multiples. Clearing all three bits to zero is in effect allowing the counter to overflow at its maximum value.

- **CTMC1 Register**

Bit	7	6	5	4	3	2	1	0
Name	CTM1	CTM0	CTIO1	CTIO0	CTOC	CTPOL	CTDPX	CTCCLR
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~6   **CTM1~CTM0**: Select CTM Operating Mode
  00: Compare Match Output Mode
  01: Undefined
  10: PWM Output Mode
  11: Timer/Counter Mode

These bits setup the required operating mode for the CTM. To ensure reliable operation the CTM should be switched off before any changes are made to the CTM1 and CTM0 bits. In the Timer/Counter Mode, the CTM output pin state is undefined.

Bit 5~4   **CTIO1~CTIO0**: Select CTM external pin CTP output function
Compare Match Output Mode
  00: No change
  01: Output low
  10: Output high
  11: Toggle output
PWM Output Mode
  00: PWM Output inactive state
  01: PWM Output active state
  10: PWM output
  11: Undefined
Timer/Counter Mode
  Unused

These two bits are used to determine how the CTM output pin changes state when a certain condition is reached. The function that these bits select depends upon in which mode the CTM is running.

In the Compare Match Output Mode, the CTIO1 and CTIO0 bits determine how the CTM output pin changes state when a compare match occurs from the Comparator A.

The CTM output pin can be setup to switch high, switch low or to toggle its present state when a compare match occurs from the Comparator A. When the bits are both zero, then no change will take place on the output. The initial value of the CTM output pin should be setup using the CTOC bit in the CTMC1 register. Note that the output level requested by the CTIO1 and CTIO0 bits must be different from the initial value setup using the CTOC bit otherwise no change will occur on the CTM output pin when a compare match occurs. After the CTM output pin changes state it can be reset to its initial level by changing the level of the CTON bit from low to high.

In the PWM Output Mode, the CTIO1 and CTIO0 bits determine how the CTM output pin changes state when a certain compare match condition occurs. The PWM output function is modified by changing these two bits. It is necessary to only change the values of the CTIO1 and CTIO0 bits only after the CTM has been switched off. Unpredictable PWM outputs will occur if the CTIO1 and CTIO0 bits are changed when The CTM is running.

Bit 3   **CTOC**: CTP Output control bit

Compare Match Output Mode
  0: Initial low
  1: Initial high

PWM Output Mode
  0: Active low
  1: Active high

This is the output control bit for the CTP output pin. Its operation depends upon whether CTM is being used in the Compare Match Output Mode or in the PWM Output Mode. It has no effect if the CTM is in the Timer/Counter Mode. In the Compare Match Output Mode it determines the logic level of the CTM output pin before a compare match occurs. In the PWM Output Mode it determines if the PWM signal is active high or active low.

Bit 2   **CTPOL**: CTM CTP Output polarity Control
  0: Non-invert
  1: Invert

This bit controls the polarity of the CTP output pin. When the bit is set high the CTM output pin will be inverted and not inverted when the bit is zero. It has no effect if the CTM is in the Timer/Counter Mode.

Bit 1   **CTDPX**: CTM PWM period/duty Control
  0: CCRP – period; CCRA – duty
  1: CCRP – duty; CCRA – period

This bit determines which of the CCRA and CCRP registers are used for period and duty control of the PWM waveform.

Bit 0   **CTCCLR**: Select CTM Counter clear condition
  0: CTM Comparatror P match
  1: CTM Comparatror A match

This bit is used to select the method which clears the counter. Remember that the Compact TM contains two comparators, Comparator A and Comparator P, either of which can be selected to clear the internal counter. With the CTCCLR bit set high, the counter will be cleared when a compare match occurs from the Comparator A. When the bit is low, the counter will be cleared when a compare match occurs from the Comparator P or with a counter overflow. A counter overflow clearing method can only be implemented if the CCRP bits are all cleared to zero. The CTCCLR bit is not used in the PWM Output Mode.

• **CTMDL Register**

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	D5	D4	D3	D2	D1	D0
R/W	R	R	R	R	R	R	R	R
POR	0	0	0	0	0	0	0	0

Bit 7~0   **D7~D0**: CTM Counter Low Byte Register bit 7 ~ bit 0

CTM 10-bit Counter bit 7 ~ bit 0

• **CTMDH Register**

Bit	7	6	5	4	3	2	1	0
Name	—	—	—	—	—	—	D9	D8
R/W	—	—	—	—	—	—	R	R
POR	—	—	—	—	—	—	0	0

Bit 7~2   Unimplemented, read as "0"

Bit 1~0   **D9~D8**: CTM Counter High Byte Register bit 1 ~ bit 0

CTM 10-bit Counter bit 9 ~ bit 8

• **CTMAL Register**

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	D5	D4	D3	D2	D1	D0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~0   **D7~D0**: CTM CCRA Low Byte Register bit 7 ~ bit 0

CTM 10-bit CCRA bit 7 ~ bit 0

• **CTMAH Register**

Bit	7	6	5	4	3	2	1	0
Name	—	—	—	—	—	—	D9	D8
R/W	—	—	—	—	—	—	R/W	R/W
POR	—	—	—	—	—	—	0	0

Bit 7~2   Unimplemented, read as "0"

Bit 1~0   **D9~D8**: CTM CCRA High Byte Register bit 1 ~ bit 0

CTM 10-bit CCRA bit 9 ~ bit 8

Compact Type TM Operating Modes

The Compact Type TM can operate in one of three operating modes, Compare Match Output Mode, PWM Output Mode or Timer/Counter Mode. The operating mode is selected using the CTM1 and CTM0 bits in the CTMC1 register.

Compare Match Output Mode

To select this mode, bits CTM1 and CTM0 in the CTMC1 register, should be set to 00 respectively. In this mode once the counter is enabled and running it can be cleared by three methods. These are a counter overflow, a compare match from Comparator A and a compare match from Comparator P. When the CTCCLR bit is low, there are two ways in which the counter can be cleared. One is when a compare match from Comparator P, the other is when the CCRP bits are all zero which allows the counter to overflow. Here both CTMAF and CTMPF interrupt request flags for Comparator A and Comparator P respectively, will both be generated.

If the CTCCLR bit in the CTMC1 register is high then the counter will be cleared when a compare match occurs from Comparator A. However, here only the CTMAF interrupt request flag will be generated even if the value of the CCRP bits is less than that of the CCRA registers. Therefore, when CTCCLR is high no CTMPF interrupt request flag will be generated. If the CCRA bits are all zero, the counter will overflow when it reaches its maximum 10-bit, 3FF Hex, value, however here the CTMAF interrupt request flag will not be generated.

As the name of the mode suggests, after a comparison is made, the CTM output pin will change state. The CTM output pin condition however only changes state when a CTMAF interrupt request flag is generated after a compare match occurs from Comparator A. The CTMPF interrupt request flag, generated from a compare match occurs from Comparator P, will have no effect on the CTM output pin. The way in which the CTM output pin changes state are determined by the condition of the CTIO1 and CTIO0 bits in the CTMC1 register. The CTM output pin can be selected using the CTIO1 and CTIO0 bits to go high, to go low or to toggle from its present condition when a compare match occurs from Comparator A. The initial condition of the CTM output pin, which is setup after the CTON bit changes from low to high, is setup using the CTOC bit. Note that if the CTIO1 and CTIO0 bits are zero then no pin change will take place.
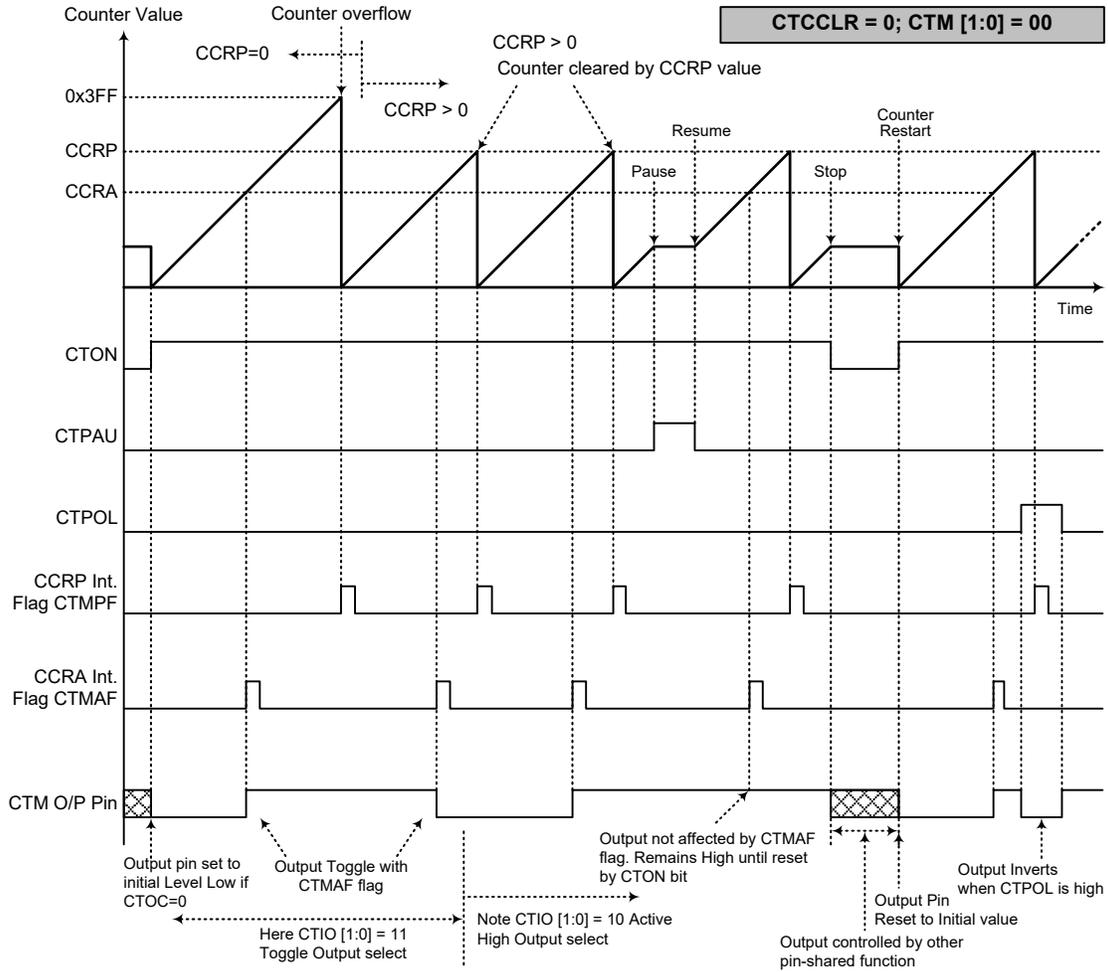
Compare Match Output Mode – CTCCLR=0

Note: 1. With CTCCLR=0, a Comparator P match will clear the counter
    2. The CTM output pin controlled only by the CTMAF flag
    3. The output pin reset to initial state by a CTON bit rising edge

Compare Match Output Mode – CTCCLR=1

Note: 1. With CTCCLR=1, a Comparator A match will clear the counter
2. The CTM output pin controlled only by the CTMAF flag
3. The output pin reset to initial state by a CTON rising edge
4. The CTMPF flags is not generated when CTCCLR=1

Timer/Counter Mode

To select this mode, bits CTM1 and CTM0 in the CTMC1 register should be set to 11 respectively. The Timer/Counter Mode operates in an identical way to the Compare Match Output Mode generating the same interrupt flags. The exception is that in the Timer/Counter Mode the CTM output pin is not used. Therefore the above description and Timing Diagrams for the Compare Match Output Mode can be used to understand its function. As the CTM output pin is not used in this mode, the pin can be used as a normal I/O pin or other pin-shared function.

PWM Output Mode

To select this mode, bits CTM1 and CTM0 in the CTMC1 register should be set to 10 respectively. The PWM function within the CTM is useful for applications which require functions such as motor control, heating control, illumination control etc. By providing a signal of fixed frequency but of varying duty cycle on the CTM output pin, a square wave AC waveform can be generated with varying equivalent DC RMS values.

As both the period and duty cycle of the PWM waveform can be controlled, the choice of generated waveform is extremely flexible. In the PWM Output Mode, the CTCCLR bit has no effect on the PWM operation. Both of the CCRA and CCRP registers are used to generate the PWM waveform, one register is used to clear the internal counter and thus control the PWM waveform frequency, while the other one is used to control the duty cycle. Which register is used to control either frequency or duty cycle is determined using the CTDPX bit in the CTMC1 register. The PWM waveform frequency and duty cycle can therefore be controlled by the values in the CCRA and CCRP registers.

An interrupt flag, one for each of the CCRA and CCRP, will be generated when a compare match occurs from either Comparator A or Comparator P. The CTOC bit in the CTMC1 register is used to select the required polarity of the PWM waveform while the two CTIO1 and CTIO0 bits are used to enable the PWM output or to force the CTM output pin to a fixed high or low level. The CTPOL bit is used to reverse the polarity of the PWM output waveform.

- **10-bit CTM, PWM Output Mode, Edge-aligned Mode, CTDPX=0**

CCRP	001b	010b	011b	100b	101b	110b	111b	000b
Period	128	256	384	512	640	768	896	1024
Duty	CCRA							

If f_{SYS}=16MHz, CTM clock source is f_{SYS}/4, CCRP=100b, CCRA=128,

The CTM PWM output frequency=(f_{SYS}/4)/512=f_{SYS}/2048=7.8125kHz, duty=128/512=25%.

If the Duty value defined by the CCRA register is equal to or greater than the Period value, then the PWM output duty is 100%.

- **10-bit CTM, PWM Output Mode, Edge-aligned Mode, CTDPX=1**

CCRP	001b	010b	011b	100b	101b	110b	111b	000b
Period	CCRA							
Duty	128	256	384	512	640	768	896	1024

The PWM output period is determined by the CCRA register value together with the CTM clock while the PWM duty cycle is defined by the CCRP register value.

PWM Output Mode – CTDPX=0
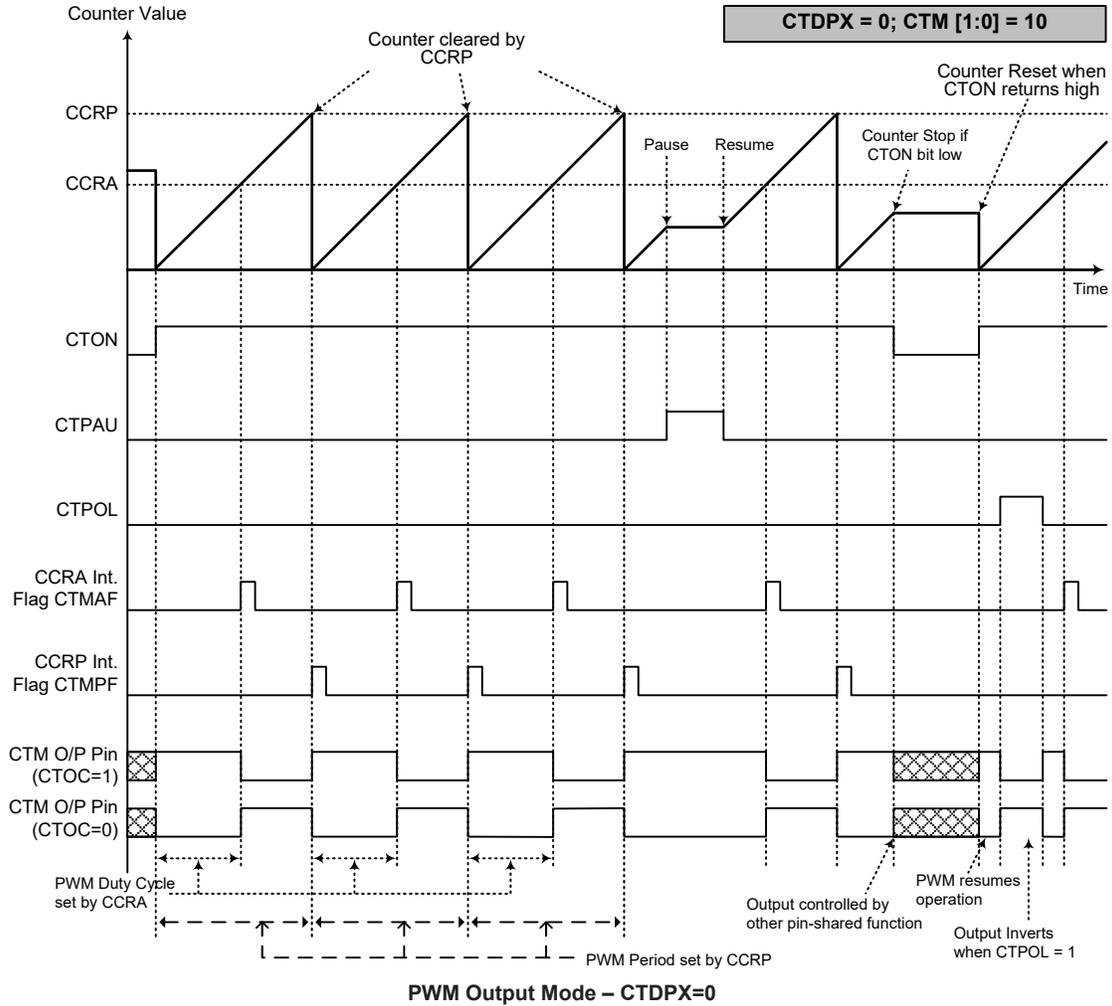
Note: 1. Here CTDPX=0 – Counter cleared by CCRP

2. A counter clear sets PWM Period

3. The internal PWM function continues running even when CTIO[1:0]=00 or 01

4. The CTCCLR bit has no influence on PWM operation

PWM Output Mode – CTDPX=1
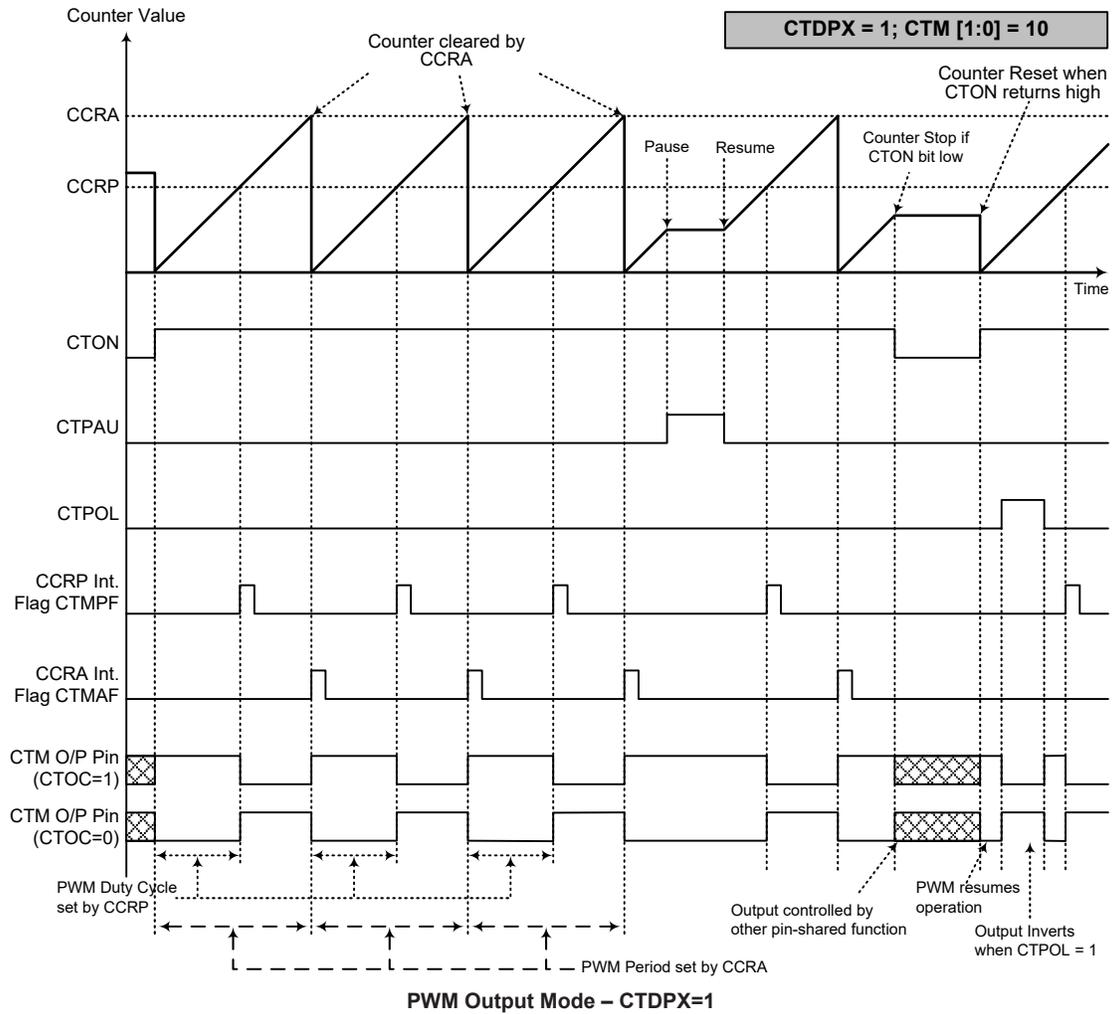
Note: 1. Here CTDPX=1 – Counter cleared by CCRA

2. A counter clear sets PWM Period

3. The internal PWM function continues even when CTIO[1:0]=00 or 01

4. The CTCCLR bit has no influence on PWM operation

Standard Type TM – STM

The Standard Type TM contains five operating modes, which are Compare Match Output, Timer/Event Counter, Capture Input, Single Pulse Output and PWM Output modes. The Standard TM can also be controlled with two external input pins and can drive one external output pins.
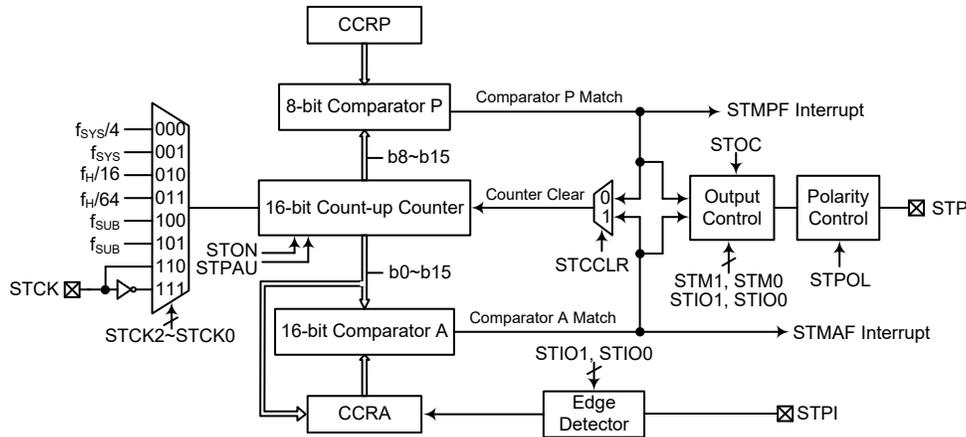
Note: The STM external pins are pin-shared with other functions, so before using the STM function, ensure that the pin-shared function registers have been set properly to enable the STM pin function.

16-bit Standard Type TM Block Diagram

Standard TM Operation

The size of the Standard type TM is 16-bit wide and its core is a 16-bit count-up counter which is driven by a user selectable internal or external clock source. There are also two internal comparators with the names, Comparator A and Comparator P. These comparators will compare the value in the counter with CCRP and CCRA registers. The CCRP comparator is 8-bit wide whose value is compared with the highest 8 bits in the counter while the CCRA is the sixteen bits and therefore compares all counter bits.

The only way of changing the value of the 16-bit counter using the application program, is to clear the counter by changing the STON bit from low to high. The counter will also be cleared automatically by a counter overflow or a compare match with one of its associated comparators. When these conditions occur, a STM interrupt signal will also usually be generated. The Standard Type TM can operate in a number of different operational modes, can be driven by different clock sources including external input pins and can also control more than one output pins. All operating setup conditions are selected using relevant internal registers.

Standard Type TM Register Description

Overall operation of the Standard TM is controlled using a series of registers. A read only register pair exists to store the internal counter 16-bit value, while a read/write register pair exists to store the internal 16-bit CCRA value. The STMRP register is used to store the 8-bit CCRP value. The remaining two registers are control registers which setup the different operating and control modes.

Register	Bit							
Name	7	6	5	4	3	2	1	0
STMC0	STPAU	STCK2	STCK1	STCK0	STON	—	—	—
STMC1	STM1	STM0	STIO1	STIO0	STOC	STPOL	STDPX	STCCLR
STMDL	D7	D6	D5	D4	D3	D2	D1	D0
STMDH	D15	D14	D13	D12	D11	D10	D9	D8
STMAL	D7	D6	D5	D4	D3	D2	D1	D0
STMAH	D15	D14	D13	D12	D11	D10	D9	D8
STMRP	D7	D6	D5	D4	D3	D2	D1	D0

16-bit Standard Type TM Register List

- **STMC0 Register**

Bit	7	6	5	4	3	2	1	0
Name	STPAU	STCK2	STCK1	STCK0	STON	—	—	—
R/W	R/W	R/W	R/W	R/W	R/W	—	—	—
POR	0	0	0	0	0	—	—	—

Bit 7   **STPAU**: STM Counter Pause control
0: Run
1: Pause

The counter can be paused by setting this bit high. Clearing the bit to zero restores normal counter operation. When in a Pause condition the STM will remain powered up and continue to consume power. The counter will retain its residual value when this bit changes from low to high and resume counting from this value when the bit changes to a low value again.

Bit 6~4   **STCK2~STCK0**: Select STM Counter clock
000: $f_{SYS}/4$
001: f_{SYS}
010: $f_H/16$
011: $f_H/64$
100: f_{SUB}
101: f_{SUB}
110: STCK rising edge clock
111: STCK falling edge clock

These three bits are used to select the clock source for the STM. The external pin clock source can be chosen to be active on the rising or falling edge. The clock source f_{SYS} is the system clock, while f_H and f_{SUB} are other internal clocks, the details of which can be found in the "Operating Modes and System Clocks" section.

Bit 3   **STON**: STM Counter On/Off control
0: Off
1: On

This bit controls the overall on/off function of the STM. Setting the bit high enables the counter to run while clearing the bit disables the STM. Clearing this bit to zero will stop the counter from counting and turn off the STM which will reduce its power consumption. When the bit changes state from low to high the internal counter value will be reset to zero, however when the bit changes from high to low, the internal counter will retain its residual value until the bit returns high again.

If the STM is in the Compare Match Output Mode, the PWM Output Mode or the Single Pulse Output Mode then the STM output pin will be reset to its initial condition, as specified by the STOC bit, when the STON bit changes from low to high.

Bit 2~0   Unimplemented, read as "0"

• **STMC1 Register**

Bit	7	6	5	4	3	2	1	0
Name	STM1	STM0	STIO1	STIO0	STOC	STPOL	STDPX	STCCLR
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~6　　**STM1~STM0**: Select STM Operating Mode
　　　　　　00: Compare Match Output Mode
　　　　　　01: Capture Input Mode
　　　　　　10: PWM Output Mode or Single Pulse Output Mode
　　　　　　11: Timer/Counter Mode

These bits setup the required operating mode for the STM. To ensure reliable operation the STM should be switched off before any changes are made to the STM1 and STM0 bits. In the Timer/Counter Mode, the STM output pin state is undefined.

Bit 5~4　　**STIO1~STIO0**: Select STM external pin STP or STPI function
　　　　　　Compare Match Output Mode
　　　　　　00: No change
　　　　　　01: Output low
　　　　　　10: Output high
　　　　　　11: Toggle output
　　　　　　PWM Output Mode/Single Pulse Output Mode
　　　　　　00: PWM output inactive state
　　　　　　01: PWM output active state
　　　　　　10: PWM output
　　　　　　11: Single Pulse output
　　　　　　Capture Input Mode
　　　　　　00: Input capture at rising edge of STPI
　　　　　　01: Input capture at falling edge of STPI
　　　　　　10: Input capture at rising/falling edge of STPI
　　　　　　11: Input capture disabled
　　　　　　Timer/Counter Mode
　　　　　　　Unused

These two bits are used to determine how the STM external pin changes state when a certain condition is reached. The function that these bits select depends upon in which mode the STM is running.

In the Compare Match Output Mode, the STIO1 and STIO0 bits determine how the STM output pin changes state when a compare match occurs from the Comparator A. The TM output pin can be setup to switch high, switch low or to toggle its present state when a compare match occurs from the Comparator A. When the bits are both zero, then no change will take place on the output. The initial value of the STM output pin should be setup using the STOC bit in the STMC1 register. Note that the output level requested by the STIO1 and STIO0 bits must be different from the initial value setup using the STOC bit otherwise no change will occur on the STM output pin when a compare match occurs. After the STM output pin changes state, it can be reset to its initial level by changing the level of the STON bit from low to high.

In the PWM Output Mode, the STIO1 and STIO0 bits determine how the STM output pin changes state when a certain compare match condition occurs. The PWM output function is modified by changing these two bits. It is necessary to only change the values of the STIO1 and STIO0 bits only after the STM has been switched off. Unpredictable PWM outputs will occur if the STIO1 and STIO0 bits are changed when the STM is running.

Bit 3   **STOC**: STM STP Output control

Compare Match Output Mode
    0: Initial low
    1: Initial high

PWM Output Mode/Single Pulse Output Mode
    0: Active low
    1: Active high

This is the output control bit for the STM output pin. Its operation depends upon whether STM is being used in the Compare Match Output Mode or in the PWM Output Mode/Single Pulse Output Mode. It has no effect if the STM is in the Timer/Counter Mode. In the Compare Match Output Mode it determines the logic level of the STM output pin before a compare match occurs. In the PWM output Mode it determines if the PWM signal is active high or active low. In the Single Pulse Output Mode it determines the logic level of the STP output pin when the STON bit changes from low to high.

Bit 2   **STPOL**: STP Output polarity control
    0: Non-invert
    1: Invert

This bit controls the polarity of the STP output pin. When the bit is set high the STM output pin will be inverted and not inverted when the bit is zero. It has no effect if the STM is in the Timer/Counter Mode.

Bit 1   **STDPX**: STM PWM duty/period control
    0: CCRP – period; CCRA – duty
    1: CCRP – duty; CCRA – period

This bit determines which of the CCRA and CCRP registers are used for period and duty control of the PWM waveform.

Bit 0   **STCCLR**: STM Counter Clear condition selection
    0: Comparator P match
    1: Comparator A match

This bit is used to select the method which clears the counter. Remember that the Standard TM contains two comparators, Comparator A and Comparator P, either of which can be selected to clear the internal counter. With the STCCLR bit set high, the counter will be cleared when a compare match occurs from the Comparator A. When the bit is low, the counter will be cleared when a compare match occurs from the Comparator P or with a counter overflow. A counter overflow clearing method can only be implemented if the CCRP bits are all cleared to zero. The STCCLR bit is not used in the PWM Output, Single Pulse Output or Capture Input Mode.

• **STMDL Register**

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	D5	D4	D3	D2	D1	D0
R/W	R	R	R	R	R	R	R	R
POR	0	0	0	0	0	0	0	0

Bit 7~0   **D7~D0**: STM Counter Low Byte Register bit 7 ~ bit 0
    STM 16-bit Counter bit 7 ~ bit 0

• **STMDH Register**

Bit	7	6	5	4	3	2	1	0
Name	D15	D14	D13	D12	D11	D10	D9	D8
R/W	R	R	R	R	R	R	R	R
POR	0	0	0	0	0	0	0	0

Bit 7~0   **D15~D8**: STM Counter High Byte Register bit 7 ~ bit 0
    STM 16-bit Counter bit 15 ~ bit 8

• **STMAL Register**

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	D5	D4	D3	D2	D1	D0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~0   **D7~D0**: STM CCRA Low Byte Register bit 7 ~ bit 0
                 STM 16-bit CCRA bit 7 ~ bit 0

• **STMAH Register**

Bit	7	6	5	4	3	2	1	0
Name	D15	D14	D13	D12	D11	D10	D9	D8
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~0   **D15~D8**: STM CCRA High Byte Register bit 7 ~ bit 0
                 STM 16-bit CCRA bit 15 ~ bit 8

• **STMRP Register**

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	D5	D4	D3	D2	D1	D0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~0   **D7~D0**: STM CCRP 8-bit register, compared with the STM counter bit 15 ~ bit 8
                 Comparator P match period
                   0: 65536 STM clocks
                   1~255: (1~255) × 256 STM clocks
                 These eight bits are used to setup the value on the internal CCRP 8-bit register, which are then compared with the internal counter's highest eight bits. The result of this comparison can be selected to clear the internal counter if the STCCLR bit is set to zero. Setting the STCCLR bit to zero ensures that a compare match with the CCRP values will reset the internal counter. As the CCRP bits are only compared with the highest eight counter bits, the compare values exist in 256 clock cycle multiples. Clearing all eight bits to zero is in effect allowing the counter to overflow at its maximum value.

Standard Type TM Operation Modes

The Standard Type TM can operate in one of five operating modes, Compare Match Output Mode, PWM Output Mode, Single Pulse Output Mode, Capture Input Mode or Timer/Counter Mode. The operating mode is selected using the STM1 and STM0 bits in the STMC1 register.

Compare Match Output Mode

To select this mode, bits STM1 and STM0 in the STMC1 register, should be set to 00 respectively. In this mode once the counter is enabled and running it can be cleared by three methods. These are a counter overflow, a compare match from Comparator A and a compare match from Comparator P. When the STCCLR bit is low, there are two ways in which the counter can be cleared. One is when a compare match from Comparator P, the other is when the CCRP bits are all zero which allows the counter to overflow. Here both STMAF and STMPF interrupt request flags for Comparator A and Comparator P respectively, will both be generated.

If the STCCLR bit in the STMC1 register is high then the counter will be cleared when a compare match occurs from Comparator A. However, here only the STMAF interrupt request flag will be generated even if the value of the CCRP bits is less than that of the CCRA registers. Therefore, when STCCLR is high no STMPF interrupt request flag will be generated. In the Compare Match Output Mode, the CCRA cannot be cleared to zero.

If the CCRA bits are all zero, the counter will overflow when it reaches its maximum 16-bit, FFFF Hex, value, however here the STMAF interrupt request flag will not be generated.

As the name of the mode suggests, after a comparison is made, the STM output pin, will change state. The STM output pin condition however only changes state when a STMAF interrupt request flag is generated after a compare match occurs from Comparator A. The STMPF interrupt request flag, generated from a compare match occurs from Comparator P, will have no effect on the STM output pin. The way in which the STM output pin changes state are determined by the condition of the STIO1 and STIO0 bits in the STMC1 register. The STM output pin can be selected using the STIO1 and STIO0 bits to go high, to go low or to toggle from its present condition when a compare match occurs from Comparator A. The initial condition of the STM output pin, which is setup after the STON bit changes from low to high, is setup using the STOC bit. Note that if the STIO1 and STIO0 bits are zero then no pin change will take place.

STCCLR = 0; STM [1:0] = 00
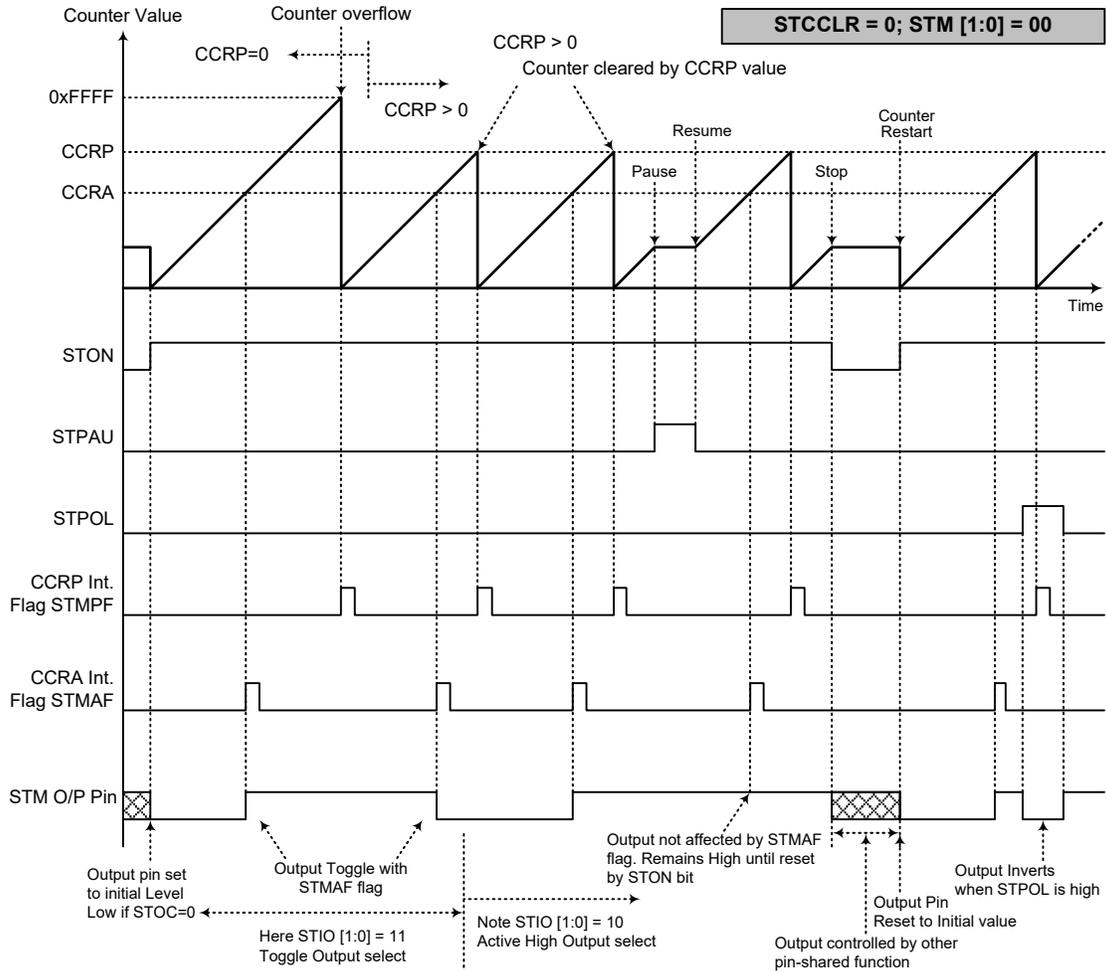
Compare Match Output Mode – STCCLR=0

Note: 1. With STCCLR=0, a Comparator P match will clear the counter

2. The STM output pin is controlled only by the STMAF flag

3. The output pin is reset to its initial state by a STON bit rising edge
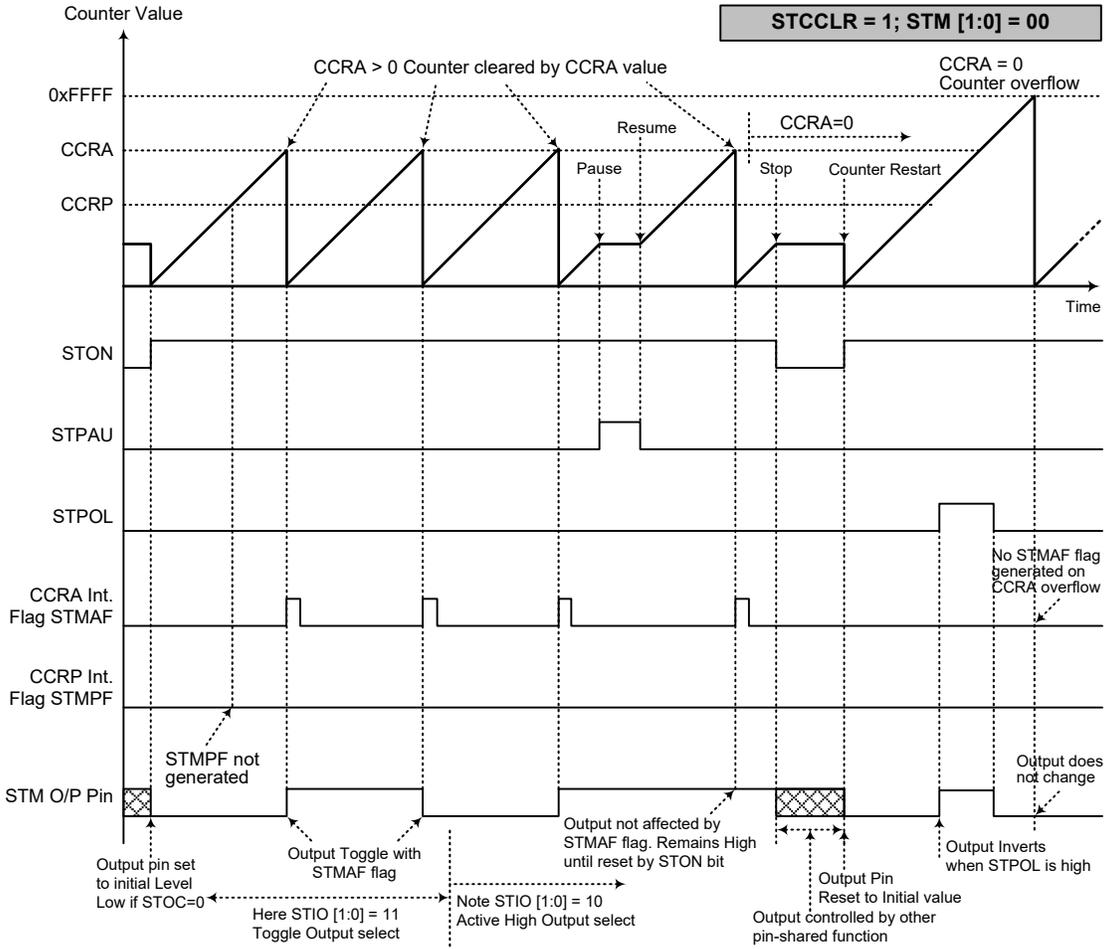
Compare Match Output Mode – STCCLR=1

Note: 1. With STCCLR=1, a Comparator A match will clear the counter

2. The STM output pin is controlled only by the STMAF flag

3. The output pin is reset to its initial state by a STON bit rising edge

4. A STMPF flag is not generated when STCCLR=1

Timer/Counter Mode

To select this mode, bits STM1 and STM0 in the STMC1 register should be set to 11 respectively. The Timer/Counter Mode operates in an identical way to the Compare Match Output Mode generating the same interrupt flags. The exception is that in the Timer/Counter Mode the STM output pin is not used. Therefore the above description and Timing Diagrams for the Compare Match Output Mode can be used to understand its function. As the STM output pin is not used in this mode, the pin can be used as a normal I/O pin or other pin-shared function.

PWM Output Mode

To select this mode, bits STM1 and STM0 in the STMC1 register should be set to 10 respectively. The PWM function within the STM is useful for applications which require functions such as motor control, heating control, illumination control etc. By providing a signal of fixed frequency but of varying duty cycle on the STM output pin, a square wave AC waveform can be generated with varying equivalent DC RMS values.

As both the period and duty cycle of the PWM waveform can be controlled, the choice of generated waveform is extremely flexible. In the PWM Output Mode, the STCCLR bit has no effect as the PWM period. Both of the CCRA and CCRP registers are used to generate the PWM waveform, one register is used to clear the internal counter and thus control the PWM waveform frequency, while the other one is used to control the duty cycle. Which register is used to control either frequency or duty cycle is determined using the STDPX bit in the STMC1 register. The PWM waveform frequency and duty cycle can therefore be controlled by the values in the CCRA and CCRP registers.

An interrupt flag, one for each of the CCRA and CCRP, will be generated when a compare match occurs from either Comparator A or Comparator P. The STOC bit in the STMC1 register is used to select the required polarity of the PWM waveform while the two STIO1 and STIO0 bits are used to enable the PWM output or to force the STM output pin to a fixed high or low level. The STPOL bit is used to reverse the polarity of the PWM output waveform.

- **16-bit STM, PWM Output Mode, Edge-aligned Mode, STDPX=0**

CCRP	1~255	0
Period	CCRP×256	65536
Duty	CCRA	

If f_{SYS}=16MHz, STM clock source is f_{SYS}/4, CCRP=2 and CCRA=128,

The STM PWM output frequency=(f_{SYS}/4)/(2×256)=f_{SYS}/2048=7.8125kHz, duty=128/(2×256)=25%.

If the Duty value defined by the CCRA register is equal to or greater than the Period value, then the PWM output duty is 100%.

- **16-bit STM, PWM Output Mode, Edge-aligned Mode, STDPX=1**

CCRP	1~255	0
Period	CCRA	
Duty	CCRP×256	65536

The PWM output period is determined by the CCRA register value together with the STM clock while the PWM duty cycle is defined by the CCRP register value.

PWM Output Mode – STDPX=0
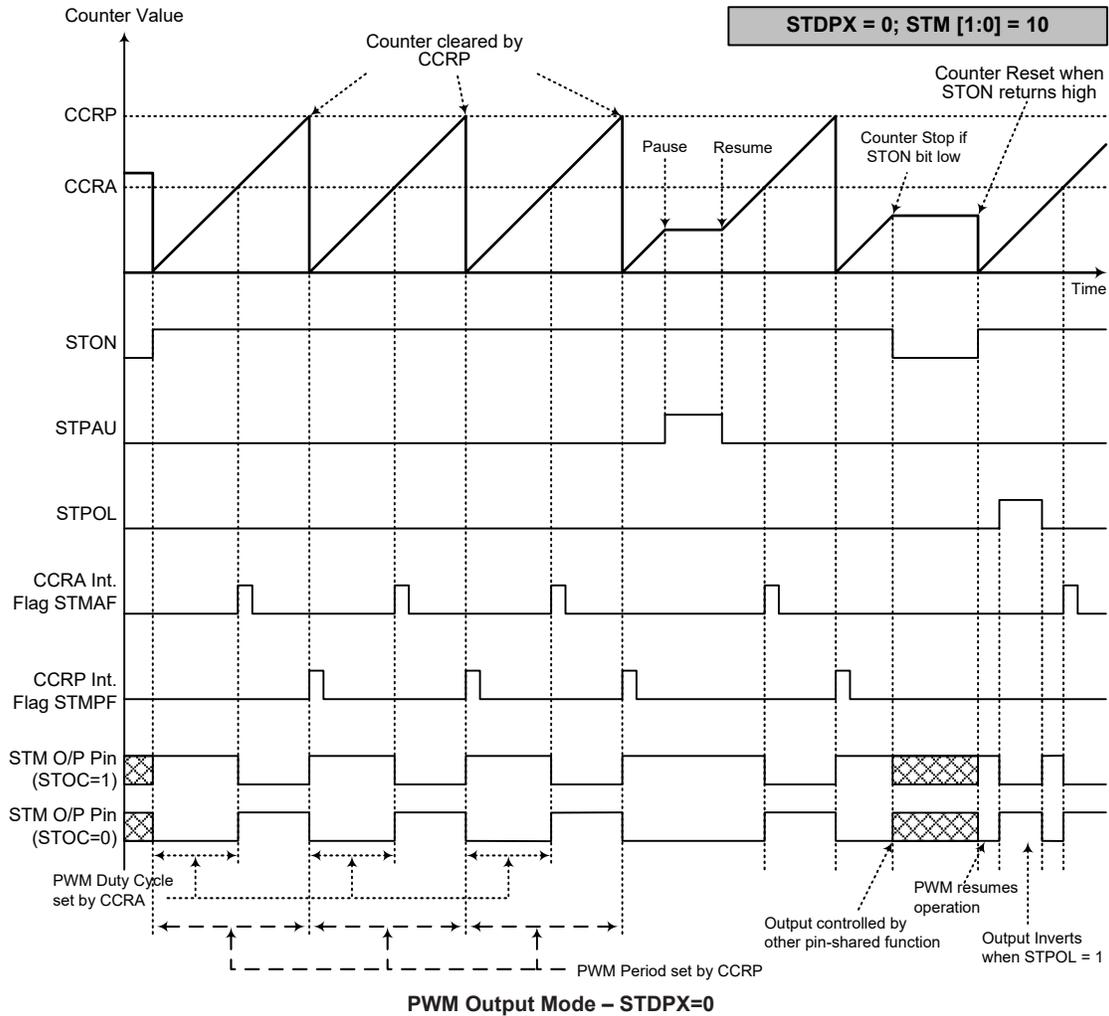
Note: 1. Here STDPX=0 – Counter cleared by CCRP
2. A counter clear sets PWM Period
3. The internal PWM function continues running even when STIO[1:0]=00 or 01
4. The STCCLR bit has no influence on PWM operation

PWM Output Mode – STDPX=1
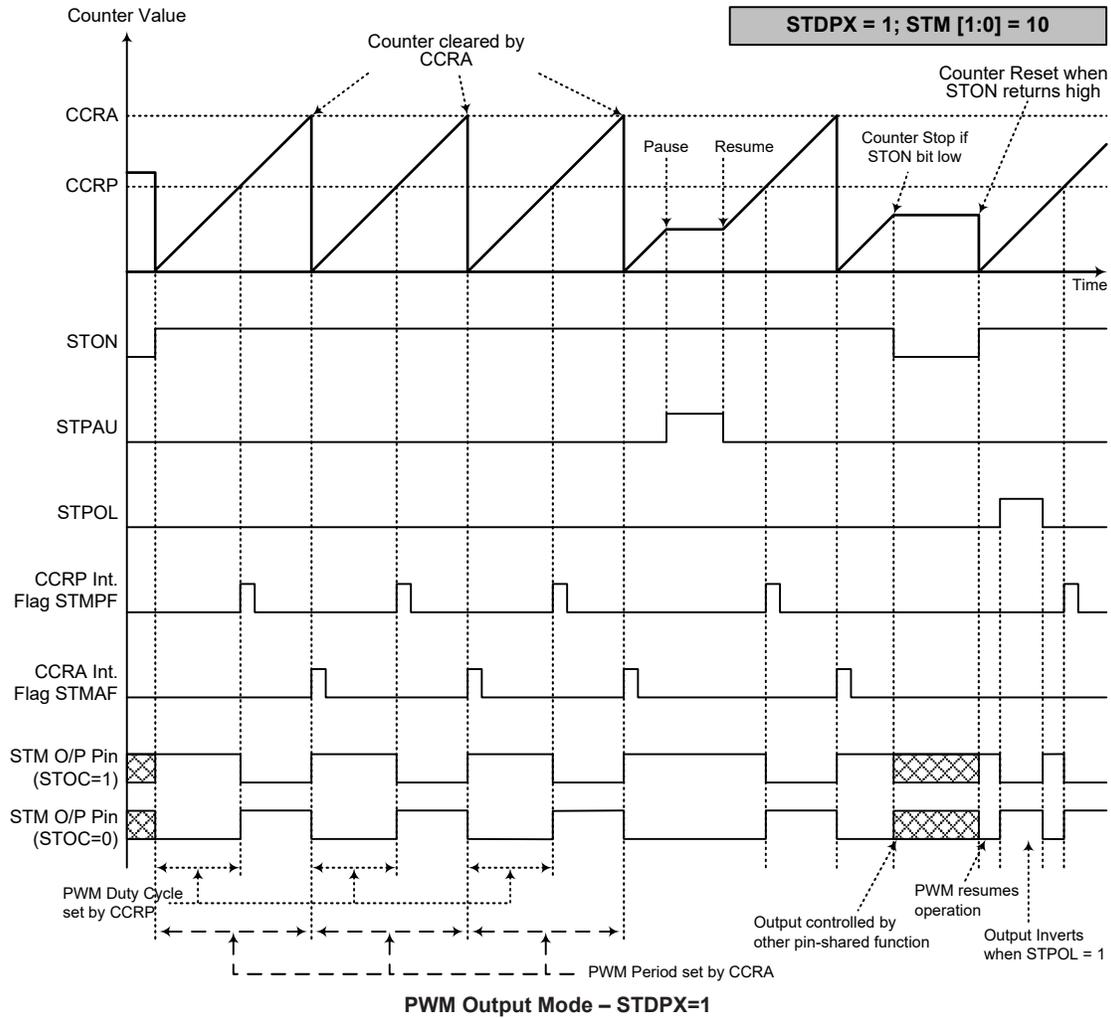
Note: 1. Here STDPX=1 – Counter cleared by CCRA

2. A counter clear sets PWM Period

3. The internal PWM function continues even when STIO[1:0]=00 or 01

4. The STCCLR bit has no influence on PWM operation

Single Pulse Output Mode

To select this mode, bits STM1 and STM0 in the STMC1 register should be set to 10 respectively and also the STIO1 and STIO0 bits should be set to 11 respectively. The Single Pulse Output Mode, as the name suggests, will generate a single shot pulse on the STM output pin.

The trigger for the pulse output leading edge is a low to high transition of the STON bit, which can be implemented using the application program. However in the Single Pulse Output Mode, the STON bit can also be made to automatically change from low to high using the external STCK pin, which will in turn initiate the Single Pulse output. When the STON bit transitions to a high level, the counter will start running and the pulse leading edge will be generated. The STON bit should remain high when the pulse is in its active state. The generated pulse trailing edge will be generated when the STON bit is cleared to zero, which can be implemented using the application program or when a compare match occurs from Comparator A.

However a compare match from Comparator A will also automatically clear the STON bit and thus generate the Single Pulse output trailing edge. In this way the CCRA value can be used to control the pulse width. A compare match from Comparator A will also generate a STM interrupt. The counter can only be reset back to zero when the STON bit changes from low to high when the counter restarts. In the Single Pulse Output Mode CCRP is not used. The STCCLR and STDPX bits are not used in this Mode.
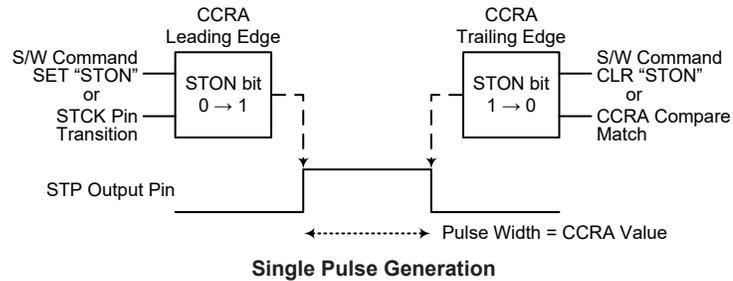
Single Pulse Generation

Single Pulse Output Mode

Note: 1. Counter stopped by CCRA

2. CCRP is not used

3. The pulse triggered by the STCK pin or by setting the STON bit high

4. A STCK pin active edge will automatically set the STON bit high

5. In the Single Pulse Output Mode, STIO[1:0] must be set to "11" and can not be changed

Capture Input Mode

To select this mode bits STM1 and STM0 in the STMC1 register should be set to 01 respectively. This mode enables external signals to capture and store the present value of the internal counter and can therefore be used for applications such as pulse width measurements. The external signal is supplied on the STPI pin, whose active edge can be a rising edge, a falling edge or both rising and falling edges; the active edge transition type is selected using the STIO1 and STIO0 bits in the STMC1 register. The counter is started when the STON bit changes from low to high which is initiated using the application program.

When the required edge transition appears on the STPI pin the present value in the counter will be latched into the CCRA registers and a STM interrupt generated. Irrespective of what events occur on the STPI pin the counter will continue to free run until the STON bit changes from high to low. When a CCRP compare match occurs the counter will reset back to zero; in this way the CCRP value can be used to control the maximum counter value. When a CCRP compare match occurs from Comparator P, a STM interrupt will also be generated. Counting the number of overflow interrupt signals from the CCRP can be a useful method in measuring long pulse widths. The STIO1 and STIO0 bits can select the active trigger edge on the STPI pin to be a rising edge, falling edge or both edge types. If the STIO1 and STIO0 bits are both set high, then no capture operation will take place irrespective of what happens on the STPI pin, however it must be noted that the counter will continue to run. There are some considerations that should be noted. If the captured pulse width is less than 2 timer clock periods, it may be ignored by hardware. After the counter value is latched to the CCRA registers by an active capture edge, the STMAF flag will be set high after 0.5 timer clock periods. The delay time from the active capture edge received to the action of latching counter value to CCRA registers is less than 1.5 timer clock periods. The STCCLR and STDPX bits are not used in this Mode.
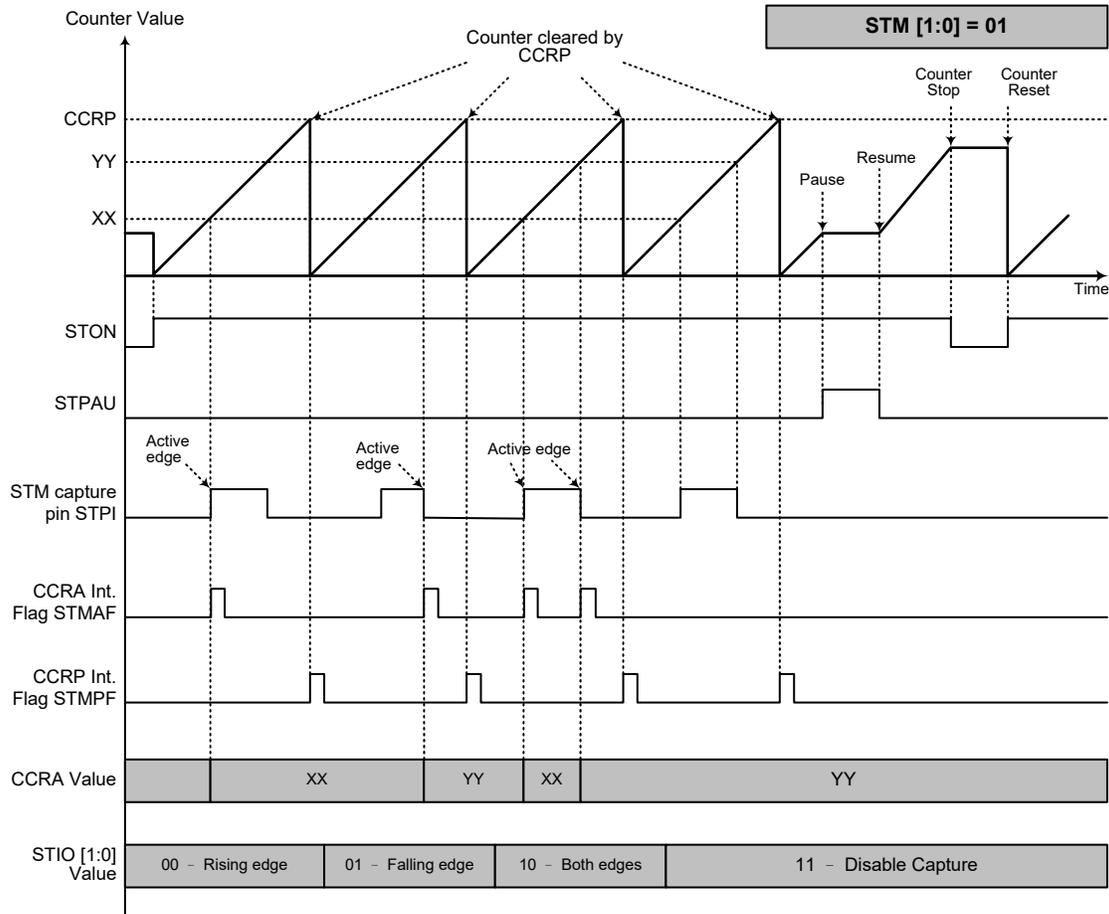
Capture Input Mode

Note: 1. STM[1:0]=01 and active edge set by the STIO[1:0] bits
2. A STM Capture input pin active edge transfers the counter value to CCRA
3. STCCLR and STDPX bits not used
4. No output function – STOC and STPOL bits are not used
5. CCRP determines the counter value and the counter has a maximum count value when CCRP is equal to zero

Periodic Type TM – PTM

The Periodic Type TM contains five operating modes, which are Compare Match Output, Timer/Event Counter, Capture Input, Single Pulse Output and PWM Output modes. The Periodic TM can be controlled with two external input pins and can drive two external output pins.
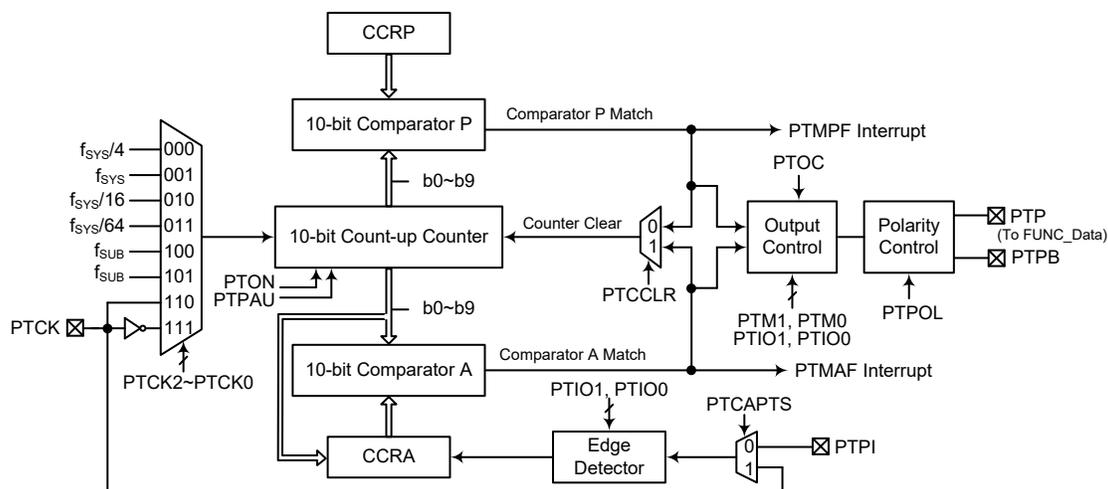
Note: 1. The PTM external pins are pin-shared with other functions, so before using the PTM function, ensure that the pin-shared function registers have been set properly to enable the PTM pin function.

2. The PTPB is the inverted signal of the PTP.

10-bit Periodic Type TM Block Diagram

Periodic TM Operation

The size of the Periodic type TM is 10-bit wide and its core is a 10-bit count-up counter which is driven by a user selectable internal or external clock source. There are also two internal comparators with the names, Comparator A and Comparator P. These comparators will compare the value in the counter with CCRP and CCRA registers. The CCRP and the CCRA comparators are both 10-bit wide whose values are compared with all the bits in the counter.

The only way of changing the value of the 10-bit counter using the application program, is to clear the counter by changing the PTON bit from low to high. The counter will also be cleared automatically by a counter overflow or a compare match with one of its associated comparators. When these conditions occur, a PTM interrupt signal will also usually be generated. The Periodic Type TM can operate in a number of different operational modes, can be driven by different clock sources including external input pins and can also control more than one output pins. All operating setup conditions are selected using relevant internal registers.

Periodic Type TM Register Description

Overall operation of the Periodic Type TM is controlled using a series of registers. A read only register pair exists to store the internal counter 10-bit value, while two read/write register pairs exist to store the internal 10-bit CCRA value and CCRP value. The remaining two registers are control registers which setup the different operating and control modes.

Register	Bit							
Name	7	6	5	4	3	2	1	0
PTMC0	PTPAU	PTCK2	PTCK1	PTCK0	PTON	—	—	—
PTMC1	PTM1	PTM0	PTIO1	PTIO0	PTOC	PTPOL	PTCAPTS	PTCCLR
PTMDL	D7	D6	D5	D4	D3	D2	D1	D0
PTMDH	—	—	—	—	—	—	D9	D8
PTMAL	D7	D6	D5	D4	D3	D2	D1	D0
PTMAH	—	—	—	—	—	—	D9	D8
PTMRPL	D7	D6	D5	D4	D3	D2	D1	D0
PTMRPH	—	—	—	—	—	—	D9	D8

10-bit Periodic Type TM Register List

- **PTMC0 Register**

Bit	7	6	5	4	3	2	1	0
Name	PTPAU	PTCK2	PTCK1	PTCK0	PTON	—	—	—
R/W	R/W	R/W	R/W	R/W	R/W	—	—	—
POR	0	0	0	0	0	—	—	—

Bit 7   **PTPAU**: PTM Counter Pause Control
    0: Run
    1: Pause

The counter can be paused by setting this bit high. Clearing the bit to zero restores normal counter operation. When in a Pause condition the PTM will remain powered up and continue to consume power. The counter will retain its residual value when this bit changes from low to high and resume counting from this value when the bit changes to a low value again.

Bit 6~4   **PTCK2~PTCK0**: Select PTM Counter clock
    000: $f_{SYS}/4$
    001: f_{SYS}
    010: $f_H/16$
    011: $f_H/64$
    100: f_{SUB}
    101: f_{SUB}
    110: PTCK rising edge clock
    111: PTCK falling edge clock

These three bits are used to select the clock source for the PTM. The external pin clock source can be chosen to be active on the rising or falling edge. The clock source f_{SYS} is the system clock, while f_H and f_{SUB} are other internal clocks, the details of which can be found in the "Operating Modes and System Clocks" section.

Bit 3   **PTON**: PTM Counter On/Off Control
    0: Off
    1: On

This bit controls the overall on/off function of the PTM. Setting the bit high enables the counter to run while clearing the bit disables the PTM. Clearing this bit to zero will stop the counter from counting and turn off the PTM which will reduce its power consumption. When the bit changes state from low to high the internal counter value will be reset to zero, however when the bit changes from high to low, the internal counter will retain its residual value until the bit returns high again.

If the PTM is in the Compare Match Output Mode, the PWM Output Mode or the Single Pulse Output Mode then the PTM output pin will be reset to its initial condition, as specified by the PTOC bit, when the PTON bit changes from low to high.

Bit 2~0   Unimplemented, read as "0"

• **PTMC1 Register**

Bit	7	6	5	4	3	2	1	0
Name	PTM1	PTM0	PTIO1	PTIO0	PTOC	PTPOL	PTCAPTS	PTCCLR
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~6   **PTM1~PTM0**: Select PTM Operating Mode

　　00: Compare Match Output Mode
　　01: Capture Input Mode
　　10: PWM Output Mode or Single Pulse Output Mode
　　11: Timer/Counter Mode

These bits setup the required operating mode for the PTM. To ensure reliable operation the PTM should be switched off before any changes are made to the PTM1 and PTM0 bits. In the Timer/Counter Mode, the PTM output pin state is undefined.

Bit 5~4   **PTIO1~PTIO0**: Select PTM external pin function

Compare Match Output Mode

　　00: No change
　　01: Output low
　　10: Output high
　　11: Toggle output

PWM Output Mode/Single Pulse Output Mode

00: PWM Output inactive state
　　01: PWM Output active state
　　10: PWM output
　　11: Single pulse output

Capture Input Mode

　　00: Input capture at rising edge of PTPI or PTCK
　　01: Input capture at falling edge of PTPI or PTCK
　　10: Input capture at falling/rising edge of PTPI or PTCK
　　11: Input capture disabled

Timer/Counter Mode

　　Unused

These two bits are used to determine how the PTM external pin changes state when a certain condition is reached. The function that these bits select depends upon in which mode the PTM is running.

In the Compare Match Output Mode, the PTIO1 and PTIO0 bits determine how the PTM output pin changes state when a compare match occurs from the Comparator A. The PTM output pin can be setup to switch high, switch low or to toggle its present state when a compare match occurs from the Comparator A. When the bits are both zero, then no change will take place on the output. The initial value of the PTM output pin should be setup using the PTOC bit in the PTMC1 register. Note that the output level requested by the PTIO1 and PTIO0 bits must be different from the initial value setup using the PTOC bit otherwise no change will occur on the PTM output pin when a compare match occurs. After the PTM output pin changes state, it can be reset to its initial level by changing the level of the PTON bit from low to high.

In the PWM Output Mode, the PTIO1 and PTIO0 bits determine how the PTM output pin changes state when a certain compare match condition occurs. The PWM output function is modified by changing these two bits. It is necessary to only change the values of the PTIO1 and PTIO0 bits only after the PTM has been switched off. Unpredictable PWM outputs will occur if the PTIO1 and PTIO0 bits are changed when the PTM is running.

Bit 3 **PTOC**: PTM PTP Output control bit

Compare Match Output Mode
 0: Initial low
 1: Initial high

PWM Output Mode/Single Pulse Output Mode
 0: Active low
 1: Active high

This is the output control bit for the PTM output pin. Its operation depends upon whether PTM is being used in the Compare Match Output Mode or in the PWM Output Mode/Single Pulse Output Mode. It has no effect if the PTM is in the Timer/Counter Mode. In the Compare Match Output Mode it determines the logic level of the PTM output pin before a compare match occurs. In the PWM Output Mode it determines if the PWM signal is active high or active low. In the Single Pulse Output Mode it determines the logic level of the PTM output pin when the PTON bit changes from low to high.

Bit 2 **PTPOL**: PTP Output polarity control
 0: Non-invert
 1: Invert

This bit controls the polarity of the PTP output pin. When the bit is set high the PTM output pin will be inverted and not inverted when the bit is zero. It has no effect if the PTM is in the Timer/Counter Mode.

Bit 1 **PTCAPTS**: PTM Capture Trigger Source Selection
 0: From PTPI pin
 1: From PTCK pin

Bit 0 **PTCCLR**: PTM Counter Clear condition selection
 0: Comparator P match
 1: Comparator A match

This bit is used to select the method which clears the counter. Remember that the Periodic TM contains two comparators, Comparator A and Comparator P, either of which can be selected to clear the internal counter. With the PTCCLR bit set high, the counter will be cleared when a compare match occurs from the Comparator A. When the bit is low, the counter will be cleared when a compare match occurs from the Comparator P or with a counter overflow. A counter overflow clearing method can only be implemented if the CCRP bits are all cleared to zero. The PTCCLR bit is not used in the PWM Output Mode, Single Pulse Output or Capture Input Mode.

• **PTMDL Register**

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	D5	D4	D3	D2	D1	D0
R/W	R	R	R	R	R	R	R	R
POR	0	0	0	0	0	0	0	0

Bit 7~0 **D7~D0**: PTM Counter Low Byte Register bit 7 ~ bit 0
    PTM 10-bit Counter bit 7 ~ bit 0

• **PTMDH Register**

Bit	7	6	5	4	3	2	1	0
Name	—	—	—	—	—	—	D9	D8
R/W	—	—	—	—	—	—	R	R
POR	—	—	—	—	—	—	0	0

Bit 7~2 Unimplemented, read as "0"

Bit 1~0 **D9~D8**: PTM Counter High Byte Register bit 1 ~ bit 0
    PTM 10-bit Counter bit 9 ~ bit 8

• **PTMAL Register**

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	D5	D4	D3	D2	D1	D0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~0   **D7~D0**: PTM CCRA Low Byte Register bit 7 ~ bit 0
                 PTM 10-bit CCRA bit 7 ~ bit 0

• **PTMAH Register**

Bit	7	6	5	4	3	2	1	0
Name	—	—	—	—	—	—	D9	D8
R/W	—	—	—	—	—	—	R/W	R/W
POR	—	—	—	—	—	—	0	0

Bit 7~2   Unimplemented, read as "0"

Bit 1~0   **D9~D8**: PTM CCRA High Byte Register bit 1 ~ bit 0
                 PTM 10-bit CCRA bit 9 ~ bit 8

• **PTMRPL Register**

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	D5	D4	D3	D2	D1	D0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~0   **D7~D0**: PTM CCRP Low Byte Register bit 7 ~ bit 0
                 PTM 10-bit CCRP bit 7 ~ bit 0

• **PTMRPH Register**

Bit	7	6	5	4	3	2	1	0
Name	—	—	—	—	—	—	D9	D8
R/W	—	—	—	—	—	—	R/W	R/W
POR	—	—	—	—	—	—	0	0

Bit 7~2   Unimplemented, read as "0"

Bit 1~0   **D9~D8**: PTM CCRP High Byte Register bit 1 ~ bit 0
                 PTM 10-bit CCRP bit 9 ~ bit 8

Periodic Type TM Operating Modes

The Periodic Type TM can operate in one of five operating modes, Compare Match Output Mode, PWM Output Mode, Single Pulse Output Mode, Capture Input Mode or Timer/Counter Mode. The operating mode is selected using the PTM1 and PTM0 bits in the PTMC1 register.

Compare Match Output Mode

To select this mode, bits PTM1 and PTM0 in the PTMC1 register, should be set to 00 respectively. In this mode once the counter is enabled and running it can be cleared by three methods. These are a counter overflow, a compare match from Comparator A and a compare match from Comparator P. When the PTCCLR bit is low, there are two ways in which the counter can be cleared. One is when a compare match from Comparator P, the other is when the CCRP bits are all zero which allows the counter to overflow. Here both PTMAF and PTMPF interrupt request flags for Comparator A and Comparator P respectively, will both be generated.

If the PTCCLR bit in the PTMC1 register is high then the counter will be cleared when a compare match occurs from Comparator A. However, here only the PTMAF interrupt request flag will be generated even if the value of the CCRP bits is less than that of the CCRA registers. Therefore when PTCCLR is high no PTMPF interrupt request flag will be generated. In the Compare Match Output Mode, the CCRA cannot be cleared to zero.

If the CCRA bits are all zero, the counter will overflow when it reaches its maximum 10-bit, 3FF Hex, value, however here the PTMAF interrupt request flag will not be generated.

As the name of the mode suggests, after a comparison is made, the PTM output pin, will change state. The PTM output pin condition however only changes state when a PTMAF interrupt request flag is generated after a compare match occurs from Comparator A. The PTMPF interrupt request flag, generated from a compare match occurs from Comparator P, will have no effect on the PTM output pin. The way in which the PTM output pin changes state are determined by the condition of the PTIO1 and PTIO0 bits in the PTMC1 register. The PTM output pin can be selected using the PTIO1 and PTIO0 bits to go high, to go low or to toggle from its present condition when a compare match occurs from Comparator A. The initial condition of the PTM output pin, which is setup after the PTON bit changes from low to high, is setup using the PTOC bit. Note that if the PTIO1 and PTIO0 bits are zero then no pin change will take place.
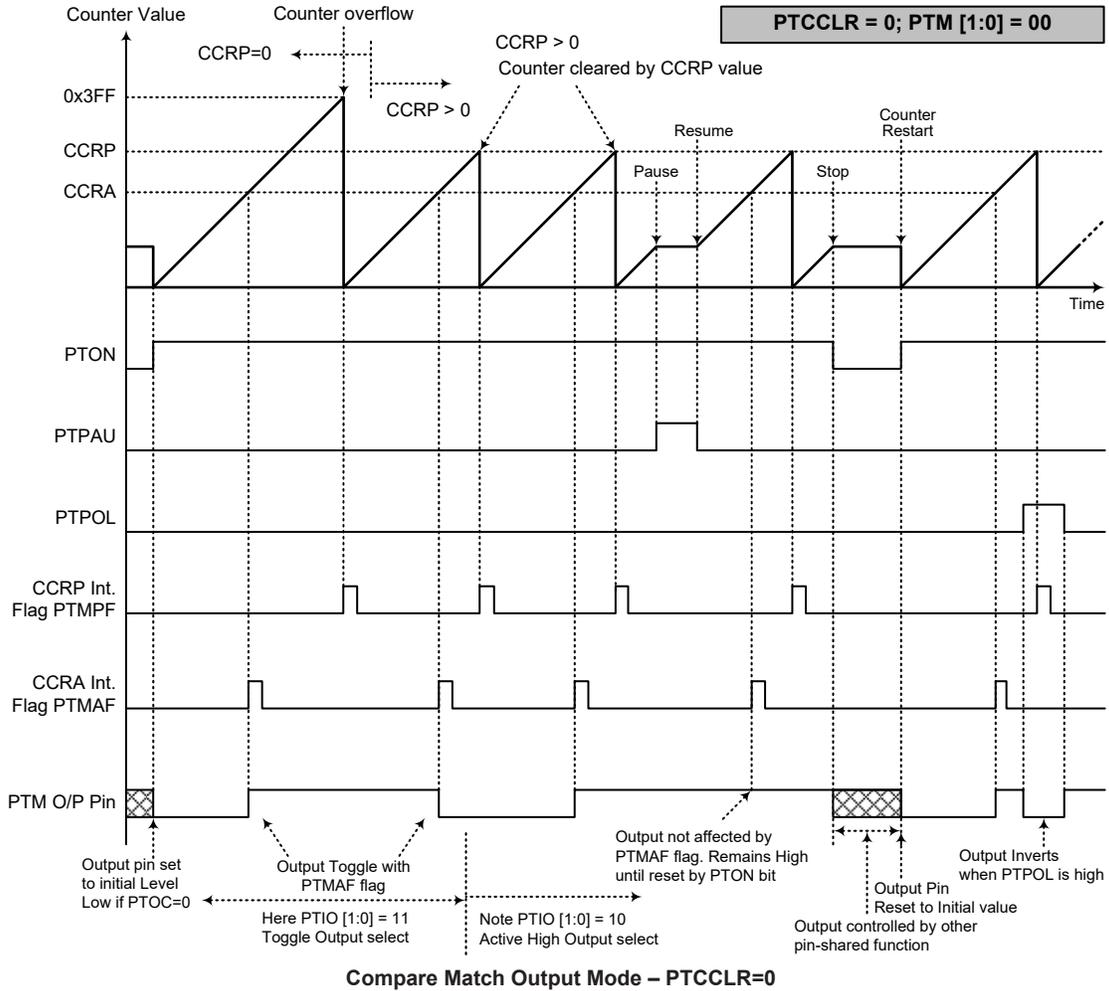
Compare Match Output Mode – PTCCLR=0

Note: 1. With PTCCLR=0 a Comparator P match will clear the counter

2. The PTM output pin is controlled only by the PTMAF flag

3. The output pin is reset to its initial state by a PTON bit rising edge
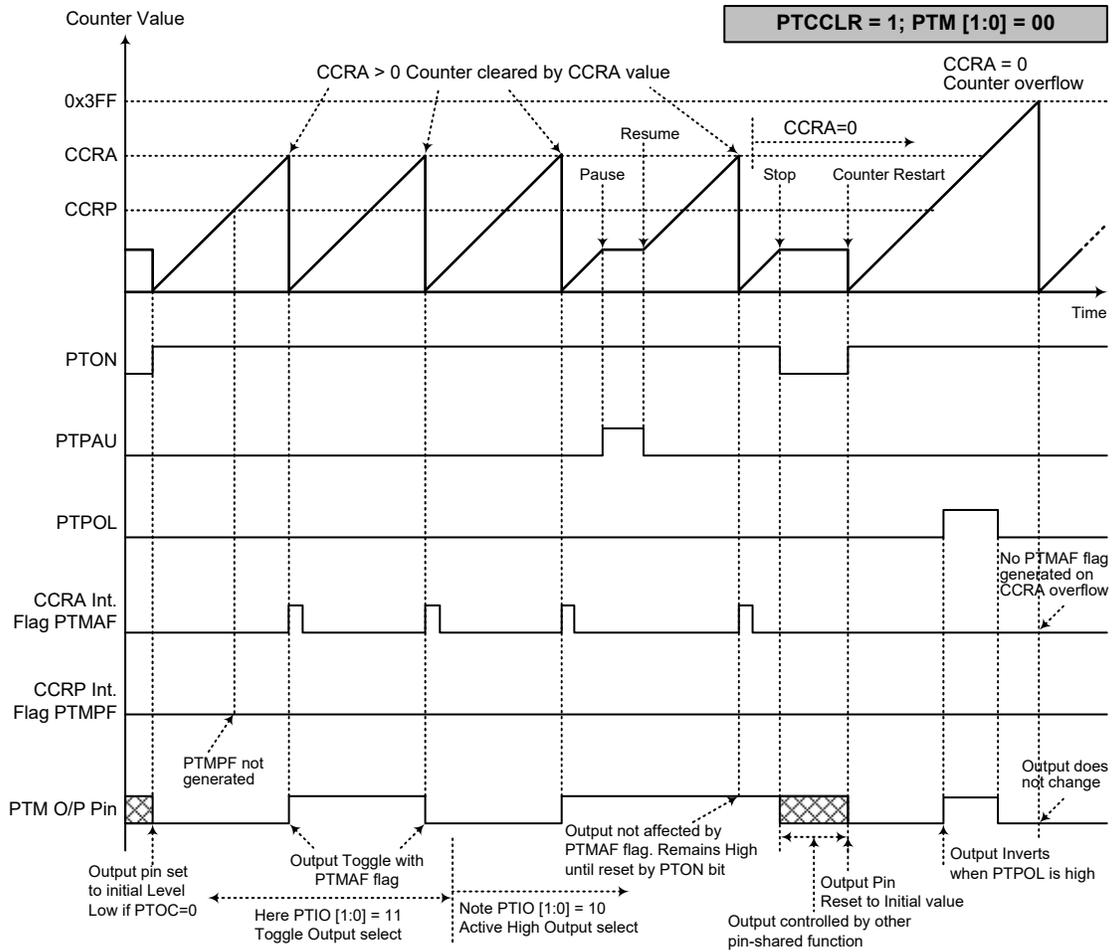
Compare Match Output Mode – PTCCLR=1

Note: 1. With PTCCLR=1 a Comparator A match will clear the counter

2. The PTM output pin is controlled only by the PTMAF flag

3. The output pin is reset to its initial state by a PTON bit rising edge

4. A PTMPF flag is not generated when PTCCLR=1

Timer/Counter Mode

To select this mode, bits PTM1 and PTM0 in the PTMC1 register should be set to 11 respectively. The Timer/Counter Mode operates in an identical way to the Compare Match Output Mode generating the same interrupt flags. The exception is that in the Timer/Counter Mode the PTM output pin is not used. Therefore the above description and Timing Diagrams for the Compare Match Output Mode can be used to understand its function. As the PTM output pin is not used in this mode, the pin can be used as a normal I/O pin or other pin-shared function.

PWM Output Mode

To select this mode, bits PTM1 and PTM0 in the PTMC1 register should be set to 10 respectively. The PWM function within the PTM is useful for applications which require functions such as motor control, heating control, illumination control etc. By providing a signal of fixed frequency but of varying duty cycle on the PTM output pin, a square wave AC waveform can be generated with varying equivalent DC RMS values.

As both the period and duty cycle of the PWM waveform can be controlled, the choice of generated waveform is extremely flexible. In the PWM Output Mode, the PTCCLR bit has no effect on the PWM operation. Both of the CCRA and CCRP registers are used to generate the PWM waveform, the CCRP is used to clear the internal counter and thus control the PWM waveform frequency, while the CCRA is used to control the duty cycle. The PWM waveform frequency and duty cycle can therefore be controlled by the values in the CCRP and CCRA registers.

An interrupt flag, one for each of the CCRA and CCRP, will be generated when a compare match occurs from either Comparator A or Comparator P. The PTOC bit in the PTMC1 register is used to select the required polarity of the PWM waveform while the two PTIO1 and PTIO0 bits are used to enable the PWM output or to force the PTM output pin to a fixed high or low level. The PTPOL bit is used to reverse the polarity of the PWM output waveform.

• **10-bit PTM, PWM Output Mode, Edge-aligned Mode**

CCRP	1~1023	0
Period	1~1023	1024
Duty	CCRA	

If f_{SYS}=16MHz, PTM clock source select f_{SYS}/4, CCRP=512 and CCRA=128,

The PTM PWM output frequency=(f_{SYS}/4)/512=f_{SYS}/2048=7.8125kHz, duty=128/512=25%.

If the Duty value defined by the CCRA register is equal to or greater than the Period value, then the PWM output duty is 100%.
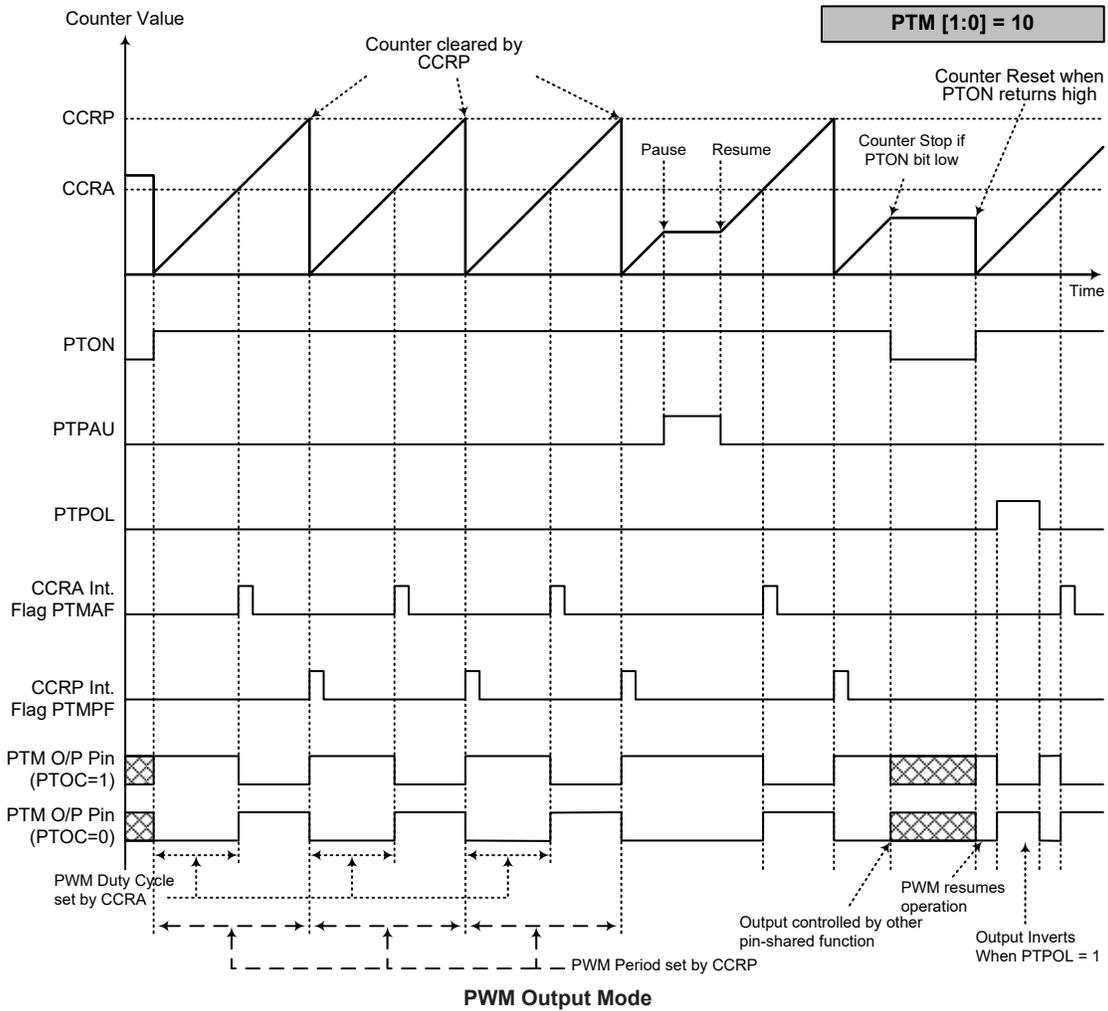
PWM Output Mode

Note: 1. Counter cleared by CCRP

2. A counter clear sets PWM Period

3. The internal PWM function continues running even when PTIO[1:0]=00 or 01

4. The PTCCLR bit has no influence on PWM operation

Single Pulse Output Mode

To select this mode, bits PTM1 and PTM0 in the PTMC1 register should be set to 10 respectively and also the PTIO1 and PTIO0 bits should be set to 11 respectively. The Single Pulse Output Mode, as the name suggests, will generate a single shot pulse on the PTM output pin.

The trigger for the pulse output leading edge is a low to high transition of the PTON bit, which can be implemented using the application program. However in the Single Pulse Output Mode, the PTON bit can also be made to automatically change from low to high using the external PTCK pin, which will in turn initiate the Single Pulse output. When the PTON bit transitions to a high level, the counter will start running and the pulse leading edge will be generated. The PTON bit should remain high when the pulse is in its active state. The generated pulse trailing edge will be generated when the PTON bit is cleared to zero, which can be implemented using the application program or when a compare match occurs from Comparator A.

However a compare match from Comparator A will also automatically clear the PTON bit and thus generate the Single Pulse output trailing edge. In this way the CCRA value can be used to control the pulse width. A compare match from Comparator A will also generate a PTM interrupt. The counter can only be reset back to zero when the PTON bit changes from low to high when the counter restarts. In the Single Pulse Output Mode CCRP is not used. The PTCCLR bit is not used in this Mode.

Single Pulse Generation
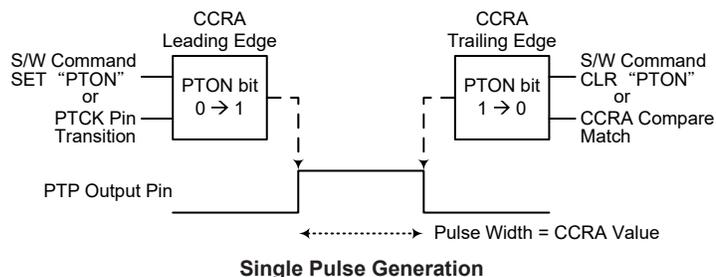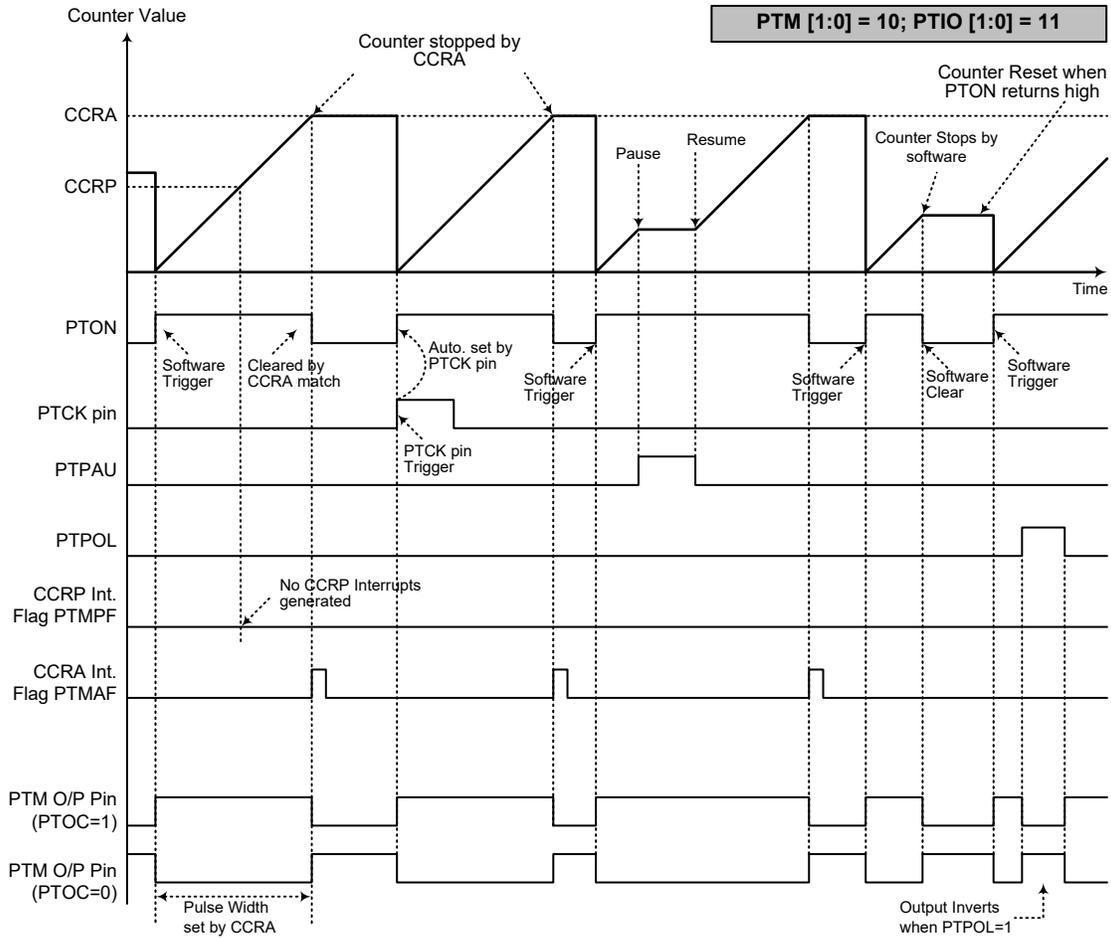
Single Pulse Output Mode

Note: 1. Counter stopped by CCRA

2. CCRP is not used

3. The pulse is triggered by the PTCK pin or by setting the PTON bit high

4. A PTCK pin active edge will automatically set the PTON bit high

5. In the Single Pulse Output Mode, PTIO[1:0] must be set to "11" and cannot be changed.

Capture Input Mode

To select this mode bits PTM1 and PTM0 in the PTMC1 register should be set to 01 respectively. This mode enables external signals to capture and store the present value of the internal counter and can therefore be used for applications such as pulse width measurements. The external signal is supplied on the PTPI or PTCK pin which is selected using the PTCAPTS bit in the PTMC1 register. The input pin active edge can be either a rising edge, a falling edge or both rising and falling edges; the active edge transition type is selected using the PTIO1 and PTIO0 bits in the PTMC1 register. The counter is started when the PTON bit changes from low to high which is initiated using the application program.

When the required edge transition appears on the PTPI or PTCK pin the present value in the counter will be latched into the CCRA registers and a PTM interrupt generated. Irrespective of what events occur on the PTPI or PTCK pin, the counter will continue to free run until the PTON bit changes from high to low. When a CCRP compare match occurs the counter will reset back to zero; in this way the CCRP value can be used to control the maximum counter value. When a CCRP compare match occurs from Comparator P, a PTM interrupt will also be generated. Counting the number of overflow interrupt signals from the CCRP can be a useful method in measuring long pulse widths. The PTIO1 and PTIO0 bits can select the active trigger edge on the PTPI or PTCK pin to be a rising edge, falling edge or both edge types. If the PTIO1 and PTIO0 bits are both set high, then no capture operation will take place irrespective of what happens on the PTPI or PTCK pin, however it must be noted that the counter will continue to run.

There are some considerations that should be noted. If PTCK is used as the capture input source, then it cannot be selected as the PTM clock source. If the captured pulse width is less than 2 timer clock periods, it may be ignored by hardware. After the counter value is latched to the CCRA registers by an active capture edge, the PTMAF flag will be set high after 0.5 timer clock periods. The delay time from the active capture edge received to the action of latching counter value to CCRA registers is less than 1.5 timer clock periods. The PTCCLR, PTOC and PTPOL bits are not used in this Mode.
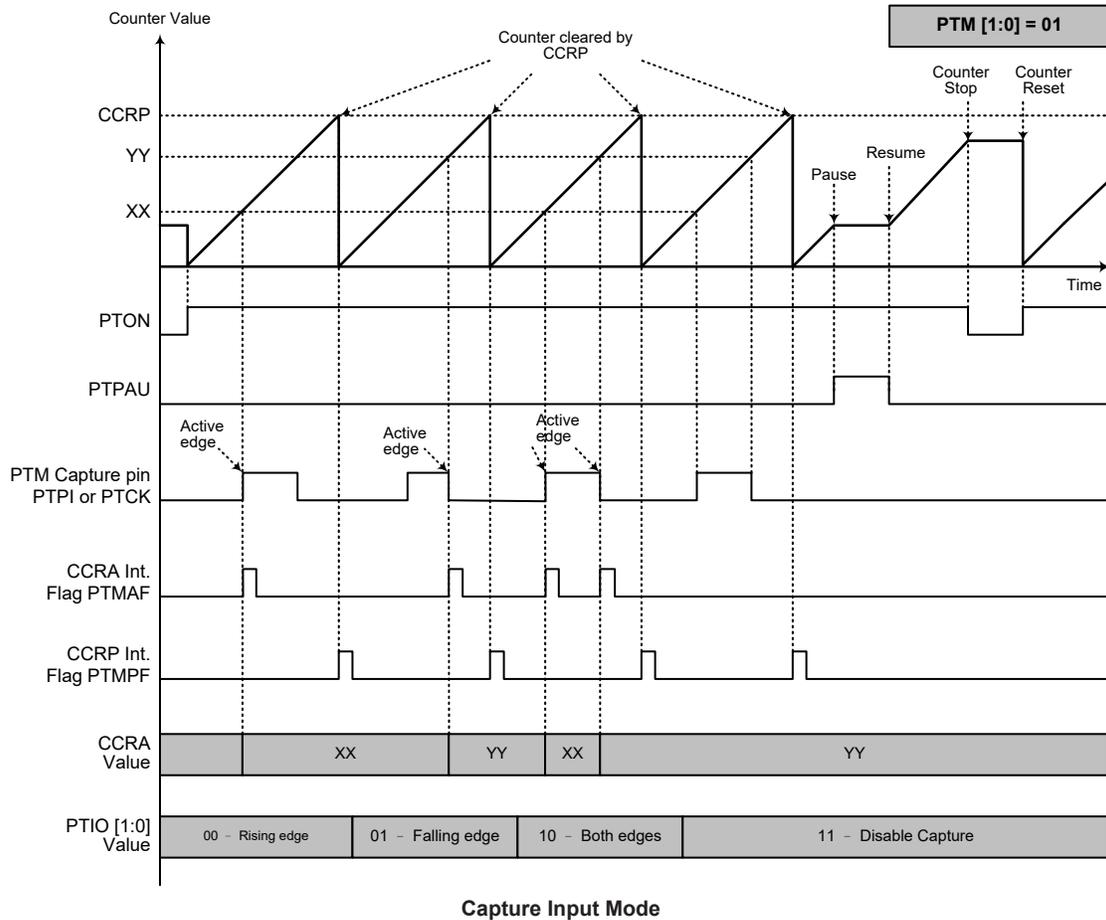
Capture Input Mode

Note: 1. PTM[1:0]=01 and active edge set by the PTIO[1:0] bits

2. A PTM Capture input pin active edge transfers the counter value to CCRA

3. PTCCLR bit not used

4. No output function – PTOC and PTPOL bits are not used

5. CCRP determines the counter value and the counter has a maximum count value when CCRP is equal to zero.

Analog to Digital Converter – ADC

The need to interface to real world analog signals is a common requirement for many electronic systems. However, to properly process these signals by a microcontroller, they must first be converted into digital signals by A/D converters. By integrating the A/D conversion electronic circuitry into the microcontroller, the need for external components is reduced significantly with the corresponding follow-on benefits of lower costs and reduced component space requirements.

A/D Converter Overview

The device contains a multi-channel analog to digital converter which can directly interface to external analog signals, such as that from sensors or other control signals and convert these signals directly into a 12-bit digital value. It also can convert the internal signals, such as the internal reference voltage, into a 12-bit digital value. The external or internal analog signal to be converted is determined by the SAINS and SACS bit fields. Note that when the internal analog signal is selected to be converted using the SAINS field, the external channel analog input will automatically be switched off. More detailed information about the A/D input signal selection will be described in the "A/D Converter Input Signals" section.

The accompanying block diagram shows the internal structure of the A/D converter with its associated registers and control bits.

External Input Channels	Internal Signal	A/D Signal Select
AN0~AN7	V_{DD}, $V_{DD}/2$, $V_{DD}/4$, V_R, $V_R/2$, $V_R/4$,	SAINS3~SAINS0 SACS3~SACS0

A/D Converter Structure
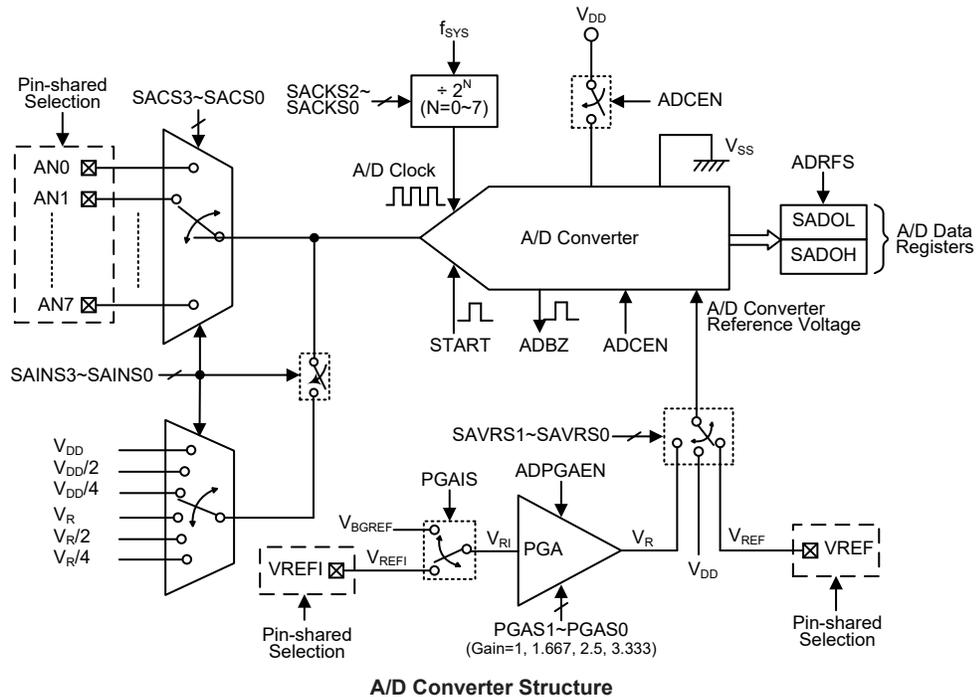
Registers Descriptions

Overall operation of the A/D converter is controlled using six registers. A read only register pair exists to store the A/D Converter data 12-bit value. Three registers, SADC0, SADC1 and SADC2, are the control registers which setup the operating conditions and control function of the A/D converter. The VBGRC register contains the VBGREN bit to control the bandgap reference voltage.

Register Name	Bit							
	7	6	5	4	3	2	1	0
SADOL (ADRFS=0)	D3	D2	D1	D0	—	—	—	—
SADOL (ADRFS=1)	D7	D6	D5	D4	D3	D2	D1	D0
SADOH (ADRFS=0)	D11	D10	D9	D8	D7	D6	D5	D4
SADOH (ADRFS=1)	—	—	—	—	D11	D10	D9	D8
SADC0	START	ADBZ	ADCEN	ADRFS	SACS3	SACS2	SACS1	SACS0
SADC1	SAINS3	SAINS2	SAINS1	SAINS0	—	SACKS2	SACKS1	SACKS0
SADC2	ADPGAEN	—	—	PGAIS	SAVRS1	SAVRS0	PGAGS1	PGAGS0
VBGRC	—	—	—	—	—	—	—	VBGREN

A/D Converter Register List

A/D Converter Data Registers – SADOL, SADOH

As the device contains an internal 12-bit A/D converter, it requires two data registers to store the converted value. These are a high byte register, known as SADOH, and a low byte register, known as SADOL. After the conversion process takes place, these registers can be directly read by the microcontroller to obtain the digitised conversion value. As only 12 bits of the 16-bit register space is utilised, the format in which the data is stored is controlled by the ADRFS bit in the SADC0 register as shown in the accompanying table. D0~D11 are the A/D conversion result data bits. Any unused bits will be read as zero. The A/D data registers contents will be unchanged if the A/D converter is disabled.

ADRFS	SADOH								SADOL							
	7	6	5	4	3	2	1	0	7	6	5	4	3	2	1	0
0	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0	0	0	0	0
1	0	0	0	0	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0

A/D Converter Data Registers

A/D Converter Control Registers – SADC0, SADC1, SADC2

To control the function and operation of the A/D converter, three control registers known as SADC0, SADC1 and SADC2 are provided. These 8-bit registers define functions such as the selection of which analog signal is connected to the internal A/D converter, the digitised data format, the A/D clock source as well as controlling the start function and monitoring the A/D converter busy status. As the device contains only one actual analog to digital converter hardware circuit, each of the external and internal analog signals must be routed to the converter. The SAINS field in the SADC1 register and SACS field in the SADC0 register are used to determine which analog signal derived from the external or internal signals will be connected to the A/D converter. The A/D converter also contains a programmable gain amplifier, PGA, to generate the A/D converter internal reference voltage. The overall operation of the PGA is controlled using the SADC2 register.

The relevant pin-shared function selection bits determine which pins on I/O Ports are used as analog inputs for the A/D converter input and which pins are not. When the pin is selected to be an A/D input, its original function whether it is an I/O or other pin-shared function will be removed. In addition, any internal pull-high resistor connected to the pin will be automatically removed if the pin is selected to be an A/D converter input.

• **SADC0 Register**

Bit	7	6	5	4	3	2	1	0
Name	START	ADBZ	ADCEN	ADRFS	SACS3	SACS2	SACS1	SACS0
R/W	R/W	R	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7　　**START**: Start the A/D Conversion
　　　　　0→1→0: Start
　　　　This bit is used to initiate an A/D conversion process. The bit is normally low but if set high and then cleared low again, the A/D converter will initiate a conversion process.

Bit 6　　**ADBZ**: A/D Converter busy flag
　　　　　0: No A/D conversion is in progress
　　　　　1: A/D conversion is in progress
　　　　This read only flag is used to indicate whether the A/D conversion is in progress or not. When the START bit is set from low to high and then to low again, the ADBZ flag will be set to 1 to indicate that the A/D conversion is initiated. The ADBZ flag will be cleared to 0 after the A/D conversion is complete.

Bit 5　　**ADCEN**: A/D Converter function enable control
　　　　　0: Disable
　　　　　1: Enable
　　　　This bit controls the A/D internal function. This bit should be set to one to enable the A/D converter. If the bit is set low, then the A/D converter will be switched off reducing the device power consumption. When the A/D converter function is disabled, the contents of the A/D data register pair known as ADRH and ADRL will be unchanged.

Bit 4　　**ADRFS**: A/D conversion data format select
　　　　　0: A/D converter data format → SADOH=D [11:4]; SADOL=D [3:0]
　　　　　1: A/D converter data format → SADOH=D [11:8]; SADOL=D [7:0]
　　　　This bit controls the format of the 12-bit converted A/D value in the two A/D data registers. Details are provided in the A/D converter data register section.

Bit 3~0　**SACS3~SACS0**: A/D converter external analog input channel select
　　　　　0000: External AN0 input
　　　　　0001: External AN1 input
　　　　　0010: External AN2 input
　　　　　0011: External AN3 input
　　　　　0100: External AN4 input
　　　　　0101: External AN5 input
　　　　　0110: External AN6 input
　　　　　0111: External AN7 input
　　　　　1000~1111: Non-existed channel, the input will be floating

• **SADC1 Register**

Bit	7	6	5	4	3	2	1	0
Name	SAINS3	SAINS2	SAINS1	SAINS0	—	SACKS2	SACKS1	SACKS0
R/W	R/W	R/W	R/W	R/W	—	R/W	R/W	R/W
POR	0	0	0	0	—	0	0	0

Bit 7~4   **SAINS3~SAINS0**: A/D converter input signal select

     0000: External source – External analog channel intput, ANn
     0001: Internal source – Internal signal derived from V_{DD}
     0010: Internal source – Internal signal derived from $V_{DD}/2$
     0011: Internal source – Internal signal derived from $V_{DD}/4$
     0100: External source – External analog channel intput, ANn
     0101: Internal source – Internal signal derived from PGA output V_R
     0110: Internal source – Internal signal derived from PGA output $V_R/2$
     0111: Internal source – Internal signal derived from PGA output $V_R/4$
     10xx: Internal source – Ground
     11xx: External source – External analog channel intput, ANn

     When the internal analog signal is selected to be converted, the external channel signal input will automatically be switched off regardless of the SACS field value. It will prevent the external channel input from being connected together with the internal analog signal.

Bit 3   Unimplemented, read as "0"

Bit 2~0   **SACKS2~SACKS0**: A/D conversion clock source select

     000: f_{SYS}
     001: $f_{SYS}/2$
     010: $f_{SYS}/4$
     011: $f_{SYS}/8$
     100: $f_{SYS}/16$
     101: $f_{SYS}/32$
     110: $f_{SYS}/64$
     111: $f_{SYS}/128$

• **SADC2 Register**

Bit	7	6	5	4	3	2	1	0
Name	ADPGAEN	—	—	PGAIS	SAVRS1	SAVRS0	PGAGS1	PGAGS0
R/W	R/W	—	—	R/W	R/W	R/W	R/W	R/W
POR	0	—	—	0	0	0	0	0

Bit 7   **ADPGAEN**: PGA enable control
     0: Disable
     1: Enable

Bit 6~5   Unimplemented, read as "0"

Bit 4   **PGAIS**: PGA input voltage selection
     0: From VREFI pin
     1: From internal reference voltage V_{BGREF}

     When the internal independent reference voltage V_{BGREF} is selected as the PGA input, the external reference voltage on the VREFI pin will be automatically switched off. In addition, the internal bandgap reference V_{BGREF} should be enabled by setting the VBGREN bit in the VBGRC register to "1".

Bit 3~2   **SAVRS1~SAVRS0**: A/D converter reference voltage select
     00: Internal A/D converter power, V_{DD}.
     01: External VREF pin
     1x: Internal PGA output voltage, V_R.

     These bits are used to select the A/D converter reference voltage source. When the internal reference voltage source is selected, the reference voltage derived from the external VREF pin will automatically be switched off.

Bit 1~0 **PGAGS1~PGAGS0**: PGA gain select

    00: Gain=1

    01: Gain=1.667 – V_R=2V as V_{RI}=1.2V

    10: Gain=2.5 – V_R=3V as V_{RI}=1.2V

    11: Gain=3.333 – V_R=4V as V_{RI}=1.2V

These bits are used to select the PGA gain. Note that here the gain is guaranteed only when the PGA input voltage is equal to 1.2V.

• **VBGRC Register**

Bit	7	6	5	4	3	2	1	0
Name	—	—	—	—	—	—	—	VBGREN
R/W	—	—	—	—	—	—	—	R/W
POR	—	—	—	—	—	—	—	0

Bit 7~1 Unimplemented, read as "0"

Bit 0 **VBGREN**: Bandgap reference voltage control

    0: Disable

    1: Enable

This bit is used to enable the internal Bandgap reference circuit. The internal Bandgap reference circuit should first be enabled before the V_{BGREF} voltage is selected to be used. A specific start-up time is necessary for the Bandgap circuit to become stable and accurate.

A/D Converter Reference Voltage

The actual reference voltage supply to the A/D Converter can be supplied from the positive power supply, V_{DD}, an external reference source supplied on pin VREF or an internal reference voltage V_R determined by the SAVRS1~SAVRS0 bits in the SADC2 register. The internal reference voltage is amplified through a programmable gain amplifier, PGA, which is controlled by the ADPGAEN bit in the SADC2 register. The PGA gain can be equal to 1, 1.667, 2.5 or 3.333 and selected using the PGAGS1~PGAGS0 bits in the SADC2 register. The PGA input can come from the external reference input pin, VREFI, or an internal Bandgap reference voltage, V_{BGREF}, selected by the PGAIS bit in the SADC2 register. As the VREFI and VREF pins both are pin-shared with other functions, when the VREFI or VREF pin is selected as the reference voltage pin, the VREFI or VREF pin-shared function selection bits should first be properly configured to disable other pin-shared functions. However, if the internal reference signal is selected as the reference source, the external reference input from the VREFI or VREF pin will automatically be switched off by hardware.

Note that the internal Bandgap reference circuit should first be enabled before the V_{BGREF} is selected to be used. A specific start-up time is necessary for the Bandgap circuit to become stable and accurate.

A/D Converter Input Signals

All of the external A/D analog input pins are pin-shared with the I/O pins as well as other functions. The corresponding pin-shared function selection bits in the PxS1 and PxS0 registers, determine whether the external input pins are setup as A/D converter analog channel inputs or whether they have other functions. If the corresponding pin is setup to be an A/D converter analog channel input, the original pin function will be disabled. In this way, pins can be changed under program control to change their function between A/D inputs and other functions. All pull-high resistors, which are setup through register programming, will be automatically disconnected if the pins are setup as A/D inputs. Note that it is not necessary to first setup the A/D pin as an input in the port control register to enable the A/D input as when the relevant A/D input function selection bits enable an A/D input, the status of the port control register will be overridden.

As the device contains only one actual analog to digital converter hardware circuit, each of the external and internal analog signals must be routed to the converter. The SAINS3~SAINS0 bits in the SADC1 register are used to determine that the analog signal to be converted comes from the external channel input or internal analog signal. The SACS3~SACS0 bits in the SADC0 register are used to determine which external channel input is selected to be converted. If the SAINS3~SAINS0 bits are set to "0000", "0100" or "11xx", the external channel input will be selected to be converted and the SACS3~SACS0 bits can determine which external channel is selected.

When the SAINS field is set to the value of "0x01", "0x10" or "0x11", the internal analog signal will be selected. If the internal analog signal is selected to be converted, the external channel signal input will automatically be switched off regardless of the SACS field value. It will prevent the external channel input from being connected together with the internal analog signal.

SAINS [3:0]	SACS [3:0]	Input Signals	Description
0000, 0100, 11xx	0000~0111	AN0~AN7	External channel analog input ANn
	1000~1111	—	Non-existed channel, input is floating.
0001	xxxx	V_{DD}	Internal signal derived from V_{DD}
0010	xxxx	$V_{DD}/2$	Internal signal derived from $V_{DD}/2$
0011	xxxx	$V_{DD}/4$	Internal signal derived from $V_{DD}/4$
0101	xxxx	V_R	Internal signal derived from PGA output V_R
0110	xxxx	$V_R/2$	Internal signal derived from PGA output $V_R/2$
0111	xxxx	$V_R/4$	Internal signal derived from PGA output $V_R/4$
10xx	xxxx	GND	Connected to the ground

A/D Converter Input Signal Selection

A/D Conversion Operation

The START bit in the SADC0 register is used to start the AD conversion. When the microcontroller sets this bit from low to high and then low again, an analog to digital conversion cycle will be initiated.

The ADBZ bit in the SADC0 register is used to indicate whether the analog to digital conversion process is in progress or not. This bit will be automatically set to 1 by the microcontroller after an A/D conversion is successfully initiated. When the A/D conversion is complete, the ADBZ bit will be cleared to 0. In addition, the corresponding A/D interrupt request flag will be set in the interrupt control register, and if the interrupts are enabled, an internal interrupt signal will be generated. This A/D internal interrupt signal will direct the program flow to the associated A/D internal interrupt address for processing. If the A/D internal interrupt is disabled, the microcontroller can poll the ADBZ bit in the SADC0 register to check whether it has been cleared as an alternative method of detecting the end of an A/D conversion cycle.

The clock source for the A/D converter, which originates from the system clock f_{SYS}, can be chosen to be either f_{SYS} or a subdivided version of f_{SYS}. The division ratio value is determined by the SACKS2~SACKS0 bits in the SADC1 register. Although the A/D clock source is determined by the system clock f_{SYS} and by bits SACKS2~SACKS0, there are some limitations on the maximum A/D clock source speed that can be selected. As the recommended range of permissible A/D clock period, t_{ADCK}, is from 0.5μs to 10μs, care must be taken for system clock frequencies. For example, if the system clock operates at a frequency of 4MHz, the SACKS2~SACKS0 bits should not be set to 000, 001 or 111. Doing so will give A/D clock periods that are less than the minimum A/D clock period or greater than the maximum A/D clock period which may result in inaccurate A/D conversion values. Refer to the following table for examples, where values marked with an asterisk * show where, special care must be taken.

f_{SYS}	A/D Clock Period (t_{ADCK})							
	SACKS[2:0]=000 (f_{SYS})	SACKS[2:0]=001 (f_{SYS}/2)	SACKS[2:0]=010 (f_{SYS}/4)	SACKS[2:0]=011 (f_{SYS}/8)	SACKS[2:0]=100 (f_{SYS}/16)	SACKS[2:0]=101 (f_{SYS}/32)	SACKS[2:0]=110 (f_{SYS}/64)	SACKS[2:0]=111 (f_{SYS}/128)
1 MHz	1µs	2µs	4µs	8µs	16µs*	32µs*	64µs*	128µs*
2 MHz	500ns	1µs	2µs	4µs	8µs	16µs*	32µs*	64µs*
4 MHz	250ns*	500ns	1µs	2µs	4µs	8µs	16µs*	32µs*

A/D Clock Period Examples

Controlling the power on/off function of the A/D converter circuitry is implemented using the ADCEN bit in the SADC0 register. This bit must be set high to power on the A/D converter. When the ADCEN bit is set high to power on the A/D converter internal circuitry, a certain delay as indicated in the timing diagram must be allowed before an A/D conversion is initiated. Even if no pins are selected for use as A/D inputs, if the ADCEN bit is high, then some power will still be consumed. In power conscious applications it is therefore recommended that the ADCEN is set low to reduce power consumption when the A/D converter function is not being used.

Conversion Rate and Timing Diagram

A complete A/D conversion contains two parts, data sampling and data conversion. The data sampling which is defined as t_{ADS} takes 4 A/D clock periods and the data conversion takes 12 A/D clock periods. Therefore a total of 16 A/D clock periods for an analog signal A/D conversion which is defined as t_{ADC} are necessary.

$$\text{Maximum single A/D conversion rate} = 1/(\text{A/D clock period} \times 16)$$

The accompanying diagram shows graphically the various stages involved in an external channel input signal analog to digital conversion process and its associated timing. After an A/D conversion process has been initiated by the application program, the microcontroller internal hardware will begin to carry out the conversion, during which time the program can continue with other functions. The time taken for the A/D conversion is 16 t_{ADCK} where t_{ADCK} is equal to the A/D clock period.
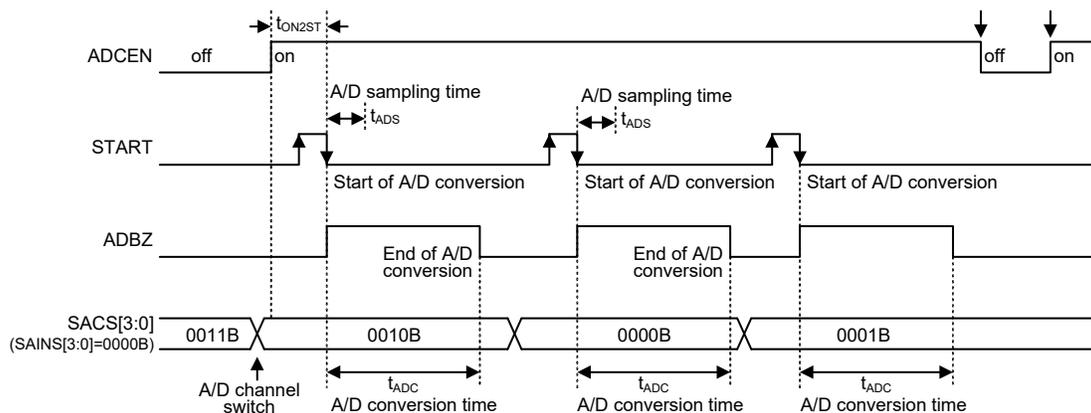
A/D Conversion Timing — External Channel Input

Summary of A/D Conversion Steps

The following summarises the individual steps that should be executed in order to implement an A/D conversion process.

- Step 1

    Select the required A/D conversion clock by properly programming the SACKS2~SACKS0 bits in the SADC1 register.

- Step 2

    Enable the A/D converter by setting the ADCEN bit in the SADC0 register to one.

- Step 3

    Select which signal is to be connected to the internal A/D converter by correctly configuring the SACS and SAINS bit fields

    Selecting the external channel input to be converted, go to Step 4.

    Selecting the internal analog signal to be converted, go to Step 5.

- Step 4

    If the SAINS field is 0000, 0100 or 11xx, the external channel input can be selected. The desired external channel input is selected by configuring the SACS field. When the A/D input signal comes from the external channel input, the corresponding pin should be configured as an A/D input function by selecting the relevant pin-shared function control bits. Then go to Step 6.

- Step 5

    If the SAINS field is set to 0x01, 0x10 or 0x11, the relevant internal analog signal will be selected. When the internal analog signal is selected to be converted, the external channel analog input will automatically be disconnected. Then go to Step 6.

- Step 6

    Select the A/D converter output data format by configuring the ADRFS bit.

- Step 7

    Select the A/D converter reference voltage source by configuring the SAVRS bit field.

    Select the PGA input signal and the desired PGA gain if the PGA output voltage, V_R, is selected as the A/D converter reference voltage.

- Step 8

    If A/D conversion interrupt is used, the interrupt control registers must be correctly configured to ensure the A/D interrupt function is active. The master interrupt control bit, EMI, and the A/D conversion interrupt control bit, ADE, must both be set high in advance.

- Step 9

    The A/D conversion procedure can now be initialized by setting the START bit from low to high and then low again.

- Step 10

    If A/D conversion is in progress, the ADBZ flag will be set high. After the A/D conversion process is complete, the ADBZ flag will go low and then the output data can be read from SADOH and SADOL registers.

Note: When checking for the end of the conversion process, if the method of polling the ADBZ bit in the SADC0 register is used, the interrupt enable step above can be omitted.

Programming Considerations

During microcontroller operations where the A/D converter is not being used, the A/D internal circuitry can be switched off to reduce power consumption, by setting bit ADCEN low in the SADC0 register. When this happens, the internal A/D converter circuits will not consume power irrespective of what analog voltage is applied to their input lines. If the A/D converter input lines are used as normal I/Os, then care must be taken as if the input voltage is not at a valid logic level, then this may lead to some increase in power consumption.

A/D Transfer Function

As the device contains a 12-bit A/D converter, its full-scale converted digitised value is equal to FFFH. Since the full-scale analog input value is equal to the actual A/D converter reference voltage, V_{REF}, this gives a single bit analog input value of reference voltage value divided by 4096.

$$1 \text{ LSB} = V_{REF} / 4096$$

The A/D Converter input voltage value can be calculated using the following equation:

$$\text{A/D input voltage} = \text{A/D output digital value} \times V_{REF} / 4096$$

The diagram shows the ideal transfer function between the analog input value and the digitised output value for the A/D converter. Except for the digitised zero value, the subsequent digitised values will change at a point 0.5 LSB below where they would change without the offset, and the last full scale digitised value will change at a point 1.5 LSB below the V_{REF} level.

Note that here the V_{REF} voltage is the actual A/D converter reference voltage determined by the SAVRS field.

Ideal A/D Transfer Function
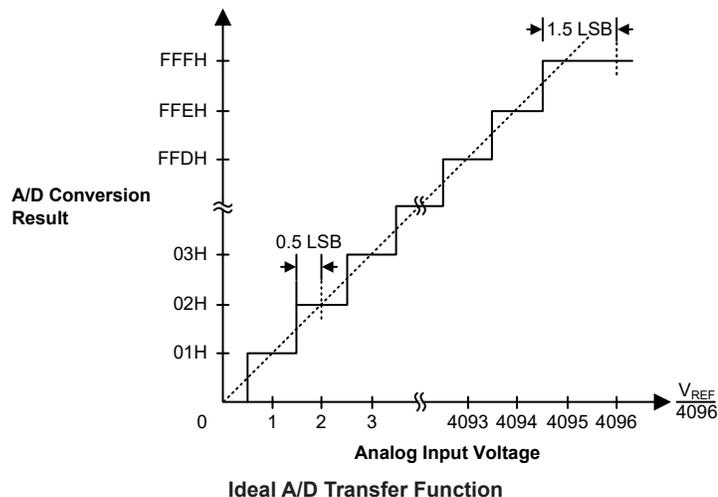
A/D Programming Examples

The following two programming examples illustrate how to setup and implement an A/D conversion. In the first example, the method of polling the ADBZ bit in the SADC0 register is used to detect when the conversion cycle is complete, whereas in the second example, the A/D interrupt is used to determine when the conversion is complete.

Example: using an ADBZ polling method to detect the end of conversion

```
clr ADE             ; disable ADC interrupt
mov a,03H           ; select fSYS/8 as A/D clock and A/D input
mov SADC1,a         ; signal comes from external channel
mov a,00H           ; select VDD as the A/D reference voltage source
```

```
            mov SADC2,a
            mov a,02H              ; setup PES0 to configure pin AN0
            mov PES0,a
            mov a,20H              ; enable A/D converter and select AN0 as the A/D external channel
            input
            mov SADC0,a
            :
start_conversion:
            clr START              ; high pulse on start bit to initiate conversion
            set START              ; reset A/D
            clr START              ; start A/D
            :
polling_EOC:
            sz  ADBZ               ; poll the SADC0 register ADBZ bit to detect end of A/D conversion
            jmp polling_EOC        ; continue polling
            :
            mov a,SADOL            ; read low byte conversion result value
            mov SADOL_buffer,a     ; save result to user defined register
            mov a,SADOH            ; read high byte conversion result value
            mov SADOH_buffer,a     ; save result to user defined register
            :
            jmp start_conversion   ; start next A/D conversion
```

Example: using the interrupt method to detect the end of conversion

```
            clr ADE                ; disable ADC interrupt
            mov a,03H              ; select fSYS/8 as A/D clock and A/D input
            mov SADC1,a            ; signal comes from external channel
            mov a,00H              ; select VDD as the A/D reference voltage source
            mov SADC2,a
            mov a,02h              ; setup PES0 to configure pin AN0
            mov PES0,a
            mov a,20h
            mov SADC0,a            ; enable A/D converter and select AN0 as the A/D external channel input
            :
Start_conversion:
            clr START              ; high pulse on START bit to initiate conversion
            set START              ; reset A/D
            clr START              ; start A/D
            clr ADF                ; clear ADC interrupt request flag
            set ADE                ; enable ADC interrupt
            set EMI                ; enable global interrupt
            :
            :
ADC_ISR:                           ; ADC interrupt service routine
            mov acc_stack,a        ; save ACC to user defined memory
            mov a,STATUS
            mov status_stack,a     ; save STATUS to user defined memory
            :
            mov a,SADOL            ; read low byte conversion result value
            mov SADOL_buffer,a     ; save result to user defined register
            mov a,SADOH            ; read high byte conversion result value
            mov SADOH_buffer,a     ; save result to user defined register
            :
EXIT_INT_ISR:
            mov a,status_stack
            mov STATUS,a           ; restore STATUS from user defined memory
            mov a,acc_stack        ; restore ACC from user defined memory
            reti
```

UART Interface

The device contains two integrated full-duplex or half-duplex asynchronous serial communications UART interface that enables communication with external devices that contain a serial interface. The UART function has many features and can transmit and receive data serially by transferring a frame of data with eight or nine data bits per transmission as well as being able to detect errors when the data is overwritten or incorrectly framed. The UART function possesses its own internal interrupt which can be used to indicate when a reception occurs or when a transmission terminates.

The integrated UART function contains the following features:

- Full-duplex or half-duplex (single wire mode) asynchronous communication

- 8 or 9 bits character length

- Even, odd or no parity options

- One or two stop bits

- Baud rate generator with 8-bit prescaler

- Parity, framing, noise and overrun error detection

- Support for interrupt on address detect (last character bit=1)

- Separately enabled transmitter and receiver

- 2-byte Deep FIFO Receive Data Buffer

- RX/TX pin wake-up function

- Transmit and receive interrupts

- Interrupts can be triggered by the following conditions:
    - Transmitter Empty
    - Transmitter Idle
    - Receiver Full
    - Receiver Overrun
    - Address Mode Detect
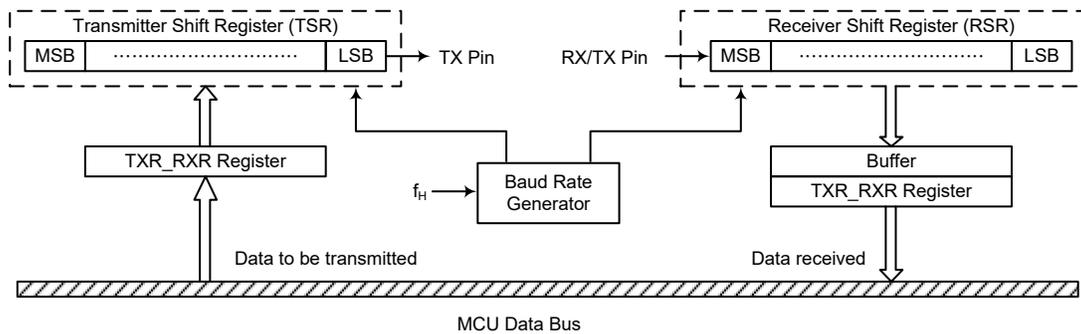
UART Data Transfer Block Diagram – SWM=0
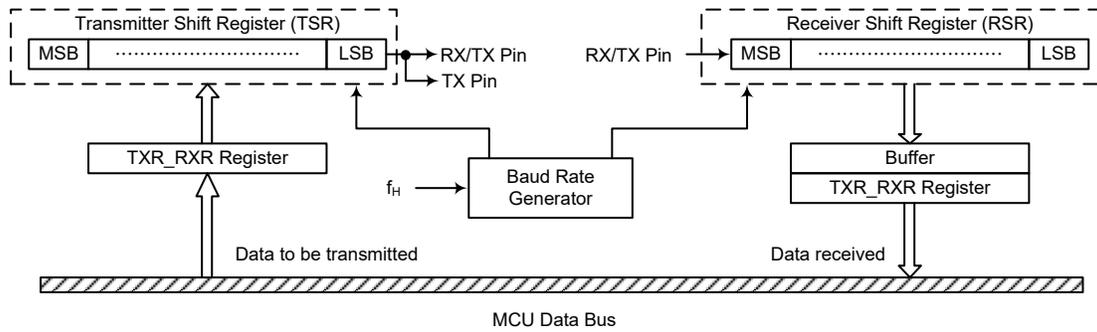
UART Data Transfer Block Diagram – SWM=1

UART External Pins

To communicate with an external serial interface, the internal UART has two external pins known as TX and RX/TX, which are pin-shared with I/O or other pin functions. The TX and RX/TX pin function should first be selected by the pin-shared function selection register before the UART function is used. Along with the UARTEN bit, the TXEN and RXEN bits, if set, will setup these pins to transmitter output and receiver input conditions. At this time the internal pull-high resistor related to the transmitter output pin will be disabled, while the internal pull-high resistor related to the receiver input pin is controlled by the corresponding I/O pull-high function control bit. When the TX or RX/TX pin function is disabled by clearing the UARTEN, TXEN or RXEN bit, the TX or RX/TX pin will be set to a floating state. At this time whether the internal pull-high resistor is connected to the TX or RX/TX pin or not is determined by the corresponding I/O pull-high function control bit.

UART Single Wire Mode

The UART function also supports a Single Wire Mode communication which is selected using the SWM bit in the UCR3 register. When the SWM bit is set high, the UART function will be in the single wire mode. In the single wire mode, a single RX/TX pin can be used to transmit and receive data depending upon the corresponding control bits. When the RXEN bit is set high, the RX/TX pin is used as a receiver pin. When the RXEN bit is cleared to zero and the TXEN bit is set high, the RX/TX pin will act as a transmitter pin.

It is recommended not to set both the RXEN and TXEN bits high in the single wire mode. If both the RXEN and TXEN bits are set high, the RXEN bit will have the priority and the UART will act as a receiver.

It is important to note that the functional description in this UART chapter, which is described from the full-duplex communication standpoint, also applies to the half-duplex (single wire mode) communication except the pin usage. In the single wire mode, the TX pin mentioned in this chapter should be replaced by the RX/TX pin to understand the whole UART single wire mode function.

In the single wire mode, the data can also be transmitted on the TX pin in a transmission operation with proper software configurations. Therefore, the data will be output on the RX/TX and TX pins.

UART Data Transfer Scheme

The above block diagram shows the overall data transfer structure arrangement for the UART. The actual data to be transmitted from the MCU is first transferred to the TXR_RXR register by the application program. The data will then be transferred to the Transmit Shift Register from where it will be shifted out, LSB first, onto the TX pin at a rate controlled by the Baud Rate Generator. Only the TXR_RXR register is mapped onto the MCU Data Memory, the Transmit Shift Register is not mapped and is therefore inaccessible to the application program.

Data to be received by the UART is accepted on the external RX/TX pin, from where it is shifted in, LSB first, to the Receiver Shift Register at a rate controlled by the Baud Rate Generator. When the shift register is full, the data will then be transferred from the shift register to the internal TXR_RXR register, where it is buffered and can be manipulated by the application program. Only the TXR_RXR register is mapped onto the MCU Data Memory, the Receiver Shift Register is not mapped and is therefore inaccessible to the application program.

It should be noted that the actual register for data transmission and reception only exists as a single shared register in the Data Memory. This shared register known as the TXR_RXR register is used for both data transmission and data reception.

UART Status and Control Registers

There are six control registers associated with the UART function. The SWM bit in the UCR3 register is used to enable/disable the UART Single Wire Mode.The USR, UCR1 and UCR2 registers control the overall function of the UART, while the BRG register controls the Baud rate. The actual data to be transmitted and received on the serial interface is managed through the TXR_RXR data register.

Register Name	Bit							
	7	6	5	4	3	2	1	0
USR	PERR	NF	FERR	OERR	RIDLE	RXIF	TIDLE	TXIF
UCR1	UARTEN	BNO	PREN	PRT	STOPS	TXBRK	RX8	TX8
UCR2	TXEN	RXEN	BRGH	ADDEN	WAKE	RIE	TIIE	TEIE
UCR3	—	—	—	—	—	—	—	SWM
TXR_RXR	D7	D6	D5	D4	D3	D2	D1	D0
BRG	D7	D6	D5	D4	D3	D2	D1	D0

UART Register List

• **USR Register**

The USR register is the status register for the UART, which can be read by the program to determine the present status of the UART. All flags within the USR register are read only. Further explanation on each of the flags is given below:

Bit	7	6	5	4	3	2	1	0
Name	PERR	NF	FERR	OERR	RIDLE	RXIF	TIDLE	TXIF
R/W	R	R	R	R	R	R	R	R
POR	0	0	0	0	1	0	1	1

Bit 7 **PERR**: Parity error flag
  0: No parity error is detected
  1: Parity error is detected
  The PERR flag is the parity error flag. When this read only flag is "0", it indicates a parity error has not been detected. When the flag is "1", it indicates that the parity of the received word is incorrect. This error flag is applicable only if Parity mode (odd or even) is selected. The flag can also be cleared to zero by a software sequence which involves a read to the status register USR followed by an access to the TXR_RXR data register.

Bit 6 **NF**: Noise flag
  0: No noise is detected
  1: Noise is detected
  The NF flag is the noise flag. When this read only flag is "0", it indicates no noise condition. When the flag is "1", it indicates that the UART has detected noise on the receiver input. The NF flag is set during the same cycle as the RXIF flag but will not be set in the case of as overrun. The NF flag can be cleared to zero by a software

sequence which will involve a read to the status register USR followed by an access to the TXR_RXR data register.

Bit 5   **FERR**: Framing error flag

     0: No framing error is detected

     1: Framing error is detected

The FERR flag is the framing error flag. When this read only flag is "0", it indicates that there is no framing error. When the flag is "1", it indicates that a framing error has been detected for the current character. The flag can also be cleared to zero by a software sequence which will involve a read to the status register USR followed by an access to the TXR_RXR data register.

Bit 4   **OERR**: Overrun error flag

     0: No overrun error is detected

     1: Overrun error is detected

The OERR flag is the overrun error flag which indicates when the receiver buffer has overflowed. When this read only flag is "0", it indicates that there is no overrun error. When the flag is "1", it indicates that an overrun error occurs which will inhibit further transfers to the TXR_RXR receive data register. The flag is cleared to zero by a software sequence, which is a read to the status register USR followed by an access to the TXR_RXR data register.

Bit 3   **RIDLE**: Receiver status

     0: Data reception is in progress (Data being received)

     1: No data reception is in progress (Receiver is idle)

The RIDLE flag is the receiver status flag. When this read only flag is "0", it indicates that the receiver is between the initial detection of the start bit and the completion of the stop bit. When the flag is "1", it indicates that the receiver is idle. Between the completion of the stop bit and the detection of the next start bit, the RIDLE bit is "1" indicating that the UART receiver is idle and the RX/TX pin stays in logic high condition.

Bit 2   **RXIF**: Receive TXR_RXR data register status

     0: TXR_RXR data register is empty

     1: TXR_RXR data register has available data

The RXIF flag is the receive data register status flag. When this read only flag is "0", it indicates that the TXR_RXR read data register is empty. When the flag is "1", it indicates that the TXR_RXR read data register contains new data. When the contents of the shift register are transferred to the TXR_RXR register, an interrupt is generated if RIE=1 in the UCR2 register. If one or more errors are detected in the received word, the appropriate receive-related flags NF, FERR, and/or PERR are set within the same clock cycle. The RXIF flag will eventually be cleared to zero when the USR register is read with RXIF set, followed by a read from the TXR_RXR register, and if the TXR_RXR register has no more new data available.

Bit 1   **TIDLE**: Transmission idle

     0: Data transmission is in progress (Data being transmitted)

     1: No data transmission is in progress (Transmitter is idle)

The TIDLE flag is known as the transmission complete flag. When this read only flag is "0", it indicates that a transmission is in progress. This flag will be set high when the TXIF flag is "1" and when there is no transmit data or break character being transmitted. When TIDLE is equal to "1", the TX pin becomes idle with the pin state in logic high condition. The TIDLE flag is cleared to zero by reading the USR register with TIDLE set and then writing to the TXR_RXR register. The flag is not generated when a data character or a break is queued and ready to be sent.

Bit 0   **TXIF**: Transmit TXR_RXR data register status

     0: Character is not transferred to the transmit shift register

     1: Character has transferred to the transmit shift register (TXR_RXR data register is empty)

The TXIF flag is the transmit data register empty flag. When this read only flag is "0", it indicates that the character is not transferred to the transmitter shift register. When

the flag is "1", it indicates that the transmitter shift register has received a character from the TXR_RXR data register. The TXIF flag is cleared to zero by reading the UART status register (USR) with TXIF set and then writing to the TXR_RXR data register. Note that when the TXEN bit is set, the TXIF flag bit will also be set since the transmit data register is not yet full.

• **UCR1 Register**

The UCR1 register together with the UCR2 and UCR3 registers are the three UART control registers that are used to set the various options for the UART function, such as overall on/off control, parity control, data transfer bit length, single wire mode communication etc. Further explanation on each of the bits is given below:

Bit	7	6	5	4	3	2	1	0
Name	UARTEN	BNO	PREN	PRT	STOPS	TXBRK	RX8	TX8
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R	W
POR	0	0	0	0	0	0	x	0

"x": unknown

Bit 7 **UARTEN**: UART function enable control
    0: Disable UART. TX and RX/TX pins are in a floating state
    1: Enable UART. TX and RX/TX pins can function as UART pins

    The UARTEN bit is the UART enable bit. When this bit is equal to "0", the UART will be disabled and the RX/TX pin as well as the TX pin will be in a floating state. When the bit is equal to "1", the UART will be enabled and the TX and RX/TX pins will function as defined by the SWM mode selection bit together with the TXEN and RXEN enable control bits.

    When the UART is disabled, it will empty the buffer so any character remaining in the buffer will be discarded. In addition, the value of the baud rate counter will be reset. If the UART is disabled, all error and status flags will be reset. Also the TXEN, RXEN, TXBRK, RXIF, OERR, FERR, PERR and NF bits will be cleared to zero, while the TIDLE, TXIF and RIDLE bits will be set high. Other control bits in UCR1, UCR2, UCR3 and BRG registers will remain unaffected. If the UART is active and the UARTEN bit is cleared to zero, all pending transmissions and receptions will be terminated and the module will be reset as defined above. When the UART is re-enabled, it will restart in the same configuration.

Bit 6 **BNO**: Number of data transfer bits selection
    0: 8-bit data transfer
    1: 9-bit data transfer

    This bit is used to select the data length format, which can have a choice of either 8-bit or 9-bit format. When this bit is equal to "1", a 9-bit data length format will be selected. If the bit is equal to "0", then an 8-bit data length format will be selected. If 9-bit data length format is selected, then bits RX8 and TX8 will be used to store the 9th bit of the received and transmitted data respectively.

    Note that the 9th bit of data if BNO=1, or the 8th bit of data if BNO=0, which is used as the parity bit, does not transfer to RX8 or TXR_RXR.7 respectively when the parity function is enabled.

Bit 5 **PREN**: Parity function enable control
    0: Parity function is disabled
    1: Parity function is enabled

    This is the parity enable bit. When this bit is equal to "1", the parity function will be enabled. If the bit is equal to "0", then the parity function will be disabled.

Bit 4 **PRT**: Parity type selection bit
    0: Even parity for parity generator
    1: Odd parity for parity generator

    This bit is the parity type selection bit. When this bit is equal to "1", odd parity type will be selected. If the bit is equal to "0", then even parity type will be selected.

Bit 3   **STOPS**: Number of Stop bits selection

0: One stop bit format is used

1: Two stop bits format is used

This bit determines if one or two stop bits are to be used. When this bit is equal to "1", two stop bits are used. If this bit is equal to "0", then only one stop bit is used.

Bit 2   **TXBRK**: Transmit break character

0: No break character is transmitted

1: Break characters transmit

The TXBRK bit is the Transmit Break Character bit. When this bit is "0", there are no break characters and the TX pin operates normally. When the bit is "1", there are transmit break characters and the transmitter will send logic zeros. When this bit is equal to "1", after the buffered data has been transmitted, the transmitter output is held low for a minimum of a 13-bit length and until the TXBRK bit is reset.

Bit 1   **RX8**: Receive data bit 8 for 9-bit data transfer format (read only)

This bit is only used if 9-bit data transfers are used, in which case this bit location will store the 9th bit of the received data known as RX8. The BNO bit is used to determine whether data transfers are in 8-bit or 9-bit format.

Bit 0   **TX8**: Transmit data bit 8 for 9-bit data transfer format (write only)

This bit is only used if 9-bit data transfers are used, in which case this bit location will store the 9th bit of the transmitted data known as TX8. The BNO bit is used to determine whether data transfers are in 8-bit or 9-bit format.

- **UCR2 Register**

The UCR2 register is the second of the two UART control registers and serves several purposes. One of its main functions is to control the basic enable/disable operation of the UART Transmitter and Receiver as well as enabling the various UART interrupt sources. The register also serves to control the baud rate speed, receiver wake-up enable and the address detect enable. Further explanation on each of the bits is given below:

Bit	7	6	5	4	3	2	1	0
Name	TXEN	RXEN	BRGH	ADDEN	WAKE	RIE	TIIE	TEIE
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7   **TXEN**: UART Transmitter enabled control

0: UART transmitter is disabled

1: UART transmitter is enabled

The bit named TXEN is the Transmitter Enable Bit. When this bit is equal to "0", the transmitter will be disabled with any pending data transmissions being aborted. In addition the buffers will be reset. In this situation the TX pin will be in a floating state.

If the TXEN bit is equal to "1" and the UARTEN bit is also equal to "1", the transmitter will be enabled and the TX pin will be controlled by the UART. Clearing the TXEN bit during a transmission will cause the data transmission to be aborted and will reset the transmitter. If this situation occurs, the TX pin will be in a floating state.

Bit 6   **RXEN**: UART Receiver enabled control

0: UART receiver is disabled

1: UART receiver is enabled

The bit named RXEN is the Receiver Enable Bit. When this bit is equal to "0", the receiver will be disabled with any pending data receptions being aborted. In addition the receive buffers will be reset. In this situation the RX/TX pin will be in a floating state. If the RXEN bit is equal to "1" and the UARTEN bit is also equal to "1", the receiver will be enabled and the RX/TX pin will be controlled by the UART. Clearing the RXEN bit during a reception will cause the data reception to be aborted and will reset the receiver. If this situation occurs, the RX/TX pin will be in a floating state.

Bit 5   **BRGH**: Baud Rate speed selection

        0: Low speed baud rate

        1: High speed baud rate

The bit named BRGH selects the high or low speed mode of the Baud Rate Generator. This bit, together with the value placed in the baud rate register BRG, controls the Baud Rate of the UART. If this bit is equal to "1", the high speed mode is selected. If the bit is equal to "0", the low speed mode is selected.

Bit 4   **ADDEN**: Address detect function enable control

        0: Address detect function is disabled

        1: Address detect function is enabled

The bit named ADDEN is the address detect function enable control bit. When this bit is equal to "1", the address detect function is enabled. When it occurs, if the 8th bit, which corresponds to TXR_RXR.7 if BNO=0 or the 9th bit, which corresponds to RX8 if BNO=1, has a value of "1", then the received word will be identified as an address, rather than data. If the corresponding interrupt is enabled, an interrupt request will be generated each time the received word has the address bit set, which is the 8th or 9th bit depending on the value of BNO. If the address bit known as the 8th or 9th bit of the received word is "0" with the address detect function being enabled, an interrupt will not be generated and the received data will be discarded.

Bit 3   **WAKE**: RX/TX pin wake-up UART function enable control

        0: RX/TX pin wake-up UART function is disabled

        1: RX/TX pin wake-up UART function is enabled

This bit is used to control the wake-up UART function when a falling edge on the RX/TX pin occurs. Note that this bit is only available when the UART clock (f_H) is switched off. There will be no RX/TX pin wake-up UART function if the UART clock (f_H) exists. If the WAKE bit is set to 1 as the UART clock (f_H) is switched off, a UART wake-up request will be initiated when a falling edge on the RX/TX pin occurs. When this request happens and the corresponding interrupt is enabled, an RX/TX pin wake-up UART interrupt will be generated to inform the MCU to wake up the UART function by switching on the UART clock (f_H) via the application program. Otherwise, the UART function can not resume even if there is a falling edge on the RX/TX pin when the WAKE bit is cleared to 0.

Bit 2   **RIE**: Receiver interrupt enable control

        0: Receiver related interrupt is disabled

        1: Receiver related interrupt is enabled

This bit enables or disables the receiver interrupt. If this bit is equal to "1" and when the receiver overrun flag OERR or receive data available flag RXIF is set, the UART interrupt request flag will be set. If this bit is equal to "0", the UART interrupt request flag will not be influenced by the condition of the OERR or RXIF flags.

Bit 1   **TIIE**: Transmitter Idle interrupt enable control

        0: Transmitter idle interrupt is disabled

        1: Transmitter idle interrupt is enabled

This bit enables or disables the transmitter idle interrupt. If this bit is equal to "1" and when the transmitter idle flag TIDLE is set, due to a transmitter idle condition, the UART interrupt request flag will be set. If this bit is equal to "0", the UART interrupt request flag will not be influenced by the condition of the TIDLE flag.

Bit 0   **TEIE**: Transmitter Empty interrupt enable control

        0: Transmitter empty interrupt is disabled

        1: Transmitter empty interrupt is enabled

This bit enables or disables the transmitter empty interrupt. If this bit is equal to "1" and when the transmitter empty flag TXIF is set, due to a transmitter empty condition, the UART interrupt request flag will be set. If this bit is equal to "0", the UART interrupt request flag will not be influenced by the condition of the TXIF flag.

• **UCR3 Register**

The UCR3 register is used to enable the UART Single Wire Mode communication. As the name suggests in the single wire mode the UART communication can be implemented in one single line, RX/TX, together with the control of the RXEN and TXEN bits in the UCR2 register.

Bit	7	6	5	4	3	2	1	0
Name	—	—	—	—	—	—	—	SWM
R/W	—	—	—	—	—	—	—	R/W
POR	—	—	—	—	—	—	—	0

Bit 7~1   Unimplemented, read as "0"

Bit 0   **SWM**: Single Wire Mode enable control

      0: Disable, the RX/TX pin is used as UART receiver function only

      1: Enable, the RX/TX pin can be used as UART receiver or transmitter function controlled by the RXEN and TXEN bits

    Note that when the Single Wire Mode is enabled, if both the RXEN and TXEN bits are high, the RX/TX pin will just be used as UART receiver input.

• **TXR_RXR Register**

The TXR_RXR register is the data register which is used to store the data to be transmitted on the TX pin or being received from the RX/TX pin.

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	D5	D4	D3	D2	D1	D0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	x	x	x	x	x	x	x	x

"x": unknown

Bit 7~0   **D7~D0**: UART Transmit/Receive Data bit 7 ~ bit 0

• **BRG Register**

Bit	7	6	5	4	3	2	1	0
Name	D7	D6	D5	D4	D3	D2	D1	D0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	x	x	x	x	x	x	x	x

"x": unknown

Bit 7~0   **D7~D0**: Baud Rate values

    By programming the BRGH bit in UCR2 Register which allows selection of the related formula described above and programming the required value in the BRG register, the required baud rate can be setup.

    Note: Baud rate=$f_H/[64\times(N+1)]$ if BRGH=0;

            Baud rate=$f_H/[16\times(N+1)]$ if BRGH=1.

Baud Rate Generator

To setup the speed of the serial data communication, the UART function contains its own dedicated baud rate generator. The baud rate is controlled by its own internal free running 8-bit timer, the period of which is determined by two factors. The first of these is the value placed in the baud rate register BRG and the second is the value of the BRGH bit with the control register UCR2. The BRGH bit decides if the baud rate generator is to be used in a high speed mode or low speed mode, which in turn determines the formula that is used to calculate the baud rate. The value N in the BRG register which is used in the following baud rate calculation formula determines the division factor. Note that N is the decimal value placed in the BRG register and has a range of between 0 and 255.

UCR2 BRGH Bit	0	1
Baud Rate (BR)	$f_H/[64\times(N+1)]$	$f_H/[16\times(N+1)]$

By programming the BRGH bit which allows selection of the related formula and programming the required value in the BRG register, the required baud rate can be setup. Note that because the actual baud rate is determined using a discrete value, N, placed in the BRG register, there will be an error associated between the actual and requested value. The following example shows how the BRG register value N and the error value can be calculated.

Calculating the Baud Rate and Error Values

For a clock frequency of 4MHz, and with BRGH cleared to zero determine the BRG register value N, the actual baud rate and the error value for a desired baud rate of 4800.

From the above table the desired baud rate $BR=f_H/[64\times(N+1)]$

Re-arranging this equation gives $N=[f_H/(BR\times64)]-1$

Giving a value for $N=[4000000/(4800\times64)]-1=12.0208$

To obtain the closest value, a decimal value of 12 should be placed into the BRG register. This gives an actual or calculated baud rate value of $BR=4000000/[64\times(12+1)]=4808$

Therefore the error is equal to $(4808-4800)/4800=0.16\%$.

UART Setup and Control

For data transfer, the UART function utilizes a non-return-to-zero, more commonly known as NRZ, format. This is composed of one start bit, eight or nine data bits, and one or two stop bits. Parity is supported by the UART hardware, and can be setup to be even, odd or no parity. For the most common data format, 8 data bits along with no parity and one stop bit, denoted as 8, N, 1, is used as the default setting, which is the setting at power-on. The number of data bits and stop bits, along with the parity, are setup by programming the corresponding BNO, PRT, PREN, and STOPS bits in the UCR1 register. The baud rate used to transmit and receive data is setup using the internal 8-bit baud rate generator, while the data is transmitted and received LSB first. Although the UART transmitter and receiver are functionally independent, they both use the same data format and baud rate. In all cases stop bits will be used for data transmission.

Enabling/Disabling the UART Interface

The basic on/off function of the internal UART function is controlled using the UARTEN bit in the UCR1 register. If the UARTEN, TXEN and RXEN bits are set, then these two UART pins will act as normal TX output pin and RX/TX input pin respectively. If no data is being transmitted on the TX pin, then it will default to a logic high value.

Clearing the UARTEN bit will disable the TX and RX/TX pins and allow these two pins to be used as normal I/O or other pin-shared functional pins. When the UART function is disabled the buffer will be reset to an empty condition, at the same time discarding any remaining residual data. Disabling the UART will also reset the error and status flags with bits TXEN, RXEN, TXBRK, RXIF, OERR, FERR, PERR and NF being cleared while bits TIDLE, TXIF and RIDLE will be set. The remaining control bits in the UCR1, UCR2, UCR3 and BRG registers will remain unaffected. If the UARTEN bit in the UCR1 register is cleared while the UART is active, then all pending transmissions and receptions will be immediately suspended and the UART will be reset to a condition as defined above. If the UART is then subsequently re-enabled, it will restart again in the same configuration.

Data, Parity and Stop Bit Selection

The format of the data to be transferred is composed of various factors such as data bit length, parity on/off, parity type, address bits and the number of stop bits. These factors are determined by the setup of various bits within the UCR1 register. The BNO bit controls the number of data bits which can be set to either 8 or 9, the PRT bit controls the choice of odd or even parity, the PREN bit controls the parity on/off function and the STOPS bit decides whether one or two stop bits are to be used. The following table shows various formats for data transmission. The address bit, which is the MSB of the data byte, identifies the frame as an address character or data if the address detect function is enabled. The number of stop bits, which can be either one or two, is independent of the data length and is only used for the transmitter. There is only one stop bit for the receiver.

Start Bit	Data Bits	Address Bit	Parity Bit	Stop Bit
Example of 8-bit Data Formats				
1	8	0	0	1
1	7	0	1	1
1	7	1	0	1
Example of 9-bit Data Formats				
1	9	0	0	1
1	8	0	1	1
1	8	1	0	1

Transmitter Receiver Data Format

The following diagram shows the transmit and receive waveforms for both 8-bit and 9-bit data formats.

8-bit Data Format

9-bit Data Format
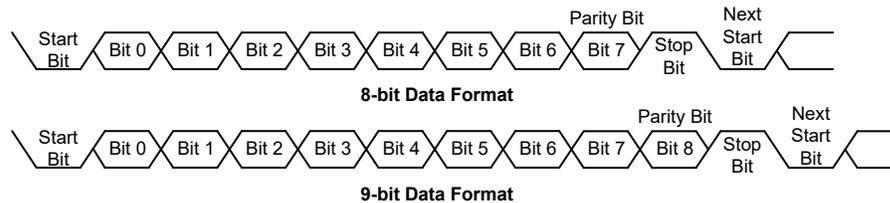
UART Transmitter

Data word lengths of either 8 or 9 bits can be selected by programming the BNO bit in the UCR1 register. When BNO bit is set, the word length will be set to 9 bits. In this case the 9th bit, which is the MSB, needs to be stored in the TX8 bit in the UCR1 register. At the transmitter core lies the Transmitter Shift Register, more commonly known as the TSR, whose data is obtained from the transmit data register, which is known as the TXR_RXR register. The data to be transmitted is loaded into this TXR_RXR register by the application program. The TSR register is not written to with new data until the stop bit from the previous transmission has been sent out. As soon as this stop bit has been transmitted, the TSR can then be loaded with new data from the TXR_RXR register, if it is available. It should be noted that the TSR register, unlike many other registers, is not directly mapped into the Data Memory area and as such is not available to the application program for direct read/write operations. An actual transmission of data will normally be enabled when the TXEN bit is set, but the data will not be transmitted until the TXR_RXR register has been loaded with data and the baud rate generator has defined a shift clock source. However, the transmission can also be initiated by first loading data into the TXR_RXR register, after which the TXEN bit can be set. When a transmission of data begins, the TSR is normally empty, in which case a transfer to the TXR_RXR register will result in an immediate transfer to the TSR. If during a transmission the TXEN bit is cleared, the transmission will immediately cease and the transmitter will be reset. The TX output pin can then be configured as the I/O or other pin-shared function by configuring the corresponding pin-shared control bits.

Transmitting Data

When the UART is transmitting data, the data is shifted on the TX pin from the shift register, with the least significant bit first. In the transmit mode, the TXR_RXR register forms a buffer between the internal bus and the transmitter shift register. It should be noted that if 9-bit data format has been selected, then the MSB will be taken from the TX8 bit in the UCR1 register. The steps to initiate a data transfer can be summarized as follows:

- Make the correct selection of the BNO, PRT, PREN and STOPS bits to define the required word length, parity type and number of stop bits.

- Setup the BRG register to select the desired baud rate.

- Set the TXEN bit to ensure that the TX pin is used as a UART transmitter pin.

- Access the USR register and write the data that is to be transmitted into the TXR_RXR register. Note that this step will clear the TXIF bit.

This sequence of events can now be repeated to send additional data.

It should be noted that when TXIF=0, data will be inhibited from being written to the TXR_RXR register. Clearing the TXIF flag is always achieved using the following software sequence:

1. A USR register access

2. A TXR_RXR register write execution

The read-only TXIF flag is set by the UART hardware and if set indicates that the TXR_RXR register is empty and that other data can now be written into the TXR_RXR register without overwriting the previous data. If the TEIE bit is set then the TXIF flag will generate an interrupt.

During a data transmission, a write instruction to the TXR_RXR register will place the data into the TXR_RXR register, which will be copied to the shift register at the end of the present transmission. When there is no data transmission in progress, a write instruction to the TXR_RXR register will place the data directly into the shift register, resulting in the commencement of data transmission, and the TXIF bit being immediately set. When a frame transmission is complete, which happens after stop bits are sent or after the break frame, the TIDLE bit will be set. To clear the TIDLE bit the following software sequence is used:

1. A USR register access

2. A TXR_RXR register write execution

Note that both the TXIF and TIDLE bits are cleared by the same software sequence.

Transmit Break

If the TXBRK bit is set high and the state keeps for a time greater than [(BRG+1)×tH], then the break characters will be sent on the next transmission. Break character transmission consists of a start bit, followed by 13×N '0' bits and stop bits, where N=1, 2, etc. If a break character is to be transmitted then the TXBRK bit must be first set by the application program, and then cleared to generate the stop bits. Transmitting a break character will not generate a transmit interrupt. Note that a break condition length is at least 13 bits long. If the TXBRK bit is continually kept at a logic high level then the transmitter circuitry will transmit continuous break characters. After the application program has cleared the TXBRK bit, the transmitter will finish transmitting the last break character and subsequently send out one or two stop bits. The automatic logic highs at the end of the last break character will ensure that the start bit of the next frame is recognized.

UART Receiver

The UART is capable of receiving word lengths of either 8 or 9 bits. If the BNO bit is set, the word length will be set to 9 bits with the MSB being stored in the RX8 bit of the UCR1 register. At the receiver core lies the Receive Serial Shift Register, commonly known as the RSR. The data which is received on the RX/TX external input pin is sent to the data recovery block. The data recovery block operating speed is 16 times that of the baud rate, while the main receive serial shifter operates at the baud rate. After the RX/TX pin is sampled for the stop bit, the received data in RSR is transferred to the receive data register, if the register is empty. The data which is received on the external RX/TX input pin is sampled three times by a majority detect circuit to determine the logic level that has been placed onto the RX/TX pin. It should be noted that the RSR register, unlike many other registers, is not directly mapped into the Data Memory area and as such is not available to the application program for direct read/write operations.

Receiving Data

When the UART receiver is receiving data, the data is serially shifted in on the external RX/TX pin input, LSB first. In the read mode, the TXR_RXR register forms a buffer between the internal bus and the receiver shift register. The TXR_RXR register is a two byte deep FIFO data buffer, where two bytes can be held in the FIFO while a third byte can continue to be received. Note that the application program must ensure that the data is read from TXR_RXR before the third byte has been completely shifted in, otherwise this third byte will be discarded and an overrun error OERR will be subsequently indicated. The steps to initiate a data transfer can be summarized as follows:

- Make the correct selection of BNO, PRT and PREN bits to define the word length, parity type.
- Setup the BRG register to select the desired baud rate.
- Set the RXEN bit to ensure that the RX/TX pin is used as a UART receiver pin.

At this point the receiver will be enabled which will begin to look for a start bit.

When a character is received the following sequence of events will occur:

- The RXIF bit in the USR register will be set when the TXR_RXR register has data available. There will be at most one more character available before an overrun error occurs.
- When the contents of the shift register have been transferred to the TXR_RXR register, then if the RIE bit is set, an interrupt will be generated.
- If during reception, a frame error, noise error, parity error, or an overrun error has been detected, then the error flags can be set.

The RXIF bit can be cleared using the following software sequence:

1. A USR register access
2. A TXR_RXR register read execution

Receiving Break

Any break character received by the UART will be managed as a framing error. The receiver will count and expect a certain number of bit times as specified by the values programmed into the BNO bit plus one stop bit. If the break is much longer than 13 bit times, the reception will be considered as complete after the number of bit times specified by BNO plus one stop bit. The RXIF bit is set, FERR is set, zeros are loaded into the receive data register, interrupts are generated if appropriate and the RIDLE bit is set. A break is regarded as a character that contains only zeros with the FERR flag set. If a long break signal has been detected, the receiver will regard it as a data frame including a start bit, data bits and the invalid stop bit and the FERR flag will be set. The receiver must wait for a valid stop bit before looking for the next start bit. The receiver will not make the assumption that

the break condition on the line is the next start bit. The break character will be loaded into the buffer and no further data will be received until stop bits are received. It should be noted that the RIDLE read only flag will go high when the stop bits have not yet been received. The reception of a break character on the UART registers will result in the following:

- The framing error flag, FERR, will be set.
- The receive data register, TXR_RXR, will be cleared.
- The OERR, NF, PERR, RIDLE or RXIF flags will possibly be set.

Idle Status

When the receiver is reading data, which means it will be in between the detection of a start bit and the reading of a stop bit, the receiver status flag in the USR register, otherwise known as the RIDLE flag, will have a zero value. In between the reception of a stop bit and the detection of the next start bit, the RIDLE flag will have a high value, which indicates the receiver is in an idle condition.

Receiver Interrupt

The read only receive interrupt flag RXIF in the USR register is set by an edge generated by the receiver. An interrupt is generated if RIE=1, when a word is transferred from the Receive Shift Register, RSR, to the Receive Data Register, TXR_RXR. An overrun error can also generate an interrupt if RIE=1.

Managing Receiver Errors

Several types of reception errors can occur within the UART module, the following section describes the various types and how they are managed by the UART.

Overrun Error – OERR

The TXR_RXR register is composed of a two byte deep FIFO data buffer, where two bytes can be held in the FIFO register, while a third byte can continue to be received. Before this third byte has been entirely shifted in, the data should be read from the TXR_RXR register. If this is not done, the overrun error flag OERR will be consequently indicated.

In the event of an overrun error occurring, the following will happen:

- The OERR flag in the USR register will be set.
- The TXR_RXR contents will not be lost.
- The shift register will be overwritten.
- An interrupt will be generated if the RIE bit is set.

The OERR flag can be cleared by an access to the USR register followed by a read to the TXR_RXR register.

Noise Error – NF

Over-sampling is used for data recovery to identify valid incoming data and noise. If noise is detected within a frame the following will occur:

- The read only noise flag, NF, in the USR register will be set on the rising edge of the RXIF bit.
- Data will be transferred from the Shift register to the TXR_RXR register.
- No interrupt will be generated. However this bit rises at the same time as the RXIF bit which itself generates an interrupt.

Note that the NF flag is reset by a USR register read operation followed by a TXR_RXR register read operation.

Framing Error – FERR

The read only framing error flag, FERR, in the USR register, is set if a zero is detected instead of stop bits. If two stop bits are selected, both stop bits must be high; otherwise the FERR flag will be set. The FERR flag and the received data will be recorded in the USR and TXR_RXR registers respectively, and the flag is cleared in any reset.

Parity Error – PERR

The read only parity error flag, PERR, in the USR register, is set if the parity of the received word is incorrect. This error flag is only applicable if the parity is enabled, PREN=1, and if the parity type, odd or even is selected. The read only PERR flag and the received data will be recorded in the USR and TXR_RXR registers respectively. It is cleared on any reset, it should be noted that the flags, FERR and PERR, in the USR register should first be read by the application program before reading the data word.

UART Interrupt Structure

Several individual UART conditions can generate a UART interrupt. When these conditions exist, a low pulse will be generated to get the attention of the microcontroller. These conditions are a transmitter data register empty, transmitter idle, receiver data available, receiver overrun, address detect and an RX/TX pin wake-up. When any of these conditions are created, if the global interrupt enable bit and its corresponding interrupt control bit are enabled and the stack is not full, the program will jump to its corresponding interrupt vector where it can be serviced before returning to the main program. Four of these conditions have the corresponding USR register flags which will generate a UART interrupt if its associated interrupt enable control bit in the UCR2 register is set. The two transmitter interrupt conditions have their own corresponding enable control bits, while the two receiver interrupt conditions have a shared enable control bit. These enable bits can be used to mask out individual UART interrupt sources.

The address detect condition, which is also a UART interrupt source, does not have an associated flag, but will generate a UART interrupt when an address detect condition occurs if its function is enabled by setting the ADDEN bit in the UCR2 register. An RX/TX pin wake-up, which is also a UART interrupt source, does not have an associated flag, but will generate a UART interrupt if the UART clock (f_H) source is switched off and the WAKE and RIE bits in the UCR2 register are set when a falling edge on the RX/TX pin occurs.

Note that the USR register flags are read only and cannot be cleared or set by the application program, neither will they be cleared when the program jumps to the corresponding interrupt servicing routine, as is the case for some of the other interrupts. The flags will be cleared automatically when certain actions are taken by the UART, the details of which are given in the UART register section. The overall UART interrupt can be disabled or enabled by the related interrupt enable control bits in the interrupt control registers of the microcontroller to decide whether the interrupt requested by the UART module is masked out or allowed.
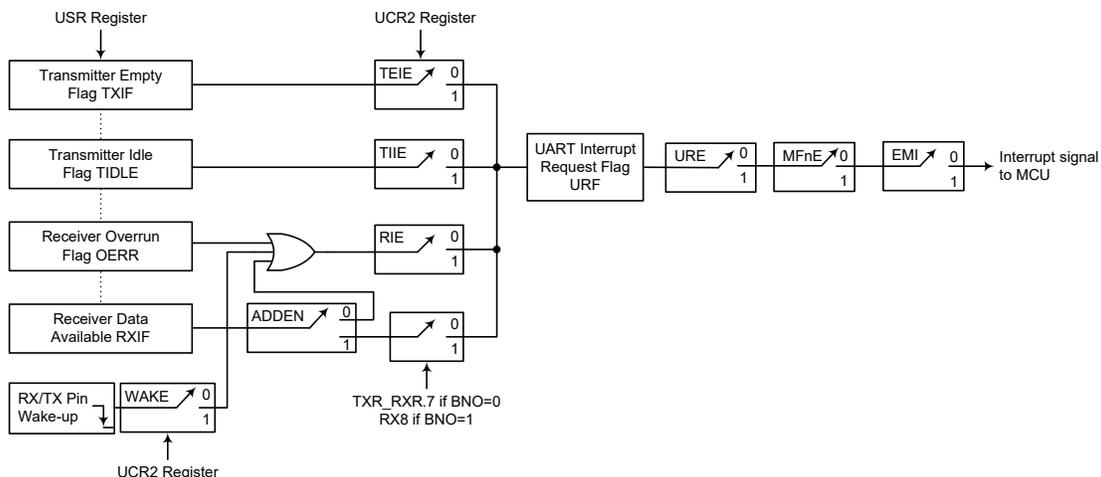
UART Interrupt Structure

Address Detect Mode

Setting the Address Detect Mode bit, ADDEN, in the UCR2 register, enables this special mode. If this bit is enabled then an additional qualifier will be placed on the generation of a Receiver Data Available interrupt, which is requested by the RXIF flag. If the ADDEN bit is enabled, then when data is available, an interrupt will only be generated, if the highest received bit has a high value. Note that the URE, MFnE and EMI interrupt enable bits must also be enabled for correct interrupt generation. This highest address bit is the 9th bit if BNO=1 or the 8th bit if BNO=0. If this bit is high, then the received word will be defined as an address rather than data. A Data Available interrupt will be generated every time the last bit of the received word is set. If the ADDEN bit is not enabled, then a Receiver Data Available interrupt will be generated each time the RXIF flag is set, irrespective of the data last bit status. The address detect mode and parity enable are mutually exclusive functions. Therefore if the address detect mode is enabled, then to ensure correct operation, the parity function should be disabled by resetting the parity enable bit PREN to zero.

ADDEN	Bit 9 if BNO=1 Bit 8 if BNO=0	UART Interrupt Generated
0	0	√
	1	√
1	0	×
	1	√

ADDEN Bit Function

UART Power Down and Wake-up

When the UART clock, f_H, is switched off, the UART will cease to function. If the MCU switches off the UART clock, f_H, and enters the power down mode while a transmission is still in progress, then the transmission will be paused until the UART clock source derived from the microcontroller is activated. In a similar way, if the MCU switches off the UART clock f_H and enters the IDLE or SLEEP mode by executing the "HALT" instruction while receiving data, then the reception of data will likewise be paused. When the MCU enters the IDLE or SLEEP mode, note that the USR, UCR1, UCR2, transmit and receive registers, as well as the BRG register will not be affected. It is recommended to make sure first that the UART data transmission or reception has been finished before the microcontroller enters the IDLE or SLEEP mode.

The UART function contains a receiver RX/TX pin wake-up function, which is enabled or disabled by the WAKE bit in the UCR2 register. If this bit, along with the UART enable bit, UARTEN, the receiver enable bit, RXEN and the receiver interrupt bit, RIE, are all set when the MCU enters the power down mode with the UART clock f_H being switched off, then a falling edge on the RX/TX pin will initiate an RX/TX pin wake-up UART interrupt. Note that as it takes certain system clock cycles after a wake-up, before normal microcontroller operation resumes, any data received during this time on the RX/TX pin will be ignored.

For a UART wake-up interrupt to occur, in addition to the bits for the wake-up being set, the global interrupt enable bit, EMI, and the UART interrupt enable bit, URE, must be set. If the EMI, the multi-function interrupt enable bit, MFnE, and URE bits are not set then only a wake up event will occur and no interrupt will be generated. Note also that as it takes certain system clock cycles after a wake-up before normal microcontroller resumes, the UART interrupt will not be generated until after this time has elapsed.

LCD Driver

For large volume applications, which incorporate an LCD in their design, the use of a custom display rather than a more expensive character based display reduces costs significantly. However, the corresponding COM and SEG signals required, which vary in both amplitude and time, to drive such a custom display require many special considerations for proper LCD operation to occur. This device contains an LCD Driver function, which with their internal LCD signal generating circuitry and various options, will automatically generate these time and amplitude varying signals to provide a means of direct driving and easy interfacing to a range of custom LCDs.

The device includes a wide range of options to enable LCD displays of various types to be driven. The table shows the range of options available for the device range.
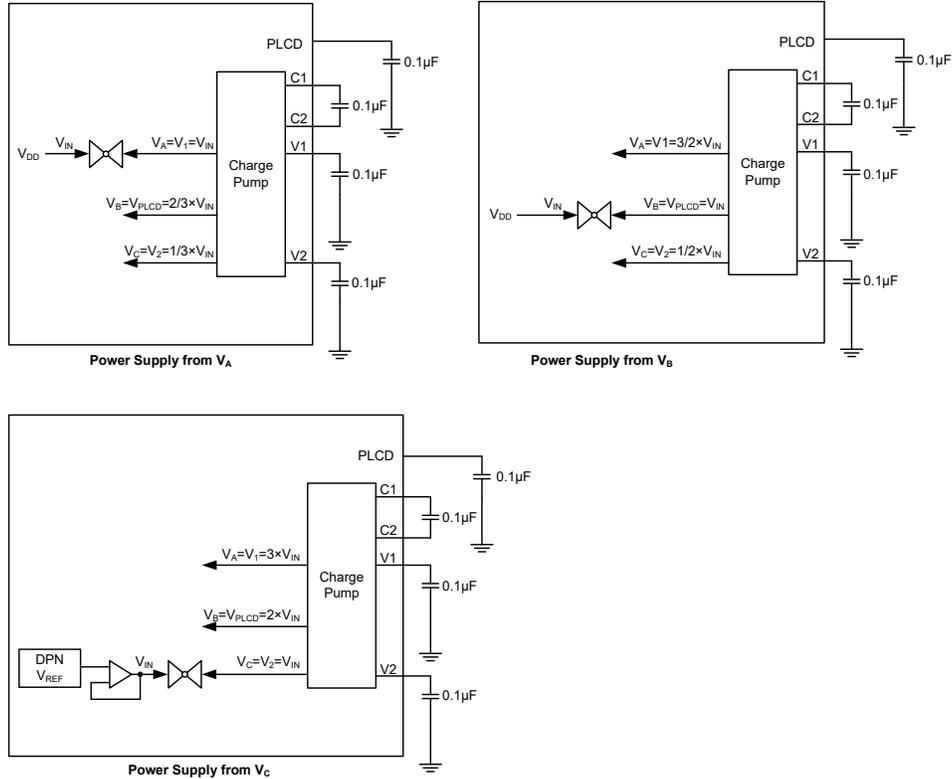
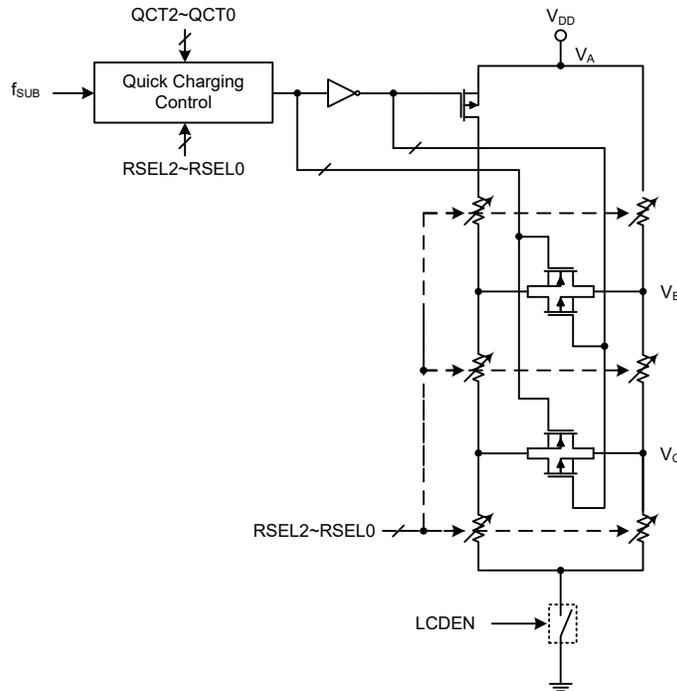| Driver No.	Duty	Bias Level	Bias Type	Waveform Type
30×4	1/4	1/3	R or C	A or B
29×5	1/5	1/3	R or C	A or B
28×6	1/6	1/3	R or C	A or B

LCD Driver Output Selection
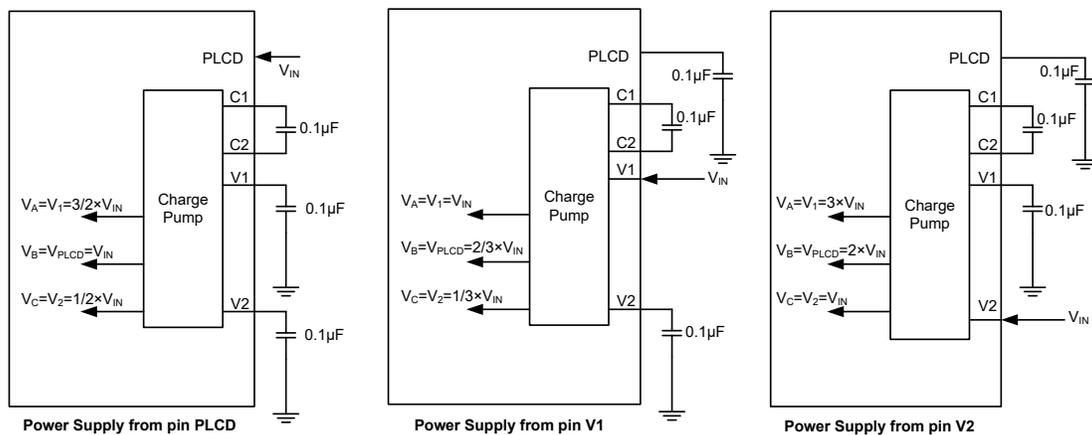
C Type Bias External Power Supply Configuration
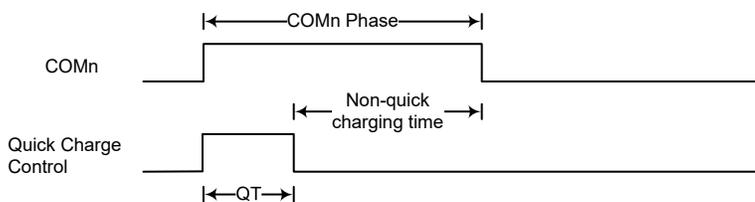
Note: $V_{DD} \leq V_1/V_A$.

Note: $V_{DD} \le V_1/V_A$

C Type Bias Internal Power Supply Configuration

Note: When the R type LCD is disabled, the DC path will be switched off.

R Type Bias Configurations

QT: Quick charging time, determined by QCT[2:0].

Quick Charging Mode

LCD Memory

An area of Data Memory is especially reserved for use for the LCD display data. This data area is known as the LCD Memory. Any data written here will be automatically read by the internal display driver circuits, which will in turn automatically generate the necessary LCD driving signals. Therefore any data written into this Memory will be immediately reflected into the actual display connected to the microcontroller. Note that for the un-bonded or unused LCD SEG/COM pins the corresponding LCD display memory data bits can be used as general data bits.

As the LCD Memory addresses overlap those of the General Purpose Data Memory, it is stored in its own independent Sector 4 area. The Data Memory sector to be used is chosen by using the Memory Pointer high byte register, which is a special function register in the Data Memory, with the name, MP1H or MP2H, to access the LCD Memory therefore requires first that Sector 4 is selected by writing a value of 04H to the MP1H or MP2H register. After this, the memory can then be accessed by using indirect addressing through the use of Memory Pointer low byte, MP1L or MP2L. With Sector 4 selected, then using MP1L or MP2L to read or write to the memory area, starting with address "00H" for all the devices, will result in operations to the LCD Memory. Directly addressing the LCD Display Memory can be applicable using the extended instructions for the full range address access.

The accompanying LCD Memory Map diagrams shows how the internal LCD Memory is mapped to the Segments and Commons of the display for the device.
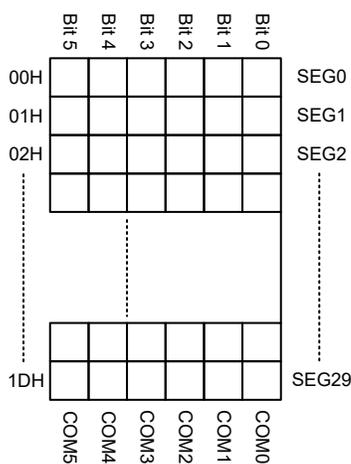
LCD Memory Map

LCD Clock Source

The LCD clock source is the internal clock signal, f_{SUB}, divided by 8 using an internal divider circuit. The f_{SUB} internal clock is supplied by either the LIRC or LXT oscillator, the choice of which is determined by a software control bit. For proper LCD operation, this arrangement is provided to generate an ideal LCD clock source frequency of 4kHz.

LCD Register

There are two control registers, named as LCDC0 and LCDC1, in the Data Memory which is used to control the various setup features of the LCD Driver.

Various bits in these registers control functions such as LCD waveform type, bias type, C-type LCD Pump Clock divider, supply power selection, total bias resistor selection together with the overall LCD enable and disable control. The LCDEN bit in the LCDC0 register, which provides the overall LCD enable/disable function, will only be effective when the device is in the FAST, SLOW or IDLE Mode. If the device is in the SLEEP Mode then the display will always be disabled. Bits, RSEL2~RSEL0, in the LCDC0 register select the internal total bias resistors to supply the LCD panel with the proper bias current. A choice to best match the LCD panel used in the application can be selected also to minimise bias current. The TYPE bit in the LCDC0 register is used to select whether Type A or Type B LCD waveform signals are used. The RCT bit in the same register is used to select whether R Type or C Type LCD bias is used. The LCDP1 and LCDP0 bits are used to select that the LCD supply power comes from either the external pin or internal power supply for C type bias application.

Register Name	Bit							
	7	6	5	4	3	2	1	0
LCDC0	TYPE	RCT	LCDP1	LCDP0	RSEL2	RSEL1	RSEL0	LCDEN
LCDC1	QCT2	QCT1	QCT0	LCDPCK2	LCDPCK1	LCDPCK0	DTYC1	DTYC0

LCD Registers List

• **LCDC0 Register**

Bit	7	6	5	4	3	2	1	0
Name	TYPE	RCT	LCDP1	LCDP0	RSEL2	RSEL1	RSEL0	LCDEN
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7   **TYPE**: LCD waveform type selection
         0: Type A
         1: Type B

Bit 6   **RCT**: LCD bias type selection
         0: R type
         1: C type

Bit 5~4   **LCDP1~LCDP0**: C type bias LCD power supply selection
         00: From external pin PLCD, V1 or V2
         01: From internal reference voltage V_{REFIN} supplied to V_C
         10: From internal voltage V_{DD} supplied to V_B
         11: From internal voltage V_{DD} supplied to V_A
     The V_{REFIN} is an internal reference voltage with an approximate level of 1.0V.

Bit 3~1   **RSEL2~RSEL0**: R type total bias resistors selection
    000: 1170kΩ
    001: 225kΩ
    010: 45kΩ
    011: Quick charging mode – switching between 45kΩ and 1170kΩ
    1xx: Quick charging mode – switching between 45kΩ and 225kΩ

The device provides the low power quick charging mode for LCD display. In quick charging mode the LCD will provide LCD bias current by R_T=45kΩ at the beginning of LCD display refreshes (i.e the moment on LCD COM changes). After quick charging time, the bias resistor will change to 225kΩ/1170kΩ.

Note that the bias resistor for 1/3 bias is R_T/3.

Bit 0   **LCDEN**: LCD Enable control
    0: Disable
    1: Enable

In the FAST, SLOW or IDLE mode, the LCD on/off function can be controlled by this bit. However, in the SLEEP mode, the LCD function is always switched off.

• **LCDC1 Register**

Bit	7	6	5	4	3	2	1	0
Name	QCT2	QCT1	QCT0	LCDPCK2	LCDPCK1	LCDPCK0	DTYC1	DTYC0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~5   **QCT2~QCT0**: R type quick charging time selection
    000: 1 t_{SUB}
    001: 2 t_{SUB}
    010: 3 t_{SUB}
    011: 4 t_{SUB}
    100: 5 t_{SUB}
    101: 6 t_{SUB}
    110: 7 t_{SUB}
    111: 8 t_{SUB}

The t_{SUB} is the period of the LCD clock source f_{SUB}, i.e., $1/f_{SUB}$.

Bit 4~2   **LCDPCK2 ~LCDPCK0**: C-type LCD Pump Clock divider
    000: 250Hz (f_{SUB}/128)
    001: 500Hz (f_{SUB}/64)
    010: 1kHz (f_{SUB}/32)
    011: 2kHz (f_{SUB}/16)
    100: 4kHz (f_{SUB}/8)
    101: 8kHz (f_{SUB}/4)
    110: 16kHz (f_{SUB}/2)
    111: 16kHz (f_{SUB}/2)

Bit 1~0   **DTYC1~DTYC0**: LCD duty selection
    00: 1/4 Duty – COM0~COM3 used
    01: 1/6 Duty – COM0~COM5 used
    10: 1/5 Duty – COM0~COM4 used
    11: Unimplemented

The unused COM pin can be configured as other pin-shared functions using the corresponding pin-shared selection register.

LCD Voltage Source and Biasing

The time and amplitude varying signals generated by the LCD Driver function require the generation of several voltage levels for their operation. The device can have either R type or C type biasing selected via a software control bit named RCT. Selecting the C type biasing will enable an internal charge pump circuitry.

R Type Biasing

For R type biasing an external LCD voltage source must be supplied on pin VDD to generate the internal biasing voltages. For the R type 1/3 bias scheme, four voltage levels V_{SS}, V_A, V_B and V_C are utilised.

Different values of internal bias resistors can be selected using the RSEL2~RESEL0 bits in the LCDC0 register. This along with the voltage on pin PLCD will determine the bias current. Note that no external capacitors or resistors are required to be connected if R type biasing is used.

Bias Selection	Bias Voltage
1/3 Bias	$V_A=V_{DD}$; $V_B=2/3V_A$; $V_C=1/3V_A$.

R Type Bias Voltage

C Type Biasing

For C type biasing the LCD voltage source can be supplied on the external pin PLCD, V1 or V2 or derived from the internal voltage source to generate the required biasing voltages. The C type bias voltage source is selected using the LCDP1 and LCDP0 bits in the LCDC0 register. The C type biasing scheme uses an internal charge pump circuit and can generate voltages higher than what is supplied on PLCD or V2. This feature is useful in applications where the microcontroller supply voltage is less than the supply voltage required by the LCD. The charge pump clock divider is selected using the LCDPCK2~LCDPCK0 bits in the LCDC1 register. Additional charge pump capacitors must also be connected between pins C1 and C2 to generate the necessary voltage levels.

For C type 1/3 bias external power supply scheme, the LCD power can be supplied on PLCD, V1 or V2 pin. However, the LCD power is internally supplied on V_A, V_B or V_C for C type 1/3 bias internal power supply scheme. Four internally generated voltage levels, V_{SS}, V_A, V_B and V_C, are utilised. These bias voltages have different levels depending upon different LCD power supply schemes.

LCD Power Supply		V_A Voltage	V_B Voltage	V_C Voltage
External Power Supply	V_{IN} on V1	V_{IN}	$2/3 \times V_{IN}$	$1/3 \times V_{IN}$
	V_{IN} on PLCD	$3/2 \times V_{IN}$	V_{IN}	$1/2 \times V_{IN}$
	V_{IN} on V2	$3 \times V_{IN}$	$2 \times V_{IN}$	V_{IN}
Internal Power Supply	V_{DD} on V_A	V_{DD}	$2/3 \times V_{DD}$	$1/3 \times V_{DD}$
	V_{DD} on V_B	$3/2 \times V_{DD}$	V_{DD}	$1/2 \times V_{DD}$
	V_{REFIN} on V_C	$3 \times V_{REFIN}$	$2 \times V_{REFIN}$	V_{REFIN}

C Type Bias Power Supply Scheme

LCD Reset Function

The LCD has an internal reset function that is an OR function of the inverted LCDEN bit in the LCDC0 register and the SLEEP function. When the LCDEN bit is set to 1 to enable the LCD driver function before the device enters the SLEEP mode, the LCD function will be reset after the device enters the SLEEP mode. Clearing the LCDEN bit to zero will also reset the LCD function.

MCU Reset	SLEEP Mode	LCDEN	LCD Reset	COM & SEG Voltage Level
No	Off	1	No	Normal Operation
No	Off	0	Yes	Low
No	On	x	Yes	Low
Yes	x	x	Yes	Floating

Note: 1. The watchdog time-out reset in the IDLE or SLEEP Mode is excluded from the MCU Reset conditions.
2. "x": Don't care.

LCD Reset Function

LCD Driver Output

The number of COM and SEG outputs supplied by the LCD driver, as well as its biasing and waveform type selections, are dependent upon how the LCD control bits are programmed. The Bias Type, whether C or R type is also selected by a software control bit.

The nature of Liquid Crystal Displays require that only AC voltages can be applied to their pixels as the application of DC voltages to LCD pixels may cause permanent damage. For this reason the relative contrast of an LCD display is controlled by the actual RMS voltage applied to each pixel, which is equal to the RMS value of the voltage on the COM pin minus the voltage applied to the SEG pin. This differential RMS voltage must be greater than the LCD saturation voltage for the pixel to be on and less than the threshold voltage for the pixel to be off.
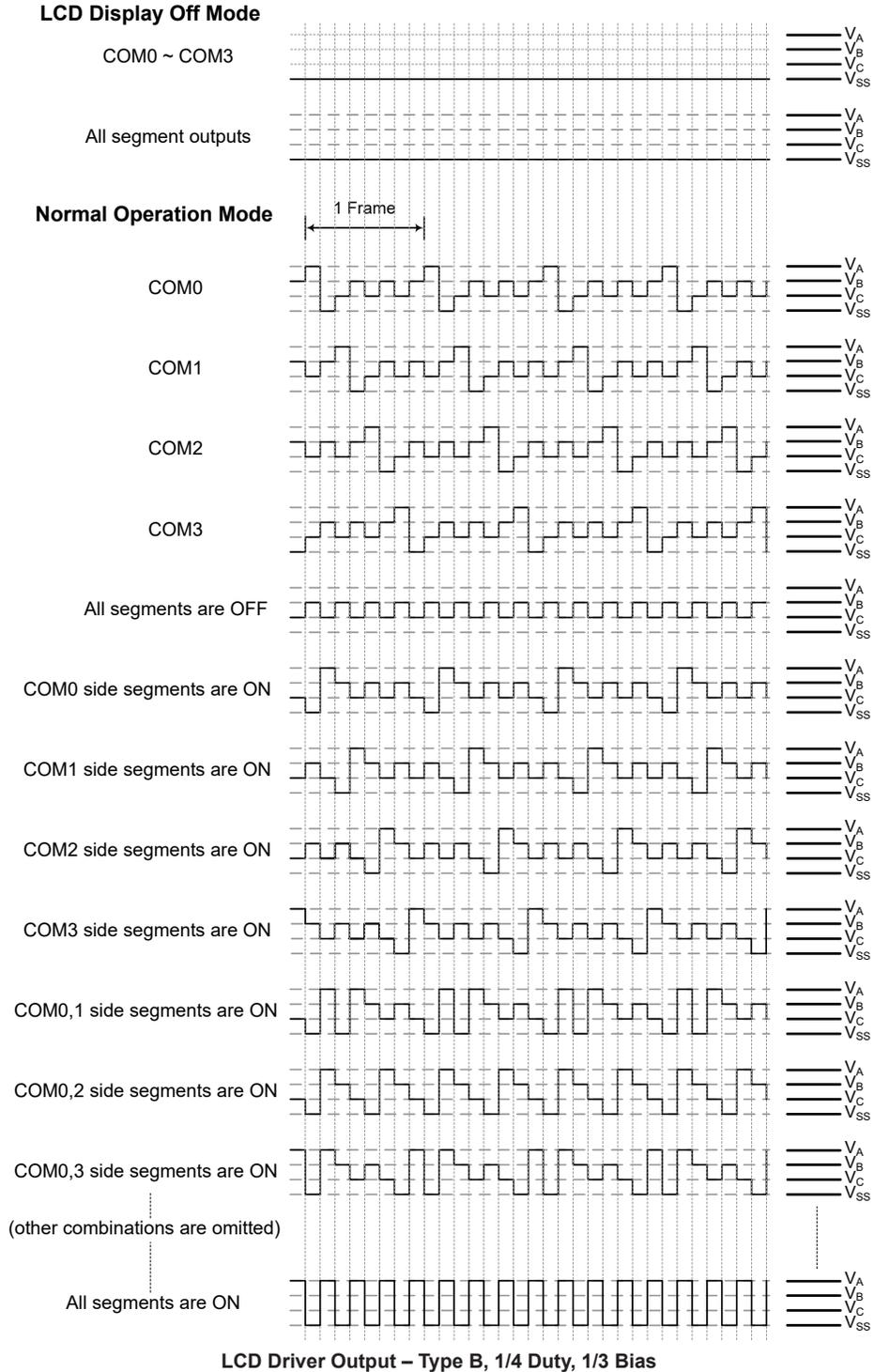
The requirement to limit the DC voltage to zero and to control as many pixels as possible with a minimum number of connections requires that both a time and amplitude signal is generated and applied to the application LCD. These time and amplitude varying signals are automatically generated by the LCD driver circuits in the microcontroller. What is known as the duty determines the number of common lines used, which are also known as backplanes or COMs. The duty, which is to have a value of 1/4 and which equates to a COM number of 4, therefore defines the number of time divisions within each LCD signal frame. Two types of signal generation are also provided, known as Type A and Type B, the required type is selected via the TYPE bit in the LCDC0 register. Type B offers lower frequency signals, however, lower frequencies may introduce flickering and influence display clarity.

R and C Type, 4 COM, 1/3 Bias

The bias type LCD driver is "R & C" type only. The LCD driver bias voltage can be 1/ 3 bias only.
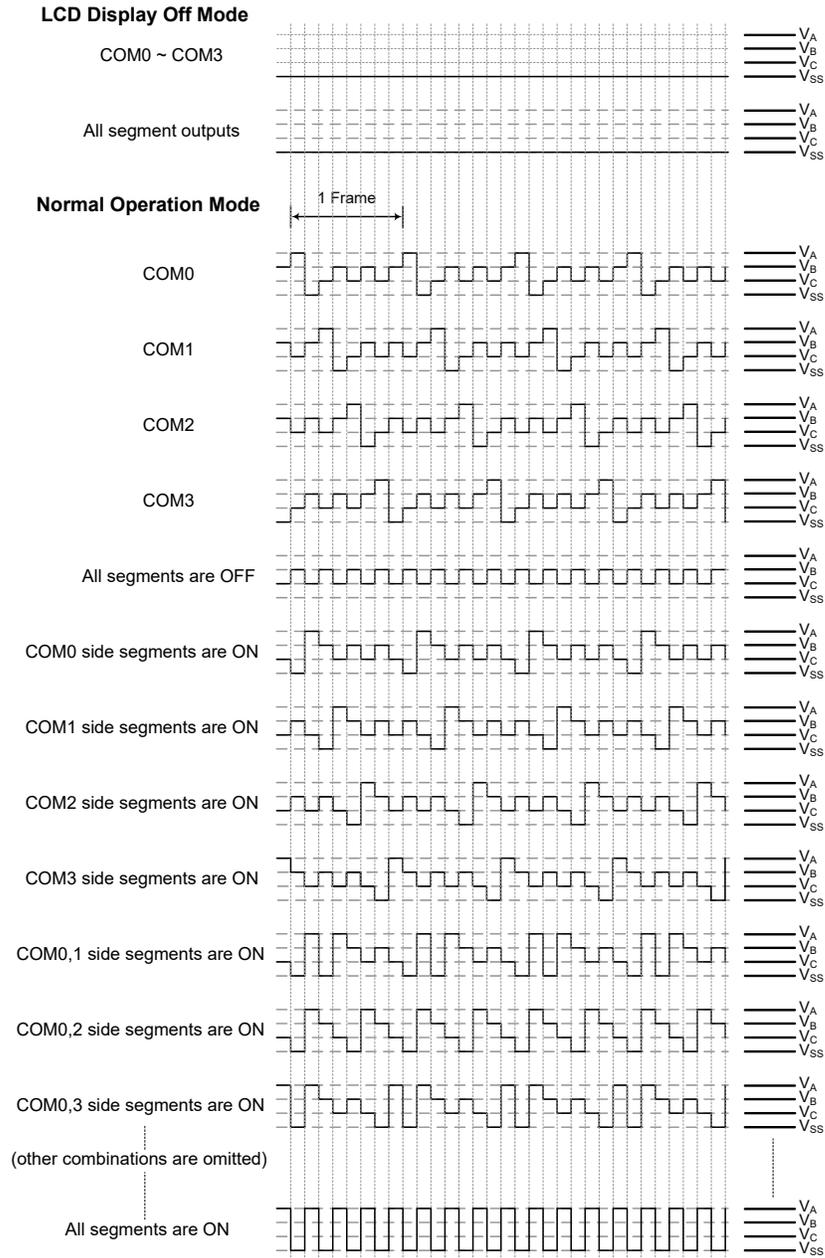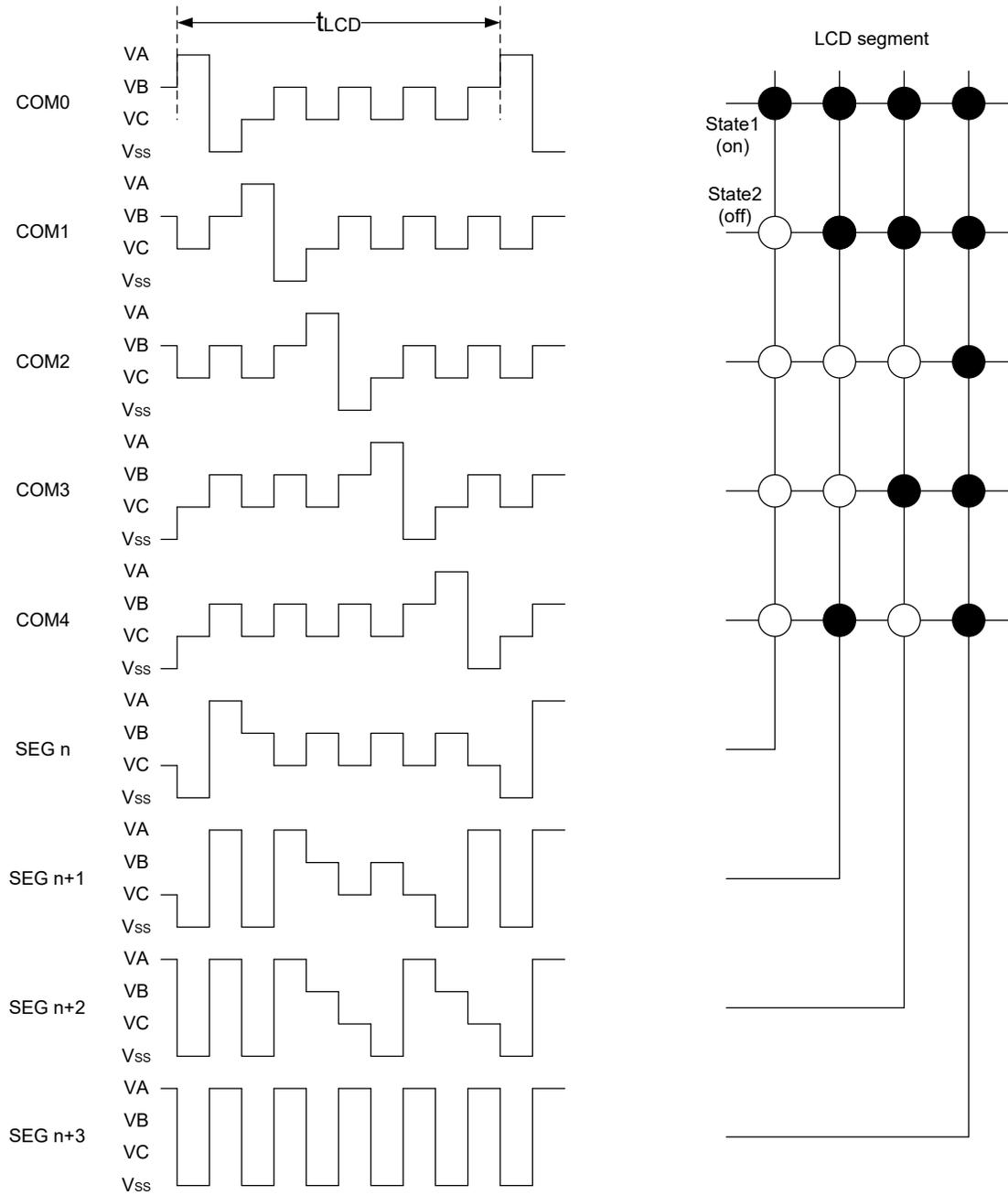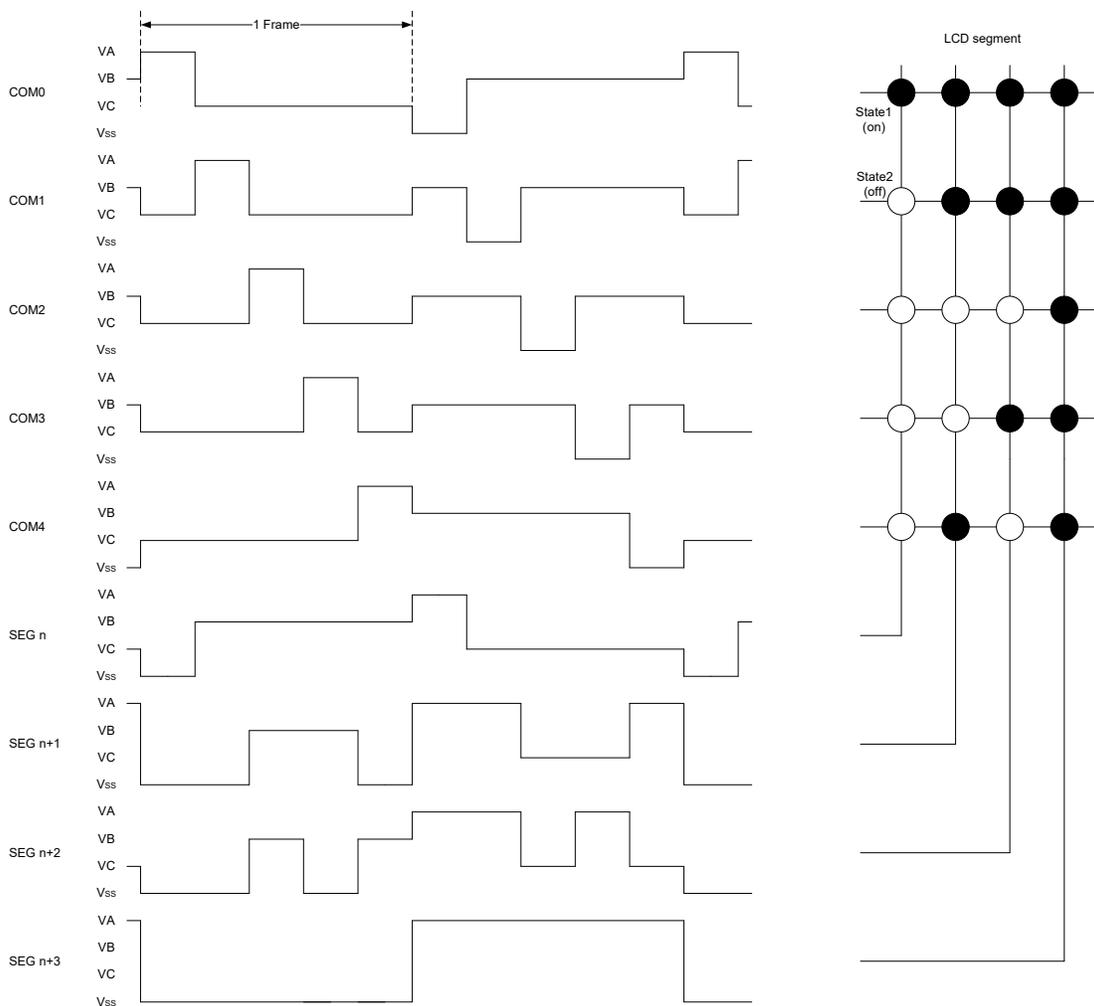

LCD Driver Output – Type A, 1/4 Duty, 1/3 Bias

LCD Display Off Mode

COM0 ~ COM3

All segment outputs

Normal Operation Mode

1 Frame

COM0

COM1

COM2

COM3

All segments are OFF

COM0 side segments are ON

COM1 side segments are ON

COM2 side segments are ON

COM3 side segments are ON

COM0,1 side segments are ON

COM0,2 side segments are ON

COM0,3 side segments are ON

(other combinations are omitted)

All segments are ON

LCD Driver Output – Type B, 1/4 Duty, 1/3 Bias

R and C Type, 5 COM, 1/3 Bias

Normal operation mode.

LCD Driver Output – Type A, 1/5 Duty, 1/3 Bias

LCD Driver Output – Type B, 1/5 Duty, 1/3 Bias

R and C Type, 6 COM, 1/3 Bias
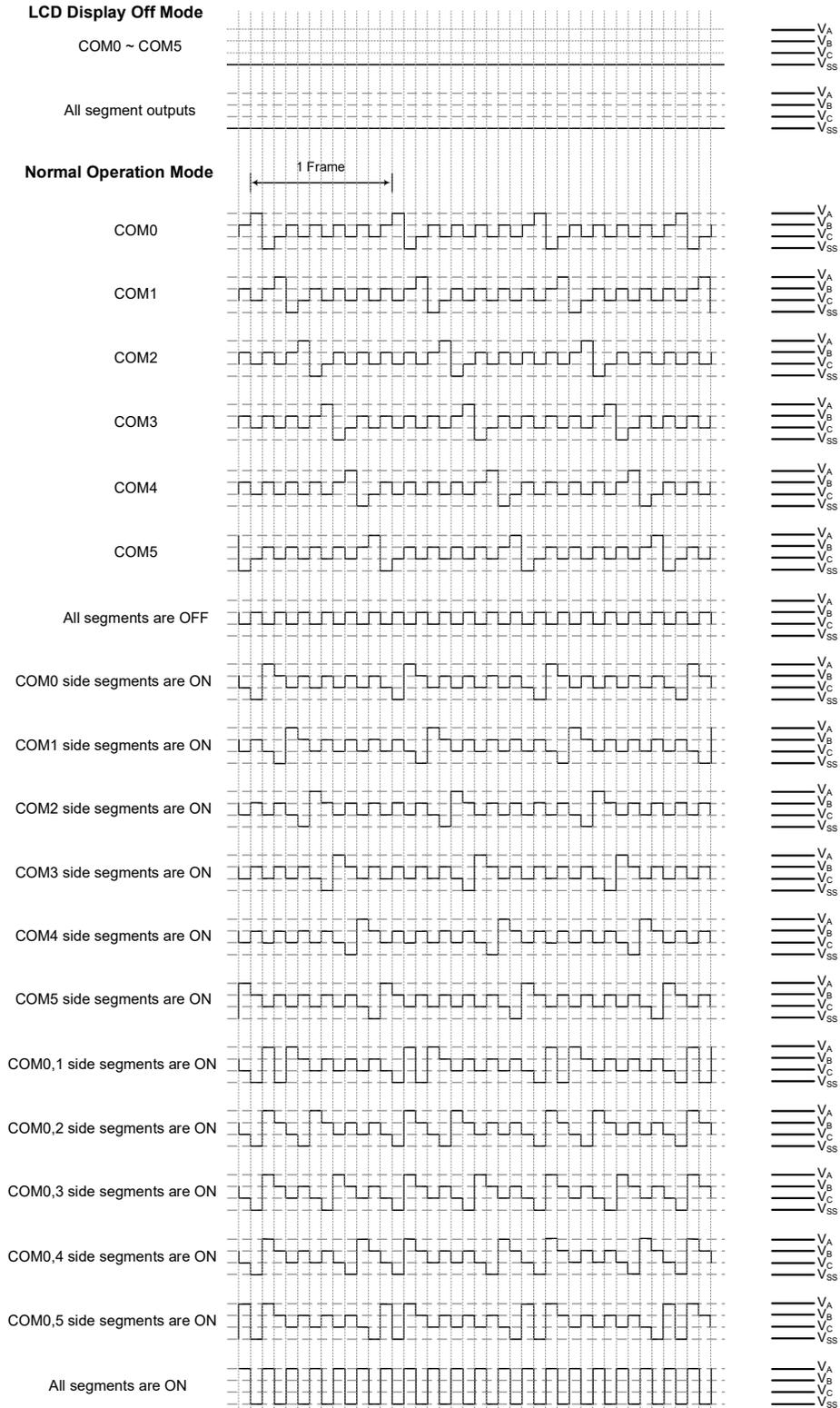
LCD Driver Output – Type A, 1/6 Duty, 1/3 Bias
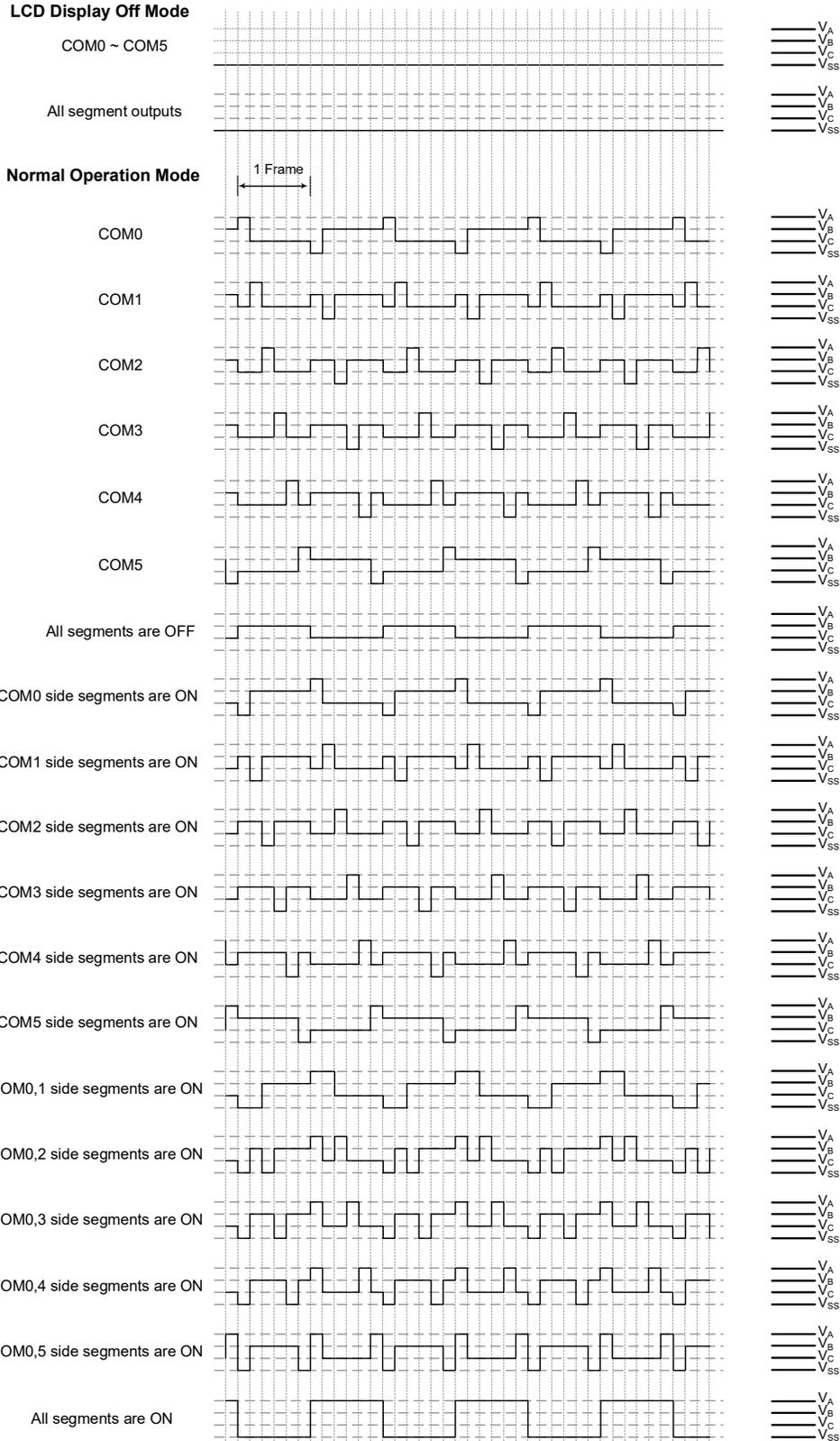
LCD Driver Output – Type B, 1/6 Duty, 1/3 Bias

Programming Considerations

Certain precautions must be taken when programming the LCD. One of these is to ensure that the LCD Memory is properly initialised after the microcontroller is powered on. Like the General Purpose Data Memory, the contents of the LCD Memory are in an unknown condition after power-on. As the contents of the LCD Memory will be mapped into the actual display, it is important to initialise this memory area into a known condition soon after applying power to obtain a proper display pattern.

Consideration must also be given to the capacitive load of the actual LCD used in the application. As the load presented to the microcontroller by LCD pixels can be generally modeled as mainly capacitive in nature, it is important that this is not excessive, a point that is particularly true in the case of the COM lines which may be connected to many LCD pixels. The accompanying diagram depicts the equivalent circuit of the LCD.

One additional consideration that must be taken into account is what happens when the microcontroller enters the IDLE or SLOW Mode. The LCDEN control bit in the LCDC0 register permits the display to be powered off to reduce power consumption. If this bit is zero, the driving signals to the display will cease, producing a blank display pattern but reducing any power consumption associated with the LCD.

After Power-on, note that as the LCDEN bit will be cleared to zero, the display function will be disabled.

LCD Panel Equivalent Circuit
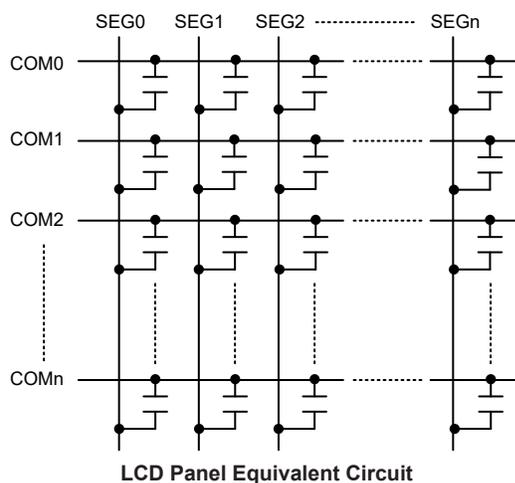
Low Voltage Detector – LVD

The device has a Low Voltage Detector function, also known as LVD. This enables the device to monitor the power supply voltage, V_{DD}, and provide a warning signal should it fall below a certain level. This function may be especially useful in battery applications where the supply voltage will gradually reduce as the battery ages, as it allows an early warning battery low signal to be generated. The Low Voltage Detector also has the capability of generating an interrupt signal.

LVD Register

The Low Voltage Detector function is controlled using a single register with the name LVDC. Three bits in this register, VLVD2~VLVD0, are used to select one of eight fixed voltages below which a low voltage condition will be determined. A low voltage condition is indicated when the LVDO bit is set. If the LVDO bit is low, this indicates that the V_{DD} pin input voltage is above the preset low voltage value. The LVDEN bit is used to control the overall on/off function of the low

voltage detector. Setting the bit high will enable the low voltage detector. Clearing the bit to zero will switch off the internal low voltage detector circuits. As the low voltage detector will consume a certain amount of power, it may be desirable to switch off the circuit when not in use, an important consideration in power sensitive battery powered applications.

- **LVDC Register**

Bit	7	6	5	4	3	2	1	0
Name	—	—	LVDO	LVDEN	—	VLVD2	VLVD1	VLVD0
R/W	—	—	R	R/W	—	R/W	R/W	R/W
POR	—	—	0	0	—	0	0	0

Bit 7~6   Unimplemented, read as "0"

Bit 5   **LVDO**: LVD output flag
    0: No Low Voltage Detected
    1: Low Voltage Detected

Bit 4   **LVDEN**: Low Voltage Detector function control
    0: Disable
    1: Enable

Bit3   Unimplemented, read as "0"

Bit 2~0   **VLVD2~VLVD0**: Select LVD Reference voltage
    000: 1.8V
    001: 2.0V
    010: 2.4V
    011: 2.7V
    100: 3.0V
    101: 3.3V
    110: 3.6V
    111: 4.0V

LVD Operation

The Low Voltage Detector function operates by comparing the power supply voltage, V_{DD}, with a pre-specified voltage level stored in the LVDC register. This has a range of between 1.8V and 4.0V. When the power supply voltage, V_{DD}, fall below this pre-determined value, the LVDO bit will be set high indicating a low power supply voltage condition. When the device is in the SLEEP mode, the low voltage detector will be disabled even if the LVDEN bit is high. After enabling the Low Voltage Detector, a time delay t_{LVDS} should be allowed for the circuitry to stabilise before reading the LVDO bit. Note also that as the V_{DD} voltage may rise and fall rather slowly, at the voltage nears that of V_{LVD}, there may be multiple bit LVDO transitions.

LVD Operation
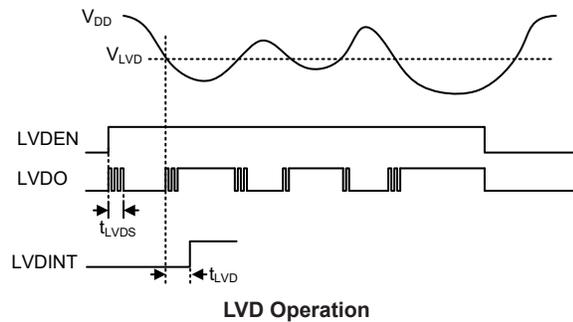
The Low Voltage Detector also has its own interrupt, providing an alternative means of low voltage detection, in addition to polling the LVDO bit. The interrupt will only be generated after a delay of t_{LVD} after the LVDO bit has been set high by a low voltage condition. In this case, the LVF interrupt request flag will be set, causing an interrupt to be generated if V_{DD} falls below the preset LVD voltage. This will cause the device to wake-up from the IDLE Mode, however if the Low Voltage Detector wake up function is not required then the LVF flag should be first set high before the device enters the IDLE Mode.

Interrupts

Interrupts are an important part of any microcontroller system. When an external event or an internal function such as a Timer Module or an A/D converter requires microcontroller attention, their corresponding interrupt will enforce a temporary suspension of the main program allowing the microcontroller to direct attention to their respective needs. The device contains several external interrupt and internal interrupt functions. The external interrupts are generated by the action of the external INT0~INT3 pins, while the internal interrupts are generated by various internal functions such as the Timer Modules, Time Bases, Low Voltage Detector (LVD), EEPROM, UART and the A/D converter.

Interrupt Registers

Overall interrupt control, which basically means the setting of request flags when certain microcontroller conditions occur and the setting of interrupt enable bits by the application program, is controlled by a series of registers, located in the Special Purpose Data Memory. The registers fall into three categories. The first is the INTC0~INTC3 registers which setup the primary interrupts, the second is the MFI0~MFI2 registers which setup the Multi-function interrupts. Finally there is an INTEG register to setup the external interrupts trigger edge type.

Each register contains a number of enable bits to enable or disable individual registers as well as interrupt flags to indicate the presence of an interrupt request. The naming convention of these follows a specific pattern. First is listed an abbreviated interrupt type, then the (optional) number of that interrupt followed by either an "E" for enable/disable bit or "F" for request flag.

Function	Enable Bit	Request Flag	Notes
Global	EMI	—	—
INTn Pin	INTnE	INTnF	n=0~3
A/D Converter	ADE	ADF	—
Multi-function	MFnE	MFnF	n=0~2
Time Base	TBnE	TBnF	n=0~1
LVD	LVE	LVF	—
EEPROM	DEE	DEF	—
UART	URE	URF	—
PTM	PTMPE	PTMPF	—
	PTMAE	PTMAF	
STM	STMPE	STMPF	—
	STMAE	STMAF	
CTM	CTMPE	CTMPF	—
	CTMAE	CTMAF	

Interrupt Register Bit Naming Conventions

Register	Bit							
Name	7	6	5	4	3	2	1	0
INTEG	INT3S1	INT3S0	INT2S1	INT2S0	INT1S1	INT1S0	INT0S1	INT0S0
INTC0	—	MF0F	INT1F	INT0F	MF0E	INT1E	INT0E	EMI
INTC1	URF	ADF	MF2F	MF1F	URE	ADE	MF2E	MF1E
INTC2	DEF	LVF	TB1F	TB0F	DEE	LVE	TB1E	TB0E
INTC3	—	—	INT3F	INT2F	—	—	INT3E	INT2E
MFI0	—	—	CTMAF	CTMPF	—	—	CTMAE	CTMPE
MFI1	—	—	PTMAF	PTMPF	—	—	PTMAE	PTMPE
MFI2	—	—	STMAF	STMPF	—	—	STMAE	STMPE

Interrupt Register List

• **INTEG Register**

Bit	7	6	5	4	3	2	1	0
Name	INT3S1	INT3S0	INT2S1	INT2S0	INT1S1	INT1S0	INT0S1	INT0S0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7~6   **INT3S1~INT3S0**: Interrupt edge control for INT3 pin
       00: Disable
       01: Rising edge
       10: Falling edge
       11: Rising and falling edges

Bit 5~4   **INT2S1~INT2S0**: Interrupt edge control for INT2 pin
       00: Disable
       01: Rising edge
       10: Falling edge
       11: Rising and falling edges

Bit 3~2   **INT1S1~INT1S0**: Interrupt edge control for INT1 pin
       00: Disable
       01: Rising edge
       10: Falling edge
       11: Rising and falling edges

Bit 1~0   **INT0S1~INT0S0**: Interrupt edge control for INT0 pin
       00: Disable
       01: Rising edge
       10: Falling edge
       11: Rising and falling edges

• **INTC0 Register**

Bit	7	6	5	4	3	2	1	0
Name	—	MF0F	INT1F	INT0F	MF0E	INT1E	INT0E	EMI
R/W	—	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	—	0	0	0	0	0	0	0

Bit 7   Unimplemented, read as "0"

Bit 6   **MF0F**: Multi-function 0 interrupt request flag
       0: No request
       1: Interrupt request

Bit 5   **INT1F**: External interrupt 1 request flag
       0: No request
       1: Interrupt request

Bit 4   **INT0F**: External interrupt 0 request flag
       0: No request
       1: Interrupt request

Bit 3   **MF0E**: Multi-function 0 interrupt control
       0: Disable
       1: Enable

Bit 2   **INT1E**: External interrupt 1 control
       0: Disable
       1: Enable

Bit 1   **INT0E**: External interrupt 0 control
       0: Disable
       1: Enable

Bit 0   **EMI**: Global interrupt control
       0: Disable
       1: Enable

• **INTC1 Register**

Bit	7	6	5	4	3	2	1	0
Name	URF	ADF	MF2F	MF1F	URE	ADE	MF2E	MF1E
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7   **URF**: UART interrupt request flag
       0: No request
       1: Interrupt request

Bit 6   **ADF**: A/D converter interrupt request flag
       0: No request
       1: Interrupt request

Bit 5   **MF2F**: Multi-function 2 interrupt request flag
       0: No request
       1: Interrupt request

Bit 4   **MF1F**: Multi-function 1 interrupt request flag
       0: No request
       1: Interrupt request

Bit 3   **URE**: UARTinterrupt control
       0: Disable
       1: Enable

Bit 2   **ADE**: A/D converter interrupt control
       0: Disable
       1: Enable

Bit 1   **MF2E**: Multi-function 2 interrupt control
       0: Disable
       1: Enable

Bit 0   **MF1E**: Multi-function 1 interrupt control
       0: Disable
       1: Enable

• **INTC2 Register**

Bit	7	6	5	4	3	2	1	0
Name	DEF	LVF	TB1F	TB0F	DEE	LVE	TB1E	TB0E
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
POR	0	0	0	0	0	0	0	0

Bit 7　　**DEF**: Data EEPROM interrupt request flag
　　　　　0: No request
　　　　　1: Interrupt request

Bit 6　　**LVF**: LVD interrupt request flag
　　　　　0: No request
　　　　　1: Interrupt request

Bit 5　　**TB1F**: Time Base 1 interrupt request flag
　　　　　0: No request
　　　　　1: Interrupt request

Bit 4　　**TB0F**: Time Base 0 interrupt request flag
　　　　　0: No request
　　　　　1: Interrupt request

Bit 3　　**DEE**: Data EEPROM interrupt control
　　　　　0: Disable
　　　　　1: Enable

Bit 2　　**LVE**: LVD interrupt control
　　　　　0: Disable
　　　　　1: Enable

Bit 1　　**TB1E**: Time Base 1 interrupt control
　　　　　0: Disable
　　　　　1: Enable

Bit 0　　**TB0E**: Time Base 0 interrupt control
　　　　　0: Disable
　　　　　1: Enable

• **INTC3 Register**

Bit	7	6	5	4	3	2	1	0
Name	—	—	INT3F	INT2F	—	—	INT3E	INT2E
R/W	—	—	R/W	R/W	—	—	R/W	R/W
POR	—	—	0	0	—	—	0	0

Bit 7~6　　Unimplemented, read as "0"

Bit 5　　**INT3F**: INT3 Interrupt Request Flag
　　　　　0: No request
　　　　　1: Interrupt request

Bit 4　　**INT2F**: INT2 Interrupt Request Flag
　　　　　0: No request
　　　　　1: Interrupt request

Bit 3~2　　Unimplemented, read as "0"

Bit 1　　**INT3E**: INT3 interrupt control
　　　　　0: Disable
　　　　　1: Enable

Bit 0　　**INT2E**: INT2 interrupt control
　　　　　0: Disable
　　　　　1: Enable

• **MFI0 Register**

Bit	7	6	5	4	3	2	1	0
Name	—	—	CTMAF	CTMPF	—	—	CTMAE	CTMPE
R/W	—	—	R/W	R/W	—	—	R/W	R/W
POR	—	—	0	0	—	—	0	0

Bit 7~6   Unimplemented, read as "0"

Bit 5   **CTMAF**: CTM CCRA comparator interrupt request flag
        0: No request
        1: Interrupt request

Bit 4   **CTMPF**: CTM CCRP comparator interrupt request flag
        0: No request
        1: Interrupt request

Bit 3~2   Unimplemented, read as "0"

Bit 1   **CTMAE**: CTM CCRA comparator interrupt control
        0: Disable
        1: Enable

Bit 0   **CTMPE**: CTM CCRP comparator interrupt control
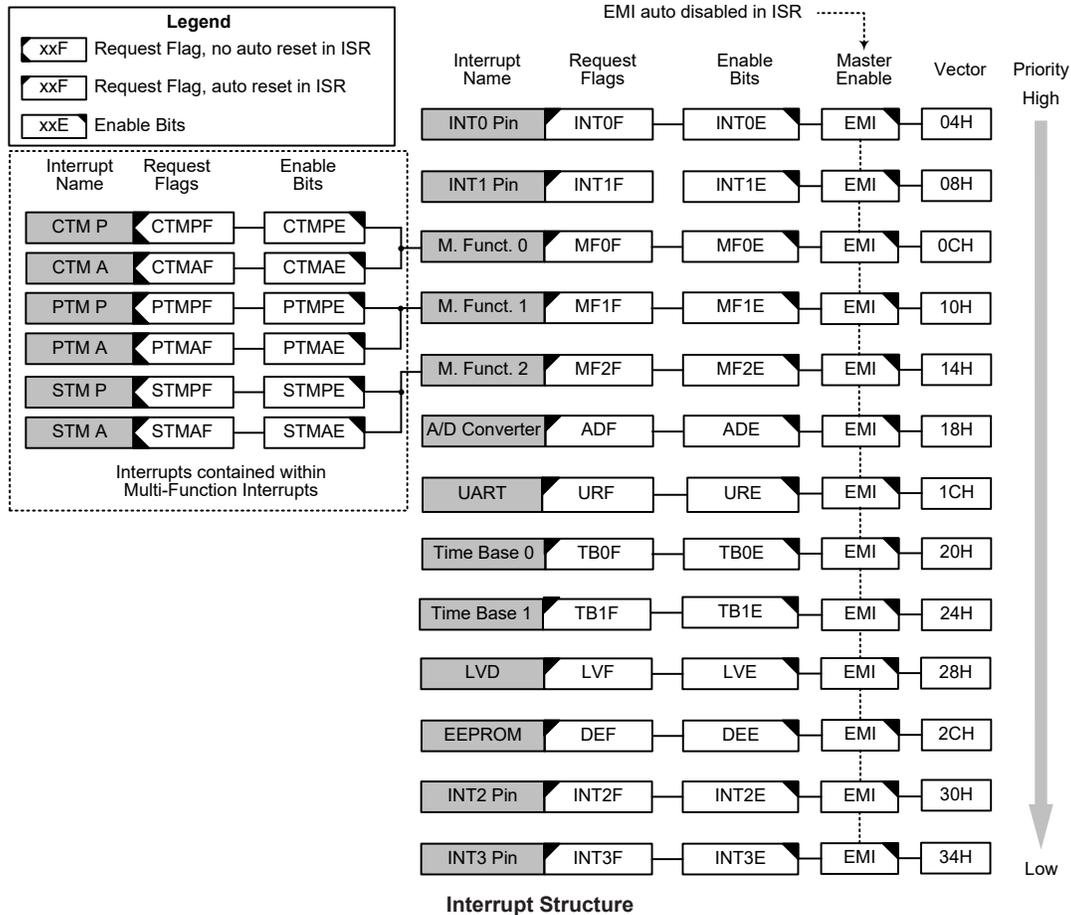   0: Disable
        1: Enable

• **MFI1 Register**

Bit	7	6	5	4	3	2	1	0
Name	—	—	PTMAF	PTMPF	—	—	PTMAE	PTMPE
R/W	—	—	R/W	R/W	—	—	R/W	R/W
POR	—	—	0	0	—	—	0	0

Bit 7~6   Unimplemented, read as "0"

Bit 5   **PTMAF**: PTM CCRA comparator interrupt request flag
        0: No request
        1: Interrupt request

Bit 4   **PTMPF**: PTM CCRP comparator interrupt request flag
        0: No request
        1: Interrupt request

Bit 3~2   Unimplemented, read as "0"

Bit 1   **PTMAE**: PTM CCRA comparator interrupt control
        0: Disable
        1: Enable

Bit 0   **PTMPE**: PTM CCRP comparator interrupt control
        0: Disable
        1: Enable

• **MFI2 Register**

Bit	7	6	5	4	3	2	1	0
Name	—	—	STMAF	STMPF	—	—	STMAE	STMPE
R/W	—	—	R/W	R/W	—	—	R/W	R/W
POR	—	—	0	0	—	—	0	0

Bit 7~6   Unimplemented, read as "0"

Bit 5   **STMAF**: STM CCRA comparator interrupt request flag
        0: No request
        1: Interrupt request

Bit 4   **STMPF**: STM CCRP comparator interrupt request flag
                    0: No request
                    1: Interrupt request

Bit 3~2   Unimplemented, read as "0"

Bit 1   **STMAE**: STM CCRA comparator interrupt control
                    0: Disable
                    1: Enable

Bit 0   **STMPE**: STM CCRP comparator interrupt control
                    0: Disable
                    1: Enable

Interrupt Operation

When the conditions for an interrupt event occur, such as a TM Comparator P, Comparator A match or A/D conversion completion etc., the relevant interrupt request flag will be set. Whether the request flag actually generates a program jump to the relevant interrupt vector is determined by the condition of the interrupt enable bit. If the enable bit is set high then the program will jump to its relevant vector; if the enable bit is zero then although the interrupt request flag is set an actual interrupt will not be generated and the program will not jump to the relevant interrupt vector. The global interrupt enable bit, if cleared to zero, will disable all interrupts.

When an interrupt is generated, the Program Counter, which stores the address of the next instruction to be executed, will be transferred onto the stack. The Program Counter will then be loaded with a new address which will be the value of the corresponding interrupt vector. The microcontroller will then fetch its next instruction from this interrupt vector. The instruction at this vector will usually be a "JMP" which will jump to another section of program which is known as the interrupt service routine. Here is located the code to control the appropriate interrupt. The interrupt service routine must be terminated with an "RETI", which retrieves the original Program Counter address from the stack and allows the microcontroller to continue with normal execution at the point where the interrupt occurred.

The various interrupt enable bits, together with their associated request flags, are shown in the accompanying diagrams with their order of priority. Some interrupt sources have their own individual vector while others share the same multi-function interrupt vector. Once an interrupt subroutine is serviced, all the other interrupts will be blocked, as the global interrupt enable bit, EMI bit will be cleared automatically. This will prevent any further interrupt nesting from occurring. However, if other interrupt requests occur during this interval, although the interrupt will not be immediately serviced, the request flag will still be recorded.

If an interrupt requires immediate servicing while the program is already in another interrupt service routine, the EMI bit should be set after entering the routine, to allow interrupt nesting. If the stack is full, the interrupt request will not be acknowledged, even if the related interrupt is enabled, until the Stack Pointer is decremented. If immediate service is desired, the stack must be prevented from becoming full. In case of simultaneous requests, the accompanying diagram shows the priority that is applied. All of the interrupt request flags when set will wake-up the device if it is in SLEEP or IDLE Mode, however to prevent a wake-up from occurring the corresponding flag should be set before the device is in SLEEP or IDLE Mode.

EMI auto disabled in ISR ⟶

Legend	
xxF	Request Flag, no auto reset in ISR
xxF	Request Flag, auto reset in ISR
xxE	Enable Bits

Interrupt Name	Request Flags	Enable Bits
CTM P	CTMPF	CTMPE
CTM A	CTMAF	CTMAE
PTM P	PTMPF	PTMPE
PTM A	PTMAF	PTMAE
STM P	STMPF	STMPE
STM A	STMAF	STMAE

Interrupts contained within
Multi-Function Interrupts

Interrupt Name	Request Flags	Enable Bits	Master Enable	Vector	Priority
INT0 Pin	INT0F	INT0E	EMI	04H	High
INT1 Pin	INT1F	INT1E	EMI	08H	
M. Funct. 0	MF0F	MF0E	EMI	0CH	
M. Funct. 1	MF1F	MF1E	EMI	10H	
M. Funct. 2	MF2F	MF2E	EMI	14H	
A/D Converter	ADF	ADE	EMI	18H	
UART	URF	URE	EMI	1CH	
Time Base 0	TB0F	TB0E	EMI	20H	
Time Base 1	TB1F	TB1E	EMI	24H	
LVD	LVF	LVE	EMI	28H	
EEPROM	DEF	DEE	EMI	2CH	
INT2 Pin	INT2F	INT2E	EMI	30H	
INT3 Pin	INT3F	INT3E	EMI	34H	Low

Interrupt Structure

External Interrupts

The external interrupts are controlled by signal transitions on the pins INT0~INT3. An external interrupt request will take place when the external interrupt request flags, INT0F~INT3F, are set, which will occur when a transition, whose type is chosen by the edge select bits, appears on the external interrupt pins. To allow the program to branch to its respective interrupt vector address, the global interrupt enable bit, EMI, and respective external interrupt enable bit, INT0E~INT3E, must first be set. Additionally the correct interrupt edge type must be selected using the INTEG register to enable the external interrupt function and to choose the trigger edge type. As the external interrupt pins are pin-shared with I/O pins, they can only be configured as external interrupt pins if their external interrupt enable bit in the corresponding interrupt register has been set and the external interrupt pin is selected by the corresponding pin-shared function selection bits. The pin must also be setup as an input by setting the corresponding bit in the port control register.

When the interrupt is enabled, the stack is not full and the correct transition type appears on the external interrupt pin, a subroutine call to the external interrupt vector, will take place. When the interrupt is serviced, the external interrupt request flags, INT0F~INT3F, will be automatically reset and the EMI bit will be automatically cleared to disable other interrupts. Note that any pull-high resistor selections on the external interrupt pins will remain valid even if the pin is used as an external interrupt input. The INTEG register is used to select the type of active edge that will trigger the external interrupt. A choice of either rising or falling or both edge types can be chosen to trigger an external interrupt. Note that the INTEG register can also be used to disable the external interrupt function.

A/D Converter Interrupt

The A/D converter interrupt is controlled by the termination of an A/D conversion process. An A/D converter interrupt request will take place when the A/D Converter Interrupt request flag, ADF, is set, which occurs when the A/D conversion process finishes. To allow the program to branch to its respective interrupt vector address, the global interrupt enable bit, EMI, and A/D converter interrupt enable bit, ADE, must first be set. When the interrupt is enabled, the stack is not full and the A/D conversion process has ended, a subroutine call to the A/D converter interrupt vector, will take place. When the interrupt is serviced, the A/D converter interrupt flag, ADF, will be automatically cleared. The EMI bit will also be automatically cleared to disable other interrupts.

Multi-function Interrupts

Within this device there are several multi-function interrupts. Unlike the other independent interrupts, these interrupts have no independent source, but rather are formed from other existing interrupt sources, namely the TM interrupts.

A multi-function interrupt request will take place when any of the multi-function interrupt request flags, MFnF are set. The multi-function interrupt flags will be set when any of their included functions generate an interrupt request flag. When the multi-function interrupt is enabled and the stack is not full, and either one of the interrupts contained within each of multi-function interrupt occurs, a subroutine call to one of the multi-function interrupt vectors will take place. When the interrupt is serviced, the related multi-function request flag will be automatically reset and the EMI bit will be automatically cleared to disable other interrupts.

However, it must be noted that, although the multi-function Interrupt flags will be automatically reset when the interrupt is serviced, the request flags from the original source of the multi-function interrupts will not be automatically reset and must be manually reset by the application program.

Timer Module Interrupts

Each of the Compact, Standard and Periodic Type TM has two interrupts. All of the TM interrupts are contained within the Multi-function Interrupts. For all of the TM types there are two interrupt request flags of CTMPF, CTMAF, STMPF, STMAF and PTMPF, PTMAF, and two enable bits of CTMPE, CTMAE, STMPE, STMAE and PTMPE, PTMAE. A TM interrupt request will take place when any of the TM request flags are set, a situation which occurs when a TM comparator P or A match situation happens.

To allow the program to branch to its respective interrupt vector address, the global interrupt enable bit, EMI, respective TM interrupt enable bit, and relevant multi-function interrupt enable bit, MFnE, must first be set. When the interrupt is enabled, the stack is not full and a TM comparator match situation occurs, a subroutine call to the relevant multi-function interrupt vector locations, will take place. When the TM interrupt is serviced, the EMI bit will be automatically cleared to disable other interrupts, however only the related MFnF flag will be automatically cleared. As the TM interrupt request flags will not be automatically cleared, they have to be cleared by the application program.

Time Base Interrupts

The function of the Time Base interrupts is to provide regular time signal in the form of an internal interrupt. They are controlled by the overflow signals from their respective timer functions. When these happen their respective interrupt request flags, TB0F or TB1F will be set. To allow the program to branch to their respective interrupt vector addresses, the global interrupt enable bit, EMI and Time Base enable bits, TB0E or TB1E, must first be set. When the interrupt is enabled, the stack is not full and the Time Base overflows, a subroutine call to their respective vector locations will take place. When the interrupt is serviced, the respective interrupt request flag, TBnF, will be automatically reset and the EMI bit will be cleared to disable other interrupts.

The purpose of the Time Base interrupt is to provide an interrupt signal at fixed time periods. Its clock source, f_{PSC0} or f_{PSC1}, originates from the internal clock source f_{SYS}, $f_{SYS}/4$ or f_{SUB} and then passes through a divider, the division ratio of which is selected by programming the appropriate bits in the TB0C and TB1C registers to obtain longer interrupt periods whose value ranges. The clock source which in turn controls the Time Base interrupt period is selected using the CLKSEL0[1:0] and CLKSEL1[1:0] bits in the PSC0R and PSC1R register.

Time Base Interrupts
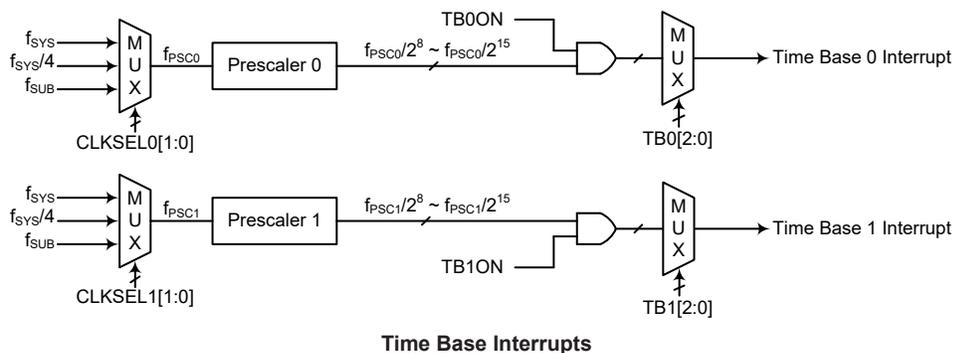
- **PSCnR Register (n=0~1)**

Bit	7	6	5	4	3	2	1	0
Name	—	—	—	—	—	—	CLKSELn1	CLKSELn0
R/W	—	—	—	—	—	—	R/W	R/W
POR	—	—	—	—	—	—	0	0

Bit 7~2   Unimplemented, read as "0"

Bit 1~0   **CLKSELn1~CLKSELn0**: Prescaler clock source f_{PSCn} selection
        00: f_{SYS}
        01: $f_{SYS}/4$
        1x: f_{SUB}

- **TB0C Register**

Bit	7	6	5	4	3	2	1	0
Name	TB0ON	—	—	—	—	TB02	TB01	TB00
R/W	R/W	—	—	—	—	R/W	R/W	R/W
POR	0	—	—	—	—	0	0	0

Bit 7   **TB0ON**: Time Base 0 control
        0: Disable
        1: Enable

Bit 6~3   Unimplemented, read as "0"

Bit 2~0   **TB02~TB00**: Select Time Base 0 time-out period
        000: $2^8/f_{PSC0}$
        001: $2^9/f_{PSC0}$
        010: $2^{10}/f_{PSC0}$
        011: $2^{11}/f_{PSC0}$
        100: $2^{12}/f_{PSC0}$
        101: $2^{13}/f_{PSC0}$
        110: $2^{14}/f_{PSC0}$
        111: $2^{15}/f_{PSC0}$

• **TB1C Register**

Bit	7	6	5	4	3	2	1	0
Name	TB1ON	—	—	—	—	TB12	TB11	TB10
R/W	R/W	—	—	—	—	R/W	R/W	R/W
POR	0	—	—	—	—	0	0	0

Bit 7   **TB1ON**: Time Base 1 control
         0: Disable
         1: Enable

Bit 6~3   Unimplemented, read as "0"

Bit 2~0   **TB12~TB10**: Select Time Base 1 time-out period
         000: $2^8/f_{PSC1}$
         001: $2^9/f_{PSC1}$
         010: $2^{10}/f_{PSC1}$
         011: $2^{11}/f_{PSC1}$
         100: $2^{12}/f_{PSC1}$
         101: $2^{13}/f_{PSC1}$
         110: $2^{14}/f_{PSC1}$
         111: $2^{15}/f_{PSC1}$

LVD Interrupt

An LVD interrupt request will take place when the LVD interrupt request flag, LVF, is set, which occurs when the Low Voltage Detector function detects a low power supply voltage. To allow the program to branch to its respective interrupt vector address, the global interrupt enable bit, EMI, and Low Voltage interrupt enable bit, LVE, must first be set. When the interrupt is enabled, the stack is not full and a low voltage condition occurs, a subroutine call to the LCD interrupt vector, will take place. When the Low Voltage interrupt is serviced, the respective interrupt request flag, LVF, will be automatically reset and the EMI bit will be cleared to disable other interrupts.

EEPROM Interrupt

An EEPROM interrupt request will take place when the EEPROM interrupt request flag, DEF, is set, which occurs when an EEPROM erase/write cycle ends. To allow the program to branch to its respective interrupt vector address, the global interrupt enable bit, EMI, and EEPROM interrupt enable bit, DEE, must first be set. When the interrupt is enabled, the stack is not full and an EEPROM erase/write cycle ends, a subroutine call to the respective EEPROM interrupt vector will take place. When the EEPROM interrupt is serviced, the respective interrupt request flag, DEF, will be automatically reset and the EMI bit will be cleared to disable other interrupts.

UART Transfer Interrupt

The UART Transfer Interrupt is controlled by several UART transfer conditions. When one of these conditions occurs, an interrupt pulse will be generated to get the attention of the microcontroller. These conditions are a transmitter data register empty, transmitter idle, receiver data available, receiver overrun, address detect and an RX/TX pin wake-up. To allow the program to branch to its respective interrupt vector address, the global interrupt enable bit, EMI, and UART Interrupt enable bit, URE, must first be set. When the interrupt is enabled, the stack is not full and any of the conditions described above occurs, a subroutine call to the Interrupt vector, will take place. When the UART interrupt is serviced, the UART Interrupt flag, URF, will be automatically cleared. The EMI bit will also be automatically cleared to disable other interrupts. However, the USR register flags will be cleared automatically when certain actions are taken by the UART, the details of which are given in the UART section.

Interrupt Wake-up Function

Each of the interrupt functions has the capability of waking up the microcontroller when in the SLEEP or IDLE Mode. A wake-up is generated when an interrupt request flag changes from low to high and is independent of whether the interrupt is enabled or not. Therefore, even though the device is in the SLEEP or IDLE Mode and its system oscillator stopped, situations such as external edge transitions on the external interrupt pins or a low power supply voltage may cause their respective interrupt flag to be set high and consequently generate an interrupt. Care must therefore be taken if spurious wake-up situations are to be avoided. If an interrupt wake-up function is to be disabled then the corresponding interrupt request flag should be set high before the device enters the SLEEP or IDLE Mode. The interrupt enable bits have no effect on the interrupt wake-up function.

Programming Considerations

By disabling the relevant interrupt enable bits, a requested interrupt can be prevented from being serviced, however, once an interrupt request flag is set, it will remain in this condition in the interrupt register until the corresponding interrupt is serviced or until the request flag is cleared by the application program.

Where a certain interrupt is contained within a multi-function interrupt, then when the interrupt service routine is executed, as only the multi-function interrupt request flags, MFnF, will be automatically cleared, the individual request flag for the function needs to be cleared by the application program.

It is recommended that programs do not use the "CALL" instruction within the interrupt service subroutine. Interrupts often occur in an unpredictable manner or need to be serviced immediately. If only one stack is left and the interrupt is not well controlled, the original control sequence will be damaged once a CALL subroutine is executed in the interrupt subroutine.

Every interrupt has the capability of waking up the microcontroller when it is in SLEEP or IDLE Mode, the wake up being generated when the interrupt request flag changes from low to high. If it is required to prevent a certain interrupt from waking up the microcontroller then its respective request flag should be first set high before enter SLEEP or IDLE Mode.

As only the Program Counter is pushed onto the stack, then when the interrupt is serviced, if the contents of the accumulator, status register or other registers are altered by the interrupt service program, their contents should be saved to the memory at the beginning of the interrupt service routine. To return from an interrupt subroutine, either an RET or RETI instruction may be executed. The RETI instruction in addition to executing a return to the main program also automatically sets the EMI bit high to allow further interrupts. The RET instruction however only executes a return to the main program leaving the EMI bit in its present zero state and therefore disabling the execution of further interrupts.

Application Circuits
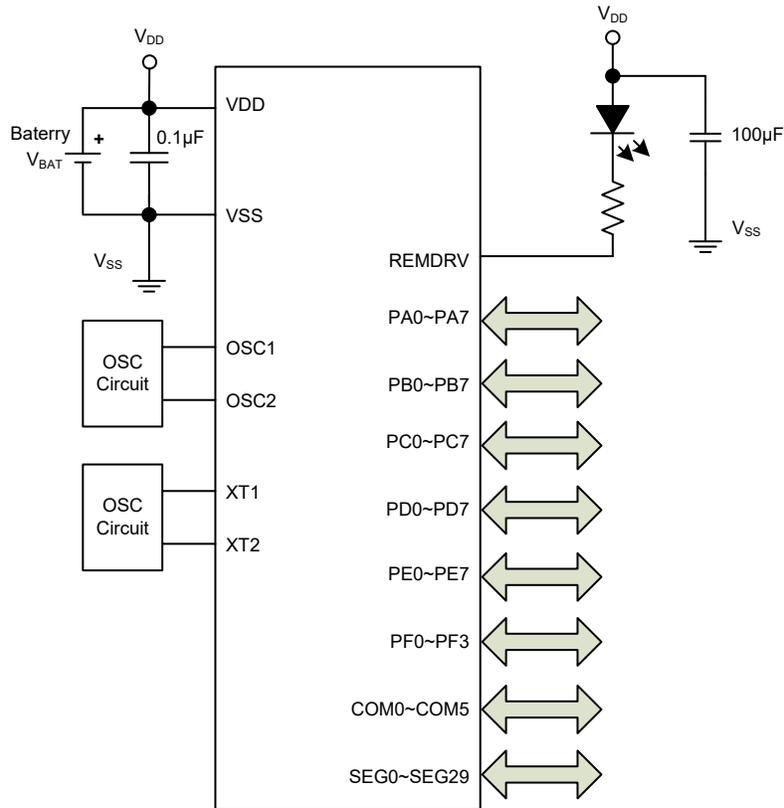
Instruction Set

Introduction

Central to the successful operation of any microcontroller is its instruction set, which is a set of program instruction codes that directs the microcontroller to perform certain operations. In the case of Holtek microcontroller, a comprehensive and flexible set of over 60 instructions is provided to enable programmers to implement their application with the minimum of programming overheads.

For easier understanding of the various instruction codes, they have been subdivided into several functional groupings.

Instruction Timing

Most instructions are implemented within one instruction cycle. The exceptions to this are branch, call, or table read instructions where two instruction cycles are required. One instruction cycle is equal to 4 system clock cycles, therefore in the case of an 8MHz system oscillator, most instructions would be implemented within 0.5μs and branch or call instructions would be implemented within 1μs. Although instructions which require one more cycle to implement are generally limited to the JMP, CALL, RET, RETI and table read instructions, it is important to realize that any other instructions which involve manipulation of the Program Counter Low register or PCL will also take one more cycle to implement. As instructions which change the contents of the PCL will imply a direct jump to that new address, one more cycle will be required. Examples of such instructions would be "CLR PCL" or "MOV PCL, A". For the case of skip instructions, it must be noted that if the result of the comparison involves a skip operation then this will also take one more cycle, if no skip is involved then only one cycle is required.

Moving and Transferring Data

The transfer of data within the microcontroller program is one of the most frequently used operations. Making use of several kinds of MOV instructions, data can be transferred from registers to the Accumulator and vice-versa as well as being able to move specific immediate data directly into the Accumulator. One of the most important data transfer applications is to receive data from the input ports and transfer data to the output ports.

Arithmetic Operations

The ability to perform certain arithmetic operations and data manipulation is a necessary feature of most microcontroller applications. Within the Holtek microcontroller instruction set are a range of add and subtract instruction mnemonics to enable the necessary arithmetic to be carried out. Care must be taken to ensure correct handling of carry and borrow data when results exceed 255 for addition and less than 0 for subtraction. The increment and decrement instructions such as INC, INCA, DEC and DECA provide a simple means of increasing or decreasing by a value of one of the values in the destination specified.

Logical and Rotate Operation

The standard logical operations such as AND, OR, XOR and CPL all have their own instruction within the Holtek microcontroller instruction set. As with the case of most instructions involving data manipulation, data must pass through the Accumulator which may involve additional programming steps. In all logical data operations, the zero flag may be set if the result of the operation is zero. Another form of logical data manipulation comes from the rotate instructions such as RR, RL, RRC and RLC which provide a simple means of rotating one bit right or left. Different rotate instructions exist depending on program requirements. Rotate instructions are useful for serial port programming applications where data can be rotated from an internal register into the Carry bit from where it can be examined and the necessary serial bit set high or low. Another application which rotate data operations are used is to implement multiplication and division calculations.

Branches and Control Transfer

Program branching takes the form of either jumps to specified locations using the JMP instruction or to a subroutine using the CALL instruction. They differ in the sense that in the case of a subroutine call, the program must return to the instruction immediately when the subroutine has been carried out. This is done by placing a return instruction "RET" in the subroutine which will cause the program to jump back to the address right after the CALL instruction. In the case of a JMP instruction, the program simply jumps to the desired location. There is no requirement to jump back to the original jumping off point as in the case of the CALL instruction. One special and extremely useful set of branch instructions are the conditional branches. Here a decision is first made regarding the condition of a certain data memory or individual bits. Depending upon the conditions, the program will continue with the next instruction or skip over it and jump to the following instruction. These instructions are the key to decision making and branching within the program perhaps determined by the condition of certain input switches or by the condition of internal data bits.

Bit Operations

The ability to provide single bit operations on Data Memory is an extremely flexible feature of all Holtek microcontrollers. This feature is especially useful for output port bit programming where individual bits or port pins can be directly set high or low using either the "SET [m].i" or "CLR [m].i" instructions respectively. The feature removes the need for programmers to first read the 8-bit output port, manipulate the input data to ensure that other bits are not changed and then output the port with the correct new data. This read-modify-write process is taken care of automatically when these bit operation instructions are used.

Table Read Operations

Data storage is normally implemented by using registers. However, when working with large amounts of fixed data, the volume involved often makes it inconvenient to store the fixed data in the Data Memory. To overcome this problem, Holtek microcontrollers allow an area of Program Memory to be setup as a table where data can be directly stored. A set of easy to use instructions provides the means by which this fixed data can be referenced and retrieved from the Program Memory.

Other Operations

In addition to the above functional instructions, a range of other instructions also exist such as the "HALT" instruction for Power-down operations and instructions to control the operation of the Watchdog Timer for reliable program operations under extreme electric or electromagnetic environments. For their relevant operations, refer to the functional related sections.

Instruction Set Summary

The instructions related to the data memory access in the following table can be used when the desired data memory is located in Data Memory sector 0.

Table Conventions

x: Bits immediate data

m: Data Memory address

A: Accumulator

i: 0~7 number of bits

addr: Program memory address

Mnemonic	Description	Cycles	Flag Affected
Arithmetic			
ADD A,[m]	Add Data Memory to ACC	1	Z, C, AC, OV, SC
ADDM A,[m]	Add ACC to Data Memory	1[Note]	Z, C, AC, OV, SC
ADD A,x	Add immediate data to ACC	1	Z, C, AC, OV, SC
ADC A,[m]	Add Data Memory to ACC with Carry	1	Z, C, AC, OV, SC
ADCM A,[m]	Add ACC to Data memory with Carry	1[Note]	Z, C, AC, OV, SC
SUB A,x	Subtract immediate data from the ACC	1	Z, C, AC, OV, SC, CZ
SUB A,[m]	Subtract Data Memory from ACC	1	Z, C, AC, OV, SC, CZ
SUBM A,[m]	Subtract Data Memory from ACC with result in Data Memory	1[Note]	Z, C, AC, OV, SC, CZ
SBC A,x	Subtract immediate data from ACC with Carry	1	Z, C, AC, OV, SC, CZ
SBC A,[m]	Subtract Data Memory from ACC with Carry	1	Z, C, AC, OV, SC, CZ
SBCM A,[m]	Subtract Data Memory from ACC with Carry, result in Data Memory	1[Note]	Z, C, AC, OV, SC, CZ
DAA [m]	Decimal adjust ACC for Addition with result in Data Memory	1[Note]	C
Logic Operation			
AND A,[m]	Logical AND Data Memory to ACC	1	Z
OR A,[m]	Logical OR Data Memory to ACC	1	Z
XOR A,[m]	Logical XOR Data Memory to ACC	1	Z
ANDM A,[m]	Logical AND ACC to Data Memory	1[Note]	Z
ORM A,[m]	Logical OR ACC to Data Memory	1[Note]	Z
XORM A,[m]	Logical XOR ACC to Data Memory	1[Note]	Z
AND A,x	Logical AND immediate Data to ACC	1	Z
OR A,x	Logical OR immediate Data to ACC	1	Z
XOR A,x	Logical XOR immediate Data to ACC	1	Z
CPL [m]	Complement Data Memory	1[Note]	Z
CPLA [m]	Complement Data Memory with result in ACC	1	Z
Increment & Decrement			
INCA [m]	Increment Data Memory with result in ACC	1	Z
INC [m]	Increment Data Memory	1[Note]	Z
DECA [m]	Decrement Data Memory with result in ACC	1	Z
DEC [m]	Decrement Data Memory	1[Note]	Z
Rotate			
RRA [m]	Rotate Data Memory right with result in ACC	1	None
RR [m]	Rotate Data Memory right	1[Note]	None
RRCA [m]	Rotate Data Memory right through Carry with result in ACC	1	C
RRC [m]	Rotate Data Memory right through Carry	1[Note]	C
RLA [m]	Rotate Data Memory left with result in ACC	1	None
RL [m]	Rotate Data Memory left	1[Note]	None
RLCA [m]	Rotate Data Memory left through Carry with result in ACC	1	C
RLC [m]	Rotate Data Memory left through Carry	1[Note]	C

Mnemonic	Description	Cycles	Flag Affected
Data Move			
MOV A,[m]	Move Data Memory to ACC	1	None
MOV [m],A	Move ACC to Data Memory	1[Note]	None
MOV A,x	Move immediate data to ACC	1	None
Bit Operation			
CLR [m].i	Clear bit of Data Memory	1[Note]	None
SET [m].i	Set bit of Data Memory	1[Note]	None
Branch Operation			
JMP addr	Jump unconditionally	2	None
SZ [m]	Skip if Data Memory is zero	1[Note]	None
SZA [m]	Skip if Data Memory is zero with data movement to ACC	1[Note]	None
SZ [m].i	Skip if bit i of Data Memory is zero	1[Note]	None
SNZ [m]	Skip if Data Memory is not zero	1[Note]	None
SNZ [m].i	Skip if bit i of Data Memory is not zero	1[Note]	None
SIZ [m]	Skip if increment Data Memory is zero	1[Note]	None
SDZ [m]	Skip if decrement Data Memory is zero	1[Note]	None
SIZA [m]	Skip if increment Data Memory is zero with result in ACC	1[Note]	None
SDZA [m]	Skip if decrement Data Memory is zero with result in ACC	1[Note]	None
CALL addr	Subroutine call	2	None
RET	Return from subroutine	2	None
RET A,x	Return from subroutine and load immediate data to ACC	2	None
RETI	Return from interrupt	2	None
Table Read Operation			
TABRD [m]	Read table (specific page) to TBLH and Data Memory	2[Note]	None
TABRDL [m]	Read table (last page) to TBLH and Data Memory	2[Note]	None
ITABRD [m]	Increment table pointer TBLP first and Read table (specific page) to TBLH and Data Memory	2[Note]	None
ITABRDL [m]	Increment table pointer TBLP first and Read table (last page) to TBLH and Data Memory	2[Note]	None
Miscellaneous			
NOP	No operation	1	None
CLR [m]	Clear Data Memory	1[Note]	None
SET [m]	Set Data Memory	1[Note]	None
CLR WDT	Clear Watchdog Timer	1	TO, PDF
SWAP [m]	Swap nibbles of Data Memory	1[Note]	None
SWAPA [m]	Swap nibbles of Data Memory with result in ACC	1	None
HALT	Enter power down mode	1	TO, PDF

Note: 1. For skip instructions, if the result of the comparison involves a skip then two cycles are required, if no skip takes place only one cycle is required.

2. Any instruction which changes the contents of the PCL will also require 2 cycles for execution.

Extended Instruction Set

The extended instructions are used to support the full range address access for the data memory. When the accessed data memory is located in any data memory sector except sector 0, the extended instruction can be used to directly access the data memory instead of using the indirect addressing access. This can not only reduce the use of Flash memory space but also improve the CPU execution efficiency.

Mnemonic	Description	Cycles	Flag Affected
Arithmetic			
LADD A,[m]	Add Data Memory to ACC	2	Z, C, AC, OV, SC
LADDM A,[m]	Add ACC to Data Memory	2[Note]	Z, C, AC, OV, SC
LADC A,[m]	Add Data Memory to ACC with Carry	2	Z, C, AC, OV, SC
LADCM A,[m]	Add ACC to Data memory with Carry	2[Note]	Z, C, AC, OV, SC
LSUB A,[m]	Subtract Data Memory from ACC	2	Z, C, AC, OV, SC, CZ
LSUBM A,[m]	Subtract Data Memory from ACC with result in Data Memory	2[Note]	Z, C, AC, OV, SC, CZ
LSBC A,[m]	Subtract Data Memory from ACC with Carry	2	Z, C, AC, OV, SC, CZ
LSBCM A,[m]	Subtract Data Memory from ACC with Carry, result in Data Memory	2[Note]	Z, C, AC, OV, SC, CZ
LDAA [m]	Decimal adjust ACC for Addition with result in Data Memory	2[Note]	C
Logic Operation			
LAND A,[m]	Logical AND Data Memory to ACC	2	Z
LOR A,[m]	Logical OR Data Memory to ACC	2	Z
LXOR A,[m]	Logical XOR Data Memory to ACC	2	Z
LANDM A,[m]	Logical AND ACC to Data Memory	2[Note]	Z
LORM A,[m]	Logical OR ACC to Data Memory	2[Note]	Z
LXORM A,[m]	Logical XOR ACC to Data Memory	2[Note]	Z
LCPL [m]	Complement Data Memory	2[Note]	Z
LCPLA [m]	Complement Data Memory with result in ACC	2	Z
Increment & Decrement			
LINCA [m]	Increment Data Memory with result in ACC	2	Z
LINC [m]	Increment Data Memory	2[Note]	Z
LDECA [m]	Decrement Data Memory with result in ACC	2	Z
LDEC [m]	Decrement Data Memory	2[Note]	Z
Rotate			
LRRA [m]	Rotate Data Memory right with result in ACC	2	None
LRR [m]	Rotate Data Memory right	2[Note]	None
LRRCA [m]	Rotate Data Memory right through Carry with result in ACC	2	C
LRRC [m]	Rotate Data Memory right through Carry	2[Note]	C
LRLA [m]	Rotate Data Memory left with result in ACC	2	None
LRL [m]	Rotate Data Memory left	2[Note]	None
LRLCA [m]	Rotate Data Memory left through Carry with result in ACC	2	C
LRLC [m]	Rotate Data Memory left through Carry	2[Note]	C
Data Move			
LMOV A,[m]	Move Data Memory to ACC	2	None
LMOV [m],A	Move ACC to Data Memory	2[Note]	None
Bit Operation			
LCLR [m].i	Clear bit of Data Memory	2[Note]	None
LSET [m].i	Set bit of Data Memory	2[Note]	None

Mnemonic	Description	Cycles	Flag Affected
Branch			
LSZ [m]	Skip if Data Memory is zero	2[Note]	None
LSZA [m]	Skip if Data Memory is zero with data movement to ACC	2[Note]	None
LSNZ [m]	Skip if Data Memory is not zero	2[Note]	None
LSZ [m].i	Skip if bit i of Data Memory is zero	2[Note]	None
LSNZ [m].i	Skip if bit i of Data Memory is not zero	2[Note]	None
LSIZ [m]	Skip if increment Data Memory is zero	2[Note]	None
LSDZ [m]	Skip if decrement Data Memory is zero	2[Note]	None
LSIZA [m]	Skip if increment Data Memory is zero with result in ACC	2[Note]	None
LSDZA [m]	Skip if decrement Data Memory is zero with result in ACC	2[Note]	None
Table Read			
LTABRD [m]	Read table (specific page) to TBLH and Data Memory	3[Note]	None
LTABRDL [m]	Read table (last page) to TBLH and Data Memory	3[Note]	None
LITABRD [m]	Increment table pointer TBLP first and Read table (specific page) to TBLH and Data Memory	3[Note]	None
LITABRDL [m]	Increment table pointer TBLP first and Read table (last page) to TBLH and Data Memory	3[Note]	None
Miscellaneous			
LCLR [m]	Clear Data Memory	2[Note]	None
LSET [m]	Set Data Memory	2[Note]	None
LSWAP [m]	Swap nibbles of Data Memory	2[Note]	None
LSWAPA [m]	Swap nibbles of Data Memory with result in ACC	2	None

Note: 1. For these extended skip instructions, if the result of the comparison involves a skip then three cycles are required, if no skip takes place two cycles is required.

2. Any extended instruction which changes the contents of the PCL register will also require three cycles for execution.

Instruction Definition

ADC A,[m]   Add Data Memory to ACC with Carry

Description   The contents of the specified Data Memory, Accumulator and the carry flag are added.
                         The result is stored in the Accumulator.

Operation $ACC \leftarrow ACC + [m] + C$

Affected flag(s)   OV, Z, AC, C, SC

ADCM A,[m]   Add ACC to Data Memory with Carry

Description   The contents of the specified Data Memory, Accumulator and the carry flag are added.
                         The result is stored in the specified Data Memory.

Operation $[m] \leftarrow ACC + [m] + C$

Affected flag(s)   OV, Z, AC, C, SC

ADD A,[m]   Add Data Memory to ACC

Description   The contents of the specified Data Memory and the Accumulator are added.
                         The result is stored in the Accumulator.

Operation $ACC \leftarrow ACC + [m]$

Affected flag(s)   OV, Z, AC, C, SC

ADD A,x   Add immediate data to ACC

Description   The contents of the Accumulator and the specified immediate data are added.
                         The result is stored in the Accumulator.

Operation $ACC \leftarrow ACC + x$

Affected flag(s)   OV, Z, AC, C, SC

ADDM A,[m]   Add ACC to Data Memory

Description   The contents of the specified Data Memory and the Accumulator are added.
                         The result is stored in the specified Data Memory.

Operation $[m] \leftarrow ACC + [m]$

Affected flag(s)   OV, Z, AC, C, SC

AND A,[m]   Logical AND Data Memory to ACC

Description   Data in the Accumulator and the specified Data Memory perform a bitwise logical AND
                         operation. The result is stored in the Accumulator.

Operation $ACC \leftarrow ACC\ ''AND''\ [m]$

Affected flag(s)   Z

AND A,x   Logical AND immediate data to ACC

Description   Data in the Accumulator and the specified immediate data perform a bit wise logical AND
                         operation. The result is stored in the Accumulator.

Operation $ACC \leftarrow ACC\ ''AND''\ x$

Affected flag(s)   Z

ANDM A,[m]   Logical AND ACC to Data Memory

Description   Data in the specified Data Memory and the Accumulator perform a bitwise logical AND
                         operation. The result is stored in the Data Memory.

Operation $[m] \leftarrow ACC\ ''AND''\ [m]$

Affected flag(s)   Z

CALL addr	Subroutine call
Description	Unconditionally calls a subroutine at the specified address. The Program Counter then increments by 1 to obtain the address of the next instruction which is then pushed onto the stack. The specified address is then loaded and the program continues execution from this new address. As this instruction requires an additional operation, it is a two cycle instruction.
Operation	Stack ← Program Counter + 1 Program Counter ← addr
Affected flag(s)	None

CLR [m]	Clear Data Memory
Description	Each bit of the specified Data Memory is cleared to 0.
Operation	[m] ← 00H
Affected flag(s)	None

CLR [m].i	Clear bit of Data Memory
Description	Bit i of the specified Data Memory is cleared to 0.
Operation	[m].i ← 0
Affected flag(s)	None

CLR WDT	Clear Watchdog Timer
Description	The TO, PDF flags and the WDT are all cleared.
Operation	WDT cleared TO ← 0 PDF ← 0
Affected flag(s)	TO, PDF

CPL [m]	Complement Data Memory
Description	Each bit of the specified Data Memory is logically complemented (1′s complement). Bits which previously contained a 1 are changed to 0 and vice versa.
Operation	[m] ← $\overline{[m]}$
Affected flag(s)	Z

CPLA [m]	Complement Data Memory with result in ACC
Description	Each bit of the specified Data Memory is logically complemented (1′s complement). Bits which previously contained a 1 are changed to 0 and vice versa. The complemented result is stored in the Accumulator and the contents of the Data Memory remain unchanged.
Operation	ACC ← $\overline{[m]}$
Affected flag(s)	Z

DAA [m]	Decimal-Adjust ACC for addition with result in Data Memory
Description	Convert the contents of the Accumulator value to a BCD (Binary Coded Decimal) value resulting from the previous addition of two BCD variables. If the low nibble is greater than 9 or if AC flag is set, then a value of 6 will be added to the low nibble. Otherwise the low nibble remains unchanged. If the high nibble is greater than 9 or if the C flag is set, then a value of 6 will be added to the high nibble. Essentially, the decimal conversion is performed by adding 00H, 06H, 60H or 66H depending on the Accumulator and flag conditions. Only the C flag may be affected by this instruction which indicates that if the original BCD sum is greater than 100, it allows multiple precision decimal addition.
Operation	[m] ← ACC + 00H or [m] ← ACC + 06H or [m] ← ACC + 60H or [m] ← ACC + 66H
Affected flag(s)	C

DEC [m]	Decrement Data Memory
Description	Data in the specified Data Memory is decremented by 1.
Operation	[m] ← [m] − 1
Affected flag(s)	Z

DECA [m]	Decrement Data Memory with result in ACC
Description	Data in the specified Data Memory is decremented by 1. The result is stored in the Accumulator. The contents of the Data Memory remain unchanged.
Operation	ACC ← [m] − 1
Affected flag(s)	Z

HALT	Enter power down mode
Description	This instruction stops the program execution and turns off the system clock. The contents of the Data Memory and registers are retained. The WDT and prescaler are cleared. The power down flag PDF is set and the WDT time-out flag TO is cleared.
Operation	TO ← 0 PDF ← 1
Affected flag(s)	TO, PDF

INC [m]	Increment Data Memory
Description	Data in the specified Data Memory is incremented by 1.
Operation	[m] ← [m] + 1
Affected flag(s)	Z

INCA [m]	Increment Data Memory with result in ACC
Description	Data in the specified Data Memory is incremented by 1. The result is stored in the Accumulator. The contents of the Data Memory remain unchanged.
Operation	ACC ← [m] + 1
Affected flag(s)	Z

JMP addr	Jump unconditionally
Description	The contents of the Program Counter are replaced with the specified address. Program execution then continues from this new address. As this requires the insertion of a dummy instruction while the new address is loaded, it is a two cycle instruction.
Operation	Program Counter ← addr
Affected flag(s)	None

MOV A,[m]	Move Data Memory to ACC
Description	The contents of the specified Data Memory are copied to the Accumulator.
Operation	ACC ← [m]
Affected flag(s)	None

MOV A,x	Move immediate data to ACC
Description	The immediate data specified is loaded into the Accumulator.
Operation	ACC ← x
Affected flag(s)	None

MOV [m],A	Move ACC to Data Memory
Description	The contents of the Accumulator are copied to the specified Data Memory.
Operation	[m] ← ACC
Affected flag(s)	None

NOP	No operation
Description	No operation is performed. Execution continues with the next instruction.
Operation	No operation
Affected flag(s)	None

OR A,[m]	Logical OR Data Memory to ACC
Description	Data in the Accumulator and the specified Data Memory perform a bitwise logical OR operation. The result is stored in the Accumulator.
Operation	ACC ← ACC ″OR″ [m]
Affected flag(s)	Z

OR A,x	Logical OR immediate data to ACC
Description	Data in the Accumulator and the specified immediate data perform a bitwise logical OR operation. The result is stored in the Accumulator.
Operation	ACC ← ACC ″OR″ x
Affected flag(s)	Z

ORM A,[m]	Logical OR ACC to Data Memory
Description	Data in the specified Data Memory and the Accumulator perform a bitwise logical OR operation. The result is stored in the Data Memory.
Operation	[m] ← ACC ″OR″ [m]
Affected flag(s)	Z

RET	Return from subroutine
Description	The Program Counter is restored from the stack. Program execution continues at the restored address.
Operation	Program Counter ← Stack
Affected flag(s)	None

RET A,x	Return from subroutine and load immediate data to ACC
Description	The Program Counter is restored from the stack and the Accumulator loaded with the specified immediate data. Program execution continues at the restored address.
Operation	Program Counter ← Stack ACC ← x
Affected flag(s)	None

RETI	Return from interrupt
Description	The Program Counter is restored from the stack and the interrupts are re-enabled by setting the EMI bit. EMI is the master interrupt global enable bit. If an interrupt was pending when the RETI instruction is executed, the pending Interrupt routine will be processed before returning to the main program.
Operation	Program Counter ← Stack EMI ← 1
Affected flag(s)	None

RL [m]	Rotate Data Memory left
Description	The contents of the specified Data Memory are rotated left by 1 bit with bit 7 rotated into bit 0.
Operation	[m].(i+1) ← [m].i; (i=0~6) [m].0 ← [m].7
Affected flag(s)	None

RLA [m]   Rotate Data Memory left with result in ACC

Description   The contents of the specified Data Memory are rotated left by 1 bit with bit 7 rotated into bit 0. The rotated result is stored in the Accumulator and the contents of the Data Memory remain unchanged.

Operation   ACC.(i+1) ← [m].i; (i=0~6)
                     ACC.0 ← [m].7

Affected flag(s)   None

RLC [m]   Rotate Data Memory left through Carry

Description   The contents of the specified Data Memory and the carry flag are rotated left by 1 bit. Bit 7 replaces the Carry bit and the original carry flag is rotated into bit 0.

Operation   [m].(i+1) ← [m].i; (i=0~6)
                     [m].0 ← C
                     C ← [m].7

Affected flag(s)   C

RLCA [m]   Rotate Data Memory left through Carry with result in ACC

Description   Data in the specified Data Memory and the carry flag are rotated left by 1 bit. Bit 7 replaces the Carry bit and the original carry flag is rotated into the bit 0. The rotated result is stored in the Accumulator and the contents of the Data Memory remain unchanged.

Operation   ACC.(i+1) ← [m].i; (i=0~6)
                     ACC.0 ← C
                     C ← [m].7

Affected flag(s)   C

RR [m]   Rotate Data Memory right

Description   The contents of the specified Data Memory are rotated right by 1 bit with bit 0 rotated into bit 7.

Operation   [m].i ← [m].(i+1); (i=0~6)
                     [m].7 ← [m].0

Affected flag(s)   None

RRA [m]   Rotate Data Memory right with result in ACC

Description   Data in the specified Data Memory is rotated right by 1 bit with bit 0
                     rotated into bit 7. The rotated result is stored in the Accumulator and the contents of the
                     Data Memory remain unchanged.

Operation   ACC.i ← [m].(i+1); (i=0~6)
                     ACC.7 ← [m].0

Affected flag(s)   None

RRC [m]   Rotate Data Memory right through Carry

Description   The contents of the specified Data Memory and the carry flag are rotated right by 1 bit. Bit 0 replaces the Carry bit and the original carry flag is rotated into bit 7.

Operation   [m].i ← [m].(i+1); (i=0~6)
                     [m].7 ← C
                     C ← [m].0

Affected flag(s)   C

RRCA [m]	Rotate Data Memory right through Carry with result in ACC
Description	Data in the specified Data Memory and the carry flag are rotated right by 1 bit. Bit 0 replaces the Carry bit and the original carry flag is rotated into bit 7. The rotated result is stored in the Accumulator and the contents of the Data Memory remain unchanged.
Operation	$ACC.i \leftarrow [m].(i+1); (i=0\sim6)$ $ACC.7 \leftarrow C$ $C \leftarrow [m].0$
Affected flag(s)	C

SBC A,[m]	Subtract Data Memory from ACC with Carry
Description	The contents of the specified Data Memory and the complement of the carry flag are subtracted from the Accumulator. The result is stored in the Accumulator. Note that if the result of subtraction is negative, the C flag will be cleared to 0, otherwise if the result is positive or zero, the C flag will be set to 1.
Operation	$ACC \leftarrow ACC - [m] - \overline{C}$
Affected flag(s)	OV, Z, AC, C, SC, CZ

SBC A, x	Subtract immediate data from ACC with Carry
Description	The immediate data and the complement of the carry flag are subtracted from the Accumulator. The result is stored in the Accumulator. Note that if the result of subtraction is negative, the C flag will be cleared to 0, otherwise if the result is positive or zero, the C flag will be set to 1.
Operation	$ACC \leftarrow ACC - [m] - \overline{C}$
Affected flag(s)	OV, Z, AC, C, SC, CZ

SBCM A,[m]	Subtract Data Memory from ACC with Carry and result in Data Memory
Description	The contents of the specified Data Memory and the complement of the carry flag are subtracted from the Accumulator. The result is stored in the Data Memory. Note that if the result of subtraction is negative, the C flag will be cleared to 0, otherwise if the result is positive or zero, the C flag will be set to 1.
Operation	$[m] \leftarrow ACC - [m] - \overline{C}$
Affected flag(s)	OV, Z, AC, C, SC, CZ

SDZ [m]	Skip if decrement Data Memory is 0
Description	The contents of the specified Data Memory are first decremented by 1. If the result is 0 the following instruction is skipped. As this requires the insertion of a dummy instruction while the next instruction is fetched, it is a two cycle instruction. If the result is not 0 the program proceeds with the following instruction.
Operation	$[m] \leftarrow [m] - 1$ Skip if [m]=0
Affected flag(s)	None

SDZA [m]	Skip if decrement Data Memory is zero with result in ACC
Description	The contents of the specified Data Memory are first decremented by 1. If the result is 0, the following instruction is skipped. The result is stored in the Accumulator but the specified Data Memory contents remain unchanged. As this requires the insertion of a dummy instruction while the next instruction is fetched, it is a two cycle instruction. If the result is not 0, the program proceeds with the following instruction.
Operation	$ACC \leftarrow [m] - 1$ Skip if ACC=0
Affected flag(s)	None

SET [m]	Set Data Memory
Description	Each bit of the specified Data Memory is set to 1.
Operation	[m] ← FFH
Affected flag(s)	None

SET [m].i	Set bit of Data Memory
Description	Bit i of the specified Data Memory is set to 1.
Operation	[m].i ← 1
Affected flag(s)	None

SIZ [m]	Skip if increment Data Memory is 0
Description	The contents of the specified Data Memory are first incremented by 1. If the result is 0, the following instruction is skipped. As this requires the insertion of a dummy instruction while the next instruction is fetched, it is a two cycle instruction. If the result is not 0 the program proceeds with the following instruction.
Operation	[m] ← [m] + 1 Skip if [m]=0
Affected flag(s)	None

SIZA [m]	Skip if increment Data Memory is zero with result in ACC
Description	The contents of the specified Data Memory are first incremented by 1. If the result is 0, the following instruction is skipped. The result is stored in the Accumulator but the specified Data Memory contents remain unchanged. As this requires the insertion of a dummy instruction while the next instruction is fetched, it is a two cycle instruction. If the result is not 0 the program proceeds with the following instruction.
Operation	ACC ← [m] + 1 Skip if ACC=0
Affected flag(s)	None

SNZ [m].i	Skip if bit i of Data Memory is not 0
Description	If bit i of the specified Data Memory is not 0, the following instruction is skipped. As this requires the insertion of a dummy instruction while the next instruction is fetched, it is a two cycle instruction. If the result is 0 the program proceeds with the following instruction.
Operation	Skip if [m].i ≠ 0
Affected flag(s)	None

SNZ [m]	Skip if Data Memory is not 0
Description	The contents of the specified Data Memory are read out and then written back to the specified Data Memory again. If the specified Data Memory is not 0, the following instruction is skipped. As this requires the insertion of a dummy instruction while the next instruction is fetched, it is a two cycle instruction. If the result is 0 the program proceeds with the following instruction.
Operation	Skip if [m]≠ 0
Affected flag(s)	None

SUB A,[m]	Subtract Data Memory from ACC
Description	The specified Data Memory is subtracted from the contents of the Accumulator. The result is stored in the Accumulator. Note that if the result of subtraction is negative, the C flag will be cleared to 0, otherwise if the result is positive or zero, the C flag will be set to 1.
Operation	ACC ← ACC − [m]
Affected flag(s)	OV, Z, AC, C, SC, CZ

SUBM A,[m]	Subtract Data Memory from ACC with result in Data Memory
Description	The specified Data Memory is subtracted from the contents of the Accumulator. The result is stored in the Data Memory. Note that if the result of subtraction is negative, the C flag will be cleared to 0, otherwise if the result is positive or zero, the C flag will be set to 1.
Operation	$[m] \leftarrow ACC - [m]$
Affected flag(s)	OV, Z, AC, C, SC, CZ

SUB A,x	Subtract immediate data from ACC
Description	The immediate data specified by the code is subtracted from the contents of the Accumulator. The result is stored in the Accumulator. Note that if the result of subtraction is negative, the C flag will be cleared to 0, otherwise if the result is positive or zero, the C flag will be set to 1.
Operation	$ACC \leftarrow ACC - x$
Affected flag(s)	OV, Z, AC, C, SC, CZ

SWAP [m]	Swap nibbles of Data Memory
Description	The low-order and high-order nibbles of the specified Data Memory are interchanged.
Operation	$[m].3\sim[m].0 \leftrightarrow [m].7\sim[m].4$
Affected flag(s)	None

SWAPA [m]	Swap nibbles of Data Memory with result in ACC
Description	The low-order and high-order nibbles of the specified Data Memory are interchanged. The result is stored in the Accumulator. The contents of the Data Memory remain unchanged.
Operation	$ACC.3\sim ACC.0 \leftarrow [m].7\sim[m].4$ $ACC.7\sim ACC.4 \leftarrow [m].3\sim[m].0$
Affected flag(s)	None

SZ [m]	Skip if Data Memory is 0
Description	The contents of the specified Data Memory are read out and then written back to the specified Data Memory again. If the contents of the specified Data Memory is 0, the following instruction is skipped. As this requires the insertion of a dummy instruction while the next instruction is fetched, it is a two cycle instruction. If the result is not 0 the program proceeds with the following instruction.
Operation	Skip if $[m]=0$
Affected flag(s)	None

SZA [m]	Skip if Data Memory is 0 with data movement to ACC
Description	The contents of the specified Data Memory are copied to the Accumulator. If the value is zero, the following instruction is skipped. As this requires the insertion of a dummy instruction while the next instruction is fetched, it is a two cycle instruction. If the result is not 0 the program proceeds with the following instruction.
Operation	$ACC \leftarrow [m]$ Skip if $[m]=0$
Affected flag(s)	None

SZ [m].i	Skip if bit i of Data Memory is 0
Description	If bit i of the specified Data Memory is 0, the following instruction is skipped. As this requires the insertion of a dummy instruction while the next instruction is fetched, it is a two cycle instruction. If the result is not 0, the program proceeds with the following instruction.
Operation	Skip if $[m].i=0$
Affected flag(s)	None

TABRD [m]	Read table (specific page) to TBLH and Data Memory
Description	The low byte of the program code (specific page) addressed by the table pointer (TBLP and TBHP) is moved to the specified Data Memory and the high byte moved to TBLH.
Operation	[m] ← program code (low byte) TBLH ← program code (high byte)
Affected flag(s)	None

TABRDL [m]	Read table (last page) to TBLH and Data Memory
Description	The low byte of the program code (last page) addressed by the table pointer (TBLP) is moved to the specified Data Memory and the high byte moved to TBLH.
Operation	[m] ← program code (low byte) TBLH ← program code (high byte)
Affected flag(s)	None

ITABRD [m]	Increment table pointer low byte first and read table (specific page) to TBLH and Data Memory
Description	Increment table pointer low byte, TBLP, first and then the program code (specific page) addressed by the table pointer (TBHP and TBLP) is moved to the specified Data Memory and the high byte moved to TBLH.
Operation	[m] ← program code (low byte) TBLH ← program code (high byte)
Affected flag(s)	None

ITABRDL [m]	Increment table pointer low byte first and read table (last page) to TBLH and Data Memory
Description	Increment table pointer low byte, TBLP, first and then the low byte of the program code (last page) addressed by the table pointer (TBLP) is moved to the specified Data Memory and the high byte moved to TBLH.
Operation	[m] ← program code (low byte) TBLH ← program code (high byte)
Affected flag(s)	None

XOR A,[m]	Logical XOR Data Memory to ACC
Description	Data in the Accumulator and the specified Data Memory perform a bitwise logical XOR operation. The result is stored in the Accumulator.
Operation	ACC ← ACC ″XOR″ [m]
Affected flag(s)	Z

XORM A,[m]	Logical XOR ACC to Data Memory
Description	Data in the specified Data Memory and the Accumulator perform a bitwise logical XOR operation. The result is stored in the Data Memory.
Operation	[m] ← ACC ″XOR″ [m]
Affected flag(s)	Z

XOR A,x	Logical XOR immediate data to ACC
Description	Data in the Accumulator and the specified immediate data perform a bitwise logical XOR operation. The result is stored in the Accumulator.
Operation	ACC ← ACC ″XOR″ x
Affected flag(s)	Z

Extended Instruction Definition

The extended instructions are used to directly access the data stored in any data memory sections.

LADC A,[m]	Add Data Memory to ACC with Carry
Description	The contents of the specified Data Memory, Accumulator and the carry flag are added. The result is stored in the Accumulator.
Operation	ACC ← ACC + [m] + C
Affected flag(s)	OV, Z, AC, C, SC

LADCM A,[m]	Add ACC to Data Memory with Carry
Description	The contents of the specified Data Memory, Accumulator and the carry flag are added. The result is stored in the specified Data Memory.
Operation	[m] ← ACC + [m] + C
Affected flag(s)	OV, Z, AC, C, SC

LADD A,[m]	Add Data Memory to ACC
Description	The contents of the specified Data Memory and the Accumulator are added. The result is stored in the Accumulator.
Operation	ACC ← ACC + [m]
Affected flag(s)	OV, Z, AC, C, SC

LADDM A,[m]	Add ACC to Data Memory
Description	The contents of the specified Data Memory and the Accumulator are added. The result is stored in the specified Data Memory.
Operation	[m] ← ACC + [m]
Affected flag(s)	OV, Z, AC, C, SC

LAND A,[m]	Logical AND Data Memory to ACC
Description	Data in the Accumulator and the specified Data Memory perform a bitwise logical AND operation. The result is stored in the Accumulator.
Operation	ACC ← ACC ″AND″ [m]
Affected flag(s)	Z

LANDM A,[m]	Logical AND ACC to Data Memory
Description	Data in the specified Data Memory and the Accumulator perform a bitwise logical AND operation. The result is stored in the Data Memory.
Operation	[m] ← ACC ″AND″ [m]
Affected flag(s)	Z

LCLR [m]	Clear Data Memory
Description	Each bit of the specified Data Memory is cleared to 0.
Operation	[m] ← 00H
Affected flag(s)	None

LCLR [m].i	Clear bit of Data Memory
Description	Bit i of the specified Data Memory is cleared to 0.
Operation	[m].i ← 0
Affected flag(s)	None

LCPL [m]	Complement Data Memory
Description	Each bit of the specified Data Memory is logically complemented (1′s complement). Bits which previously contained a 1 are changed to 0 and vice versa.
Operation	$[m] \leftarrow \overline{[m]}$
Affected flag(s)	Z

LCPLA [m]	Complement Data Memory with result in ACC
Description	Each bit of the specified Data Memory is logically complemented (1′s complement). Bits which previously contained a 1 are changed to 0 and vice versa. The complemented result is stored in the Accumulator and the contents of the Data Memory remain unchanged.
Operation	$ACC \leftarrow \overline{[m]}$
Affected flag(s)	Z

LDAA [m]	Decimal-Adjust ACC for addition with result in Data Memory
Description	Convert the contents of the Accumulator value to a BCD (Binary Coded Decimal) value resulting from the previous addition of two BCD variables. If the low nibble is greater than 9 or if AC flag is set, then a value of 6 will be added to the low nibble. Otherwise the low nibble remains unchanged. If the high nibble is greater than 9 or if the C flag is set, then a value of 6 will be added to the high nibble. Essentially, the decimal conversion is performed by adding 00H, 06H, 60H or 66H depending on the Accumulator and flag conditions. Only the C flag may be affected by this instruction which indicates that if the original BCD sum is greater than 100, it allows multiple precision decimal addition.
Operation	$[m] \leftarrow ACC + 00H$ or $[m] \leftarrow ACC + 06H$ or $[m] \leftarrow ACC + 60H$ or $[m] \leftarrow ACC + 66H$
Affected flag(s)	C

LDEC [m]	Decrement Data Memory
Description	Data in the specified Data Memory is decremented by 1.
Operation	$[m] \leftarrow [m] - 1$
Affected flag(s)	Z

LDECA [m]	Decrement Data Memory with result in ACC
Description	Data in the specified Data Memory is decremented by 1. The result is stored in the Accumulator. The contents of the Data Memory remain unchanged.
Operation	$ACC \leftarrow [m] - 1$
Affected flag(s)	Z

LINC [m]	Increment Data Memory
Description	Data in the specified Data Memory is incremented by 1.
Operation	$[m] \leftarrow [m] + 1$
Affected flag(s)	Z

LINCA [m]	Increment Data Memory with result in ACC
Description	Data in the specified Data Memory is incremented by 1. The result is stored in the Accumulator. The contents of the Data Memory remain unchanged.
Operation	$ACC \leftarrow [m] + 1$
Affected flag(s)	Z

LMOV A,[m]	Move Data Memory to ACC
Description	The contents of the specified Data Memory are copied to the Accumulator.
Operation	ACC ← [m]
Affected flag(s)	None

LMOV [m],A	Move ACC to Data Memory
Description	The contents of the Accumulator are copied to the specified Data Memory.
Operation	[m] ← ACC
Affected flag(s)	None

LOR A,[m]	Logical OR Data Memory to ACC
Description	Data in the Accumulator and the specified Data Memory perform a bitwise logical OR operation. The result is stored in the Accumulator.
Operation	ACC ← ACC ″OR″ [m]
Affected flag(s)	Z

LORM A,[m]	Logical OR ACC to Data Memory
Description	Data in the specified Data Memory and the Accumulator perform a bitwise logical OR operation. The result is stored in the Data Memory.
Operation	[m] ← ACC ″OR″ [m]
Affected flag(s)	Z

LRL [m]	Rotate Data Memory left
Description	The contents of the specified Data Memory are rotated left by 1 bit with bit 7 rotated into bit 0.
Operation	[m].(i+1) ← [m].i; (i=0~6) [m].0 ← [m].7
Affected flag(s)	None

LRLA [m]	Rotate Data Memory left with result in ACC
Description	The contents of the specified Data Memory are rotated left by 1 bit with bit 7 rotated into bit 0. The rotated result is stored in the Accumulator and the contents of the Data Memory remain unchanged.
Operation	ACC.(i+1) ← [m].i; (i=0~6) ACC.0 ← [m].7
Affected flag(s)	None

LRLC [m]	Rotate Data Memory left through Carry
Description	The contents of the specified Data Memory and the carry flag are rotated left by 1 bit. Bit 7 replaces the Carry bit and the original carry flag is rotated into bit 0.
Operation	[m].(i+1) ← [m].i; (i=0~6) [m].0 ← C C ← [m].7
Affected flag(s)	C

LRLCA [m]	Rotate Data Memory left through Carry with result in ACC
Description	Data in the specified Data Memory and the carry flag are rotated left by 1 bit. Bit 7 replaces the Carry bit and the original carry flag is rotated into the bit 0. The rotated result is stored in the Accumulator and the contents of the Data Memory remain unchanged.
Operation	ACC.(i+1) ← [m].i; (i=0~6) ACC.0 ← C C ← [m].7
Affected flag(s)	C

LRR [m]	Rotate Data Memory right
Description	The contents of the specified Data Memory are rotated right by 1 bit with bit 0 rotated into bit 7.
Operation	[m].i ← [m].(i+1); (i=0~6) [m].7 ← [m].0
Affected flag(s)	None

LRRA [m]	Rotate Data Memory right with result in ACC
Description	Data in the specified Data Memory is rotated right by 1 bit with bit 0 rotated into bit 7. The rotated result is stored in the Accumulator and the contents of the Data Memory remain unchanged.
Operation	ACC.i ← [m].(i+1); (i=0~6) ACC.7 ← [m].0
Affected flag(s)	None

LRRC [m]	Rotate Data Memory right through Carry
Description	The contents of the specified Data Memory and the carry flag are rotated right by 1 bit. Bit 0 replaces the Carry bit and the original carry flag is rotated into bit 7.
Operation	[m].i ← [m].(i+1); (i=0~6) [m].7 ← C C ← [m].0
Affected flag(s)	C

LRRCA [m]	Rotate Data Memory right through Carry with result in ACC
Description	Data in the specified Data Memory and the carry flag are rotated right by 1 bit. Bit 0 replaces the Carry bit and the original carry flag is rotated into bit 7. The rotated result is stored in the Accumulator and the contents of the Data Memory remain unchanged.
Operation	ACC.i ← [m].(i+1); (i=0~6) ACC.7 ← C C ← [m].0
Affected flag(s)	C

LSBC A,[m]	Subtract Data Memory from ACC with Carry
Description	The contents of the specified Data Memory and the complement of the carry flag are subtracted from the Accumulator. The result is stored in the Accumulator. Note that if the result of subtraction is negative, the C flag will be cleared to 0, otherwise if the result is positive or zero, the C flag will be set to 1.
Operation	$ACC \leftarrow ACC - [m] - \overline{C}$
Affected flag(s)	OV, Z, AC, C, SC, CZ

LSBCM A,[m]	Subtract Data Memory from ACC with Carry and result in Data Memory
Description	The contents of the specified Data Memory and the complement of the carry flag are subtracted from the Accumulator. The result is stored in the Data Memory. Note that if the result of subtraction is negative, the C flag will be cleared to 0, otherwise if the result is positive or zero, the C flag will be set to 1.
Operation	$[m] \leftarrow ACC - [m] - \overline{C}$
Affected flag(s)	OV, Z, AC, C, SC, CZ

LSDZ [m]	Skip if decrement Data Memory is 0
Description	The contents of the specified Data Memory are first decremented by 1. If the result is 0 the following instruction is skipped. As this requires the insertion of a dummy instruction while the next instruction is fetched, it is a three cycle instruction. If the result is not 0 the program proceeds with the following instruction.
Operation	$[m] \leftarrow [m] - 1$ Skip if $[m]=0$
Affected flag(s)	None

LSDZA [m]	Skip if decrement Data Memory is zero with result in ACC
Description	The contents of the specified Data Memory are first decremented by 1. If the result is 0, the following instruction is skipped. The result is stored in the Accumulator but the specified Data Memory contents remain unchanged. As this requires the insertion of a dummy instruction while the next instruction is fetched, it is a three cycle instruction. If the result is not 0, the program proceeds with the following instruction.
Operation	$ACC \leftarrow [m] - 1$ Skip if $ACC=0$
Affected flag(s)	None

LSET [m]	Set Data Memory
Description	Each bit of the specified Data Memory is set to 1.
Operation	$[m] \leftarrow FFH$
Affected flag(s)	None

LSET [m].i	Set bit of Data Memory
Description	Bit i of the specified Data Memory is set to 1.
Operation	$[m].i \leftarrow 1$
Affected flag(s)	None

LSIZ [m]	Skip if increment Data Memory is 0
Description	The contents of the specified Data Memory are first incremented by 1. If the result is 0, the following instruction is skipped. As this requires the insertion of a dummy instruction while the next instruction is fetched, it is a three cycle instruction. If the result is not 0 the program proceeds with the following instruction.
Operation	$[m] \leftarrow [m] + 1$ Skip if $[m]=0$
Affected flag(s)	None

LSIZA [m]	Skip if increment Data Memory is zero with result in ACC
Description	The contents of the specified Data Memory are first incremented by 1. If the result is 0, the following instruction is skipped. The result is stored in the Accumulator but the specified Data Memory contents remain unchanged. As this requires the insertion of a dummy instruction while the next instruction is fetched, it is a three cycle instruction. If the result is not 0 the program proceeds with the following instruction.
Operation	$ACC \leftarrow [m] + 1$ Skip if $ACC=0$
Affected flag(s)	None

LSNZ [m].i	Skip if bit i of Data Memory is not 0
Description	If bit i of the specified Data Memory is not 0, the following instruction is skipped. As this requires the insertion of a dummy instruction while the next instruction is fetched, it is a three cycle instruction. If the result is 0 the program proceeds with the following instruction.
Operation	Skip if $[m].i \neq 0$
Affected flag(s)	None

LSNZ [m]   Skip if Data Memory is not 0

Description   The contents of the specified Data Memory are read out and then written to the specified Data Memory again. If the content of the specified Data Memory is not 0, the following instruction is skipped. As this requires the insertion of a dummy instruction while the next instruction is fetched, it is a three cycle instruction. If the result is 0 the program proceeds with the following instruction.

Operation   Skip if $[m] \neq 0$

Affected flag(s)   None

LSUB A,[m]   Subtract Data Memory from ACC

Description   The specified Data Memory is subtracted from the contents of the Accumulator. The result is stored in the Accumulator. Note that if the result of subtraction is negative, the C flag will be cleared to 0, otherwise if the result is positive or zero, the C flag will be set to 1.

Operation $ACC \leftarrow ACC - [m]$

Affected flag(s)   OV, Z, AC, C, SC, CZ

LSUBM A,[m]   Subtract Data Memory from ACC with result in Data Memory

Description   The specified Data Memory is subtracted from the contents of the Accumulator. The result is stored in the Data Memory. Note that if the result of subtraction is negative, the C flag will be cleared to 0, otherwise if the result is positive or zero, the C flag will be set to 1.

Operation $[m] \leftarrow ACC - [m]$

Affected flag(s)   OV, Z, AC, C, SC, CZ

LSWAP [m]   Swap nibbles of Data Memory

Description   The low-order and high-order nibbles of the specified Data Memory are interchanged.

Operation $[m].3 \sim [m].0 \leftrightarrow [m].7 \sim [m].4$

Affected flag(s)   None

LSWAPA [m]   Swap nibbles of Data Memory with result in ACC

Description   The low-order and high-order nibbles of the specified Data Memory are interchanged. The result is stored in the Accumulator. The contents of the Data Memory remain unchanged.

Operation $ACC.3 \sim ACC.0 \leftarrow [m].7 \sim [m].4$
                     $ACC.7 \sim ACC.4 \leftarrow [m].3 \sim [m].0$

Affected flag(s)   None

LSZ [m]   Skip if Data Memory is 0

Description   The contents of the specified Data Memory are read out and then written to the specified Data Memory again. If the contents of the specified Data Memory is 0, the following instruction is skipped. As this requires the insertion of a dummy instruction while the next instruction is fetched, it is a three cycle instruction. If the result is not 0 the program proceeds with the following instruction.

Operation   Skip if $[m]=0$

Affected flag(s)   None

LSZA [m]   Skip if Data Memory is 0 with data movement to ACC

Description   The contents of the specified Data Memory are copied to the Accumulator. If the value is zero, the following instruction is skipped. As this requires the insertion of a dummy instruction while the next instruction is fetched, it is a three cycle instruction. If the result is not 0 the program proceeds with the following instruction.

Operation $ACC \leftarrow [m]$
                     Skip if $[m]=0$

Affected flag(s)   None

LSZ [m].i	Skip if bit i of Data Memory is 0
Description	If bit i of the specified Data Memory is 0, the following instruction is skipped. As this requires the insertion of a dummy instruction while the next instruction is fetched, it is a three cycle instruction. If the result is not 0, the program proceeds with the following instruction.
Operation	Skip if [m].i=0
Affected flag(s)	None

LTABRD [m]	Read table (specific page) to TBLH and Data Memory
Description	The low byte of the program code (specific page) addressed by the table pointer (TBHP and TBLP) is moved to the specified Data Memory and the high byte moved to TBLH.
Operation	[m] ← program code (low byte) TBLH ← program code (high byte)
Affected flag(s)	None

LTABRDL [m]	Read table (last page) to TBLH and Data Memory
Description	The low byte of the program code (last page) addressed by the table pointer (TBLP) is moved to the specified Data Memory and the high byte moved to TBLH.
Operation	[m] ← program code (low byte) TBLH ← program code (high byte)
Affected flag(s)	None

LITABRD [m]	Increment table pointer low byte first and read table (specific page) to TBLH and Data Memory
Description	Increment table pointer low byte, TBLP, first and then the program code (specific page) addressed by the table pointer (TBHP and TBLP) is moved to the specified Data Memory and the high byte moved to TBLH.
Operation	[m] ← program code (low byte) TBLH ← program code (high byte)
Affected flag(s)	None

LITABRDL [m]	Increment table pointer low byte first and read table (last page) to TBLH and Data Memory
Description	Increment table pointer low byte, TBLP, first and then the low byte of the program code (last page) addressed by the table pointer (TBLP) is moved to the specified Data Memory and the high byte moved to TBLH.
Operation	[m] ← program code (low byte) TBLH ← program code (high byte)
Affected flag(s)	None

LXOR A,[m]	Logical XOR Data Memory to ACC
Description	Data in the Accumulator and the specified Data Memory perform a bitwise logical XOR operation. The result is stored in the Accumulator.
Operation	ACC ← ACC ″XOR″ [m]
Affected flag(s)	Z

LXORM A,[m]	Logical XOR ACC to Data Memory
Description	Data in the specified Data Memory and the Accumulator perform a bitwise logical XOR operation. The result is stored in the Data Memory.
Operation	[m] ← ACC ″XOR″ [m]
Affected flag(s)	Z

Package Information

Note that the package information provided here is for consultation purposes only. As this information may be updated at regular intervals users are reminded to consult the Holtek website for the latest version of the Package/Carton Information.

Additional supplementary information with regard to packaging is listed below. Click on the relevant section to be transferred to the relevant website page.

- Package Information (include Outline Dimensions, Product Tape and Reel Specifications)

- The Operation Instruction of Packing Materials

- Carton information

32-pin LQFP (7mm×7mm) Outline Dimension
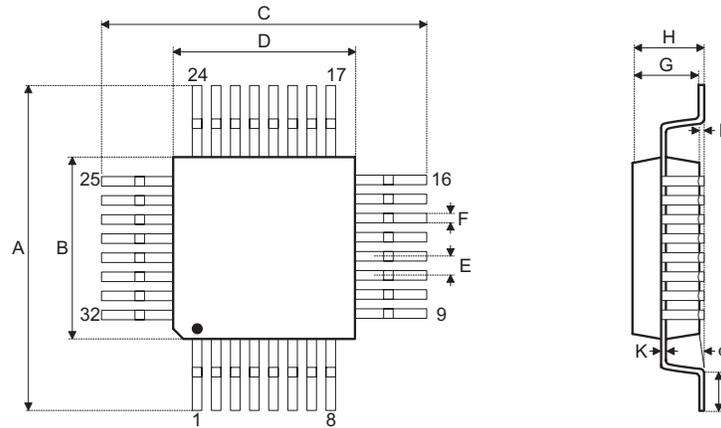
Symbol	Dimensions in inch		
	Min.	Nom.	Max.
A		0.354 BSC	
B		0.276 BSC	
C		0.354 BSC	
D		0.276 BSC	
E		0.032 BSC	
F	0.012	0.015	0.018
G	0.053	0.055	0.057
H	—	—	0.063
I	0.002	—	0.006
J	0.018	0.024	0.030
K	0.004	—	0.008
α	0°	—	7°

Symbol	Dimensions in mm		
	Min.	Nom.	Max.
A		9.00 BSC	
B		7.00 BSC	
C		9.00 BSC	
D		7.00 BSC	
E		0.80 BSC	
F	0.30	0.37	0.45
G	1.35	1.40	1.45
H	—	—	1.60
I	0.05	—	0.15
J	0.45	0.60	0.75
K	0.09	—	0.20
α	0°	—	7°

44-pin LQFP (10mm×10mm) (FP2.0mm) Outline Dimensions
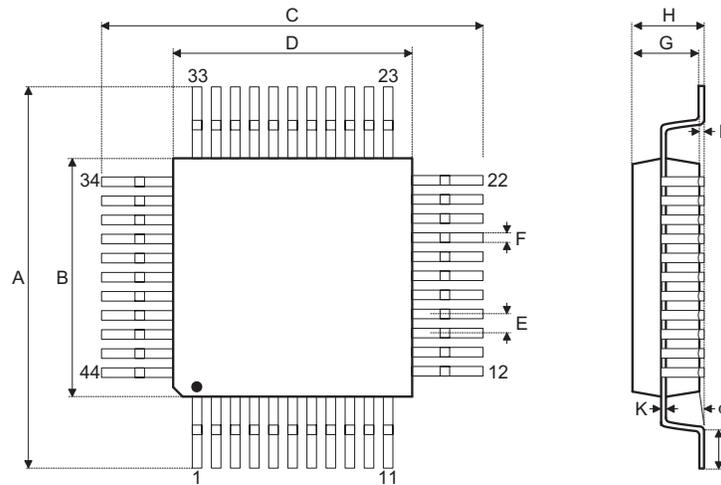
Symbol	Dimensions in inch		
	Min.	**Nom.**	**Max.**
A		0.472 BSC	
B		0.394 BSC	
C		0.472 BSC	
D		0.394 BSC	
E		0.032 BSC	
F	0.012	0.015	0.018
G	0.053	0.055	0.057
H	—	—	0.063
I	0.002	—	0.006
J	0.018	0.024	0.030
K	0.004	—	0.008
α	0°	—	7°

Symbol	Dimensions in mm		
	Min.	**Nom.**	**Max.**
A		12.00 BSC	
B		10.00 BSC	
C		12.00 BSC	
D		10.00 BSC	
E		0.80 BSC	
F	0.30	0.37	0.45
G	1.35	1.40	1.45
H	—	—	1.60
I	0.05	—	0.15
J	0.45	0.60	0.75
K	0.09	—	0.20
α	0°	—	7°

48-pin LQFP (7mm×7mm) Outline Dimensions
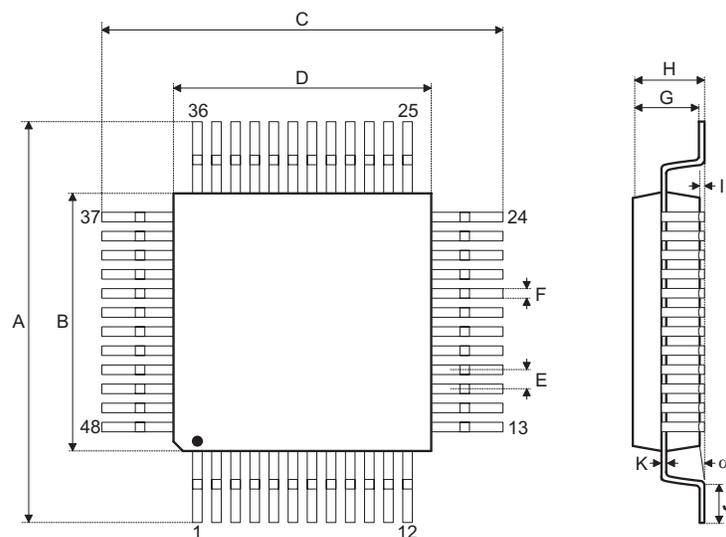
Symbol	Dimensions in inch		
	Min.	Nom.	Max.
A		0.354 BSC	
B		0.276 BSC	
C		0.354 BSC	
D		0.276 BSC	
E		0.020 BSC	
F	0.007	0.009	0.011
G	0.053	0.055	0.057
H	—	—	0.063
I	0.002	—	0.006
J	0.018	0.024	0.030
K	0.004	—	0.008
α	0°	—	7°

Symbol	Dimensions in mm		
	Min.	Nom.	Max.
A		9.00 BSC	
B		7.00 BSC	
C		9.00 BSC	
D		7.00 BSC	
E		0.50 BSC	
F	0.17	0.22	0.27
G	1.35	1.40	1.45
H	—	—	1.60
I	0.05	—	0.15
J	0.45	0.60	0.75
K	0.09	—	0.20
α	0°	—	7°